TEKTRONIX®

LA 501 LOGIC ANALYZER

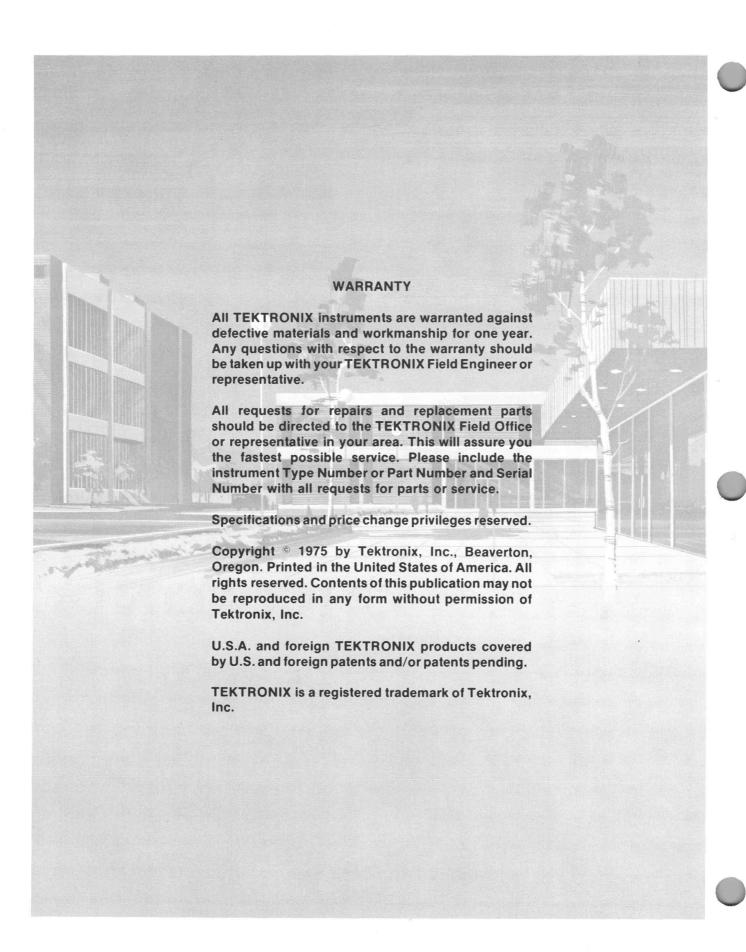
WITH OPTIONS

INSTRUCTION MANUAL

Tektronix, Inc. P.O. Box 500 Beaverton, Oregon 97077

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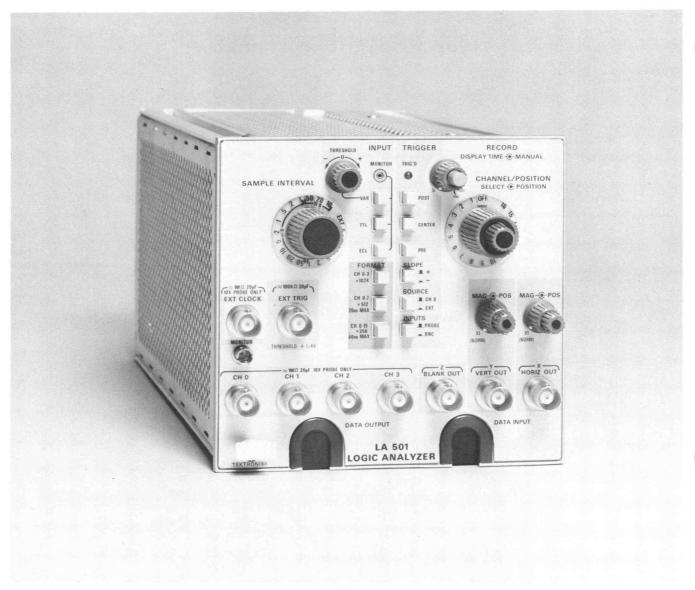
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LA 501 Features

The LA 501 Logic Analyzer is designed for rapid troubleshooting of digital equipment. The simultaneous multi-channel raster can be displayed on almost any low-frequency X-Y monitor or oscilloscope.

The 4096-bit memory can be formatted into 4 channels of 1024 data bits, 8 channels of 512 data bits, or 16 channels of 256 data bits, for a wide range of bit serial, byte serial, or word serial data.

The flexible external (synchronous) or internal (asynchronous) sample rate clock capability will accommodate nearly all of the logic family speeds in use.

Three trigger delay modes (PRE, CENTER, and POST) allows selection of the best mode for the application. Negative trigger delay (PRE) allows analysis of the sequence of events that precede a fault trigger.

Digital data outputs provide a serial or parallel format to "loop back" stored data to a computer for quick error checks. This feature allows analysis or logging of data while viewing it, or it can be used without a display device.

Horizontal and vertical magnification, with positioning, provide high resolution. A unique vertical positioning system allows the selection and positioning of any one trace for timing comparisons with other traces in the raster.

The LA 501 can be powered by any TM-500-series power module which has three-unit, or greater, capability.

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OPERATING INSTRUCTIONS

TM 500-SERIES INSTRUMENTS

The LA 501 Logic Analyzer is a member of Tektronix' growing TM 500 line of Test and Measurement Instruments. This product line consists of both general- and special-purpose instruments such as digital multimeters, counter-timers, variable dc power supplies, pulse generators, function generators, calibration sources, oscilloscopes, signal processors, and others. Each instrument is a plug-in module. Powermodule mainframes with 1, 3, 4, 5, and 6 compartments are available. The power module provides power and an overall housing for the plug-in modules, and permits internal signal interconnections between plug-in instruments to reduce clutter or to allow two or more instruments to perform a function which neither could perform alone. Each user can thus select from a broad choice of instrumentation to assemble a multi-function test set to fit his needs. This test set is compact and portable; yet it can be quickly reconfigured by exchanging plug-in instruments when test needs change. TM 500 systems can be configured for benchtop, rackmount, roll-about, and portable applications. For more information on the TM 500 line, please contact your Tektronix Field Office or representative.

SAFETY INFORMATION

The following warnings must be observed during maintenance and adjustment of the LA 501.

Component Replacement

To avoid electrical shock, disconnect the LA 501 from the power source before replacing components.

Soldering

To avoid electrical shock, disconnect the LA 501 from the power source before soldering.

Semiconductor Replacement

Semiconductors that have heat radiators use silicone grease to increase heat transfer. When one of these semiconductors is replaced, the silicone grease must also be replaced. Handle silicone grease with care. Avoid getting silicone grease in eyes. Wash hands thoroughly after use.

FRONT-PANEL CONTROLS, CONNECTORS, AND INDICATORS

The major controls and connectors for operation of the LA 501 are located on the front panel. Figure 1-1 shows and briefly describes the front-panel controls, connectors,

and indicators. More information is given under Detailed Operating Information in this section.

Several connectors and switches are located inside the LA 501. These are described under Internal Connectors and Switches in this section.

INTERNAL CONNECTORS AND SWITCHES

Figure 1-2 shows the location of the internal connectors and switches. A brief description of these internal functions is given here. More information is given under Detailed Operating Information in this section.

A Data Input Connector

Multi-pin connector for use with the Data Acquisition Probe to provide the following functions:

DATA INPUTS. Provides input for each of the 16 channels (selected when the front-panel INPUTS switch is in the PROBE position).

CLOCK OUT. Provides signal output from the internal clock.

INVALID MODE. Provides an input to indicate an external-source sample interval that is too fast for the selected memory format (selected by jumper-connector P300).

B Data Output Connector

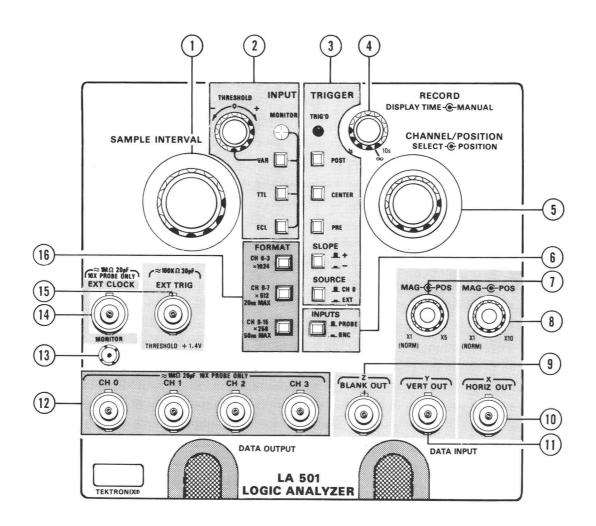
Multi-pin connector with the following functions:

PARALLEL DATA OUTPUT. Provides outputs for each of the 16 memory channels.

SERIAL DATA OUTPUT. Provides an output for serial data from the memory.

FLAG OUTPUT. Provides an output that indicates the start of each channel of data.

FORMAT OUTPUT. Provides an output that indicates memory format (selected by jumper-connector P300).



- SAMPLE INTERVAL Switch—Selects data input sample interval. The EXT position selects input from the EXT CLOCK connector. The knob skirt lamp blinks when the sample interval is too fast when in 8 or 16 channel record format.
- 2) INPUT-

THRESHOLD Control: Provides a variable threshold voltage level for data input channels (selected by VAR switch).

MONITOR Pin Jack: Provides an output to monitor the dc threshold voltage level of the data input channels.

VAR Switch: Selects the variable THRESHOLD control.

TTL Switch: Selects a preset data input threshold voltage level for TTL logic.

ECL Switch: Selects a preset data input threshold voltage level for negative voltage ECL logic.

Fig. 1-1. Front-panel controls, connectors, and indicators.

(3) TRIGGER-

TRIG'D Indicator: Lights when record circuit has received a trigger signal.

POST Switch: Selects data to be stored after the trigger.

CENTER Switch: Selects data to be stored before and after the trigger.

PRE Switch: Selects data to be stored before the trigger.

SLOPE Switch: Selects the positive or negative-going edge of the record trigger signal.

SOURCE Switch: Selects Channel 0 or EXT TRIG connector for record trigger source.

4 RECORD-

DISPLAY TIME Control: A variable control sets the time which memory stored data will be held for display before a new record cycle begins.

MANUAL Switch: A push button switch which resets the trigger circuit to start a new record cycle.

(5) CHANNEL/POSITION-

SELECT Switch: Selects any channel for positioning within the raster.

POSITION Control: Vertically positions channel selected by SELECT switch.

- (6) INPUTS Switch—Selects data input signals from CH 0 through CH 3 front-panel BNC high impedance connectors or the internal low impedance DATA INPUT connector.
- (7) MAG/POS Controls—Provides variable vertical magnification (X1 to X5) and vertical positioning of the displayed raster.
- 8 MAG/POS Controls—Provides variable horizontal magnification (X1 to X10) and horizontal positioning of the displayed raster.
- (9) Z BLANK OUT Connector-BNC connector for output of crt retrace blanking pulses.
- (10) X HORIZ OUT Connector—BNC connector for output of horizontal (X-axis) display signal.
- (11) Y VERT OUT Connector—BNC connector for output of Y-axis display signal.
- (12) CH 0 Through CH 3 Connectors—BNC connectors for data inputs with 10X probes (selected by INPUTS switch in the BNC position).
- MONITOR Probe-Tip Connector—Provides output to monitor the EXT CLOCK connector when compensating high impedance 10X probes.
- EXT CLOCK Connector—BNC connector for input of external sampling clock signal (selected by SAMPLE INTERVAL switch in the EXT position).
- EXT TRIG Connector—BNC connector for external input to record trigger circuit (selected by SOURCE switch in the EXT position).
- (16) FORMAT-

CH 0-3 X 1024 Switch: Selects channel 0 through channel 3 for data recording with 1024 bits of memory per channel.

CH 0-7 X 512 Switch: Selects channel 0 through channel 7 for data recording with 512 bits of memory per channel. Maximum sample interval is 50 nanoseconds.

CH 0-15 X 256 Switch: Selects channel 0 through channel 15 for data recording with 256 bits of memory per channel. Maximum sample interval is 20 nanoseconds.

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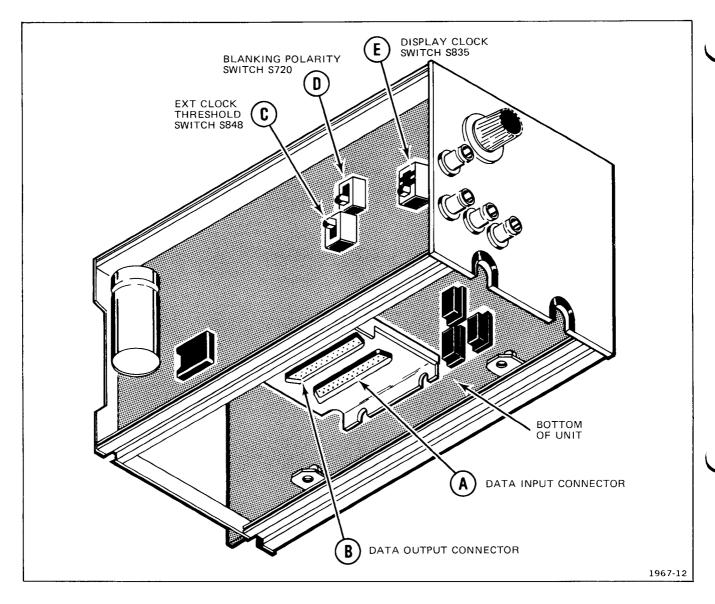


Fig. 1-2. Location of internal connectors and switches.

DISPLAY-STORE MODE OUTPUT. Provides an output to indicate whether the memory is in a Display or Store Mode (selected by jumper-connector P300).

FRAME OUTPUT. Provides an output to show a complete memory scan when reading the memory serially (selected by jumper-connector P300).

DISPLAY-CLOCK OUTPUT. Provides an ECL-level clock output during the Display Mode (selected by jumper-connector P300).

Z-AXIS INPUT. Provides an input to intensify a crt display via the front-panel Z BLANK OUT connector.

RECORD ENABLE. Provides an input to set the memory into a Store Mode.

EXT DISPLAY CLOCK INPUT. Provides an input to read the memory with an external clock signal (ECL level).

© External Clock Threshold Switch (S848)

Selects the external clock threshold level source. In the up position, threshold levels are selected by front-panel INPUT switches VAR, TTL, or ECL. In the down position, a fixed ECL threshold level is selected.

(S720) Blanking Polarity Switch

Selects the polarity of the blanking pulses at the Z BLANK OUT connector. In the up position, the blanking pulses are +5 volts (positive blanking signal). In the down position, the blanking pulses are -5 volts (negative blanking signal).

(E)Display Clock Switch (S835)

A three position switch that selects the source of the display clock signal applied to the clock gate. In the up position, an ECL input clock signal from the DATA OUTPUT connector is selected. In the center position, the front-panel EXT CLOCK connector is selected. In the down position, the 500 kHz internal display clock signal is selected.

INSTALLATION

The LA 501 is calibrated and ready for use when received. It is designed to operate in a TM 500-series power module only. Before proceeding with installation, check that the internal switches and jumpers are set as necessary to operate the LA 501 with the associated equipment. For more information, refer to Internal Connectors and Switches in this section.



Turn the power module off before inserting or removing the LA 501; otherwise, damage may occur to the LA 501 circuitry.

To install (refer to Figure 1-3), align the upper and lower rails of the LA 501 with the power module tracks and fully insert it. The front will be flush with the front of the power module when the LA 501 is fully inserted.

To remove the LA 501, pull on the release latch at the bottom of the front panel and the LA 501 will unlatch. Continue pulling on the release latch to slide the LA 501 out of the power module.

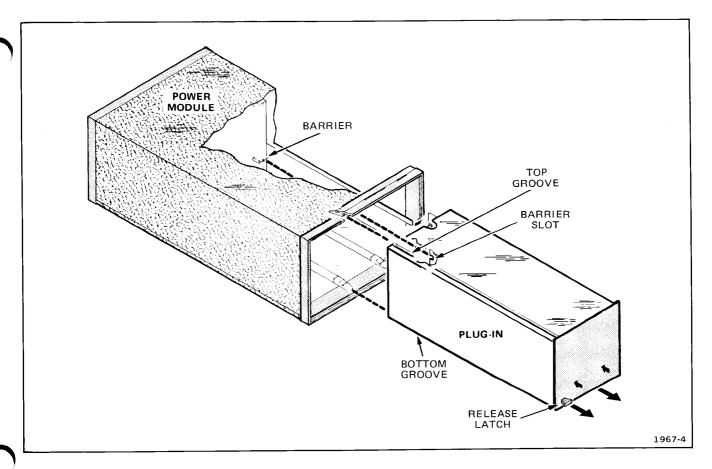


Fig. 1-3. LA 501 installation and removal.

FUNCTIONAL CHECK

The following procedure provides a method to check the basic operation of this instrument. The procedure can be used for incoming inspection to verify proper operation. The procedure can also be used by the operator for instrument familiarization or system troubleshooting.

Functions only are checked in this procedure. Measurement quantities and tolerances are not checked. Therefore, a minimum amount of test equipment is required.

Test Equipment Required

The following test equipment was used as a basis to write the Functional Check procedure. Other test equipment, which meets the requirements, may be substituted. When other equipment is substituted, the control settings or set up might need to be altered.

1. Test Oscilloscope

Description: Frequency response, dc to 500 kilohertz minimum; deflection factor, 50 millivolts to 2 volts/division. Test oscilloscope must have an external Z-axis input. Time base should have an external horizontal amplifier input with deflection factor of 50 millivolts/division.

Type Used: Tektronix 5403/D40 Oscilloscope system with 5A45 Amplifier, and 5B40 Time Base.

2. Power Module

Description: Tektronix TM 500-series power module with 3 or more plug-in compartments.

Type Used: Tektronix TM 503 Power Module (used with the LA 501 and pulse generator).

3. Pulse Generator

Description: Frequency range, 10 kilohertz to 10 megahertz minimum; output amplitude, minus 2 volts to plus 2 volts with 50-ohm output impedance.

Type Used: Tektronix PG 502 Pulse Generator (used with TM 503 Power Module).

4. Cables (5 Required)

Description: Impedance, 50 ohms; length, 18 inches (2 needed), 42 inches (3 needed); connectors, BNC.

Type Used: Type RG-58/U, 50 ohm coaxial, Tektronix Part 012-0076-00 (18 inch), Tektronix Part 012-0057-01 (42 inch).

5. Termination

Description: Impedance, 50 ohms; connectors, BNC.

Type Used: 50-ohm termination with BNC connectors, Tektronix Part 011-0049-01.

6. T Connector

Description: Connectors, BNC-to-BNC.

Type Used: BNC-to-BNC T connector, Tektronix Part 103-0030-00.

Preliminary Set Up

- 1. Within the LA 501, set the slide switches as follows (see Figure 1-2 for switch locations):
 - a. Display Clock switch (S835), set to down position for internal Display Clock.
 - b. External Clock Threshold switch (S848), set to up position for front-panel selection of threshold level.
 - c. Blanking Polarity switch (S720), set to down position for negative Z-axis blanking.

NOTE

If the Tektronix 5403/D40 test oscilloscope is not used, check the oscilloscope or monitor instruction manual for the required Z-axis blanking polarity.

- 2. Install the LA 501 in the 2 right side compartments and the pulse generator in the left compartment of power module (see Figure 1-4).
- 3. Turn on power module and test oscilloscope system.

- 4. Set pulse generator for 10 kilohertz square wave. Using a 0-volt base-line reference, set output amplitude to ± 0.25 volts.
- 5. Connect cables from LA 501 to test oscilloscope as shown in Figure 1-5.
- 6. Set LA 501 controls as follows:

SAMPLE INTERVAL	1 μs
INPUT	TTL
FORMAT	CH 0-3 X1024
TRIGGER	POST
SLOPE	(+)
SOURCE	CH 0
INPUTS	BNC
DISPLAY TIME	1 s
CHANNEL SELECT	OFF
Vertical MAG	X1 (NORM)
Vertical POS	Midrange
Horizontal MAG	X1 (NORM)
Horizontal POS	Midrange

7. With test oscilloscope inputs grounded, set the display to graticule center, and adjust oscilloscope for well-defined display. If necessary, refer to oscilloscope instruction manual for operating instructions.

- 8. Set test oscilloscope for vertical deflection factor of 100 millivolts/division with dc input coupling.
- 9. Set test oscilloscope for external horizontal amplifier operation (horizontal deflection factor of 50 millivolts/division with dc input coupling).

Raster Display

If necessary, perform the Preliminary Set Up procedure. To obtain a raster display, proceed as follows:

- 1. Connect the +0.25 volt, 10 kilohertz square-wave signal from pulse generator (as set in Preliminary Set Up procedure) to LA 501 CH 0 input connector.
- 2. Check that TRIG'D indicator is lit.
- 3. Set the LA 501 vertical and horizontal POS controls for centered display.
- 4. Set test oscilloscope intensity control at desired viewing level
- 5. Check display for one square wave (top trace, channel 0) and 3 trace lines.

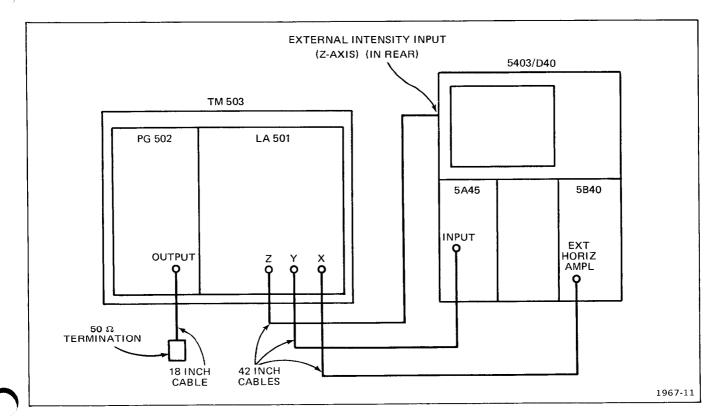


Fig. 1-4. Equipment set up for Functional Check.

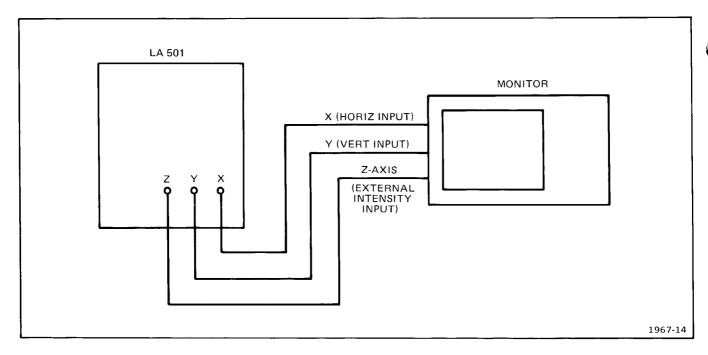


Fig. 1-5. LA 501 and monitor X, Y, and Z signal connections for Functional Check.

Display Functions

If necessary, perform the Preliminary Set Up procedure. Use the following procedure to check the Display Functions:

- 1. Connect the +0.25 volt, 10 kilohertz square-wave signal from pulse generator (as set in Preliminary Set Up procedure) to CH 0 and CH 1 input connectors with BNC T connector.
- 2. Check test oscilloscope for a square-wave display on channels 0 and 1.
- 3. Disconnect pulse generator signal from CH 1, and connect to CH 2 (retain connection to CH 0).
- 4. Check for square-wave display on channels 0 and 2.
- 5. Disconnect pulse generator signal from CH 2, and connect to CH 3.
- 6. Check for square-wave display on channels 0 and 3.
- 7. Check that display expands vertically as vertical MAG control is rotated to X5.
- 8. Return vertical MAG control to X1 position.

- 9. Check that display expands horizontally as horizontal MAG control is rotated to X10.
- 10. Return MAG control to X1 position.
- 11. Press in CH 0-7 X512 FORMAT switch.
- 12. Set the LA 501 Vertical and Horizontal POS controls for centered display.
- 13. Check display for 8 traces.
- 14. Press in CH 0-15 X256 FORMAT switch.
- 15. Set the LA 501 Vertical and Horizontal POS controls for centered display.
- 16. Check display for 16 traces.
- 17. Set CHANNEL:SELECT switch to 0.
- 18. Check that channel 0 trace can be positioned anywhere within raster as POSITION control (CHANNEL/POSITION) is rotated.

- 19. If desired, repeat step 18 for remainder of channel selections.
- 20. Return CHANNEL: SELECT switch to OFF.
- 21. Set RECORD DISPLAY TIME control to ∞ detent position.
- 22. Disconnect pulse generator from CH 3 connector.
- 23. Press in RECORD MANUAL switch and release it.
- 24. Check display for square wave on channel 0 only.
- 25. Return RECORD DISPLAY TIME control to 1 s.
- 26. Check that SAMPLE INTERVAL knob skirt lamp blinks as SAMPLE INTERVAL switch is set to 20 ns and 10 ns.
- 27. Set SAMPLE INTERVAL switch to EXT.
- 28. Disconnect the pulse generator from CH 0 connector.
- 29. Press in INPUT: ECL switch.
- 30. Press in CH 0-3 X1024 FORMAT switch.
- 31. Set pulse generator for 0-volt base-line reference, and set output amplitude to $-0.2\ \text{volts}$.
- 32. Connect -0.2 volt, 10 kilohertz square-wave signal from pulse generator (as set in step 31) to EXT CLOCK and CH 0 connectors.
- 33. Check display for 4 traces.
- 34. Disconnect pulse generator from EXT CLOCK and CH 0 connectors.

Trigger Functions

If necessary, perform the Preliminary Set Up procedure. Use the following procedure to check the Trigger Functions:

- 1. Set SAMPLE INTERVAL switch to 50 ns.
- 2. Connect a ± 0.25 volt, 10 kilohertz square-wave signal from pulse generator (as set in Preliminary Set Up procedure) to CH 0 connector.
- 3. Check that channel 0 (top trace) has positive-going transition at left side of trace.
- 4. Press in TRIGGER: CENTER switch.
- 5. Check that positive-going transition is now near center of trace.
- 6. Press in TRIGGER:PRE switch.
- 7. Check that positive-going transition is at right side of trace.
- 8. Set SLOPE switch to -.
- 9. Check for negative-going transition at right side of trace.
- 10. Disconnect pulse generator signal from CH 0 connector.
- 11. Press in TRIGGER:POST switch.
- 12. Set SLOPE switch to +.
- 13. Set SOURCE switch to EXT.
- 14. Using a 0-volt base-line reference, set pulse generator output amplitude to +2 volts.
- 15. Connect the +2 volt, 10 kilohertz signal (as set in previous step) to LA 501 EXT TRIG connector.
- 16. Check that TRIG'D indicator is lit.
- 17. Check display for 4 traces.

18. Disconnect signal from EXT TRIG connector.

This completes the Functional Check procedure.

DETAILED OPERATING INFORMATION

Signal Connection

Probes offer the most convenient means of connecting signals to the LA 501 inputs. Tektronix probes are shielded to prevent pickup of electrostatic interference, and are designed to monitor the signal source with minimum circuit loading.

10X PROBES. The P6108 (optional accessory), a 10X attenuation probe, offers a high input impedance and allows the circuit under test to perform very close to the normal operating conditions.

When using 10X probes, select a probe with a rise time of less than 2.25 nanoseconds, and which is capable of compensating 20 picofarads of input capacitance.

10X PROBE COMPENSATION. When using 10X probes on the EXT CLOCK and CH 0 to CH 3 front-panel BNC input connectors, the probe capacitance must be compensated to match instrument input capacitance to obtain the best rise-time response. See Figure 1-6 for probe compensation set up and procedure.

DATA ACQUISITION PROBE. The P6450 (standard accessory) is a passive, 5X attenuation probe, which is designed for use with the LA 501. When plugged into the DATA INPUT connector, it offers input connections to all 16 channels.

DATA OUTPUT CABLE. In order to use DATA OUTPUT connector, J120, it is necessary to assemble a special cable. One end of the cable must be terminated with a connector to meet the test requirements. The other end of the cable is terminated with a connector to mate with the DATA OUTPUT connector. Use a type DB-25P, 25-pin, male connector; order Tektronix part 131-0570-00. For further information, contact your Tektronix Field Office or representative.

COAXIAL CABLE. The front-panel output signals, Z BLANK OUT, Y VERT OUT, and X HORIZ OUT, should be connected to other equipment with 50-ohm coaxial cables. Use high-quality, low-loss cables.

Display Monitor

The display monitor may be any oscilloscope or display monitor with X, Y, and Z-axis capabilities with the following characteristics:

Frequency response dc to
Deflection factor
Horizontal 50 m
Vertical 100 r
External Z-Axis sensitivity (external intensity input)

dc to 500 kilohertz

50 millivolts/division 100 millivolts/division plus or minus 5 volts

Connections from the LA 501 X, Y, and Z outputs to the oscilloscope or monitor inputs should be made with coaxial cables. Figure 1-5 shows the proper set up for operation. Check the oscilloscope or monitor instruction manual for the required Z-axis blanking polarity. Set the Blanking Polarity switch (S720) down for negative blanking, or up for positive blanking. See Figure 1-2 for the location of S720. For more information on blanking polarity selection, see Internal Switches in this section.

Sample Interval

The SAMPLE INTERVAL switch selects calibrated sample-interval times from the internal clock. The number of times that the input channels are sampled is determined by the format selected. A 4-channel format is sampled 1024 times; 8-channel format, 512 times; and a 16-channel format, 256 times.

To capture and store the state of a pulse, one or more sample intervals must occur during the pulse. Resolution is determined by the number of samples taken during the pulse.

The lamp that illuminates the SAMPLE INTERVAL knob skirt blinks when the sample interval is too fast for 8 channel (10 nanosecond) or 16 channel (10 or 20 nanosecond) storage. When using an external clock signal, the EXT position of the SAMPLE INTERVAL switch selects the front-panel EXT CLOCK connector.

External Clock Input

The EXT CLOCK input provides a means of using a clock signal from the equipment under test, or any other clock signal that the operator may desire.

EXT CLOCK. This connector allows the connection of external clock signals. The external clock threshold level is selected by an internal switch (S848) that selects a preset

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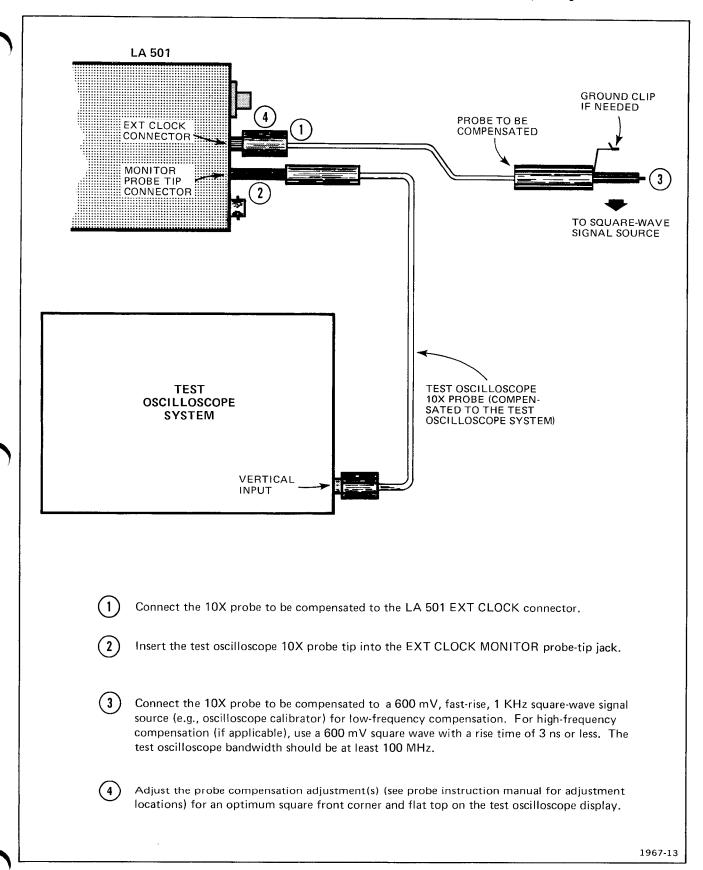


Fig. 1-6. 10X probe compensation set up and procedure.

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ECL threshold voltage level or the front-panel INPUT THRESHOLD controls. When in the EXT CLOCK mode, either the positive or negative slope may be used for the clock edge. When the negative edge is selected, data sample intervals are stored into memory on the negative edge of the external clock signal. When the positive edge is selected, data sample intervals are stored into memory on the positive edge of the external clock signal. An internal jumper-connector, P831, provides polarity selection. Figure 1-7 shows the location of P831 and the selection positions.

MONITOR. This probe-tip jack allows the operator to view the external clock signal, and is also used for compensating 10X probes. Refer to 10X Probe Compensation in this section for more information.

Input Threshold Controls

The INPUT THRESHOLD controls allow the selection of two fixed threshold levels, or the variable THRESHOLD level control. Fixed threshold levels are for TTL and ECL logic.

TTL. This switch selects a preset TTL input threshold level for each of the data input channels, and for the EXT CLOCK input. When the recommended probes are used, the input threshold level is +1.4 volts.

ECL. This switch selects a preset ECL input threshold level for each of the data input channels and for the EXT CLOCK input. When the recommended probes are used, the input threshold level is -1.25 volts.

VAR. This switch selects the variable THRESHOLD level control.

THRESHOLD. The variable THRESHOLD control allows the selection of a wide range of threshold levels for the data input channels and for the EXT CLOCK input. When the recommended probes are used, the threshold level is adjustable from -10 volts to +10 volts.

MONITOR. The MONITOR pin jack provides an output to monitor the dc threshold voltage level.

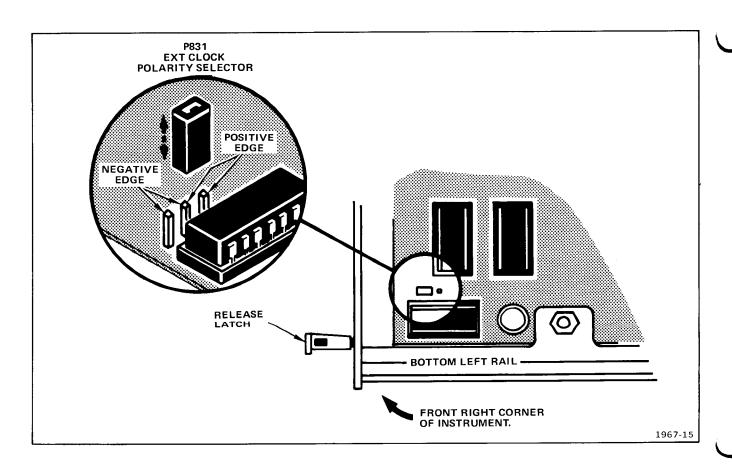


Fig. 1-7. Location of EXT CLOCK polarity selector.

Trigger Controls

The TRIGGER controls provide a means to select the signal source, select the slope on the waveform to stop the storage cycle, and select the point in the storage cycle at which the trigger will occur.

TRIG'D INDICATOR. This light provides a convenient indication of the Trigger circuit condition. If the INPUT THRESHOLD controls are correctly set for the input logic level used and the Trigger circuit has received a trigger, the TRIG'D light is on. If the TRIG'D light is off, the LA 501 is in the storage cycle, but has not yet received a trigger.

POST. This switch selects data for memory storage after the trigger has occurred. The stored data consists of 6 per cent before-trigger data and 94 per cent after-trigger data.

CENTER. This switch selects data for memory storage before and after the trigger has occurred. Half of the stored data is before the trigger, and the other half is data after the trigger.

PRE. This switch selects data for memory storage before the trigger has occurred. The stored data consists of 94 per cent before-trigger data and 6 per cent after-trigger data.

SLOPE. This switch determines whether the Trigger circuit responds to a positive- or a negative-going transition of the trigger signal. When the SLOPE switch is set to —, the Trigger circuit responds to negative-going transitions. When the SLOPE switch is set to +, the Trigger circuit responds to positive-going transitions.

SOURCE. This switch selects the source of the signal for the Trigger circuit. When the switch is set to CH 0, the input signal connected to the channel 0 input is used for the trigger source. When the switch is set to EXT, an external signal connected to the EXT TRIG connector is selected for the trigger source.

EXTERNAL TRIGGER. Trigger signals from the equipment under test, or other equipment the operator may prefer to use, can be connected to the EXT TRIG connector.

Ext Trig. This connector allows the connection of an external TTL logic level trigger signal. The input threshold level is fixed at +1.4 volts. This connector is selected when the SOURCE switch is in the EXT position.

Format Switches

The FORMAT switches select the number of data channels to be used. Three switches allow the operator to select 4, 8, or 16 data channels.

CH 0-3 (X1024). This switch selects the first 4 data channels. In this mode, each channel has a memory storage capacity of 1024 bits. The 4-channel mode has a maximum sample rate of 10 nanoseconds.

CH 0-7 (X512). This switch selects the first 8 data channels. In this mode, each channel has a memory storage capacity of 512 bits. The 8-channel mode has a maximum sample rate of 20 nanoseconds.

CH 0-15 (X256). This switch selects all 16 data channels. In this mode, each channel has a memory storage capacity of 256 bits. The 16-channel mode has a maximum sample rate of 50 nanoseconds.

Record Controls

The RECORD controls allow the operator to select the display time to view stored information, and also allows manual or automatic resetting of the Trigger circuit.

DISPLAY TIME. This variable control sets the time during which stored data will be held for display before a new storage cycle begins. The display time is variable from 1 to 10 seconds, or is held indefinitely when turned to the fully clockwise detent position (∞) .

MANUAL. This switch resets the Trigger circuit to start a new storage cycle.

Monitor Output Signals and Controls

Vertical, horizontal, and Z-axis output signals are provided to produce a raster display on the display monitor. The vertical and horizontal outputs each have magnification and positioning controls.

Z BLANK OUT. When connected to a display monitor external Z-axis input, the Z-axis blanking signal performs two functions.

The first function is to blank the crt retrace lines. The second function is, if the new storage cycle fails to go through

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a full memory storage cycle before a trigger is received, old data (bad data) is blanked out on the crt display. Positive or negative blanking pulses are selected by Blanking Polarity switch, S720.

Y VERT OUT. When connected to a display monitor Y-axis (vertical) input, this output signal provides an on-screen display of serial data from the memory. Channel separation is accomplished by stepping each channel down with a dc offset voltage. Channel 0 is at the top of the display.

Mag (Y-Axis). This control provides a variable X1 to X5 amplification of the Y VERT OUT signal to permit greater display resolution.

Pos (Y-Axis). This control vertically positions the raster within the display area of the monitor. To obtain maximum use of the Vertical POS control, the display monitor must first be adjusted for a centered spot with the X- and Y-axis inputs grounded. All vertical position adjustments are then made with the LA 501 Vertical POS control.

X HORIZ OUT. When connected to a display monitor X-axis (horizontal) input, this output signal provides the display with an X-axis sweep. The sweep rate is determined by the FORMAT switch setting. If desired, an external clock source may be used to scan the memory; however, any clock rate other than that of the internal clock will affect the sweep length. The external clock signal may be from the front-panel EXT CLOCK connector, or from the Ext Display Clock input at the DATA OUTPUT connector. The display clock source is selected by the internal Display Clock switch (S835).

Mag (X-Axis). This control provides a variable X1 to X10 amplification of the X HORIZ OUT signal to permit greater display resolution.

Pos (X-Axis). This control horizontally positions the data channels within the display area of the monitor. To obtain maximum use of the horizontal control, the display monitor must first be adjusted for a centered spot with the X- and Y-axis inputs grounded. All horizontal position adjustments are then made with the LA 501 Horizontal POS control.

CHANNEL/POSITION. The SELECT and POSITION controls under this title are used for comparison of any one channel with any other channel.

Select. This switch selects any channel (0 through 15) for positioning within the display raster.

Position. This control vertically positions the selected comparison channel within the display.

Data Input Signals

Both low impedance and high impedance inputs are provided for the data channels. Front-panel BNC connectors, CH 0 through CH 3, provide high impedance inputs, and multi-pin DATA INPUT connector, J100, provides low impedance inputs to all 16 channels. The INPUTS switch selects the desired input connector(s). 10X probes are used for connecting signals to the front-panel data input connectors.

INPUTS. This switch selects the desired data input probe connector(s). When in the BNC position, the four front-panel CH 0 through CH 3 connectors are selected. When in the PROBE position, the multi-pin DATA INPUT connector is selected.

CH 0 THROUGH CH 3. The four front-panel BNC connectors provide a means of connecting data signals through 10X probes to the channel 0, 1, 2, and 3 input preamplifiers. The 10X probes must be compensated for use with ECL logic, due to the low signal levels.

DATA INPUT. The internal, multi-pin connector, J100, provides a means of connecting data signals through the Data Acquisition Probe to the inputs of all 16 channels. Figure 1-8 identifies the pin assignments for the DATA INPUT connector. The Clock Out at pin 22 is an unterminated ECL-level output of the internal clock signal. Pin 23 of J100 (probe line A) is connected to Signal Selector jumper, P300. At the factory, P300 is wired to connect pin 23 of J100 to the Invalid Mode Input line. However, this connection can be changed to a different signal line if desired. For further information, see P300 Signal Selector in this section.

Data Output Connector

Internal multi-pin connector, J120, provides several functions. Figure 1-9 identifies the DATA OUTPUT connector pin assignments. As shown in Figure 1-9, three of the pins of J120 are connected to Signal Selector jumper, P300. At the factory, P300 is wired to make signal-line connections to these pins as shown in Figure 1-10. The connections can be changed to different signal lines if desired. For further information, see P300 Signal Selector in this section. The functions provided by the Data Output connector are described as follows:

PARALLEL DATA OUTPUT. Output connections are provided from each of the 16 memory channels to read the memory in parallel data form. The parallel data outputs are ECL-logic level signals.

SERIAL DATA OUTPUT. This connection is provided to read the memory in serial data form. The serial data output is an ECL-logic level signal.

FLAG OUTPUT. This connection provides for the output of an ECL-level pulse. The negative-going edge of the Flag Output pulse indicates the beginning of each channel.

Z-AXIS INPUT. This connection is provided to intensify the display by application of an external signal. A positive 5-volt input will fully intensify the display. As the input voltage is lowered towards zero volts, the display will be intensified less.

RECORD ENABLE. This connection is provided to set the memory into the Store Mode by application of an external

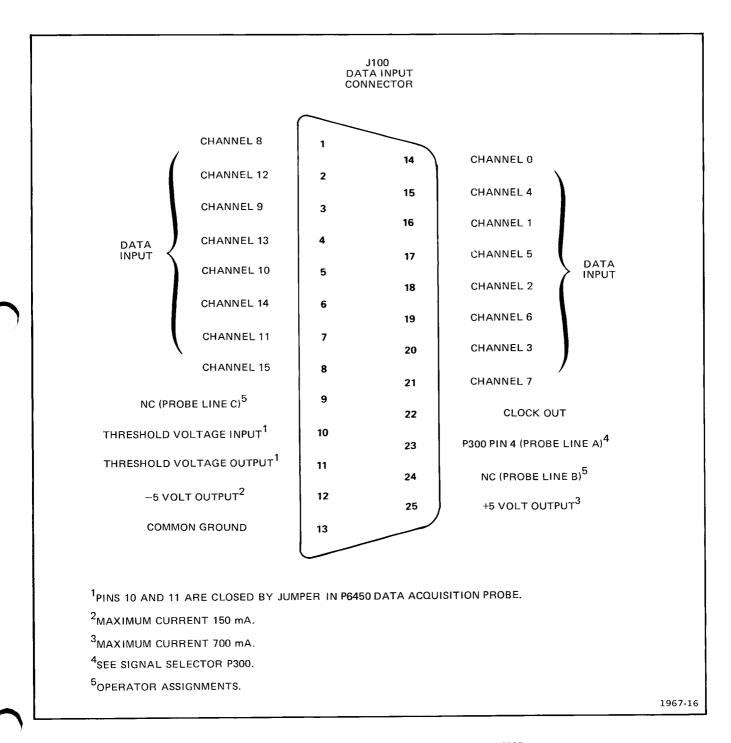


Fig. 1-8. Pin assignments for the DATA INPUT connector, J100.

signal. The Record Enable input is ac coupled, and requires only the negative-going edge of a 1.5-volt pulse to enable the Store Mode.

EXT DISPLAY CLOCK INPUT. This connection is provided for the application of an external, ECL-level, display clock signal. The input is terminated by 100 ohms to -2 volts. The External Display Clock Input signal requirements are: The HI level must be more positive than -1 volt, and the LO level must be more negative than -1.5 volts. The usable frequency range is from less than one hertz to two megahertz.

P300 Signal Selector

Internal multi-pin jumper-connector, P300, provides selection of several input and output signal lines to the DATA INPUT, J100, and DATA OUTPUT, J120, connectors. Figure 1-10 shows the location of P300 and identifies the pin assignments. Figure 1-10 shows the jumpers as they are installed at the factory. To change the connections for different requirements, see Signal Selection with P300 in this section.

DISPLAY CLOCK OUTPUT. This connection provides a display-clock output from the memory. An ECL-level clock output is provided during the Display Mode. During the Store Mode, the output assumes an ECL LO state.

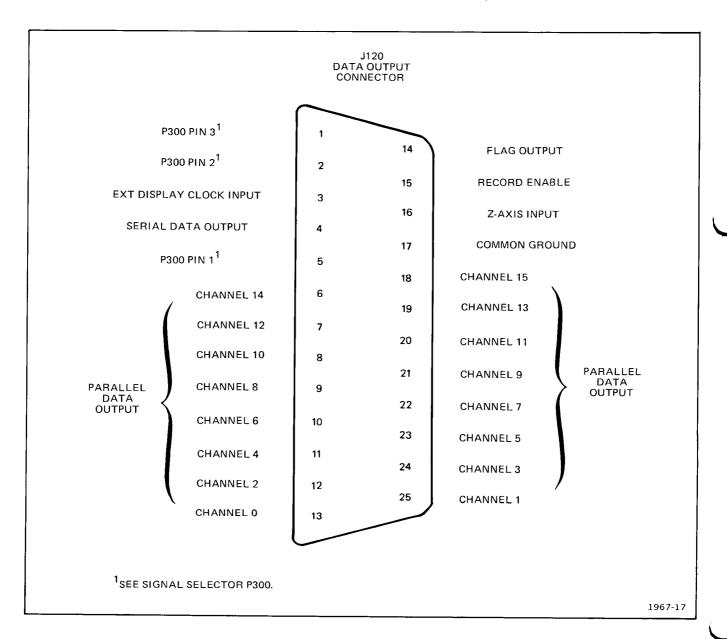


Fig. 1-9. Pin assignments for the DATA OUTPUT connector, J120.

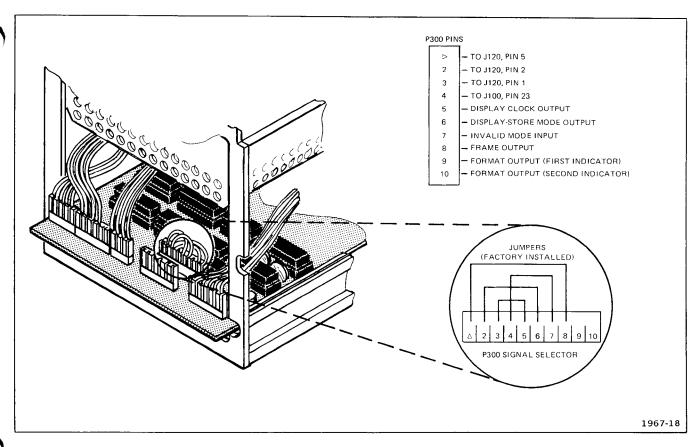


Fig. 1-10. Location of Signal Selector P300, and P300 pin assignments.

DISPLAY-STORE MODE OUTPUT. This output indicates whether the memory is in a Display or a Store Mode. An ECL LO level indicates that the memory is in the Display Mode. An ECL HI level indicates that the memory is in the Store Mode.

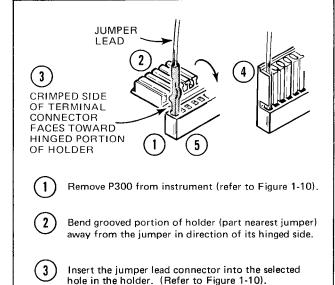
INVALID MODE INPUT. The Invalid Mode Input is used in conjunction with an external clock source. When an external ground is applied to this input, the SAMPLE INTERVAL light blinks to indicate that the sample interval is too fast for the selected memory format.

FRAME OUTPUT. This connection provides for the output of an ECL-level pulse. One complete pulse cycle represents at least one complete serial scan of the data in the memory.

FORMAT OUTPUT. Two connections provide ECL-level outputs which indicate the memory format selected by the front-panel FORMAT switches. Table 1-1 shows the ECL-level output states at pins 9 and 10 of P300 for each of the FORMAT switch positions.

TABLE 1-1 Format Output Levels at P300

	P30	00
FORMAT Switch	Pin 9	Pin 10
CH 0-3 X1024	Н	НІ
CH 0-7 X512	LO	HI
CH 0-15 X256	LO	LO



- Bend the grooved part of holder back to its vertical position so connector is inserted into groove.
- Observe the connector polarity (refer to Figure 1-10), and install P300 back into the instrument.

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Fig. 1-11. P300 jumper placement procedure.

SIGNAL SELECTION WITH P300. To change the signal selections to the DATA INPUT (J100) and DATA OUTPUT (J120) connectors shown in Figure 1-10, perform the procedure shown in Figure 1-11.

Internal Switches

Three switches within the LA 501 provide selection of display Blanking Polarity, EXT CLOCK threshold source, and the Display Clock source. Figure 1-12 shows the location and describes the use of these switches.

LA 501 GLOSSARY

The terms listed in this glossary are used throughout this manual.

Asynchronous—Multiple digital information transferred at non-common clock rates.

Bit-The smallest increment of digital information.

CPU-Central Processing Unit.

ECL-Emitter-Coupled Logic.

Jitter—A form of distortion in asynchronous systems that is due to timing variations of the received data.

Multiplexing—The combining of multiple inputs into a single output.

Parallel Data—Data transferred on multiple lines. Parallel data logic is derived from the multiple lines.

Parallel-to-Serial Conversion—The technique of storing a digital pattern from a parallel bus, then transferring that pattern out to a serial bus.

Parity Bits—Bits added to the data stream which enable the receiver to verify whether the data is correctly or incorrectly received.

PROM-Programmable Read Only Memory.

RAM-Random Access Memory.

Serial Data—Data transferred on a single line. Serial data logic is derived in a sequential mode.

Store Clock—The clock used to store information into the LA 501 memory.

Synchronous—Digital information transferred with the same clock reference.

Threshold Voltage—The comparator input voltage on the inverting input, which is used as a reference. Thus, if the signal on the non-inverting input is more positive than the threshold voltage, the output is HI; if the signal is more negative, the output is LO.

TTL-Transistor-Transistor Logic.

"wired OR"—ECL gate outputs that are connected together to yield the equivalent output of an OR gate.

Blanking Polarity

Switch S720 selects the polarity of the voltage at the Z BLANK OUT connector.

- 1 In the up position, the display blanking pulses are +5 volts (positive blanking).
- 2 In the down position, the display blanking pulses are -5 volts (negative blanking).

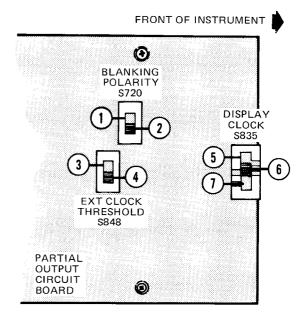
Ext Clock Threshold S848

Switch S848 selects the external clock threshold level source.

- (3) In the up position, threshold levels are selected by the front-panel INPUT switches VAR, TTL, or ECL.
- 4 In the down position, a fixed ECL threshold level is selected.

Display Clock S835

Switch S835, a three-position switch, selects the source of the display clock signal applied to the display clock gate.



LEFT SIDE, WITH SIDE PANEL REMOVED.

- 5 In the up position, an ECL input clock signal from the DATA OUTPUT connector is selected.
- 6 In the center position, the front-panel EXT CLOCK connector is selected.
- In the down position, the internal 500 kilohertz display clock signal is selected.

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Fig. 1-12. Internal switch locations, and switch selection positions.

APPLICATIONS

Malfunctions in digital equipment systems are difficult to isolate with conventional test equipment, such as oscilloscopes or counters. The following applications describe some typical situations in which the LA 501 Logic Analyzer can be used to make digital equipment troubleshooting relatively easy.

MICROPROCESSORS

A malfunctioning microprocessor system is shown in Figure 1-13. Software had previously worked properly, but was still not free of suspicion. Data was stored in the RAM (random-access read/write memory). The system program was resident in the PROM (programmable read only memory). Restart vectors pointed to the address of the first instruction in the restart routine.

When the restart hardware was exercised, the CPU (central processing unit) should have performed certain initialization

routines and then gone to the Wait for Interrupt mode. The terminal would then call up other operating software in the PROM, or provide access to a binary loader. The failure consisted of very erratic operation after restart.

The LA 501 was connected to the system as shown in Figure 1-13 to store and display a large data block from the eight data lines. The display was obtained by triggering the LA 501 on the beginning of the restart cycle and using the system clock as an external data sampling strobe.

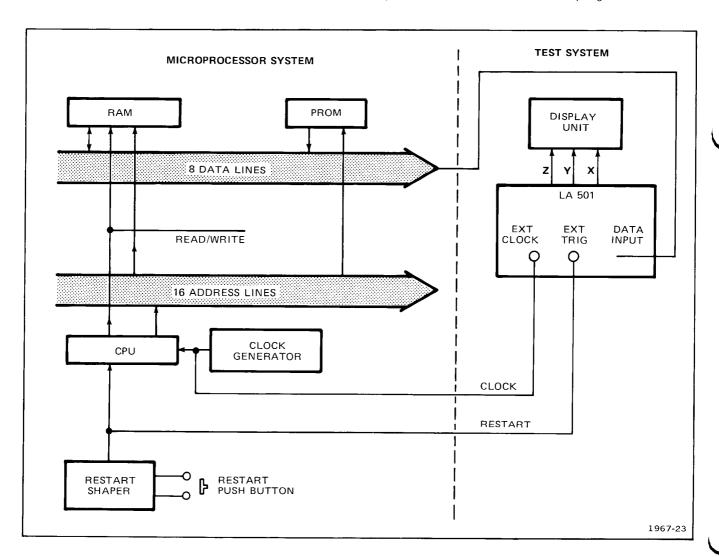


Fig. 1-13. Typical set up for troubleshooting a microprocessor system with the LA 501 Logic Analyzer.

Analysis of the data display showed the problem to be a dropped bit in the portion of the PROM providing the restart routine. The CPU fetched an invalid restart vector, causing data from the RAM to be executed as instructions.

STORAGE BUFFERS

A multi-input logic analyzer will provide a quick and easy method for checking the performance of a storage buffer. The following application shows how the inputs and outputs of a buffer can be monitored simultaneously and observed for verification of performance or for a malfunction, if it is suspected.

The non-synchronous buffer is a commonly used type, in which data flows continuously from input to output. A quick snapshot of this data flow will show at a glance if all the memory cells are functioning properly.

The LA 501 can take this single shot snapshot of 8 input and 8 output lines simultaneously and display all sixteen data lines on a single display for a quick comparison. A typical set up and display are shown in Figure 1-14. When the LA 501 is clocked asynchronously from the internal clock, a high-resolution timing diagram display will provide timing information as well as reveal malfunctions that would otherwise be difficult to detect with any other type of test equipment such as an oscilloscope or DVM.

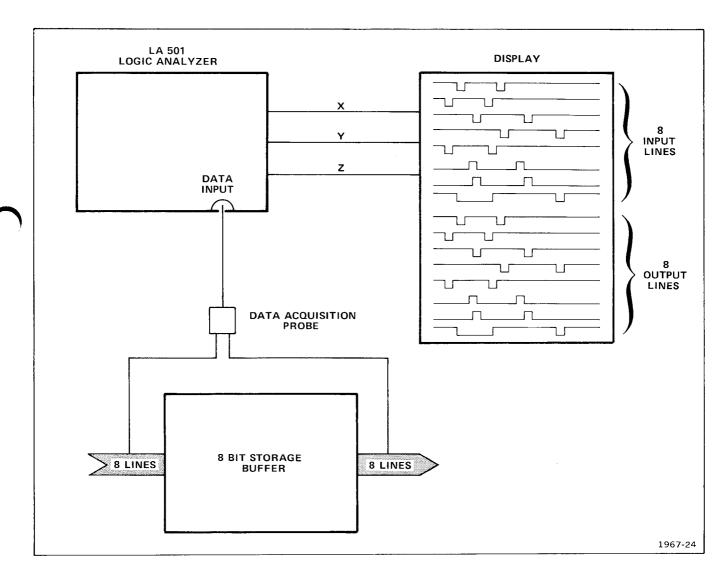


Fig. 1-14. Typical set up and display for troubleshooting a storage buffer with the LA 501 Logic Analyzer.

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SPECIFICATION

The electrical specifications listed in Table 2-1 apply when the following conditions are met: (1) The instrument must have been adjusted at an ambient temperature between $+20^{\circ}$ and $+30^{\circ}$ C, (2) the instrument must be operating at an ambient temperature between 0° and $+50^{\circ}$ C, and (3) the instrument must be operating for at least 15 minutes.

TABLE 2-1 Electrical

Elec	trical			
Characteristic	Pe	erformance Requirem	nent	
DATA INPUTS				
Impedance				
Channel 0-3 (High-Impedance Data Input connectors)	1 M Ω within 1% pa	aralleled by approxim	nately 20 pF.	
Channel 0-15 (Low-Impedance Data Input connector)	$20~\mathrm{k}\Omega$ within $1\%~\mathrm{p}$	aralleled by approxir	nately 20 pF.	
Threshold Level	Data Inpu	At ut Connectors		
	P6450 Probe ¹	10X Probe ¹	At Probe Tip	
VAR (Variable)	At least $-2~V$ to +2 V	At least1 V to +1 V	At least 10 V to +10 V	
TTL	+0.280 V within .05 V	+0.140 V within .025 V	+1.4 V within 0.25 V	
ECL	0.250 V within .010 V	-0.125 V within .006 V	-1.25 V within .06 V	
MONITOR Output	Within 3% of thres	hold level at Data Inp	out connectors.	
Sensitivity (without probes)				
High-Impedance Data Input	At least 60 mV p-p).		
Low-Impedance Data Input	At least 120 mV p	p.		
Minimum Pulse Width	1 sample interval +	5 ns HI or LO to ens	sure pulse recording	
Input Delay Between Channels				
High-Impedance Data Input	6 ns or less.			
Low-Impedance Data Input				
Channel 0-7	7 ns or less.			
Channel 0-15	12 ns or less.			
Input Delay Between High-Impedance Data Input Connectors and P6450 Probe Tip	22 ns or less.			

¹ Probe rise time for high-impedance data and external clock inputs should be 2.25 ns or less with aberrations not to exceed 10% p-p.

	Electrical
Characteristic	Performance Requirement
DATA	INPUTS (CONT.)
Maximum Input Voltage	
At High-Impedance Data Input Connectors	Clamped at ± 2.5 V, protected to ± 150 V.
At Low-Impedance Data Input Connector	Clamped at ±2.5 V (no protection).
With P6450 Probe	Clamped at ±12.5 V, protected to ±50 V.
-	TRIGGER
Source	
Input Level	
Internal (CH 0)	Set by INPUT controls.
External	Threshold Level: +1.4 V, within 0.2 V, clamped at +2.7 V and -0.6 V, protected to ±15 V.
Input R and C	Approximately 100 k Ω paralleled by approximately 20 pF.
Minimum Pulse Width	10 ns.
Record Display Time Range	Approximately 1 s to 10 s.
ד	TIME BASE
Internal	
Frequency	100 MHz within 50 parts per million.
Sample Rate	10 ns to 5 ms/sample in 1-2-5 sequence. Maximum sample rate: 4X = 10 ns, 8X = 20 ns, 16X = 50 ns.
External (EXT CLOCK Input)	
Input R and C	1 M Ω within 1% paralleled by approximately 20 pF. Clamped at ± 2.5 V, protected to ± 150 V.
Sensitivity	At least 60 mV p-p.
Pulse Width	
CH 0-3 X1024	HI for at least 10 ns and LO for at least 10 ns.
CH 0-7 X512	HI for at least 10 ns and LO for at least 10 ns.
CH 0-15 X256	HI for at least 25 ns and LO for at least 25 ns.

Electrical				
Characteristic	Performance Requirement			
TIME BASE (CONT.)				
Threshold Level	Same as data inputs, or -0.125 V within .006 V (internal switch).			
Slope	Data strobed in on positive or negative edge of external clock.			
Data Change With Respect to Clock Edge at EXT CLOCK Connector (internally selectable + or – edge)				
At High-Impedance Data Input Connectors				
Set-Up	2 ns.			
Hold	15 ns.			
At P6450 Probe Tip				
Channel 0-7				
Set-Up	14 ns.			
Hold	3 ns.			
Channel 8-15				
Set-Up	20 ns.			
Hold	2 ns.			
DISPLAY SIGNAL	_S (FRONT PANEL)			
Blanking Output	0 V to +5 V or 0 V to -5 V within 1 V (internal switch)			
CRT Retrace Blanking Time				
CH 0-3 X1024	4.2 μs within 20% (4 bits).			
CH 0-7 X512	2.2 μs within 20% (2 bits).			
CH 0-15 X256	1.2 μs within 20% (1 bit).			
Vertical Output	0.1 V/div within 10%.			
Magnify	X1 to X5 within 10%.			
Horizontal Output	.05 V/div within 10%.			
Linearity	Pulse width within 10% from 10% to 100% of sweep.			
Magnify	X1 to X10 within 10%.			

Characteristic	Characteristic Performance Requirement		
DISPLAY SIGNALS (FRONT PANEL) (CONT.)			
Display Format			
CH 0-3 X1024	1 group of 4 lines.		
CH 0-7 X512	2 groups of 4 lines each.		
CH 0-15 X256	4 groups of 4 lines each.		
Raster Shift With Format Change	1 div or less at X1 magnification.		

LOW-IMPEDANCE DATA INPUT

Data Input	Pin	Channel	Pin_	Channel		
	1	8	14	0		
	2	12	15	4		
	3	9	16	1		
	4	13	17	5		
	5	10	18	2		
	6	14	19	6		
	7	11	20	3		
	8	15	21	7		
Clock Out		Pin 22. Unterminated ECL level. The output, when termi ated, is a standard negative voltage ECL level.				
Invalid Mode		Jumper, P300 pin 7. Ground closure causes blinking of SAMPLE INTERVAL switch light.				
Threshold DC	Pin 10.	Pin 10.				
Comparator Input	Pin 11.	Pin 11.				
+5 Volts	Pin 25. 7	Pin 25. 700 mA or less.				
-5 Volts	Pin 12. 1	Pin 12. 150 mA or less.				
Ground	Pin 13.	Pin 13.				

DATA OUTPUT

Parallel Data Output	Parallel data from memory (ECL level).			
	Pin	Channel	Pin	Channel
	6	14	18	15
	7	12	19	13
	8	10	20	11
	9	8	21	9
	10	6	22	7
	11	4	23	5
	12	2	24	3
	13	0	25	1

	Electrical				
Characteristic	Performance Requirement				
DATA OUTPUT (CONT.)					
Serial Data Output	Pin 4. Serial data from memory (ECL level).				
Flag Output	Pin 14. Negative-going edge indicates beginning of each channel (ECL level).				
Format Output	Jumper, P300. Indicates memory format.				
	Pin 9 Pin 10				
CH 0-3 X1024	1 1				
CH 0-7 X512	0 1				
CH 0-15 X256	0 0				
Z-Axis Input	Pin 16. A positive signal (+5 V or less) intensifies the display				
Record Enable	Pin 15. Negative-going pulse of at least 1.5 V sets memory into Record mode.				
Ext Display Clock Input	Pin 3. Terminated by 100 Ω to -2 V.				
	Signal Levels: HI = more positive than -1 V . LO= more negative than -1.5 V .				
Frequency	From less than 1 Hz to 2 MHz.				
Display—Store Mode Output	Jumper, P300 pin 6. A HI indicates memory is in Store mode. A LO indicates memory is in Display mode.				
Frame Output	Jumper, P300 pin 8. A positive-going edge indicates the start of channel 0.				
Display Clock Output	Jumper, P300 pin 5. LO when memory is in Store mode.				
Ground	Pin 17.				
Р	OWER SOURCE				
Line Voltage Ranges	Refer to TM 500 power module performance requirements.				
Power Consumption	32 W at nominal line voltage.				

TABLE 2-2 Environmental

Characteristic	Performance Requirement	
Temperature		
Operating	0° to +50°C.	
Storage	-40° to +75°C.	
Altitude		
Operating	To 15,000 feet.	
Storage	To 50,000 feet.	
Transportation	Qualified under National Safe Transit Committee Test Procedure 1A, Category II.	

TABLE 2-3 Physical

Characteristic	Description		
Weight (without accessories)	Approximately 4 lbs (1.8 kg).		
Dimensions	See Fig. 2-1.		

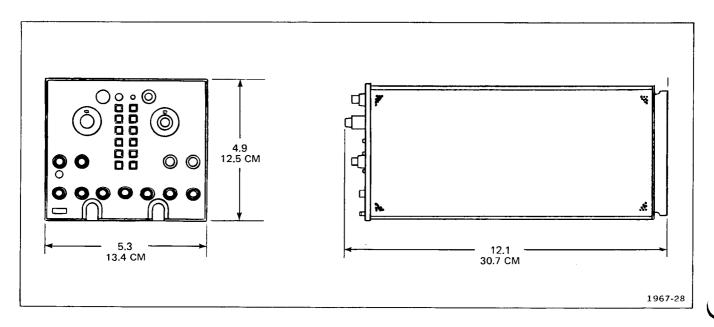


Fig. 2-1. LA 501 dimensional drawing.

STANDARD ACCESSORIES

1 ea	Instruction Manual	070-1967-00
1 ea	Operators Manual	070-2047-00
3 ea	Cables, Coaxial BNC, 50 Ohm, 42 Inch	012-0057-01
1 ea	Probe Package Includes:	010-6450-01

1 ea P6450 Probe

2 ea Lead Sets, Probe to Hook Tip (10 Leads/Set Color Coded)

2 ea Lead Sets, Probe to :025 Inch, Square Pin (10 Leads/Set Color Coded)

1 ea Data Sheet

1 ea Accessory Pouch

For more detailed information, refer to the tabbed Accessories page in the back of this manual.

RECOMMENDED ACCESSORIES

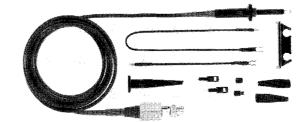
The following accessories have been selected from our catalog specifically for your instrument. They are listed as a convenience to help you meet your measurement needs. For detailed information and prices, refer to a Tektronix Products Catalog or contact your local Tektronix Field Representative.

PROBE

P6108: Miniature passive modular probe. Attenuation, 10X, within 1%. Bandwidth, at least 100 MHz. Input R and C, 10 M Ω with capacitance adjustable from 15 to 47 pF. Maximum input voltage, 500 V (dc + peak ac), derated with frequency.

Cable length:

1 meter (input C, approx. 10.5 pF) Order...010-6108-01 2 meter (input C, approx. 13.0 pF) Order...010-6108-03 3 meter (input C, approx. 15.0 pF) Order...010-6108-05



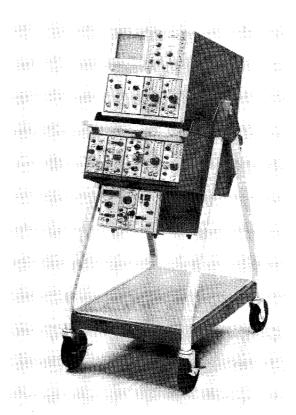
CARTS

203 Opt. 1: Designed to accommodate a 5000-series or 3-plug-in compartment 7000-series oscilloscope and one TM 503 in a roll-around test-station configuration.

Order. 203 OPT, 1

204 Opt. 1: Designed to accommodate a 4-plug-in compartment 7000-series oscilloscope and one TM 503 in a roll-around test-station configuration.

203 MOD 901R: Designed to accommodate a 400-series (except 455) oscilloscope and two TM 503's in a roll-around test-station configuration. This is a modified item; consult your local Tektronix representative for ordering information.



204 OPTION 1 SCOPE-MOBILE CART

THEORY OF OPERATION

This section of the manual contains a description of the circuitry used in the LA 501 Logic Analyzer. The description begins with a discussion of the instrument using the Block Diagram in the Diagrams section to show the major interconnections between circuits. Each circuit is then described in detail in the Circuit Description.

BLOCK DIAGRAM DESCRIPTION

The Data Inputs circuit provides an interface between the Memory and the actual input signals. The input signals are compared to a fixed or a variable threshold voltage to accommodate any logic signal source from ± 10 volts dc to ± 10 volts dc. The 16 output channels from the Data Inputs circuit are connected to the Memory circuit. The channel 0 output is also connected to the Trigger circuit as the internal trigger source.

The Trigger circuit controls the store and display modes of the Memory circuit, the retrace and retrace-blanking functions of the Horizontal and Blanking Signal Outputs circuit, and the time that each display is presented before new data is written into the Memory. Trigger position on the display (POST, CENTER, or PRE trigger) is also controlled by the Trigger circuit.

The Memory circuit stores data from the Data Inputs circuit at a rate controlled by the Time Base circuit. The Memory circuit consists of sixteen 256-bit RAMs (random access memories) and the required control circuits. The 16 RAMs are arranged in groups of four. Each group of 4 RAMs can store 256 bits of data from four different channels, 512 bits from two channels, or 1024 bits from one input channel, depending on the setting of the FORMAT switch.

The Time Base provides an internal store clock (SAMPLE INTERVAL) source of from 5 ms to 10 ns per sample. The Time Base circuit also provides a display clock and inputs for external clock sources.

The Serial Logic and Vertical Signal Outputs circuits provide the parallel-to-serial conversion required to display the stored data on the crt of a display monitor or oscilloscope. The vertical offset between displayed channels is also generated by these circuits.

The Horizontal and Blanking Signal Outputs circuits generate the horizontal sweep-ramp waveform and the crt blanking pulses for the display.

DETAILED CIRCUIT DESCRIPTION

Complete schematic diagrams are given in the Diagrams section of this manual. Refer to these schematics throughout the following circuit description.

FRONT PANEL WIRING (1)



The Front Panel Wiring diagram shows the controls, switches, indicators, and connectors mounted on the front panel and the circuit boards to which they are connected. Also shown are the interconnecting cables and pin numbers.

DATA INPUTS (2)

Refer to Fig. 3-1 for a detailed block diagram of the Data Inputs circuit. The inputs are separated into four groups of four channels each. As each of these four groups are identical in operation, only the Threshold Level circuit and the first group of input channels (0, 4, 8, and 12) will be discussed.

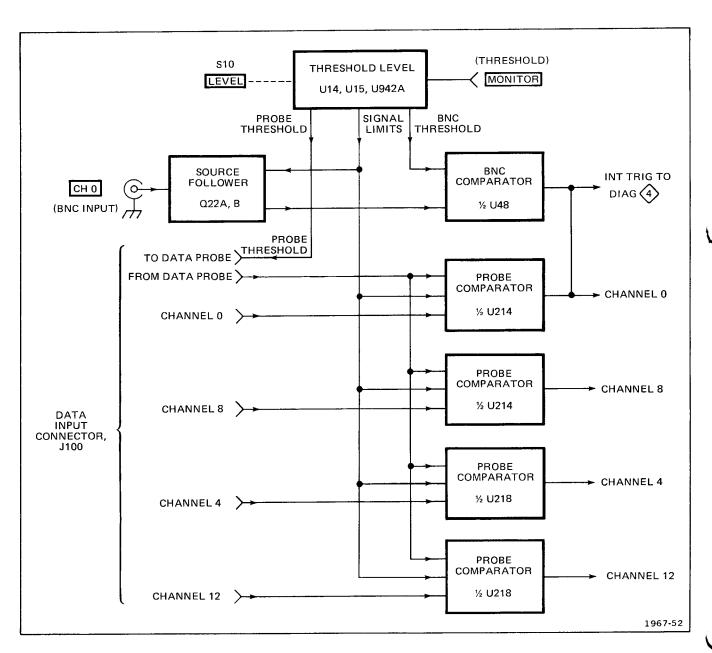


Fig. 3-1. Detailed block diagram of Data Inputs circuit (partial).

Threshold Level

The Threshold Level stage produces six different dc voltages which are used by the Data Inputs circuitry. These voltages are: Upper and lower signal limits, probe threshold, threshold monitor, BNC threshold, and a comparator disable voltage.

SIGNAL LIMITS. The upper and lower signal limits are set by Q16 and Q18, respectively. If the input signal voltage at the data input connector exceeds about 2.5 volts positive or negative, the clamp diode(s) conduct and limit the input signal voltage. For example, if the 10X probe connected to the CH 0 BNC input connector were to accidentally contact the ac power line, CR21 would conduct on the positive half-cycle and CR20 would conduct on the negative half-cycle. With CR20 or CR21 conducting, the excess voltage is dropped across R20 and the 9-megohm resistor in the 10X probe.

PROBE THRESHOLD. The probe threshold voltage is selected by INPUT switch S10 from divider R1, R3, R4, R5, R9, R6, and R8, or from INPUT THRESHOLD control, R10. The selected voltage is connected to the non-inverting input of U14. Operational amplifier, U14, is connected as a unitygain voltage follower. The output of U14 (probe threshold voltage) is connected through pin 1 of P90 and P9 to pin 11 of Data Input connector, J100.

THRESHOLD MONITOR. The threshold monitor voltage indicates the effective reference voltage for the input signals. The output of U14 is connected to the non-inverting input of U942A. Operational amplifier, U942A, is connected as a X5 amplifier. The output of U942A (threshold monitor voltage) is connected to the INPUT THRESHOLD MONITOR output jack.

BNC THRESHOLD. The voltage level, selected by S10, is also connected to the non-inverting input of U15 through divider R14 and R15. Operational amplifier, U15, is connected as a X2 amplifier; however, because of divider R14 and R15, the overall gain from the output of S10 to the output of U15 is 0.5. The output of U15 (BNC threshold voltage) is connected to the INPUTS switch, S15, and to the Time Base circuit as a reference voltage for the EXT CLOCK input.

COMPARATOR DISABLE. The comparator disable voltage is connected, as the reference voltage, to either the BNC Comparators or the Probe Comparators for channels 0, 1, 2, and 3. When INPUTS switch, S15, is set for PROBE inputs, the reference voltage for the BNC Comparators is switched from the BNC threshold voltage to the comparator disable voltage. The comparator disable voltage is more positive than the upper signal limit; therefore, the output of the BNC

Comparator is LO. When S15 is set for BNC inputs, the comparator disable voltage is connected to the reference input of the channel 0, 1, 2, and 3 Probe Comparators.

Source Follower

The Source Follower is a high input impedance (1 megohm) buffer between the front panel BNC connector and the BNC Comparator. Transistor, Q22A, is connected as a source follower. Transistor, Q22B, maintains a constant current through Q22A. The CH 0 Dc Balance adjustment, R25, sets the dc offset voltage for the Source Follower to 0 volts.

BNC Comparator

The BNC Comparator, U48A, compares the input signal (data) from the Source Follower with a reference voltage (BNC threshold voltage) from the Threshold Level stage. If the input signal voltage is more positive than the reference voltage, the output of the comparator is HI. If the input signal is less positive than the reference, the output is LO.

Probe Comparators

The Probe Comparators operate the same as the BNC Comparators described above except the reference voltage (probe threshold) is connected to the comparators through the data probe. The outputs of the Probe Comparators are connected to the Memory circuit. The outputs of the channel 0 BNC Comparator and the channel 0 Probe Comparator are tied together as a "wired OR". If either comparator output is HI, the channel 0 output line will be HI.

MEMORY



Refer to Figure 3-2 for a detailed block diagram of the Memory circuit. The 16 channels are separated into four groups of four channels each. As each of these four groups are identical in operation, only the control stages (Store/Display Clock Gate, Latch Clock, Memory Selector, WE and LF Clock and Address Counter) and the first group of memory channels will be discussed.

Store/Display Clock Gate

The display clock inhibit and store clock inhibit signals from the Trigger circuit control the outputs of the Store/Display Clock Gate. When the display clock inhibit (pin 10-U110) signal is HI, the store clock inhibit (pin 7-U110) signal is LO. The HI signal at pin 10 turns U110A off (pins 12 and 14, LO). The LO signal at pin 7 allows the store clock signal to pass, inverted, through U110B. Pins 4 and 14, and pins 3 and 12 are connected together in "wired-OR" configurations. Therefore, if either the outputs of U110A or the outputs of U110B are HI, the output signal lines will be HI. The other

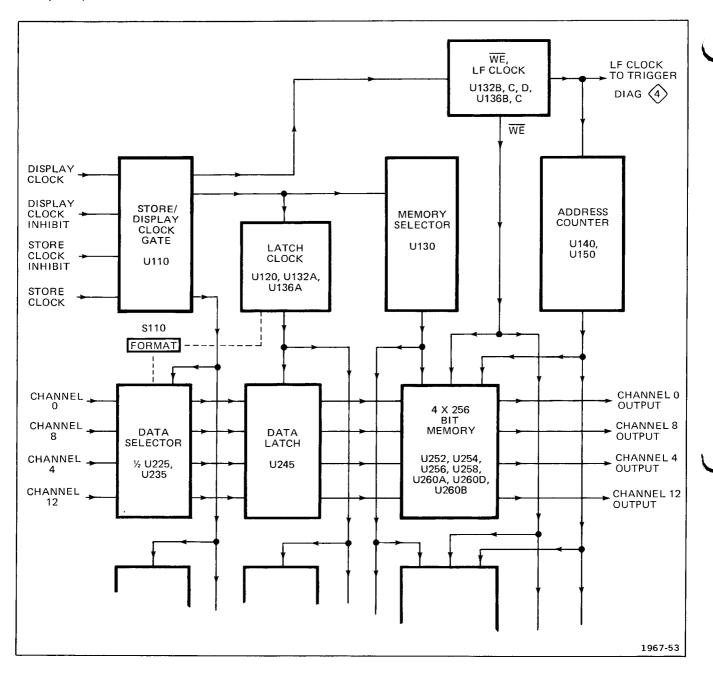


Fig. 3-2. Detailed block diagram of Memory circuit (partial).

output of U110B (pin 2) is not connected to U110A, and is only HI when the store clock and record clock inhibit signals are both LO. Refer to Figure 3-3 for a truth table of the Store/Display Clock Gate.

Latch Clock

The Latch Clock, U120, U132A, and U136A, strobes data into the Data Latch from the Data Selector. The timing of the Latch Clock output depends on the setting of the FORMAT switch.

FOUR CHANNEL. Figure 3-4 shows the timing of the Latch Clock outputs for 4-channel operation. When FOR-MAT switch, S110, is set for 4-channel operation, pins 12, 11, and 9 of U120 are held HI. When the Q2 output of U120 (also connected to pin 10 function select input) is LO, the next rising edge of the clock transfers the data at the DØ through D3 inputs to the outputs. When the data from the FORMAT switch is transferred to the outputs, the QØ, Q1, and Q2 outputs go HI (the D3 input is open or LO). A HI level at the S1 input (pin 10) sets U120 into the shift left mode. Each rising edge of the clock signal moves the data

at each output of U120 to the next output, until the Q2 output returns to a LO level. This occurs every fourth clock pulse. Gate, U132A, produces a HI output when both the Q3 output of U120 and the clock signal are LO. The output of U132A is connected through U136A to the clock inputs of the Data Latch stages. Buffer, U136A, delays the output of U132A to compensate for propagation delays through the circuitry.

EIGHT CHANNEL. Figure 3-5 shows the timing of the Latch Clock outputs for 8-channel operation. When the FORMAT switch is set for 8-channel operation, pins 12 and 9 (DØ and D2) of U120 are held HI. When the Q2 output of U120 is LO, the rising edge of the next clock pulse transfers the data at the DØ through D3 inputs to the outputs. When the input data is transferred to the outputs, the QØ and Q2 outputs go HI. A HI level at the S1 input (pin 10) sets U120 into the shift left mode. The next rising edge of the clock signal moves the LO level at the Q1 output to the Q2 output. With the S1 input LO, U120 is again ready to transfer data from the inputs to the outputs on the next rising edge of the clock signal. The output of U132A is HI when both the Q3 output of U120 and the clock signal are LO. This occurs every second clock pulse.

SIXTEEN CHANNEL. When the FORMAT switch, S110, is set for 16-channel operation, all of the data inputs of U120 are held LO. With all the outputs of U120 LO, the output of U132A is HI when the clock signal is LO.

Memory Selector

The Memory Selector, U130, enables the output of each memory IC, in sequence, during the display time. When the

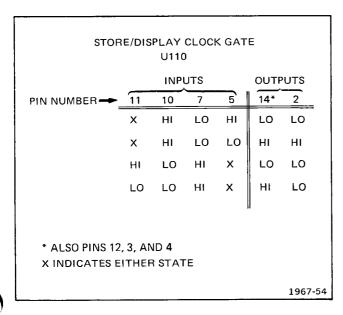


Fig. 3-3. Truth table for Store/Display Clock Gate.

store clock inhibit signal (pin 10) is HI, U130 operates as a 4-bit shift register. The data from Q2 of U120 is connected to the DL input of U130 (pin 13). Each rising edge of the clock signal at pin 4 shifts the data at the DL input to the QØ output and the data at each output (Qn) to the next output (Qn + 1). A LO level at an output enables the memory ICs driven by that output (e.g., a LO at QØ enables U258, U358, U458, and U558). When the FORMAT switch is set for 4-channel operation, one output at a time is LO (see Figure 3-6). In 8-channel operation, two outputs are

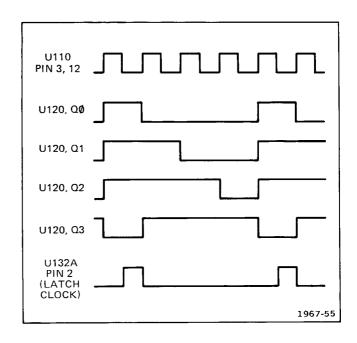


Fig. 3-4. Latch Clock timing for 4-channel operation.

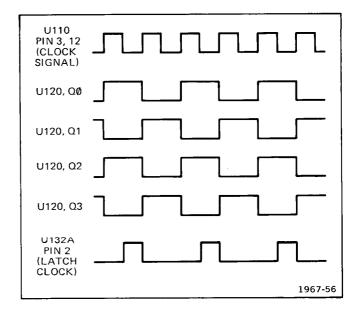


Fig. 3-5. Latch Clock timing for 8-channel operation.

Theory of Operation-LA 501

LO at the same time (see Figure 3-7). In 16-channel operation, all four outputs are LO. During the store time, the store clock inhibit signal is LO, and all the outputs of U130 are LO.

WE and LF Clock

The \overline{WE} (write enable not) and LF clock signals are the same frequency and polarity; the only difference is that the \overline{WE} signal is only active during the store time (display clock inhibit signal HI).

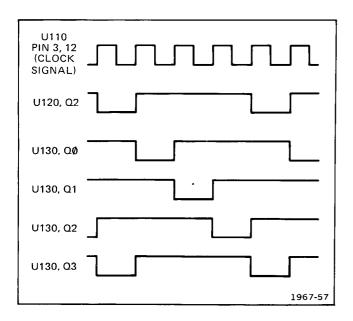


Fig. 3-6. Memory Selector timing for 4-channel operation (display time only).

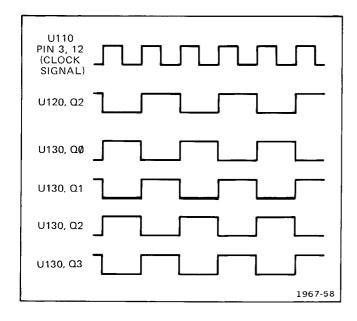


Fig. 3-7. Memory Selector timing for 8-channel operation (display time only).

FOUR CHANNEL. When the FORMAT switch is set for 4-channel operation, pin 7 of U132B and pin 11 of U132C are held HI, driving their outputs LO. The FORMAT switch also allows pin 7 of U136B and pin 14 of U136C to fall to a LO level. When the Q1 output of U120 is HI, the outputs of U136B and U136C are HI. The outputs of U136B, U132C, and U132D and the outputs of U136C and U132B are tied together in "wired-OR" configurations. Therefore, when the outputs of U136B and U136C go HI, the WE and LF clock lines go HI, respectively.

EIGHT CHANNEL. When the FORMAT switch is set for 8-channel operation, the WE and LF Clock stage operates the same as in 4-channel operation except that pin 7 of U136B and pin 14 of U136C are held HI. When the Q1 output of U120 is LO, the outputs of U136B and U136C are HI.

SIXTEEN CHANNEL. When the FORMAT switch is set for 16-channel operation, pin 7 of U132B, pin 11 of U132C, pin 7 of U136B, pin 14 of U136C, and the Q1 output of U120 are all LO. With both inputs of U136B and U136C LO, their outputs are LO. With one input of U132B and U132C LO, the $\overline{\rm WE}$ and LF clock lines will be HI when the clock signal (pins 6 and 10) is LO. When the display clock inhibit signal is LO (display mode), the output of U132D is HI, holding the $\overline{\rm WE}$ line HI.

Address Counter

The Address Counter, U140 and U150, selects the memory location where each data bit is stored. The Address Counter is a synchronous 8-bit (÷256) binary counter which is reset to zero at the beginning of each store cycle. The AØ through A7 outputs are connected to each memory IC.

Data Selector

The Data Selector stage selects the channels, and arranges the data to be connected to the memory ICs through the Data Latch. The operation of the Data Selector depends on the setting of the FORMAT switch.

FOUR CHANNEL. When the FORMAT switch is set for 4-channel operation, pin 10 of U235 is held HI. With pin 10 HI, U235 functions as a 4-bit shift register. Channel 0 data connected to pin 13 of U235 is shifted to the Q0 output on the first rising edge of the clock signal at pin 4. The data at pin 13 moves through the shift register until the first data bit is at the Q3 output (four clock pulses). The shift register then has four data bits stored in sequence, ready to be read into the Data Latch. In 4-channel operation, U225 is not used.

EIGHT CHANNEL. When the FORMAT switch is set for 8-channel operation, pin 10 of U235 is LO and pin 9 of U225 is HI. With pin 10 held LO, U235 functions as a 4-bit latch. The channel 0 data connected to pin 12 of U235 is transferred to the $\Omega\emptyset$ output at pin 14 on the first rising edge of the clock signal at pin 4. The level at the $\Omega\emptyset$ output

is connected back to the D1 input at pin 11 through pins 6 and 1 of U225. The next rising edge of the clock signal transfers the level at the DØ input to the QØ output, and the level that had been at the QØ output to the Q1 output. The same operations occur with the channel 4 data at pin 9 of U235, resulting in two bits of channel 0 data (QØ and Q1 outputs) and two bits of channel 4 data (Q2 and Q3 outputs) stored in sequence, ready to be read into the Data Latch.

SIXTEEN CHANNEL. When the FORMAT switch is set for 16-channel operation, pin 9 of U225 and pin 10 of U235 are both LO. With pin 10 held LO, U235 functions as a 4-bit latch. With pin 9 of U225 held LO, the data from channel 8 and channel 12 is connected through pins 5 and 3 of U225 to the D1 and D3 inputs of U235, respectively. Each rising edge of the clock signal transfers the data at the inputs of U235 to its outputs.

Data Latch

The Data Latch stage transfers the data from the outputs of the Data Selector to the inputs of the 4×256 Bit Memory on the rising edge of the latch clock signal (pin 4).

4 X 256 Bit Memory

The 4 x 256 Bit Memory consists of four RAMs (random access memories) and three gates. The RAMs, U252, U254, U256, and U258, are 256-bit memory units which can store one, two, or four channels of data, depending on how the data is presented by the Data Selector. If the FORMAT switch is set for 4-channel operation, the 4 x 256 Bit Memory

stores 1024 bits of data from channel 0. When set for 8-channel operation, the 4 \times 256 Bit Memory stores 512 bits of data from channel 0 and 512 bits of data from channel 4. When set for 16-channel operation, the 4 \times 256 Bit Memory stores 256 bits each from channels 0, 4, 8, and 12. The memory location where each bit of data is stored is controlled by the Address Counter.

In the display mode, a LO level on pin 5 enables the Q output of each memory IC in sequence. The outputs of the memory ICs are combined by AND-gates U260A, U260D, and U260B, as controlled by the FORMAT switch. In 4channel operation, pin 5 of U260A, pin 12 of U260D, and pin 6 of U260B are HI. Therefore, the data from all four O outputs are connected to the channel O data output line (J120, pin 13). In 8-channel operation, pins 5 and 6 (U260A and U260B) are HI. With pins 5 and 6 of U260 HI, the outputs of U252 and U254 are connected to pin 13 of J120 and the outputs of U256 and U258 are connected to pin 4 of J120 (channel 4 data output line). In 16-channel operation, pins 5, 12, and 6 of U260 are all LO; therefore, the data at the output of U252 is connected to the channel 0 data output line, the output of U254 is connected to the channel 8 data output line, etc.

TRIGGER 4

Refer to Figure 3-8 for a detailed block diagram of the Trigger circuit.

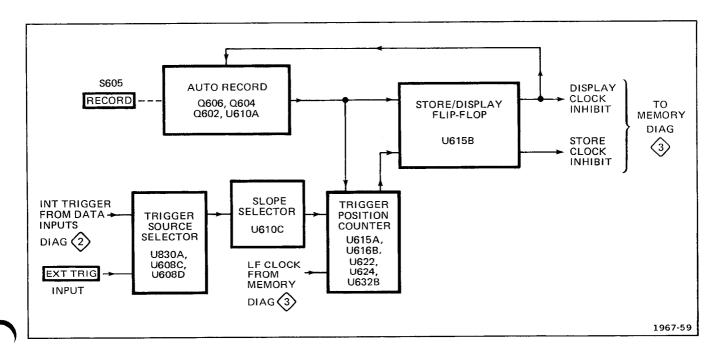


Fig. 3-8. Detailed block diagram of Trigger circuit.

Auto Record

The Auto Record stage controls the time that a display is presented before the Memory returns to the store mode. The display time is set by the DISPLAY TIME control, R605. Capacitor, C606, charges through R604 and R605. After approximately one time constant, Q606 conducts, discharging C606 and pulling pin 4 of U610A LO. When pin 4 of U610A is LO, pin 2 is LO and pin 3 is HI. The HI at pin 3 resets the $\overline{\mathbb{Q}}$ output (pin 14) of the Store/Display Flip-Flop, U615B, to a HI level. Pin 14 of U615B is connected to the emitter of Q602. A HI at the emitter of Q602 causes Q602 and Q604 to conduct, disabling the timing circuit for Q606. Therefore, Q606 only operates when the memory is in the display mode (pin 14 of U615B LO). A HI level pulse at pin 3 of U610A can also be obtained by pressing the MANUAL push button, S605A. NOR gates, U608A and B, are connected as a set-reset flip-flop to prevent any contact bounce in S605A from being coupled to the rest of the circuitry. When S605A is pressed, pin 5 of U608A goes LO and pin 7 of U608B goes HI. The resultant LO on pin 3 of U608B is connected to pin 5 of U610A, producing a HI level pulse at pin 3.

Trigger Source Selector

The Trigger Source Selector allows triggering the Logic Analyzer from either the channel 0 data signal or an external signal applied to the EXT TRIG input connector. The EXT TRIG input is intended for TTL signals (the threshold voltage is fixed at approximately +1.4 volts); however, other signal sources of appropriate amplitude may be used. Comparator, U830A, converts the signal at the EXT TRIG input to the ECL signal level used in the Logic Analyzer. If the input signal is more positive than the threshold voltage, the output of the comparator (pin 2) is HI.

The trigger source is selected by SOURCE switch, S608. When the SOURCE switch is set to EXT (button in), a HI level is connected to one input (pin 10) of NOR-gate, U608C. With one input HI, the output of U608C is held LO. At the same time, pin 13 of U608D is LO. With one input LO, U608D inverts the signal from U830A. The outputs of U608C and D are tied together in a "wired-OR" configuration, and connected to one input of exclusive-OR gate, U610C.

Slope Selector

The Slope Selector stage allows the Logic Analyzer to be triggered on either the rising or falling edge of the trigger signal. Exclusive-OR gate, U610C, operates as either an inverting or a non-inverting gate, determined by the setting of SLOPE switch, S610. With S610 closed (+), a HI level is applied to pin 14 of U610C, causing U610C to invert the signal at pin 15. (The trigger signal is inverted by the Trigger Source Selector; therefore, another inversion in the Slope Selector returns the trigger signal to its original state.) With

S610 open (—), pin 14 of U610C drops to a LO level, coupling the signal from the Trigger Source Selector to pin 6 of U615A without inverting it.

Trigger Position Counter

The Trigger Position Counter determines the relative position of the triggering event on the display by providing a delay between the triggering event and the time that the Memory stops storing data and switches to the display mode. Flipflops, U615A and U616B, control the operating modes of counters, U622 and U624. On the rising edge of the trigger signal at pin 6 of U615A, the Q output (pin 2) goes HI. The Q output of U615A is connected to the D input of U616B. The next rising edge of the LF clock signal (pin 11) sets the Q output of U616B HI. The Q output of U616B is connected to the S2 inputs of U622 and U624. With the S1 inputs (pin 9) held LO, the S2 inputs control the function of U622 and U624. When the S2 inputs are LO (before trigger), U622 and U624 load the data at their DØ through D3 inputs to their respective outputs. When the S2 inputs go HI, U622 and U624 start counting LF clock pulses (pin 13). The outputs of U622 and U624 are tied together in a "wired-OR" configuration. The output line at pin 7 of U632B is HI if any of the U622-U624 outputs are HI. When all outputs are LO, pin 7 of U632B is LO. When pin 7 and the LF clock signal are both LO, the output of U632B (frame clock) is HI.

Store/Display Flip-Flop

The Store/Display Flip-Flop, U615B, controls the mode of the Memory circuit. The rising edge of the frame clock signal at pin 11 sets the Ω output of U615B HI, and the $\overline{\Omega}$ output LO. This switches the Memory from the store mode to the display mode.

TIME BASE (5)

The Time Base circuit generates the store clock and display clock signals. The Time Base circuitry consists of a 100 MHz Oscillator, a series of counters with divide-by-two and divideby-five outputs, data selectors, and an external clock input. The 100 MHz Oscillator is controlled by crystal Y800. The output of the 100 MHz Oscillator is connected to data selector, U820, and to the input of divide-by-two and divideby-five counter U810. The store clock signal is selected from the outputs of the frequency-divider counters by the data selectors. The SAMPLE INTERVAL switch sets the "address" of the desired counter output. The display clock signal is taken from the QØ (2 μ s) output of counter U814. The external clock input circuitry allows use of an external clock source for the store clock signal, the display clock signal, or both. The jumper at the outputs of U830B allow polarity selection for the external clock signal.

SERIAL LOGIC AND VERTICAL SIGNAL OUTPUTS 6

The Serial Logic and Vertical Signal Outputs circuit provides the parallel-to-serial conversion and channel offset required to display the stored data on an oscilloscope or monitor. Figure 3-9 shows a detailed block diagram of this circuit.

Channel Counter

The Channel Counter, U630, U632A, and U632D, determines the data channel to be coupled through the Parallel-to-Serial Converter to the Vertical Output Amplifier. The Channel Counter also controls the Channel Offset stage and enables the Channel Position Selector. Four-bit counter, U630, counts frame clock pulses from the Trigger circuit. The output of the Channel Counter depends on the format selected by the FORMAT switch. When set for 4-channel operation, pin 12 of U632D and pin 4 of U632A are both HI. A HI level on pin 12 of U632D drives pin 9 HI and pin 15 LO. The HI level on pin 4 of U632A drives pin 2 LO. When set for 8-channel operation, only pin 12 of U632D is HI, holding pin 9 HI and pin 15 LO. The Q2 output of U630 is inverted by U632A. When set for 16-channel operation, pin 12 of U632D and pin 4 of U632A are both LO. The Q2 output of U630 is inverted by U632A. The Q3 output is coupled through U632D to pin 9 and is inverted at pin 15.

Parallel-to-Serial Converter

The Parallel-to-Serial Converter, U270 and U570, is actually a 16-channel data selector. The data channel to be connected to the Q output (pin 15) is determined by the binary count on the address (pins 7, 9, and 10) and enable not $\overline{(EN)}$ lines. Refer to Figure 3-10 for the relationship between the binary count on U630 and the data channel selected by the Parallel-to-Serial Converter.

Channel Position Selector

The Channel Position Selector allows variable offset for one channel for easier comparison of displayed data between channels. The CHANNEL/POSITION SELECT switch (S565) sets the binary code of the desired channel number on the switched inputs (pins 5, 13, 6, and 11) of U565. The other inputs (pins 4, 12, 7, and 10) are connected to the address lines from the Channel Counter. When the data on the address lines match the data from the CHANNEL/POSITION SELECT switch, the output of U565 goes LO. The LO level at the output of U565 disables the Channel Offset stage and turns Q684 off. With Q684 off, the current from the CHANNEL POSITION control, R565, flows through Q680 and Q682 to the Vertical Output Amplifier. When the inputs to U565 do not match, or if the CHANNEL/POSITION SELECT switch is set to OFF, the output of U565 is held HI, enabling the Channel Offset stage and turning on Q684

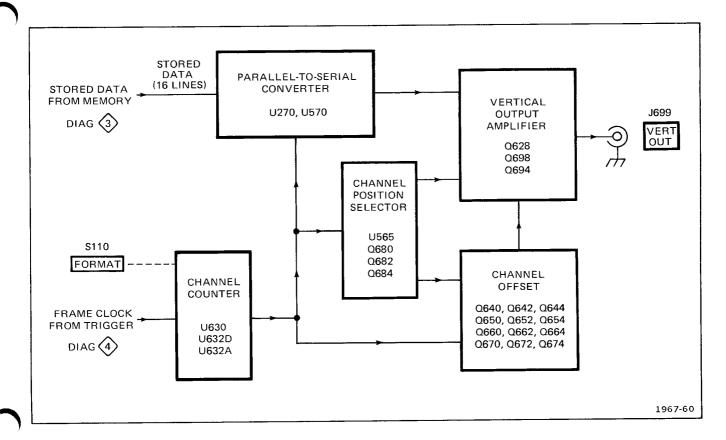


Fig. 3-9. Detailed block diagram of Serial Logic and Vertical Signal Outputs circuit.

Theory of Operation-LA 501

and turning off Q682, disconnecting the CHANNEL POSITION control from the Vertical Output Amplifier.

Channel Offset

The Channel Offset stage provides the vertical offset for each channel of data displayed on the crt of the monitor or oscilloscope. The amount of offset is determined by the binary count at the output of the Channel Counter. Each of the four output lines control one of the Channel Offset comparators (e.g., pin 15 of U632D controls comparator Q672, Q674). Each comparator applies a current, determined by its current setting resistor (e.g., R670 sets the current for comparator Q672, Q674), to the Vertical Output Amplifier. The total offset is determined by the number of comparators conducting current to the Vertical Output Amplifier and the amount of current each comparator is conducting.

Vertical Output Amplifier

The Vertical Output Amplifier, Q628, Q698, and Q694, combines the data and offset signals and drives the vertical deflection circuitry of the display monitor or oscilloscope.

Transistor, Q628, inverts and attenuates the output from the Parallel-to-Serial Converter (the gain of Q628 is approximately R628 divided by R627). Current from the Channel Position Selector or the Channel Offset is added, in R628, to the current through Q628 to change the dc level for each channel.

CHANNEL DISPLAYED		BINARY COUNT (U630)				
16 CH	8 CH	4 CH	Q3	Ω2	Q1	ΟØ
8	4	0	0	0	0	0
9	5	1	0	0	0	1
10	6	2	0	0	1	0
11	7	3	0	0	1	1
12	0	0	0	1	0	0
13	1	1	0	1	0	1
14	2	2	0	1	1	0
15	3	3	0	1	1	1
0	4	0	1	0	0	0
1	5	1	1	0	0	1
2	6	2	1	0	1	0
3	7	3	1	0	1	1
4	0	0	1	1	0	0
5	1	1	1	1	0	1
6	2	2	1	1	1	0
7	3	3	1	1	1	1

Fig. 3-10. Binary count on U630 versus channel displayed.

The combined data and offset signal is applied across R698 by Q698. The load resistance which the collector of Q698 works into can be varied by MAG control, R695, from approximately 100 ohms to approximately 500 ohms, resulting in an approximate gain range of X1 to X5. Additional offset current is added by Q694 to position the display on the crt of the display monitor or oscilloscope.

HORIZONTAL AND BLANKING SIGNAL OUTPUTS



The Horizontal and Blanking Signal Outputs circuit generate the X-axis (sweep) and Z-axis (blanking) signals needed to produce a display on the crt of a display monitor or oscilloscope. Also shown on this schematic diagram is the Invalid Mode Indicator circuitry.

Sweep Generator

When the frame clock signal from the Trigger circuit goes HI, the collector of Q728 goes LO, turns on Q732, and discharges sweep timing capacitor C732. When Q732 stops conducting, C732 starts to charge, producing a negative-going ramp. The rate of charge is determined by the current flowing through Q716, which is set by FORMAT switch S110. If S110 is set for 4-channel operation, Q712 and Q714 are both turned off; therefore, the emitter current for Q716 must flow through R715, R714, and R717. If S110 is set for 8-channel operation, Q714 turns on, shorting out R715. In 16-channel operation, Q712 also turns on. The negativegoing ramp is inverted by Q738 and Q740. The amplitude of the ramp signal at the HORIZ OUT connector is determined by the MAG control, R745. The horizontal position of the display on the crt can be varied by adding a dc offset current to the ramp signal through Q734, Q736, and the POS control, R740.

Blanking

The Blanking stage provides retrace blanking, store blanking, and "bad data" blanking for the display.

RETRACE BLANKING. Retrace blanking occurs when the frame clock pulse from the Trigger circuit goes HI. The frame clock pulse is connected to pin 11 of U632C. A HI level pulse on pin 11 drives pin 14 of U632C LO. If S720 is set to \overline{Z} , the LO level pulse from pin 14 of U632C is connected to the bases of Q718 and Q720, and a HI level reference is connected to the emitters of Q718 and Q720. When the base of Q720 goes LO, Q720 conducts, turning on Q724 and pulling the BLANK OUT output level to about -4.5 volts. If S720 is set to Z, pin 14 of U632C is connected to the emitters of Q718 and Q720, and the HI level reference is connected to the bases. When the emitters go LO, Q718 conducts and turns on Q722, pulling the BLANK OUT output level to approximately +5 volts.

STORE BLANKING. While the Memory is storing new data, no useful information is available for display; therefore, the display is blanked during this time. The display clock inhibit signal (U616A, pin 5) is HI during the store time. A HI level at pin 5 sets the Q output (pin 2) HI. Pin 5 of U616A is connected to one input of U632C. (When either input of U632C is HI, the display is blanked.) The Q output of U616A remains HI until the next frame clock pulse after the memory has returned to the display mode. This allows time for the sweep generator to stabilize and reset before the display is presented on the display monitor or oscilloscope.

"BAD DATA" BLANKING. "Bad data" blanking occurs if the LA 501 is triggered and the Memory switches from the store mode to the display mode before a complete store cycle has occurred. (For example, if the FORMAT switch is set to CH 0-3 X1024, and only 1000 bits of new data were stored before the Memory switched to the display mode, the other 24 bits of stored data on each channel would be left over from the previous store cycle. These 24 bits of "bad data" will be blanked out on the display.)

The $\overline{\Omega}$ output (pin 3) of U628 is set LO at the beginning of the store cycle. Normally, the address count carry signal at pin 9 causes the Ω output to go HI, indicating a complete store cycle has occurred and all stored data is "good data". However, if this does not occur, pin 3 remains LO during the display time. With pin 3 LO, the Ω output (pin 15) is set HI by the frame clock signal (pin 12) which blanks the display until the address count carry signal switches the Ω output (pin 15) LO.

The Q output (pin 15) of U628 is connected to the Q output (pin 2) of U616A. If either Q output is HI, pin 10 of U632C is HI resulting in a blanked display.

Invalid Mode Indicator

The Invalid Mode Indicator causes the light bulb behind the SAMPLE INTERVAL switch to blink on and off if the switch is set to a position which exceeds the maximum operating speed of the Memory circuit. This occurs when the SAMPLE INTERVAL switch is set to 10 ns or 20 ns during 16-channel operation, or is set to 10 ns during 8-channel operation. Either of these switch combinations cause astable multivibrator, Q702 and Q704, to oscillate. Transistor, Q708, is driven by the output at the collector of Q704. When the base of Q708 goes LO, light bulb, DS708, turns off.

POWER SUPPLIES (8)



The Power Supplies use the unregulated ac and dc voltages provided by the TM 500-series power module. The TM 500-series power module provides two 25 volt (rms) power transformer windings, unregulated positive and negative

33.5 volt dc supplies, and an unregulated +11.5 volt dc supply. The power module also contains two power transistors, one NPN and one PNP, for each plug-in unit. These transistors are used as the series-pass transistors for the +5.1-Volt and -2-Volt supplies.

+5.1-Volt Supply

The +5.1-Volt Supply consists of U942B, Q944, and the PNP power transistor in the power module. Operational amplifier, U942B, compares the output voltage at pin 6 with the +5.1 volt reference at pin 5. If the output voltage is higher than the reference, Q944 and the power transistor conduct less, allowing the output voltage to drop. If the output is lower than the reference, Q944 and the power transistor conduct more, pulling the output voltage higher.

-4.8-Volt Supply

The -4.8-Volt Supply is derived from the 25 volt ac windings. The 25 volts ac supplied by the power module is rectified and filtered by CR904, C904, L905, and C905. The resultant dc source is converted by a switching regulator to -4.8 volts. Zener diode, VR922, and transistor, Q922, maintain a constant current through VR920. The reference voltage at the wiper of R925 is connected to the base of Q914. Transistors, Q914 and Q916, compare the output voltage with the reference. If the output voltage is more negative than the reference, Q916 turns on and Q914, Q910. and Q905 turn off. With Q905 cut off, CR905 conducts to discharge T911 and pull the output voltage positive. The positive transition at the collector of Q905 is coupled through C911, R912, C927, and R927 to the base of Q928. The positive transition saturates Q928, resulting in a very fast turn off time for Q905. When the output voltage becomes less negative than the reference, Q916 turns off and Q914, Q910, and Q905 turn on. With Q905 saturated, its collector switches to the dc supply at its emitter, pulling the output negative. The waveform at the collector of Q905 is filtered by T911 and C912 before being compared to the reference voltage. Zener diode, VR932, and SCR, Q932, provide over-voltage protection for the ICs connected to this supply. If the output voltage exceeds about -6.2 volts, Q932 switches on, shorting out the -4.8-Volt Supply and blowing fuse F905.

-2-Volt Supply

The -2-Volt Supply is derived from the -4.8-Volt Supply. The reference voltage for the -2-Volt Supply is provided by U800A. Transistor, Q934, compares the output voltage to the reference. (The emitter-base voltage drop of Q934 is added to the voltage at pin 2 of U800A, resulting in an output voltage approximately 0.6 volts more negative than the voltage at pin 2.) If the output voltage is too positive, Q934 conducts less and Q936 and the NPN power transistor conduct more, pulling the output voltage negative.

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MAINTENANCE

This section of the manual contains information for performing preventive maintenance, troubleshooting, and corrective maintenance for the LA 501.

PREVENTIVE MAINTENANCE

Preventive maintenance consists of cleaning, visual inspection, lubrication, etc. Preventive maintenance performed on a regular basis may prevent instrument breakdown and will improve the reliability of the instrument. The severity of the environment to which the LA 501 is subjected determines the frequency of maintenance. A convenient time to perform preventive maintenance is preceding adjustment of the instrument.

CLEANING

The LA 501 should be cleaned as often as operating conditions require. Accumulation of dirt on components acts as an insulating blanket and prevents efficient heat dissipation which can cause overheating and component breakdown.

Remove any dirt which remains with a soft brush or a cloth dampened with a mild detergent and water solution. A cotton-tipped applicator is useful for cleaning in narrow spaces.

VISUAL INSPECTION

The LA 501 should be inspected occasionally for such defects as broken connections, improperly seated semiconductors, damaged circuit boards, and heat-damaged parts.

however, particular care must be taken if heat-damaged components are found. Overheating usually indicates other trouble in the instrument; therefore, it is important that the cause of overheating be corrected to prevent recurrence of

The corrective procedure for most visible defects is obvious; the damage.

LUBRICATION

Generally, there are no components in the LA 501 that will require lubrication during the life of the instrument.

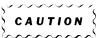
Slide Switches

These switches are lubricated prior to leaving the factory and should not require further lubrication. However, if they become electrically noisy, cleaning and lubricating with Electronic Chemical Corporation No Noise may solve the problem.

Cam Switches

In most cases, the factory lubrication of these switches should be adequate for the life of the instrument. The switch contacts are designed to operate dry for the life of the switch.





Avoid the use of chemical cleaning agents which might damage the plastics used in this instrument. In particular, avoid chemicals that contain benzene, toluene, xylene, acetone, or similar solvents.

Exterior

Loose dust accumulated on the front panel can be removed with a soft cloth or small brush. Dirt that remains can be removed with a soft cloth dampened in a mild detergent and water solution. Abrasive cleaners should not be used.

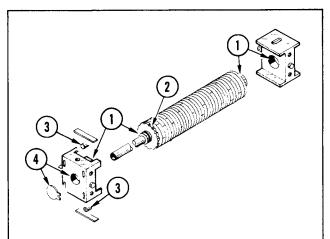
Interior

Dust in the interior of the instrument should be removed occasionally due to its electrical conductivity under highhumidity conditions. The best way to clean the interior is to blow off the accumulated dust with dry, low-pressure air.

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Maintenance-LA 501

If the switch has been disassembled for replacement of switch sub-parts, a lubrication kit containing the necessary lubricating materials and instructions is available through any Tektronix Field Office. Order Tektronix Part 003-0342-01. General Electric Versilube silicone grease may be applied sparingly so that the lubricant does not get on the contacts. Refer to Figure 4-1 for lubrication instructions.



- 1 Apply lubricant to the drum journals and mating surface in the mounting bearings.
- 2 Apply lubricant to the wear surface of the index wheel.
- 3) Apply lubricant to the index roller and roller guide in the front bearing. A thin film should be applied to the inner face of the detent springs if more than one spring is replaced.
- 4 Ensure that some lubricant is present at the interface between the bearing and retainer clip.

C1967-2

Figure 4-1. Lubrication procedure for a typical cam switch.

Push-Button Switches

Modular push-button switches are self lubricating. Switch contacts and pads are designed to operate dry for the life of the switch. However, as the switches are not sealed, dust attracted to the contact area may cause switch contacts to become electrically noisy. Cleaning may be accomplished by flushing the contact area with isopropyl alcohol or kelite (1 part kelite to 20 parts water). Do not use chemical cleaning agents that leave a film or that might damage plastic parts.

Should it become necessary to remove a switch for replacement or cleaning, refer to Component Removal and Replacement in this section.

SEMICONDUCTOR CHECKS

Periodic checks of the semiconductors in the LA 501 are not recommended. The best check of semiconductor performance is actual operation in the instrument. More details on checking semiconductor operation are given under trouble-shooting.

ADJUSTMENT AFTER REPAIR

After any electrical component has been replaced, the adjustment of that particular circuit should be checked, as well as the adjustment of other closely related circuits. The Performance Check and Adjustment procedure in this manual provides a quick and convenient means of checking instrument operation. In some cases, minor troubles may be revealed or corrected by adjustment.

TROUBLESHOOTING

The following information is provided to help troubleshoot the LA 501. Information contained in other sections of this manual should be used along with the following information to aid in locating the defective component. An understanding of the circuit operation is very helpful in locating troubles, particularly where integrated circuits are used.

TROUBLESHOOTING EQUIPMENT

The following equipment, in addition to that listed in the Performance Check and Adjustment section, is useful for troubleshooting the LA 501 Logic Analyzer unit.

Transistor Tester

Description: Dynamic-type tester.

Purpose: Test semiconductors.

Recommended Tektronix types: 576 Curve Tracer, 577/177 Curve Tracer system, 7CT1N Curve Tracer unit and a 7000-series oscilloscope system, or a 5CT1N Curve Tracer unit and a 5000-series oscilloscope.

Multimeter

Description: Voltmeter, 10 megohm input impedance and a range from 0 to at least 50 volts dc; accuracy, within 0.1%. Ohmmeter, 0 to 20 megohms. Test probes should be insulated to prevent accidental shorting.

Purpose: Check voltage and resistance.

Test Oscilloscope

Description: Frequency response, dc to 100 megahertz minimum; deflection factor, 5 millivolts to 5 volts/division. A 10X, 10 megohm voltage probe should be used to reduce circuit loading.

Purpose: Check operating waveforms.

Variable Autotransformer

Description: Output variable from 0 to 140 volts, 2 amperes minimum rating. Must have three-wire power cord, plug, and receptacle.

Purpose: Vary input line voltage when troubleshooting in the power supply.

TROUBLESHOOTING TECHNIQUES

This troubleshooting procedure is arranged to check the simple trouble possibilities before proceeding with extensive troubleshooting. The first few checks ensure proper connection, operation, and adjustment. If the trouble is not located by these checks, the remaining steps aid in locating the defective component. When the defective component is located, it should be replaced using the replacement procedure given under Corrective Maintenance.

- 1. CHECK CONTROL SETTINGS. Incorrect control settings can indicate a trouble that does not exist. If there is any question about the control function or operation of any control, see the Operating Instructions section.
- 2. CHECK ASSOCIATED EQUIPMENT. Before proceeding with troubleshooting of the LA 501, check that the equipment used with this instrument is operating correctly. Check that the signal is properly connected and that the interconnecting cables are not defective. Also, check the power source. If the trouble persists, the LA 501 is probably at fault.
- **3. VISUAL CHECK.** Visually check the portion of the instrument in which the trouble is located. Many troubles can be located by visible indications such as unsoldered connections, broken wires, damaged circuit boards, damaged components, etc.
- 4. CHECK INSTRUMENT ADJUSTMENT. Check the adjustment of this instrument, or the affected circuit if the trouble appears in one circuit. The apparent trouble may only be a result of misadjustment. Complete adjustment instructions are given in the Performance Check and Adjustment section.
- 5. ISOLATE TROUBLE TO A CIRCUIT. To isolate trouble to a circuit, note the trouble symptom. The symptom often identifies the circuit in which the trouble is located. When trouble symptoms appear in more than one circuit, check the affected circuits by taking voltage and waveform readings. Also check for the correct output signals at the frontpanel output connectors with a test oscilloscope. Incorrect operation of all circuits often indicates trouble in the power supply. Check first for correct voltages of the individual supplies. However, a defective component elsewhere in the instrument can appear as a power-supply trouble and may also affect the operation of other circuits.
- **6. CHECK VOLTAGES AND WAVEFORMS.** Often the defective component can be located by checking for the correct voltage or waveform in the circuit. Refer to the diagrams section for correct voltages and waveforms.

Power Supply. If incorrect operation of the power supply is suspected, first check that the power-module line selector block is in the M position (99 V AC to 121 V AC). Then, connect the power module to a variable autotransformer. Adjust the autotransformer output for 110 V AC. Load the power supply as follows:

- A. Set SAMPLE INTERVAL switch to 10 nanoseconds.
- B. Push the INPUT ECL button in for ECL logic.
- C. Press the RECORD MANUAL button to reset the trigger circuit.
- D. Push the SLOPE button to generate a trigger (TRIG'D indicator should light).

NOTE

Input signals are not required for this test.

Use a dc voltmeter with 0.1% accuracy to check each supply voltage, and check ripple with a test oscilloscope. Voltages are measured between the power supply test points and chassis ground. Power supply test points are shown on the Adjustment and Test Point Locations pullout at the rear of this manual. Vary the autotransformer output from 99 volts ac to 121 volts ac and check that each power supply is within the tolerances given in Table 4-1.

TABLE 4-1
Power Supply Tolerances¹

Power Supply	Test Point	Output Voltage Range	Maximum Ripple Peak-to-Peak
-4.8 V	TP 933	-4.757 to -4.872	50 mV low freq. 50 mV high freq.
+5.1 V	U942 Pin 6	+4.845 to +5.355	10 mV low freq. 50 mV high freq.

¹ Checked under full load (refer to text).

If a power supply is within the tolerance in Table 4-1, the supply can be assumed to be working correctly. If outside the given tolerance, the supply may be misadjusted or operating incorrectly. Use the procedure given in the Performance Check and Adjustment section to adjust the power supply voltage.

7. CHECK INDIVIDUAL COMPONENTS. The following procedures describe methods of checking individual components in the LA 501. Two-lead components that are soldered in place are best checked by first disconnecting one end. This isolates the measurement from the effects of surrounding circuitry.



CAUTION

To avoid component damage, disconnect the power source before removing or replacing semiconductors.

Semiconductors. A good check of transistor operation is actual performance under operating conditions. A transistor can be most effectively checked by substituting a new component or one that has been checked previously. However, be sure that circuit conditions are not such that a replacement transistor might also be damaged. If substitute transistors are not available, use a dynamic tester. Static-type testers are not recommended, since they do not check operation under simulated operating conditions.

IC's (integrated circuits) can be checked with a voltmeter, test oscilloscope, or by direct substitution. A good understanding of circuit operation is desirable when trouble-shooting circuits using IC's. Use care when checking voltages and waveforms around the IC's so that adjacent leads are not shorted together. A convenient means of clipping a test probe to the 14- and 16-pin IC's is with an IC test clip. This device also serves as an extraction tool. The lead configuration for the semiconductors used in this instrument are shown on a pullout page in the front of the diagrams section.

Diodes. A diode can be checked for an open or shorted condition by measuring the resistance between terminals with an ohmmeter scale having a low internal source current, such as the R X 1K scale. The resistance should be very high in one direction and very low when the meter leads are reversed.



Do not use an ohmmeter scale that has a high internal current. High currents may damage the diode. The cathode end of each glass-encased diode is indicated by a stripe, a series of stripes, or a dot. The cathode and anode ends of metal-encased diodes are identified by the diode symbol marked on the case. For most silicon or germanium diodes with a series of stripes, the color code identifies the four significant digits of the JEDEC or vendor number using the resistor color-code system (e.g., a diode color-coded yellow-brown-green-red indicates a 1N-4152 diode).

Resistors. Check the resistors with an ohmmeter. See the Replaceable Electrical Parts list for the tolerance of the resistors used in this instrument. Resistors normally do not need to be replaced unless the measured value varies widely from that specified.

Inductors. Check for open inductors by checking continuity with an ohmmeter. Shorted or partially shorted

inductors can usually be found by checking the waveform response when high-frequency signals are passed through the circuit. Partial shorting often reduces high-frequency response (roll off).

Capacitors. A leaky or shorted capacitor can usually be detected by checking resistance with an ohmmeter on the highest scale. Do not exceed the voltage rating of the capacitor. The resistance reading should be high after initial charge of the capacitor. An open capacitor can best be detected with a capacitance meter or by checking if the capacitor passes ac signals.

8. REPAIR AND ADJUSTMENT. If any defective parts are located, follow the replacement procedures given in Corrective Maintenance. Be sure to check the performance of any circuit that has been repaired or had any electrical components replaced.

CORRECTIVE MAINTENANCE

Corrective maintenance consists of component replacement and instrument repair. Special techniques required to replace components in this instrument are given here.

OBTAINING REPLACEMENT PARTS

All electrical and mechanical part replacements for the LA 501 can be obtained through your Tektronix Field Office or representative. However, many of the standard electronic components can be obtained locally in less time than is required to order them from Tektronix, Inc. Before purchasing or ordering replacement parts, check the parts list for value, tolerance, rating, and description.

NOTE

When selecting replacement parts, it is important to remember that the physical size and shape of a component may affect its performance in the instrument, particularly at high frequencies. All parts should be direct replacements unless it is known that a different component will not adversely affect instrument performance.

Some parts are manufactured or selected by Tektronix, Inc. to satisfy particular requirements, or are manufactured for

Tektronix, Inc. to our specifications. Most of the mechanical parts used in this instrument have been manufactured by Tektronix, Inc. To determine the manufacturer of parts, refer to parts list, Cross Index Mfr. Code Number to Manufacturer.

When ordering replacement parts from Tektronix, Inc., include the following information:

- 1. Instrument type.
- 2. Instrument serial number.
- 3. A description of the part (if electrical, include circuit number).
- 4. Tektronix part number.

SOLDERING TECHNIQUES



WARNING

To avoid electrical shock, disconnect the instrument from the power source before soldering.

The reliability and accuracy of this instrument can be maintained only if proper soldering techniques are used when repairing or replacing parts. General soldering techniques, which apply to maintenance of any precision electronic equipment, should be used when working on this instrument. Use only 60/40 rosin-core, electronic-grade solder. The choice of soldering iron is determined by the repair to be made. When soldering on circuit boards, use a 15- to 40-watt pencil-type soldering iron with a 1/8-inch wide, wedge-shaped tip. Keep the tip properly tinned for best heat transfer to the solder joint. A higher wattage soldering iron may separate the wiring from the base material. Avoid excessive heat; apply only enough heat to remove the component or to make a good solder joint. Also, apply only enough solder to make a firm solder joint; do not apply too much solder.



CAUTION

The Memory and Output circuit boards in this instrument are multilayer type boards with a conductive path(s) laminated between the top and bottom board layers. All soldering on these boards should be done with extreme care to prevent breaking the connections to the center conductor(s); only experienced maintenance personnel should attempt repair of these boards.

For metal terminals, (e.g., switch terminals, potentiometers, etc.) a higher wattage-rating soldering iron may be required. Match the soldering iron to the work being done. For example, if the component is connected to the chassis or other large heat-radiating surface, it will require a 75-watt or larger soldering iron.

The following technique should be used to replace a component on a circuit board:

- 1. Grip the component lead with long-nose pliers. Touch the soldering iron to the lead at the solder connection. Do not lay the iron directly on the board, as it may damage the board.
- 2. When the solder begins to melt, gently pull the lead out. If unable to pull the lead without using force, try removing the other end of the component as it may be more easily removed.

NOTE

The reason that some component leads seem troublesome to remove is due to a bend placed on each lead during machine insertion of the component in the manufacturing process. The purpose of the bent leads is to hold the component in place during a flow-soldering manufacturing process that solders all components at one time.

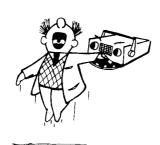
If a component lead is extremely difficult to remove, it may be helpful to straighten the leads on the back side of the board with a small screwdriver or pliers while heating the soldered connection.

Desolder the component from the circuit board using heat on the component lead so that the solder will stay behind on the board. If it is desired to remove solder from a circuit-board hole for easier installation of a new component, a solder-removing wick should be used for this purpose.

3. Bend the leads of the new component to fit the holes in the board. If the component is replaced while the board is mounted in the instrument, cut the leads so they will just protrude through the board. Insert the leads into the holes in the board so the component is firmly seated against the board (or as positioned originally). If it does not seat properly, heat the solder and gently press the component into place.

- 4. Touch the iron to the connection and apply a small amount of solder to make a firm solder joint. To protect heat-sensitive components, hold the lead between the component body and the solder joint with a pair of long-nose pliers or other heat sink.
- 5. Clip the excess lead that protrudes through the board (if not clipped in step 3).
- 6. Clean the area around the solder connection with a flux-remover solvent. Be careful not to remove information printed on the board.

COMPONENT REMOVAL AND REPLACEMENT



WARNING

To avoid electrical shock, disconnect the instrument from the power source before replacing components.

The exploded-view drawing associated with the Replaceable Mechanical Parts list may be helpful in the removal or disassembly of individual components or subassemblies. Component locations and circuit board locations are shown in the Diagrams section.

Circuit Boards

If a circuit board is damaged beyond repair, replace the entire board assembly. Part numbers are given in the Replaceable Electrical Parts list for completely wired boards.

MEMORY CIRCUIT BOARD. To remove the circuit board:

- 1. Remove 6 screws from rear panel and remove rear panel.
- 2. Remove knobs from CHANNEL/POSITION switch.
- 3. Note color of multi-pin connectors and P number to which each connects. Note wire color on single-conductor shielded cables and connector to which each is connected.

- 4. Disconnect all cables that terminate on Memory circuit board.
- 5. Remove knobs from X MAG-POS controls.
- 6. Remove hex nut and flat washer from CHANNEL/POSITION switch.
- 7. Remove hex nut and flat washer from X MAG-POS control.
- 8. Remove 1 flat-head screw (see Figure 4-2A) from bracket holding Data Input and Data Output jacks.
- 9. Remove 4 screws (A, B, C, and D on Figure 4-2B) holding circuit board to frame tabs.
- 10. Push the panel bushing away from the front panel. Lift rear of board away from frame to clear the frame tabs and slide circuit board toward rear until clear of frame and front panel.

To replace the circuit board:

- 1. Place front-panel bushing and grounding spring on camswitch shaft and slide circuit-board assembly into place with switch shaft through front panel. With circuit board roughly positioned, hold front-panel bushing in place (flats on bushing must align with panel opening). Place flat washer and hex nut on bushing and tighten.
- 2. Reverse order of removal to complete circuit-board replacement.

OUTPUT CIRCUIT BOARD. To remove the circuit board:

- 1. Note color of multi-pin connectors and P number to which each connects. Note wire color on single-conductor shielded cables and connector to which each is attached.
- 2. Disconnect all cables that terminate on circuit board.
- 3. Remove 1 screw (A on Figure 4-3) from circuit board and remove power-supply shield.
- 4. Remove 1 screw (B on Figure 4-3).
- 5. Remove screw that passes through heat sink on power diode CR905. Remove heat sink. See Figure 4-4.
- Remove knob from front-panel SAMPLE INTERVAL switch.
- 7. Remove hex nut and flat washer from SAMPLE INTER-VAL switch-shaft bushing.

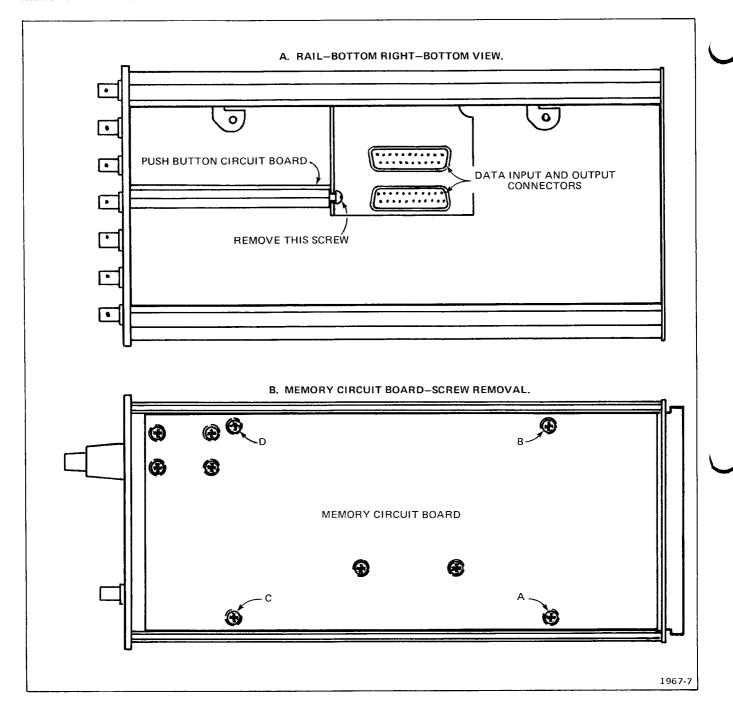


Figure 4-2. (A) Locations of Data Input and Data Output connectors. (B) Locations of securing screws on the Memory circuit board.

- 8. Remove 2 screws (C and D on Figure 4-3) from circuit board.
- 9. Lift rear of circuit board away from frame far enough that components mounted near SAMPLE INTERVAL cam switch clear board-mounting tab.
- 10. Push the panel bushing away from the front panel, and slide the circuit board to the rear far enough to clear the switch shaft.

To replace the circuit board:

1. Place front-panel bushing and grounding spring on camswitch shaft and slide circuit board assembly into place with switch shaft through front panel. With board roughly positioned, hold bushing in place (flats on bushing must be aligned with panel opening). Place flat washer and hex nut on bushing and tighten.

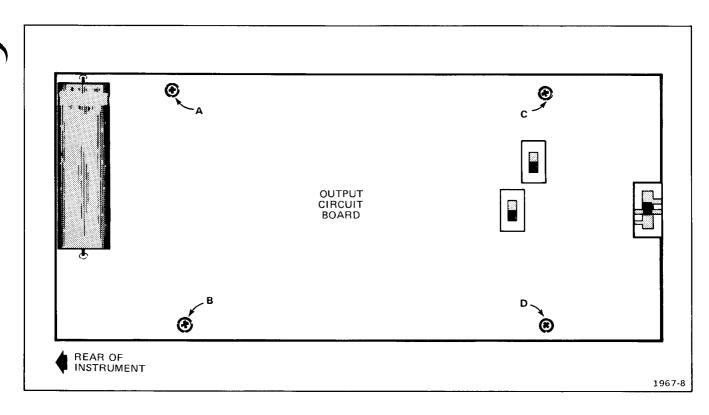


Figure 4-3. Locations of securing screws on the Output circuit board.

2. To complete assembly, reverse order of removal. When replacing heat sink, regrease heat sink with heat-conducting material such as DOW-4¹ silicone grease.

PUSH-BUTTON SWITCH CIRCUIT BOARD.

1. Remove Memory circuit board as outlined previously.

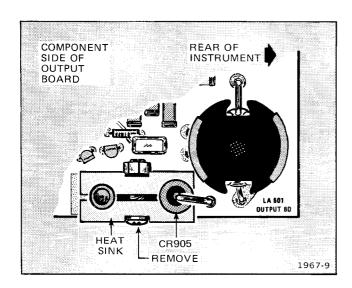


Figure 4-4. Location of CR905 heat sink on the Output circuit board.

¹ Registered trademark of Dow Corning Corporation.

- 2. Loosen 2 screws on THRESHOLD control-shaft coupling.
- 3. Remove RECORD (DISPLAY TIME-MANUAL) knobs from control-switch shafts. Pull on small, gray, center knob to remove (no set screw).
- 4. Note color of multi-pin connectors and P number to which each connects and disconnect any cable that terminates on circuit board.
- 5. Remove 4 screws holding circuit board to square rails. See Figure 4-5.
- 6. Pull circuit board straight toward rear until switch buttons clear front panel and remove circuit board.

To replace the Push-Button Switch circuit board, reverse the order of removal.

Switches

Several types of switches are used in this instrument. Contact alignment and spacing is critical to the operation of the push-button and cam switches. Therefore, defective switches should be replaced as a unit or repaired only by personnel experienced with these types of switches. Your local Tektronix Field Office or representative can provide additional

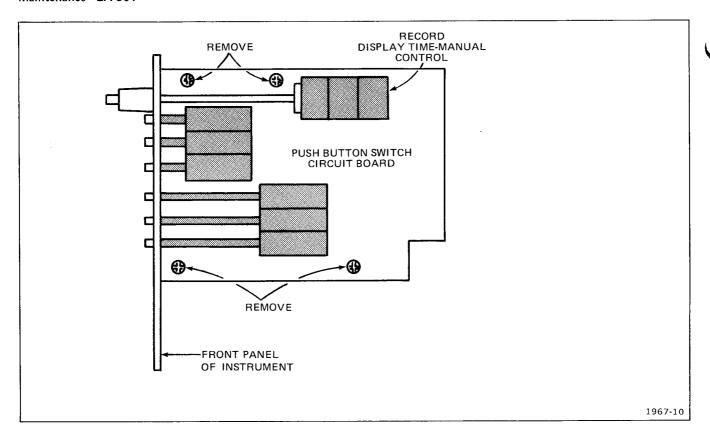


Figure 4-5. Locations of securing screws on the Push-Button Switch circuit board.

repair information. The following special maintenance information is provided for switch replacement.

CAM SWITCHES. The cam switches used in this instrument consist of a rotating cam which mates with contacts on the adjacent circuit board. These contacts are activated by lobes on the cams as the switch is rotated. A cam switch can be disassembled for inspection, cleaning, repair, or replacement; however, it is recommended that the switch be removed and replaced as a unit.

Repair of a cam switch should be undertaken only by experienced maintenance personnel. Switch alignment and contact spacing must be

CAUTION

carefully maintained for proper operation. A cam switch repair kit is available (Tektronix part 040-0541-00) which contains special alignment tools for use in repairing or replacing the switch contacts. For information or assistance on maintenance of cam switches, contact your local Tektronix Field Office or representative.

Use the following procedure to remove and replace a cam switch:

- 1. Remove circuit board following instructions given previously.
- 2. For CHANNEL/POSITION switch only, unsolder potentiometer contacts from circuit board.
- 3. Remove four screws that secure switch to circuit board.
- 4. Remove cam-switch assembly from board.

To replace the cam switch, reverse the order of removal.

PUSH-BUTTON SWITCHES. See Figure 4-6 for removal and replacement instructions of push-button switches.

Semiconductors

Semiconductors should not be replaced unless actually defective. If removed from their sockets during routine maintenance, return them to their original sockets. Unnecessary replacement of semiconductors may affect the adjustment of this instrument. When semiconductors are replaced, check the operation of the part of the instrument which may be affected.



CAUTION

To avoid component damage, power must be turned off before removing or replacing semiconductors.

Replacement devices should be of the original type or a direct replacement. Figure 8-1 (located in the diagrams section) shows the lead configurations of the semiconductor devices used in this instrument. When replacing, check the manufacturer's basing diagram for correct basing. Semiconductors which have heat radiators use silicone grease to increase heat transfer. Replace the silicone grease when replacing these semiconductors.



WARNING

Handle silicone grease with care. Avoid getting silicone grease in eyes. Wash hands thoroughly after use.

An extracting tool should be used to remove the 14- and 16-pin integrated circuits to prevent damage to the pins. This tool is available from Tektronix, Inc. Order Tektronix Part 003-0619-00. If an extracting tool is not available when removing one of these integrated circuits, pull slowly and evenly on both ends of the device. Try to avoid having one end of the integrated circuit disengage from the socket before the other, as the pins may be damaged.

Interconnecting Pins

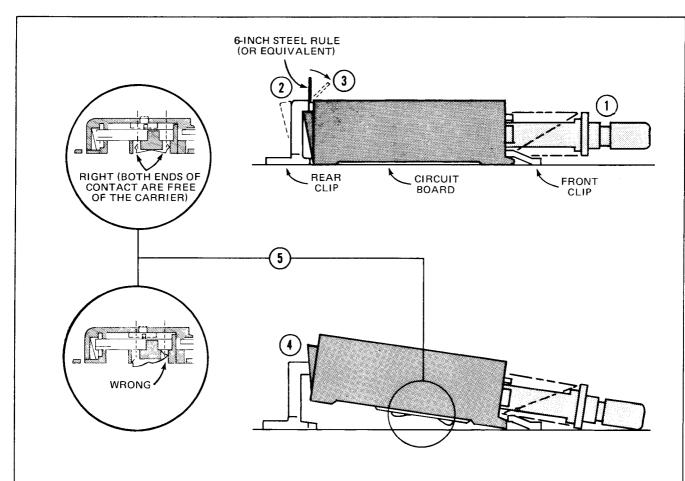
Two methods of interconnection are used to connect the circuit boards with other boards and components. When the interconnection is made with a coaxial cable, a special end-lead connector plugs into a socket on the board. When the interconnection is made with a wire lead, an end-lead connector is used which mates with the interconnecting pin soldered into the board. The following information provides the removal and replacement procedure for the various types of interconnecting methods:

COAXIAL-TYPE END-LEAD CONNECTORS. Replacement of the coaxial-type end-lead connectors requires special tools and techniques; only experienced maintenance personnel should attempt to remove and replace these connectors. It is recommended that the cable be replaced as a unit. For cable part numbers, see the Replaceable Mechanical Parts list. An alternative solution is to refer the replacement of the defective connector to your local Tektronix Field Office or representative.

END-LEAD PIN CONNECTORS. The pin connectors used to connect the wires to the interconnecting pins are clamped to the ends of the associated leads. To remove and replace damaged end-lead pin connectors, remove the old pin connector from the end of the lead and clamp the replacement connector to the lead.

Some of the pin connectors are grouped together and mounted in a plastic holder; the overall result is that these connectors are removed and installed as a multi-pin connector. To provide correct orientation of this multi-pin connector when it is replaced, an arrow is stamped on the circuit board and a matching arrow is molded into the plastic housing of the multi-pin connector. Be sure these arrows are aligned as the multi-pin connector is replaced. If the individual end-lead pin connectors are removed from the plastic holder, note the color of the individual wires for replacement.

CIRCUIT-BOARD PINS. A circuit-board pin replacement kit including necessary tools, instructions, and replacement pins is available from Tektronix, Inc. Order Tektronix Part 040-0542-00. Replacement of circuit-board pins on



- 1) Make sure that all switch shafts are in the OUT position to clear the rear clip.
- 2 Place the long edge of a six-inch rule or similar thin straight edge between the top edge of the rear clip and the switch body.
- (3) Carefully pry the rear clip back just far enough to push the steel rule down between the clip and switch body.

CAUTION

When the switch is removed, the contacts may drop free and be damaged or lost. Body salts or acids can contaminate the switch contacts. Wear cotton gloves to prevent touching the contacts in the switch or on the board with bare hands.

- Pull the rear of the switch up, remove the steel rule, and pull the switch out of the front clip.
- 5 To replace the switch, first check that the slide contacts are properly installed in the carrier. Then, place the front of the switch into the front clip and push the rear of the switch down until the rear clip catches and holds the switch in place.

1967-3

Figure 4-6. Push-button switch removal and replacement instructions.

multi-layer boards is not recommended; refer such repairs to your local Tektronix Field Office or representative.



CAUTION

Only experienced service personnel should replace circuit-board pins on multi-layer boards. Therefore, refer repairs of the Memory circuit board and the Output circuit board to your local Tektronix Field Office or representative.

To replace a damaged pin which is mounted on a single-layer circuit board, first disconnect any pin connectors. Then (using Soldering Techniques given earlier in this section), unsolder the damaged pin and pull it from the board with a pair of pliers, leaving the ferrule (see Figure 4-7) in the hole. if possible. If the ferrule remains in the circuit board, remove the spare ferrule from the replacement pin and press the new pin into the hole in the circuit board. If the ferrule is removed with the damaged pin, clean out the hole using a solder-removing wick and a scribe. Then press the replacement pin with attached spare ferrule into the hole. Position the replacement pin in the same manner as the old pin. Solder the pin to the circuit board on each side of the board. If the old pin was bent at an angle to mate with a connector, carefully bend the new pin to the same angle. Replace the pin connector.

Fuses

Three fuses are used in this instrument. See the circuit-board illustrations in the Diagrams section for location and the Replaceable Electrical Parts list for values.

Incandescent Bulbs

Light bulbs are mounted on the sub-panel using a plastic sleeve. Unsolder the lead wires and pull the bulb out of the sleeve from the rear of the sub-panel.

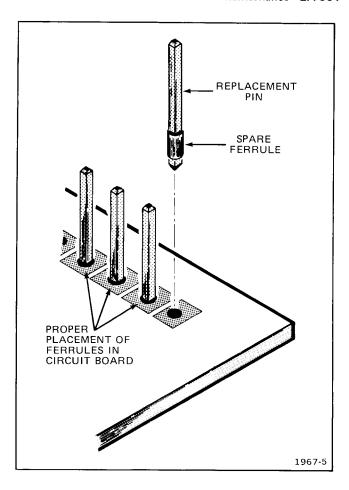


Figure 4-7. Exploded view of circuit-board pin and ferrule.

ADJUSTMENT AFTER REPAIR

After any electrical component has been replaced, the adjustment of that particular circuit should be checked, as well as other closely related circuits. See Section 5 for a complete adjustment procedure.

INSTRUMENT REPACKAGING

If this instrument is to be shipped for long distances by commercial means of transportation, it is recommended that it be repackaged in the original manner for maximum protection. The original shipping carton can be saved and used for this purpose. Should more information be needed, contact your local Tektronix Field Office or representative.

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PERFORMANCE CHECK AND ADJUSTMENT

This section contains information necessary to perform a complete instrument performance check and adjustment. Limits given in the procedure are adjustment guides and should not be interpreted as performance requirements unless preceded by a check mark $(\sqrt{})$. Where possible, instrument performance is checked before an adjustment is made.

PRELIMINARY INFORMATION

Adjustment Interval

To maintain instrument accuracy, check the performance of the LA 501 every 1000 hours of operation, or every 6 months if used infrequently. Before complete adjustment, thoroughly clean and inspect this instrument as outlined in Section 4, Maintenance.

Tektronix Field Service

Tektronix Field Service Centers and the Factory Service Center provide instrument repair and adjustment services. Contact your Tektronix Field Office or representative for further information.

Using This Procedure

This Performance Check and Adjustment procedure can be used either for complete adjustment or as a check of instrument performance. Completion of each step in the procedure ensures that the instrument is correctly adjusted and operating within specified limits. Refer to the following discussion for instructions on a complete or partial check and adjustment.

INDEX. An index precedes the procedure to aid in locating Performance Check and Adjustment steps.

PERFORMANCE CHECK. Instrument performance can be checked by performing the complete Performance Check and Adjustment procedure and omitting only the ADJUST parts of the steps. A check mark $(\sqrt{})$ preceding a CHECK indicates that the limit given is a performance requirement specified in Section 2, Specification.

ADJUSTMENT. Completion of each step in the Performance Check and Adjustment procedure ensures that the instrument is correctly adjusted and performing within specified limits. Where possible, instrument performance is checked before an adjustment is made. For best overall performance when performing the complete adjustment procedure, make each adjustment to the exact setting indicated.

PARTIAL PROCEDURES. The following procedure is written to completely check and adjust the instrument to the Performance Requirements listed in Section 2, Specification. If the applications for which the instrument is used do not require the full available performance, the procedures and the required equipment list can be shortened accordingly.

A partial performance check and adjustment may be desirable after replacing components, or to touch up the adjustment of a portion of the instrument. To check or adjust only part of the instrument, refer to the Equipment Required list which precedes that portion of the procedure to be performed. To avoid unnecessary adjustment of other parts, adjust only if the tolerance given in each CHECK is not met.

TEST EQUIPMENT REQUIRED

The test equipment listed in Table 5-1 is required for a complete performance check and adjustment of this instrument. The specifications given in Table 5-1 for test equipment are the minimum required to meet the Performance Requirements listed in Section 2, Specification. Detailed operating instructions for test equipment are omitted in this procedure. Refer to the test equipment instruction manual if more information is needed.

Special Fixtures

Special fixtures are used only where they facilitate instrument adjustment. These fixtures are available from Tektronix, Inc. Order by part number from Tektronix Field Offices or representatives.

Test Equipment Alternatives

The test equipment listed in the Examples of Applicable Test Equipment column, Table 5-1, is required to check and adjust this instrument. The Performance Check and Adjustment procedure is based on the first item of equipment given as an example. If other equipment is substituted, control settings or setups may need to be altered. If the exact item of equipment given as an example is not available, refer to the Minimum Specifications column to determine if other equipment may be substituted. Then check the Purpose column. If you determine that your measurement requirements will not be affected, the item and corresponding step(s) can be deleted.

TABLE 5-1 Test Equipment

		quipment	Examples of Applicable
Description	Minimum Specifications	Purpose	Examples of Applicable Test Equipment
1. Test Oscilloscope ¹	Bandwidth, dc to 100 MHz; minimum deflection factor, 10 mV/div; accuracy, within 3%. Dual-channel with chopped display mode.	Check triggers, display formats, vertical, horizontal, and Z-axis. Check and adjust dc balance and data inputs.	a. Tektronix 7603 Oscilloscope system with 7A26 Amplifier and 7B70 Time Base.b. Tektronix 465 Oscilloscope.
2. Monitor	Bandwidth, dc to 500 kHz; deflection factor, 50 mV/div (vertical) and 100 mV/div (horizontal) both dc coupled. Graticule, 8 x 10 div. External Z-axis input.	Check triggers, display formats, vertical and horizontal, and Z-axis.	a. Any Tektronix 600-series display unit that meets bandwidth requirements.
3. Precision Dc Voltmeter	Range, ±2 V to ±50 V; accuracy, within 0.1%. Digital voltmeter must have at least 4½-digit readout.	Check power supply, threshold voltages, and internal clock. Check and adjust dobalance and data inputs.	a. Tektronix DM 501 Digital Multimeter (operates in Tek- tronix TM 500-series power module). b. Fluke Model 825A Differ- ential DC Voltmeter.
4. Pulse Generator	Pulse duration, 10 ns to 1 ms; pulse period, 0.1 μ s to 10 ms; risetime, 2 ns or less; output amplitude, -3 V to $+3$ V with dc offset.	Check triggers, display formats, vertical and horizontal, and Z-axis. Check and adjust dc balance and data inputs.	a. Tektronix PG 502 Pulse Generator (operates in Tek- tronix TM 500-series power module).
5. Frequency Counter	Frequency range, 40 MHz to 55 MHz; accuracy, within 10 parts in 10 ⁶ .	Check internal clock.	 a. Tektronix DC 501 110 MHz Counter (operates in Tektronix TM 500-series power module). b. Tektronix 7D14 Digital Counter (operates in any Tektronix 7000-series oscilloscope except those without readout).
6. Delay Generator	Delayed events, 0 to 1024; trigger level range and slope, ±1 V; minimum detectable pulse width, 0.5 μs.	Check Z-axis intensify.	a. Tektronix DD 501 Digital Delay (operates in TM 500- series power module. b. Tektronix 7D11 Digital Delay (operates in any Tek- tronix 7000-series oscilloscope with readout).
7. 10X Probes (4 required)	Compatible with test oscilloscope used.	Check triggers and Z-axis. Check and adjust dc balance and data inputs.	a. Tektronix P6108 or P6054A probes.
8. 1X Probe	Compatible with test oscilloscope used.	Check internal clock.	a. Tektronix P6028 or P6062A probes (3.5 foot).

¹ Can be used instead of monitor throughout procedure.

TABLE 5-1 (CONT.) Test Equipment

Description	Minimum Specifications	Purpose	Examples of Applicable Test Equipment
9. Variable Line Voltage Source	Output, 110 V ac (or 220 V ac) 200 W; accuracy, within 3%.	Adjust –4.8 V supply.	a. General Radio W8MT3 VM Variac Autotransformer.
10. 50-Ohm Termination	Impedance, 50 ohms; accuracy, within 2%; connectors, BNC.	Output termination for signal generators.	a. Tektronix part 011-0049-01.
11. BNC-to-Probe Tip Adapter	Adapt to Tektronix probes used.	Provide connection from pulse generator to probe tip.	a. Tektronix part 013-0084-01.
12. BNC T Connector	BNC to BNC.	Provide cable and probe connection to pulse generator.	a. Tektronix part 103-0030-00.
13. Coaxial Cables (5 required)	Impedance, 50 ohms; type, RG 58/U; length, 42 inches; connectors, BNC.	Provide signal interconnections.	a. Tektronix part 012-0057-01 (3 supplied with LA 501).
14. Flexible Extender Cable	Compatible with TM 500- series plug-ins.	Provide access to test points and adjustments.	a. Tektronix part 067-0645-01.
15. Screwdriver	3-inch shaft, 3/32-inch bit.	Adjust power supply and dc balance.	a. Xcelite R-3323.

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PRELIMINARY PROCEDURE

Perform the following steps before proceeding with the Performance Check and Adjustment procedure.

- 1. Connect LA 501 to power module with flexible extender cable (Tektronix part 067-0645-01).
- 2. Remove LA 501 side covers.
- 3. Pull PWR button on left or right edge of power module to apply power to LA 501. Allow at least 15 minutes warmup.

NOTE

Titles for external LA 501 controls and connectors are capitalized in this procedure (e.g., SAMPLE INTERVAL, EXT CLOCK). Internal controls, connectors, and adjustments are initial capitalized (e.g., Blanking Switch, Ch 0 DC Bal adjustment, Low-Impedance Data Input connector).

A. POWER SUPPLY

Equipment Required

- 1. Precision dc voltmeter
- 2. Variable line-voltage source

3. Three-inch screwdriver

BEFORE YOU BEGIN, see

TEST POINT AND ADJUSTMENT LOCATIONS

in the Diagrams section.

A1. ADJUST -4.8 VOLT SUPPLY (R925)

- a. With power module PWR button pushed in, connect power module line cord to variable line voltage source.
- b. Set variable line voltage source for 110 (or 220) volts ac and pull PWR button out.
- c. Press ECL button and set DISPLAY TIME control fully counterclockwise (1 s).
- d. Set SAMPLE INTERVAL switch to 50 ns and press CH 0-15 X256 button.
- e. Connect P6450 probe to internal Low-Impedance Data Input connector (J100).
- f. Connect precision dc voltmeter between TP933 and chassis ground.
- g. CHECK—Voltmeter for reading from -4.796 volts to -4.834 volts.

- h. ADJUST-R925, (-4.8 volts adjustment) for a voltmeter reading of exactly -4.800 volts.
- i. INTERACTION—Any change in setting of R925 may affect operation of all circuits in instrument.

A2. CHECK -2 VOLT SUPPLY

- a. Connect precision dc voltmeter between pin 2 of P5 and chassis ground.
- b. CHECK-Voltmeter for reading from -1.90 volts to -2.10 volts.

A3. CHECK +5.1 VOLT SUPPLY

- a. Connect precision dc voltmeter between pin 3 of P4 and ground.
- b. CHECK—Voltmeter for reading from +4.845 volts to +5.355 volts.

B. THRESHOLD VOLTAGES AND INTERNAL CLOCK

Equipment Required

1. Frequency counter

3. 1X probe

2. Precision dc voltmeter

BEFORE YOU BEGIN, see

TEST POINT AND ADJUSTMENT LOCATIONS

in the Diagrams section.

$\sqrt{\,}$ B1. CHECK 10X PROBE THRESHOLD VOLTAGES

- a. Press VAR and INPUTS buttons.
- b. Connect precision dc voltmeter between pin 5 of U48 and chassis ground.
- √ c. CHECK-Voltmeter reading for a range of at least -1
 volt to +1 volt as THRESHOLD control is rotated from
 fully counterclockwise to fully clockwise.
 - d. Press TTL button.
- $\sqrt{\text{e. CHECK-Voltmeter for reading from +0.115 volt to}}$ +0.165 volt.
 - f. Press ECL button.
- $\sqrt{\text{g. CHECK-Voltmeter for reading from }-0.121 \text{ volt to }} -0.129 \text{ volt.}$

- f. Press ECL button.
- $\sqrt{\mbox{g. CHECK-Voltmeter for reading from }-0.242\mbox{ volt to }} -0.258\mbox{ volt.}$

$\sqrt{\,}$ B3. CHECK THRESHOLD MONITOR OUTPUT

- a. Press VAR button.
- b. Connect precision dc voltmeter between INPUT MONITOR jack and chassis ground.
- ✓ c. CHECK-Voltmeter reading for a range of at least
 -10 volts to +10 volts as THRESHOLD control is rotated from fully counterclockwise to fully clockwise.
 - d. Press TTL button.
- √ e. CHECK-Voltmeter for reading from +1.12 volts to +1.70 volts.

$\sqrt{\,}$ B2. CHECK 5X PROBE (P6450) THRESHOLD VOLTAGES

- a. Press VAR button and press to release INPUTS button.
- b. Connect precision dc voltmeter between pin 1 of J9 and chassis ground.
- $\sqrt{\text{c. CHECK-Voltmeter reading for a range of at least } -2}$ volts to +2 volts as THRESHOLD control is rotated from fully counterclockwise to fully clockwise.
 - d. Press TTL button.
- $\sqrt{\text{e. CHECK-Voltmeter for reading from +0.230 volt to }}$

- f. Press ECL button.
- \sqrt{g} . CHECK-Voltmeter for reading from -1.17 volts to -1.33 volts.

$\sqrt{\,}$ B4. CHECK EXTERNAL CLOCK THRESHOLD VOLTAGES

- a. Press VAR button and place internal Ext Clock Threshold switch, S848, in Front Panel (up) position.
- b. Connect precision dc voltmeter between pin 11 of U830 and chassis ground.
- √ c. CHECK-Voltmeter reading for a range of at least -1 volt to +1 volt as THRESHOLD control is rotated from fully counterclockwise to fully clockwise.

Performance Check and Adjustment-LA 501

- d. Press TTL button.
- $\sqrt{\rm e.~CHECK-Voltmeter}$ for reading from +0.115 volt to +0.165 volt.
 - f. Press ECL button.
- \sqrt{g} . CHECK-Voltmeter for reading from -0.121 volt to -0.129 volt.

- h. Place internal Ext Clock Threshold switch, S848, to ECL (down) position.
- $\sqrt{\,}$ i. CHECK–Voltmeter for reading from -0.122 volt to -0.128 volt.

$\sqrt{\,$ B5. CHECK INTERNAL CLOCK

- a. Set SAMPLE INTERVAL switch to 20 ns and connect frequency counter to TP138 with a 1X probe.
- \surd b. CHECK—Counter for readout from 49.99750 to 50.00250 megahertz.

C. TRIGGERS

Equipment Required

- 1. Test oscilloscope or monitor
- 2. Pulse generator
- 3. 10X probe
- 4. 50-ohm termination

- 5. BNC-to-probe tip adapter
- 6. 50-ohm BNC cables (4)

BEFORE YOU BEGIN, see

TEST POINT AND ADJUSTMENT LOCATIONS

in the Diagrams section.

$\sqrt{\,}$ C1. CHECK EXTERNAL TRIGGER LEVEL AND MINI-**MUM PULSE WIDTH**

a. Set controls as follows:

LA 501

INPUT FORMAT TTL (button in) CH 0 - 3 X1024 (button in)

TRIGGER SOURCE DISPLAY TIME

EXT (button in) Fully counterclockwise (1 s)

OFF

CHANNEL SELECT SAMPLE INTERVAL

Fully counter-Vertical MAG

clockwise

50 ns

Horizontal MAG

Fully counterclockwise

Down

Display Clock

S835 (internal)

c. Connect 50-ohm cables from X HORIZ OUT, Y VERT OUT, and Z BLANK OUT connectors to corresponding test oscilloscope or monitor inputs.

d. Connect 50-ohm termination to EXT TRIG connector.

e. Set pulse generator for a TTL level (approximately 0 to +3 volts), 10-nanosecond duration, 10-millisecond period, pulse output.

f. Connect 50-ohm cable from pulse generator output to 50-ohm termination at EXT TRIG connector.

NOTE

Determine the Z-axis input blanking polarity required by the test oscilloscope or monitor. Place internal Blanking Polarity switch, S720, up for positive blanking, down for negative blanking.

 \sqrt{g} . CHECK-For visible display on test oscilloscope or monitor and that TRIG'D indicator is lit. Note that TRIG'D indicator blinks off momentarily with auto record pulse.

Test Oscilloscope or Monitor

Mode **Deflection Factor**

or Gain

50 mV/div Х 100 mV/div

X-Y

$\sqrt{}$ C2. CHECK DISPLAY TIME RANGE

- √ a. CHECK—That test oscilloscope or monitor display alternately blanks then reappears for approximately 1 second.
 - b. Set DISPLAY TIME control fully clockwise (not in detent).
- $\sqrt{\,}$ c. CHECK—That test oscilloscope or monitor display alter nately blanks, then reappears for approximately 10 seconds.

b. Position a low-intensity spot at the vertical and horizontal center of test oscilloscope or monitor graticule.

Performance Check and Adjustment-LA 501

- d. Set DISPLAY TIME control to ∞ (detent) position.
- e. Disconnect pulse generator output from EXT TRIG connector.
- √ f. CHECK—For stable display on test oscilloscope or monitor.

$\sqrt{}$ C3. CHECK TRIGGER HOLDOFF

- a. Press and release MANUAL button.
- √ b. CHECK—For no display on test oscilloscope or monitor and that TRIG'D indicator is not lit.
 - c. Connect 50-ohm cable from pulse generator output to EXT TRIG connector.
- √ d. CHECK-For display on test oscilloscope or monitor and that TRIG'D indicator is lit.
 - e. Remove 50-ohm cable between pulse generator output and EXT TRIG connector.

C4. CHECK CHANNEL 0 TRIGGERS

a. Set LA 501 controls as follows:

INPUT

TRIGGER SLOPE
TRIGGER SOURCE
INPUTS
TRIGGER
DISPLAY TIME

TTL (button in)
CH 0 - 3 X1024
(button in)
+ (button out)
CH 0 (button out)
PROBE (button out)
CENTER (button in)
Fully counterclockwise (1 s)

b. Connect P6450 probe to internal Low-Impedance Data Input connector (J100).

- c. Set pulse generator for a TTL level (approximately 0 to +3 volts), 1-microsecond duration, 10-millisecond period, pulse output.
- d. Connect P6450 channel 0 lead to 50-ohm termination at pulse generator output.

NOTE

To make it easier to connect the P6450 probe to the 50-ohm termination at the pulse generator output, connect a BNC-to-banana plug adapter (such as the Tektronix part 103-0035-00) to the 50-ohm termination. Attach a short length of bus wire to the center conductor terminal and clip the probes to the bus wire.

- e. CHECK—Display for 4 lines with generator output pulse displayed near center of channel 0 line.
- f. Press POST button.
- g. CHECK—That generator output pulse is displayed near left edge of channel 0 line.
- h. Press PRE button.
- i. CHECK—That generator output pulse is displayed near right edge of channel 0 line.

C5. CHECK TRIGGER SLOPE

- a. Press CENTER button.
- b. Position left edge of generator output pulse to graticule vertical center line.
- c. Press SLOPE button.
- d. CHECK—That displayed generator output pulse shifts to left side of graticule vertical center line.

D. DISPLAY FORMATS

Equipment Required

- 1. Test oscilloscope or monitor
- 2. Pulse generator
- 3. 50-ohm termination

4. 50-ohm BNC cables (3)

BEFORE YOU BEGIN, see

TEST POINT AND ADJUSTMENT LOCATIONS

in the Diagrams section.

$\sqrt{\,}$ D1. CHECK LOW-IMPEDANCE DATA INPUT DISPLAY

- a. Connect P6450 probe to internal Low-Impedance Data Input connector (J100).
- b. Set SAMPLE INTERVAL switch to 50 ns and press CH 0 3 X1024 button.
- c. Connect 50-ohm cables from X HORIZ OUT, Y VERT OUT, and Z BLANK OUT connectors to corresponding test oscilloscope or monitor inputs.
- d. Set pulse generator for a TTL level (approximately 0 to +3 volts) 1-microsecond duration, 10-millisecond period, pulse output.
- e. Connect 50-ohm termination to pulse generator output.
- f. Connect P6450 probe channel 0 through 7 leads to 50-ohm termination at pulse generator output.

NOTE

The output of the Tektronix PG 502 will feed 8 channels simultaneously without pulse degradation. A BNC-to-banana plug adapter (such as Tektronix part 103-0035-00) with a short length of bus wire attached to the centerconductor terminal can be used to connect the P6450 probe leads to the pulse generator.

√ g. CHECK—Display for 4 lines with no breaks or abnormalities in display pattern. Set Horizontal and Vertical MAG and POS controls to allow close examination of display.

- h. Return MAG and POS controls to fully counterclockwise (X1) position.
- i. Press CH 0 7 X512 button.
- √ j. CHECK—Display for 2 groups of 4 lines each with about twice the pulse width noted in part (g). Examine display for no breaks or abnormalities in display pattern. Set Horizontal and Vertical MAG and POS controls to allow close examination of display.
 - k. Return MAG and POS controls to fully counterclockwise (X1) position.
 - I. Press CH 0 15 X256 button and set THRESHOLD control for stable display.
- √ m. CHECK—Display for 4 groups of 4 lines each with about twice the pulse width noted in part (j). Examine display for no breaks or abnormalities in display pattern. Set Horizontal and Vertical MAG and POS controls to allow close examination of display.
 - n. Return MAG and POS controls to fully counterclockwise (X1) position.

NOTE

When using a Tektronix PG 502 Pulse Generator, check the remaining channels by disconnecting the P6450 probe channel 1 through 7 leads from the pulse generator (do not disconnect the channel 0 lead). Connect the channel 8 through 15 leads and check display as described in part (m).

E. VERTICAL AND HORIZONTAL

Equipment Required

- 1. Test oscilloscope or monitor

3. 50-ohm termination

4. 50-ohm cables (3)

- 2. Pulse generator
 - BEFORE YOU BEGIN, see

TEST POINT AND ADJUSTMENT LOCATIONS

in the Diagrams section.

√ E1. CHECK VERTICAL OUTPUT

a. Set LA 501 controls as follows:

- $\sqrt{}$ h. CHECK—That Vertical POS control positions display smoothly anywhere within graticule area.
 - i. Set Vertical MAG fully counterclockwise (X1).

SAMPLE INTERVAL INPUT **FORMAT**

TRIGGER SOURCE **INPUTS** Vertical MAG

50 ns TTL (button in) CH 0 - 15 X256 (button in) CH 0 (button out) PROBE (button out) Fully counterclockwise (X1)

- $\sqrt{\ }$ j. CHECK—That each channel can be selected with SELECT control and positioned with POSITION control from above channel 0 to even with channel 15.
- √ E2. CHECK RASTER SHIFT WITH FORMAT
 - a. Press CH 0 3 X1024 button.
- b. Connect 50-ohm cables from X HORIZ OUT, Y VERT OUT, and Z BLANK OUT connectors to corresponding test oscilloscope or monitor inputs.
- b. Move left edge of display to left edge of test oscilloscope or monitor graticule.
- c. Press CH 0 15 X256 button.
- c. Connect 50-ohm termination to pulse generator output.
- $\sqrt{}$ d. CHECK-That display shifts to right 1 division or less.
- d. Connect P6450 probe channel 0 lead to 50-ohm termination on pulse generator.
- e. Set pulse generator for a TTL level (approximately 0 to +3 volts), 1-microsecond duration, 10-millisecond period, pulse output.
- √ E3. CHECK SWEEP LENGTH
 - a. Set Horizontal MAG control fully counterclockwise (X1).

- $\sqrt{}$ f. CHECK-For vertical display of from 6.3 to 7.7
- $\sqrt{}$ b. CHECK—That displayed sweep length is from 9 to 11 divisions.
- $\sqrt{\,}$ g. CHECK-That Vertical MAG control expands display by 5 times within 10% in fully clockwise (X5) position.
- $\sqrt{}$ E4. CHECK HORIZONTAL MAGNIFIER AND POSITION
 - a. Set LA 501 controls as follows:

TRIGGER SAMPLE INTERVAL POST (button in) 10 ns

divisions.

Performance Check and Adjustment-LA 501

a. (Continued)

TRIGGER SOURCE DISPLAY TIME FORMAT CH 0 (button out) ∞ (fully clockwise) CH 0-3 X1024 (button in)

- b. Set pulse generator for a symmetrical 1-megahertz, TTL-level (approximately 0 to ± 3 volts), square-wave output.
- c. Press MANUAL button momentarily to obtain a continuous data display on channel 0.
- d. Set test oscilloscope or monitor horizontal deflection factor for a 1 division displayed pulse width.
- e. Set Horizontal MAG control fully clockwise (X10).
- √ f. CHECK—That displayed pulse width is from 9 to 11 divisions.
 - g. Reset test oscilloscope horizontal deflection factor for 50 millivolts/division.
 - h. Rotate Horizontal POS control fully counterclockwise.
- $\sqrt{}$ i. CHECK—That right edge of magnified display can be positioned to within 2 divisions of graticule center.
 - j. Rotate Horizontal POS control fully clockwise.

√ k. CHECK—That left edge of magnified display can be positioned to within 2 divisions of graticule center.

√ E5. CHECK HORIZONTAL LINEARITY

- a. Set SAMPLE INTERVAL switch to .1 μ s, Horizontal MAG control fully clockwise (X10), and press POST button.
- b. Press and release MANUAL button.
- c. Disconnect 50-ohm cable from Z BLANK OUT connector.
- d. Horizontally position display so that left 10% of display is off screen.
- e. Set test oscilloscope or monitor horizontal deflection factor for an even number of data bits displayed in center 6 graticule divisions.
- f. Horizontally position right end of display so that it fills center 6 graticule divisions.
- $\sqrt{\,}$ g. CHECK—That number of data bits in center 6 graticule divisions is within 10% of the number displayed in part (e).
 - h. Set test oscilloscope or monitor horizontal deflection factor for 50 millivolts/division.

F. DC BALANCE AND DATA INPUTS

Equipment Required

- 1. Pulse generator
- 2. Test oscilloscope
- 3. Precision dc voltmeter
- 4. 10X probes (4)
- 5. BNC T connector

- 6. BNC-to-probe tip adapter
- 7. 50-ohm termination
- 8. 50-ohm cables (4)
- 9. Three-inch screwdriver

BEFORE YOU BEGIN, see

TEST POINT AND ADJUSTMENT LOCATIONS

in the Diagrams section.

√ F1. ADJUST EXTERNAL CLOCK DC BALANCE (R845)

- a. Connect 50-ohm termination and BNC-to-probe tip adapter to pulse generator output.
- b. Set pulse generator for a symmetrical 50-megahertz, minimum ECL level (-1.55 to -0.95 volts), square-wave output.
- c. Connect 10X probe from EXT CLOCK connector to BNC-to-probe tip adapter. (Compensate probe as described in Section 1, Operating Instructions.)
- d. Set SAMPLE INTERVAL switch to EXT and press ECL button.
- e. Set test oscilloscope sweep rate for 5 nanoseconds/division and connect a 10X probe to test oscilloscope vertical input.
- f. CHECK—For waveform at J838 with test oscilloscope probe.

NOTE

If no signal is present at J838, check that internal Clock Polarity selector, P831, is connected to pin 15 of U830.

- g. ADJUST-R845 (Ext Clock DC Bal) for a clean, symmetrical, 50-megahertz ECL display.
- h. Place internal Ext Clock Threshold switch, S848, in front panel (up) position.

- i. Press VAR button and adjust THRESHOLD for same display obtained in part (g).
- Connect precision dc voltmeter to INPUT MONITOR jack and note voltmeter reading.
- k. Position display as shown in Figure 5-1(A). Set test oscilloscope trigger level for stable display.
- I. Set THRESHOLD control for a voltmeter reading 60 millivolts above reading noted in part (i).
- √ m. CHECK—Display for 5 nanoseconds or less of threshold level uncertainty as shown in Figure 5-1(B).
 - n. Set THRESHOLD control for a voltmeter reading 60 millivolts below reading noted in part (i).
- √ o. CHECK—Display for 5 nanoseconds or less of threshold level uncertainty as shown in Figure 5-1(C).
 - p. Reset THRESHOLD control for voltmeter reading noted in part (i).

F2. ADJUST CHANNEL 0 DC BALANCE (R25)

- a. Disconnect 10X probe from EXT CLOCK connector and connect to CH 0 BNC connector.
- b. Press INPUTS button.
- c. Set pulse generator for a symmetrical 33-megahertz, minimum ECL level (-1.55 to -0.95 volts), square-wave output.

d. CHECK—For waveform at J24 with test oscilloscope probe.

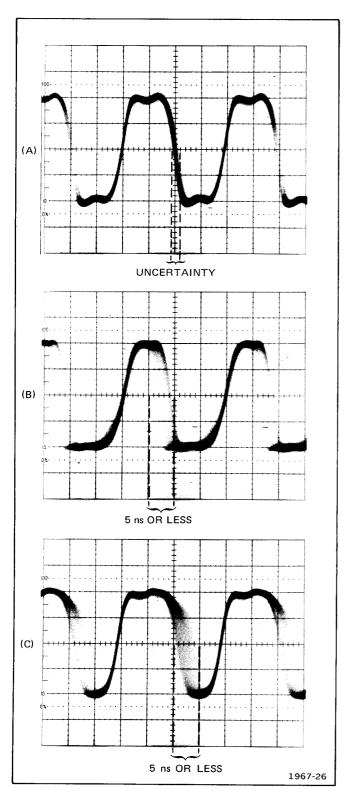


Fig. 5-1. Typical threshold level waveform at J838.

e. ADJUST-R25 (CH 0 DC Bal) for a clean symmetrical 33-megahertz ECL display.

F3. ADJUST CHANNEL 1 DC BALANCE (R45)

- a. Disconnect 10X probe from CH 0 BNC connector and connect to CH 1 BNC connector.
- b. CHECK—For waveform at J44 with test oscilloscope probe.
- c. ADJUST-R45 (CH 1 DC Bal) for a clean, symmetrical, 33-megahertz ECL display.

F4. ADJUST CHANNEL 2 DC BALANCE (R65)

- a. Disconnect 10X probe from CH 1 BNC connector and connect to CH 2 BNC connector.
- b. CHECK—For waveform at J64 with test oscilloscope probe.
- c. ADJUST-R65 (CH 2 DC Bal) for a clean, symmetrical, 33-megahertz ECL display.

F5. ADJUST CHANNEL 3 DC BALANCE (R85)

- a. Disconnect 10X probe from CH 2 BNC connector and connect to CH 3 BNC connector.
- b. CHECK—For waveform at J84 with test oscilloscope probe.
- c. ADJUST—R85 (CH 3 DC Bal) for a clean, symmetrical, 33-megahertz ECL display.

$\sqrt{}$ F6. CHECK HIGH-IMPEDANCE DATA INPUTS

- a. Disconnect 10X probe from CH 3 BNC connector and connect to CH 0 connector.
- b. Set pulse generator for a 15-nanosecond duration, 0.5-microsecond period, minimum ECL level (-1.55 to -0.95 volts), pulse output.
- c. Connect 50-ohm cable from pulse generator trigger output to EXT TRIG connector.
- d. Connect 50-ohm cables from X HORIZ OUT, Y VERT OUT, and Z BLANK OUT connectors to corresponding test oscilloscope or monitor inputs.

- e. Set SAMPLE INTERVAL switch to 10 ns, DISPLAY TIME control fully counterclockwise (1 s), and press CH 0 3 X1024, POST, and SOURCE buttons.
- √ f. CHECK—Channel 0 line for data bits spaced evenly across entire display with no holes.
 - g. Repeat part (e) with 10X probe connected to CH 1, CH 2, and CH 3 BNC connectors respectively.

F7. CHECK LOW-IMPEDANCE DATA INPUTS

- a. Connect P6450 probe to internal Low-Impedance Data Input connector (J100).
- b. Press to release INPUTS button and connect P6450 probe channel 0 lead to 50-ohm termination at pulse generator output. (Make sure P6450 probe ground lead is connected to suitable ground.)
- √ c. CHECK—Channel 0 line for data bits spaced evenly across entire display with no holes.
 - d. Repeat part (c) with P6450 probe channel 1 through 3 leads connected, one at a time, to 50-ohm termination at pulse generator output.
 - e. Set pulse generator for a 25-nanosecond duration, 0.5-microsecond period, pulse output.
 - f. Set SAMPLE INTERVAL switch to 20 ns and press CH 0 7 X512 button.
 - g. Repeat part (c) with P6450 probe channel 4 through 7 leads connected, one at a time, to 50-ohm termination at pulse generator output.
 - h. Set pulse generator for a 55-nanosecond duration, 0.5-microsecond period, pulse output.
 - i. Set SAMPLE INTERVAL switch to 50 ns and press CH 0 15 X256 button.
 - Repeat part (c) with P6450 probe channel 8 through 15 leads connected, one at a time, to 50-ohm termination at pulse generator output.

- $k. \;\; Disconnect \; P6450 \; probe \; lead \; from \; pulse \; generator \; output.$
- 1. Disconnect 50-ohm cable from EXT TRIG connector.

$\sqrt{}$ F8. CHECK LOW-IMPEDANCE DATA INPUT DELAYS

- a. Set pulse generator for a 25-nanosecond duration,0.1-microsecond period, pulse output.
- b. Set SAMPLE INTERVAL switch to EXT.
- c. Connect P6450 probe channel 0 lead to 50-ohm termination at pulse generator output.
- d. Connect a 10X probe from EXT CLOCK connector to 50-ohm termination at pulse generator output.
- e. Connect a 10X probe to test oscilloscope channel 1 vertical input.
- f. Set test oscilloscope vertical for chopped mode and triggering for channel 1, + slope.
- g. Connect a 10X probe with identical delay to probe used in part (e) to test oscilloscope channel 2 vertical input.
- √ h. CHECK—Channel 0 through 7 and channel 8 through 15 delays by connecting proper P6450 probe channel leads, one at a time, to pulse generator output and test oscilloscope channel 1 and 2 probes to test points as outlined in Table 5-2. Test oscilloscope channel 2 displayed waveform should be within 8 nanoseconds before, to 9 nanoseconds after, the test oscilloscope channel 1 displayed waveform with pulse generator output applied to P6450 probe channel 0 through 7. Test oscilloscope channel 2 displayed waveform should be within 7 nanoseconds before, to 15 nanoseconds after, the test oscilloscope channel 1 displayed waveform with pulse generator output applied to P6450 probe channel 8 through 15.
 - i. Disconnect P6450 probe from pulse generator output.

TABLE 5-2 Low-Impedance Data Input Delays

Test Oscilloscope Channel 1 Probe Test Point	Test Oscilloscope Channel 2 Probe Test Point	P6450 Probe Channel Leads Connected to Pulse Generator
	U235, Pin 12	0
	U235, Pin 9	4
U235, Pin 4	U235, Pin 11	8
0200,11111	U235, Pin 6	12
	U335, Pin 12	1
	U335, Pin 9	5
U335, Pin 4	U335, Pin 11	9
·	U335, Pin 6	13
	U435, Pin 12	2
	U435, Pin 9	6
U435, Pin 4	U435, Pin 11	10
	U435, Pin 6	14
	U535, Pin 12	3
	U535, Pin 9	7
U535, Pin 4	U535, Pin 11	11
	U535, Pin 6	15

 $\sqrt{}$ F9. CHECK HIGH-IMPEDANCE DATA INPUT DELAYS

a. Press INPUTS button.

√ b. CHECK—Channel 0 through 3 delays by connecting a 10X probe from front-panel High-Impedance Data Input connectors, one at a time, to pulse generator output, and probes from test oscilloscope channel 1 and 2 to test points as outlined in Table 5-3. Test oscilloscope channel 2 displayed waveform should be within 0 to 14 nanoseconds before the test oscilloscope channel 1 displayed waveform.

TABLE 5-3
High-Impedance Data Input Delays

Test Oscilloscope Channel 1 Probe Test Point	Test Oscilloscope Channel 2 Probe Test Point	High-Impedance Data Input Connected to Pulse Generator Output
U235, Pin 4	U235, Pin 12	CH 0
U335, Pin 4	U335, Pin 12	CH 1
U435, Pin 4	U435, Pin 12	CH 2
U535, Pin 4	U535, Pin 12	CH 3

G. Z-AXIS

Equipment Required

- 1. Test oscilloscope or monitor
- 2. Pulse generator
- 3. Delay generator
- 4. 10X probes (3)

- 5. 50-ohm termination
- 6. 50-ohm BNC cables (5)
- 7. Coaxial cable (BNC on one end)

BEFORE YOU BEGIN, see

TEST POINT AND ADJUSTMENT LOCATIONS

in the Diagrams section.

G1. CHECK RETRACE BLANKING TIME

- a. Connect 50-ohm termination to pulse generator output.
- b. Set pulse generator for a TTL level (approximately 0 to +3 volts), 10-nanosecond duration, 10-millisecond period, pulse output.
- c. Connect 50-ohm cable from 50-ohm termination at pulse generator output to EXT TRIG connector.
- d. Connect 50-ohm cable from Z BLANK OUT connector to test oscilloscope vertical input.
- e. Press CH 0 3 X1024 burron and set SAMPLE INTERVAL switch to 1 μ s.
- f. CHECK—Display for + or 4 to 6 volt pulse (depending on position of internal Blanking Polarity switch, S720) with a duration of 3.5 to 5 microseconds.
- g. Press CH 0 7 X512 button.
- h. CHECK—Display for pulse duration from 1.7 to 2.7 microseconds.
- i. Press CH 0 15 X256 button.
- j. CHECK—Display for pulse duration from 0.9 to 1.5 microseconds.

G2. CHECK BAD-DATA BLANKING

- a. Connect 50-ohm cables from X HORIZ OUT, Y VERT OUT, and Z BLANK OUT connectors to corresponding test oscilloscope or monitor inputs.
- b. Connect 50-ohm termination to pulse generator output.
- c. Connect a 10X probe from CH 0 BNC connector to 50-ohm termination at pulse generator output.
- d. Set DISPLAY TIME control fully counterclockwise (1 s).
- e. Set pulse generator for a symmetrical 1-megahertz, TTL-level (approximately 0 to +3 volts), square-wave output.
- f. Press TTL, CENTER, and CH 0 15 X256 buttons.
- g. Press to release SOURCE button.
- h. CHECK—That bad data on left side of display is blanked.

G3. CHECK Z-AXIS INTENSIFY

a. Set SAMPLE INTERVAL switch to 50 ns.

Performance Check and Adjustment-LA 501

- b. Set pulse generator for a 0.5-microsecond duration, 10-microsecond period, pulse output.
- c. Remove bottom cover from LA 501 to gain access to Data Output connector, J120.
- d. Connect a 10X probe from delay generator start input to pin 14 of J120.
- e. Connect a 10X probe from delay generator events input to pin 1 of J120.
- f. Connect coaxial cable from delay generator delayed trigger output to pin 16 of J120. (Use pin 17 of J120 for ground connection.)
- g. CHECK—Display for 16 channels with pulse generator output appearing on channel 0.
- h. Set delay generator for less than 254 delayed events with + (positive) start and events trigger slope.

- i. Set delay generator start and events trigger levels for a delayed trigger output.
- j. CHECK—For an intensified spot on each displayed channel.
- k. Press CH 0 7 X512 button.
- I. Set delay generator for less than 511 delayed events and repeat part (i) and (j).
- m. Press CH 0 3 X1024 button.
- n. Set delay generator for less than 1023 delayed events and repeat part (i) and (j).

This completes the Performance Check and Adjustment procedure.

REPLACEABLE ELECTRICAL PARTS

PARTS ORDERING INFORMATION

Replacement parts are available from or through your local Tektronix, Inc. Field Office or representative.

Changes to Tektronix instruments are sometimes made to accommodate improved components as they become available, and to give you the benefit of the latest circuit improvements developed in our engineering department. It is therefore important, when ordering parts, to include the following information in your order: Part number, instrument type or number, serial number, and modification number if applicable.

If a part you have ordered has been replaced with a new or improved part, your local Tektronix, Inc. Field Office or representative will contact you concerning any change in part number.

Change information, if any, is located at the rear of this manual.

SPECIAL NOTES AND SYMBOLS

X000 Part first added at this serial number
00X Part removed after this serial number

ITEM NAME

In the Parts List, an Item Name is separated from the description by a colon (:). Because of space limitations, an Item Name may sometimes appear as incomplete. For further Item Name identification, the U.S. Federal Cataloging Handbook H6-1 can be utilized where possible.

ABBREVIATIONS

ACTR	ACTUATOR	PLSTC	PLASTIC
ASSY	ASSEMBLY	QTZ	QUARTZ
CAP	CAPACITOR	RECP	RECEPTACLE
CER	CERAMIC	RES	RESISTOR
CKT	CIRCUIT	RF	RADIO FREQUENCY
COMP	COMPOSITION	SEL	SELECTED
CONN	CONNECTOR	SEMICOND	SEMICONDUCTOR
ELCTLT	ELECTROLYTIC	SENS	SENSITIVE
ELEC	ELECTRICAL	VAR	VARIABLE
INCAND	INCANDESCENT	WW	WIREWOUND
LED	LIGHT EMITTING DIODE	XFMR	TRANSFORMER
NONWIR	NON WIREWOUND	XTAL	CRYSTAL

CROSS INDEX MFR. CODE NUMBER TO MANUFACTURER

MFR.CODE	MANUFACTURER	ADDRESS	CITY,STATE,ZIP		
00853	SANGAMO ELECTRIC CO., S. CAROLINA DIV.	P. O. BOX 128	PICKENS, SC 29671		
01121	ALLEN-BRADLEY CO.	1201 2ND ST. SOUTH	MILWAUKEE, WI 53204		
01295	TEXAS INSTRUMENTS, INC.,				
	SEMICONDUCTOR GROUP	P. O. BOX 5012	DALLAS, TX 75222		
02735	RCA CORP., SOLID STATE DIVISION	ROUTE 202	SOMERVILLE, NY 08876		
04222	AVX CERAMIC CORP.	P.O. BOX 867	MURTLE BEACH, SC 29577		
04239	GENERAL ELECTRIC CO., CHEMICAL AND				
04203	METALLURGICAL VENTURES, OPN MAGNETIC				
	MATERIALS PRODUCT	P. O. BOX 72	EDMORE, MI 48829		
04713	MOTOROLA, INC., SEMICONDUCTOR				
01,25	PRODUCTS DIV.	5005 E. MCDOWELL RD.	PHOENIX, AZ 85036		
07263	FAIRCHILD SEMICONDUCTOR, A DIV. OF				
0,200	FAIRCHILD CAMERA AND INSTRUMENT CORP.	464 ELLIS ST.	MOUNTAIN VIEW, CA 94042		
07910	TELEDYNE SEMICONDUCTOR	12515 CHADRON AVE.	HAWTHORNE, CA 90250		
08806	GENERAL ELECTRIC CO., MINIATURE				
00000	LAMP PRODUCTS DEPT.	NELA PK.	CLEVELAND, OH 44112		
12040	NATIONAL SEMICONDUCTOR CORP.	COMMERCE DRIVE	DANBURY, CT 06810		
12697	CLAROSTAT MFG. CO., INC.	LOWER WASHINGTON ST.	DOVER, NH 03820		
12954	DICKSON ELECTRONICS CORP.	8700 E. THOMAS RD.	SCOTTSDALE, AZ 85252		
12969	UNITRODE CORP.	580 PLEASANT ST.	WATERTOWN, MA 02172		
13715	FAIRCHILD SEMICONDUCTOR, A DIV. OF				
23723	FAIRCHILD CAMERA AND INSTRUMENT CORP.	4300 REDWOOD HWY.	SAN RAFAEL, CA 94903		
14433	ITT SEMICONDUCTORS, A DIV. OF				
11100	INTERNATIONAL TELEPHONE AND TELEGRAPH				
	CORP.	3301 ELECTRONICS WAY	WEST PALM BEACH, FL 33401		
15818	TELEDYNE SEMICONDUCTOR	1300 TERRA BELLA AVE.	MOUNTAIN VIEW, CA 94040		
21845	SOLITRON DEVICES, INC., TRANSISTOR DIV.	1177 BLUE HERON BLVD.	RIVIERA BEACH, FL 33404		
27014	NATIONAL SEMICONDUCTOR CORP.	2900 SAN YSIDRO WAY	SANTA CLARA, CA 95051		
28480	HEWLETT-PACKARD CO., CORPORATE HQ.	1501 PAGE MILL RD.	PALO ALTO, CA 94304		
37138	RIETMAR CHEMICAL INDUSTRIES, LTD.	300 ARRAN AVENUE	ST. LAMBERT, QUEBEC, CANADA		
50157	N. L. INDUSTRIES, INC., ELECTRONICS				
	DEPT.	P. O. BOX 787	MUSKEGON, MI 49443		
56289	SPRAGUE ELECTRIC CO.		NORTH ADAMS, MA 01247		
71400	BUSSMAN MFG., DIVISION OF MCGRAW-				
71400	EDISON CO.	2536 W. UNIVERSITY ST.	ST. LOUIS, MO 63107		
71590	CENTRALAB ELECTRONICS, DIV. OF				
71330	GLOBE-UNION, INC.	5757 N. GREEN BAY AVE.	MILWAUKEE, WI 53201		
72042	CLINTON, E AND CO., INC.	3916 POWELTON AVENUE.	PHILADELPHIA, PA 19104		
72982	ERIE TECHNOLOGICAL PRODUCTS, INC.	644 W. 12TH ST.	ERIE, PA 16512		
73138	BECKMAN INSTRUMENTS, INC., HELIPOT DIV.	2500 HARBOR BLVD.	FULLERTON, CA 92634		
74970	JOHNSON, E. F., CO.	299 10TH AVE. S. W.	WASECA, MN 56093		
75042	TRW ELECTRONIC COMPONENTS, IRC FIXED				
73042	RESISTORS, PHILADELPHIA DIVISION	401 N. BROAD ST.	PHILADELPHIA, PA 19108		
80009	TEKTRONIX, INC.	P. O. BOX 500	BEAVERTON, OR 97077		
80294	BOURNS, INC., INSTRUMENT DIV.	6135 MAGNOLIA AVE.	RIVERSIDE, CA 92506		
81483	INTERNATIONAL RECTIFIER CORP.	9220 SUNSET BLVD.	LOS ANGELES, CA 90069		
83003	VARO, INC.	800 W. GARLAND AVE.	GARLAND, TX 75040		
86684	RCA CORP., ELECTRONIC COMPONENTS	415 S. 5TH ST.	HARRISON, NJ 07029		
91637	DALE ELECTRONICS, INC.	P. O. BOX 609	COLUMBUS, NB 68601		
91929	HONEYWELL, INC., MICRO SWITCH DIV.	CHICAGO & SPRING STS.	FREEPORT, IL 61032		
93410	ESSEX INTERNATIONAL, INC., CONTROLS DIV.				
)J410	MANSFIELD PLANT	P. O. BOX 1007	MANSFIELD, OH 44903		
	1.77.27.27.27				

Ckt No.	Tektronix Part N o.	Serial/Mod Eff	el No. Dscont	Name & Description	Mfr Code	Mfr Part Numbe
Al	670-4054-00	B010100	во10249	CKT BOARD ASSY: PUSH BUTTON SWITCH	80009	670-4054-00
11	670-4054-01	B010250		CKT BOARD ASSY: PUSH BUTTON SWITCH	80009	670-4054-01
.2	670-3867-00	B010100	B010249	CKT BOARD ASSY:MEMORY	80009	670-3867-00
.2	670-3867-01	B010250	2010213	CKT BOARD ASSY: MEMORY	80009	670-3867-01
.3	670-3908-00	B010100	B010249	CKT BOARD ASSY:OUTPUT	80009	670-3908-00
3	670-3908-01	B010100	B010249	CKT BOARD ASSY:OUTPUT	80009	670-3908-01
:7	290-0512-00			CAP.,FXD,ELCTLT:22UF,20%,15V	56289	196D226X0015KA
11	283-0023-00	XB010250		CAP., FXD, CER DI:0.1UF, +80-20%, 10V	91418	MX104Z1201R0
12	283-0164-00			CAP.,FXD,CER DI:2.2UF,20%,25V	72982	8141N037Z5U0225
13	283-0023-00	XB010250		CAP., FXD, CER DI:0.1UF, +80-20%, 10V	91418	MX104Z1201R0
14	283-0023-00			CAP., FXD, CER DI:0.1UF, +80-20%, 10V	91418	MX104Z1201R0
15	283-0023-00			CAP.,FXD,CER DI:0.lUF,+80-20%,10V	91418	MX104Z1201R0
16	283-0167-00			CAP., FXD, CER DI:0.1UF, 10%, 100V	72982	81314147 C 1041
17	281-0783-00			CAP., FXD, CER DI:0.1UF, 20%, 100V	72982	8045-D-Z5U104M
18	283-0167-00			CAP., FXD, CER DI:0.1UF, 10%, 100V	72982	81314147 C 1041
19	281-0783-00			CAP.,FXD,CER DI:0.1UF,20%,100V	7 2982	8045-D-Z5U104M
20	283-0000-00			CAP.,FXD,CER DI:0.001UF,+100-0%,500V	72982	831-516E102P
22	283-0000-00			CAP., FXD, CER DI:0.001UF, +100-0%,500V	72982	831-516E102P
27	283-0023-00			CAP., FXD, CER DI:0.1UF, +80-20%, 10V	91418	
29	283-0023-00			CAP., FXD, CER DI:0.1UF, +80-20%, 10V	91418	MX104Z1201R0
40	283-0000-00			CAP., FXD, CER DI:0.001UF, +100-0%, 500V	72982	831-516E102P
:42	283-0000-00			CAP.,FXD,CER DI:0.001UF,+100-0%,500V	72982	831-516E102P
:60	283-0000-00			CAP., FXD, CER DI:0.001UF, +100-0%,500V		831-516E102P
:62	283-0000-00			CAP.,FXD,CER DI:0.001UF,+100-0%,500V		831-516E102P
67	283-0023-00			CAP., FXD, CER DI:0.luf, +80-20%, 10V	91418	MX104Z1201R0
68	283-0167-00			CAP.,FXD,CER DI:0.1UF,10%,100V	72982	81314147 C 104
:80	283-0000-00			CAP.,FXD,CER DI:0.001UF,+100-0%,500V	72982	831-516E102P
82	283-0000-00			CAP.,FXD,CER DI:0.001UF,+100-0%,500V		831-516E102P
2132	281-0564-00	XB010275		CAP., FXD, CER DI:24PF, 5%, 500V	72982	
2136	283-0051-00			CAP.,FXD,CER DI:0.0033UF,5%,100V	72982	
:137	283-0167-00			CAP.,FXD,CER DI:0.1UF,10%,100V	72982	
211	283-0023-00	XB010250		CAP.,FXD,CER DI:0.lUF,+80-20%,10V	91418	MX104Z1201R0
212	283-0023-00	AD010230		CAP.,FXD,CER DI:0.lUF,+80-20%,10V	91418	
213	283-0023-00			CAP.,FXD,CER DI:0.1UF,+80-20%,10V	91418	MX104Z1201R0
213				CAP., FXD, CER DI:0.10F, +80-20%, 10V	91418	MX104Z1201R0
214	283-0023-00 283-0023-00			CAP.,FXD,CER DI:0.1UF,+80-20%,10V	91418	MX104Z1201R0
216	283-0023-00			CAP.,FXD,CER DI:0.1UF,+80-20%,10V	91418	MX104Z1201R0
216	283-0023-00			CAP.,FXD,CER DI:0.1UF,+80-20%,10V	91418	MX104Z1201R0
:562	283-0023-00	B010100	P010249	CAP., FXD, CER DI:0.1UF, +80-20%, 10V	91418	MX104Z1201R0
:562	283-0023-00	B010100 B010250	DOT0243	CAP., FXD, CER DI: 0.10F, +80-20*, 10V	72982	8141N037Z5U022
563	283-0164-00	BU10230		CAP.,FXD,CER DI:2.20F,20%,25V CAP.,FXD,CER DI:0.1UF,+80-20%,10V	91418	MX104Z1201R0
:564	283-0023-00			CAP.,FXD,CER DI:0.lUF,+80-20%,10V	91418	MX104Z1201R0
2565	283-0023-00			CAP.,FXD,CER DI:0.1UF,+80-20%,10V	91418	MX104Z1201R0
		P010100	B010240	CAP.,FXD,CER DI:0.10F,+80-20%,10V	91418	MX104Z1201R0
566	283-0023-00	B010100	B010249		72982	8141N037Z5U022
566 568	283-0164-00 283-0167-00	в010250		CAP., FXD, CER DI:2.2UF, 20%, 25V CAP., FXD, CER DI:0.1UF, 10%, 100V	72982	81314147 C 1041
:569 :571	283-0167-00 290-0746-00			CAP., FXD, CER DI:0.1UF, 10%, 100V CAP., FXD, ELCTLT:47UF, +50-10%, 16V	72982 0000W	81314147 C 104: 16VBSL47
:572	283-0023-00	B010100	B010249	CAP.,FXD,CER DI:0.1UF,+80-20%,10V	91418	MX104Z1201R0
			D010243	CAP.,FXD,CER DI:0.10F,760-204,10V	72982	8141N037Z5U022
572 573	283-0164-00 283-0023-00	B010250		CAP.,FXD,CER DI:2.20F,20%,25V CAP.,FXD,CER DI:0.1UF,+80-20%,10V	91418	MX104Z1201R0
574	283-0023-00			CAP.,FXD,CER DI:0.lUF,+80-20%,10V	91418	MX104Z1201R0
574 575	283-0023-00			CAP.,FXD,CER DI:0.1UF,+80-20%,10V	91418	MX104Z1201R0
	283-0023-00			CAP.,FXD,CER DI:0.10F,+80-20%,10V	91418	MX104Z1201R0
576				CAP.,FXD,CER DI:0.1UF,+80-20%,10V	91418	MX104Z1201R0
577	283-0023-00			CAP., FXD, CER DI:0.1UF, +80-20%, 10V CAP., FXD, CER DI:0.1UF, +80-20%, 10V	91418	
578	283-0023-00					MX104Z1201R0

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Ckt No.	Tektronix Part No.	Serial/Mod Eff	lel No. Dscont	Name & Description	Mfr Code	Mfr Part Number
C579	283-0023-00	B010100	B010249	CAP.,FXD,CER DI:0.luF,+80-20%,10V	91418	MX104Z1201R0
C579	283-0164-00		B010249	CAP., FXD, CER DI:0.10F, +80-20%, 10V CAP., FXD, CER DI:2.2UF, 20%, 25V	72982	
C602	290-0527-00		B010249X		90201	TDC156M020FL
C606	290-0724-00		B010249	CAP., FXD, ELCTLT: 330UF, 20%, 6V	56289	196D337X0006TE3
C609	283-0023-00			CAP.,FXD,CER DI:0.1UF,+80-20%,10V	91418	MX104Z1201R0
C606	290-0519-00	B010250		CAP.,FXD,ELCTLT:100UF,20%,20V	56289	196D107X0020MA3
C610	283-0000-00			CAP.,FXD,CER DI:0.001UF,+100-0%,500V	72982	
C611	281-0773-00			CAP., FXD, CER DI:0.01UF, 10%, 100V	72982	8005H9AADW5R103K
C 6 25	290-0530-00			CAP.,FXD,ELCTLT:68UF,20%,6V	90201	TDC686M006NLF
C680	283-0167-00			CAP.,FXD,CER DI:0.1UF,10%,100V	72982	81314147 C 104K
C686	283-0000-00			CAP.,FXD,CER DI:0.001UF,+100-0%,500V	72982	831-516E102P
C692	290-0530-00			CAP.,FXD,ELCTLT:68UF,20%,6V	90201	TDC686M006NLF
C702	290-0524-00			CAP.,FXD,ELCTLT:4.7UF,20%,10V	90201	
C704	290-0524-00			CAP.,FXD,ELCTLT:4.7UF,20%,10V	90201	TDC475M010EL
C731	285-0882-00			CAP.,FXD,PLSTC:0.047UF,10%,100V	56289	LP66A1B473K001
C732	285-1134-00			CAP.,FXD,PLSTC:0.lUF,0.5%,100V	50558	ECT 285-1134-00
C733	290-0519-00			CAP., FXD, ELCTLT: 100UF, 20%, 20V	56289	196D107X0020MA3
C736	290-0524-00			CAP.,FXD,ELCTLT:4.7UF,20%,10V	90201	TDC475M010EL
C800	281-0634-00			CAP.,FXD,CER DI:10PF,+/-0.25PF,500V	72982	374-011C0G0100C
C801	281-0773-00			CAP., FXD, CER DI:0.01UF, 10%, 100V	72 9 82	
C825	283-0023-00			CAP., FXD, CER DI:0.1UF, +80-20%, 10V	91418	MX104Z1201R0
C826	283-0023-00			CAP., FXD, CER DI:0.1UF, +80-20%, 10V	91418	MX104Z1201R0
C830	281 - 0783-00			CAP.,FXD,CER DI:0.1UF,20%,100V	72982	8045-D-Z5U104M
C844	283-0000-00			CAP.,FXD,CER DI:0.001UF,+100-0%,500V	72982	
C845	283-0167-00			CAP., FXD, CER DI:0.1UF, 10%, 100V	72982	
C846	283-0000-00			CAP.,FXD,CER DI:0.001UF,+100-0%,500V	72982	
C847	283-0167-00			CAP., FXD, CER DI:0.1UF, 10%, 100V	72982	
C904	290-0714-00			CAP., FXD, ELCTLT: 2000UF, +75-10%, 40V	56289	39D641
C905	285-1120-00			CAP.,FXD,PISTC:20UF,10%,200V	50558	ECT285-1120-00
C911	283-0150-00			CAP., FXD, CER DI:650PF, 5%, 200V	72 9 82	
C912	290-0759-00			CAP., FXD, ELCTLT: 290UF, +75-10%, 15V	90201	TTX291U015C1A3
C925	283-0023-00			CAP., FXD, CER DI:0.1UF, +80-20%, 10V	91418	
C926	281-0773-00			CAP.,FXD,CER DI:0.01UF,10%,100V	72982	
C927	283-0167-00			CAP.,FXD,CER DI:0.1UF,10%,100V	72982	81314147 C 104K
C928	290-0573-00	B010100	B010324	CAP.,FXD,ELCTLT:2.7UF,20%,50V	56289	196D275X0050JA1
C928	283-0212-00	B010325		CAP.,FXD,CER DI:2UF,20%,50V	72 9 82	8141N064Z5U0205M
C929	290-0535-00			CAP.,FXD,ELCTLT:33UF,20%,10V	5628 9	196D336X0010KA1
C932	283-0023-00			CAP.,FXD,CER DI:0.1UF,+80-20%,10V	91418	MX104Z1201R0
C933	290-0759-00			CAP.,FXD,ELCTLT:290UF,+75-10%,15V	90201	TTX291U015C1A3
C934	283-0023-00	в010100	в010249	CAP.,FXD,CER DI:0.1UF,+80-20%,10V	91418	MX104Z1201R0
C934	283-0164-00	B010250		CAP.,FXD,CER DI:2.2UF,20%,25V	72982	8141N037Z5U0225M
C936	281-0783-00	XB010250		CAP.,FXD,CER DI:0.1UF,20%,100V	72982	8045-D-Z5U104M
C942	290-0726-00			CAP.,FXD,ELCTLT:220UF,20%,10V	56289	196D227X0010TE3
C943	290-0519-00			CAP.,FXD,ELCTLT:100UF,20%,20V	5628 9	196D107X0020MA3
C944	283-0023-00			CAP.,FXD,CER DI:0.1UF,+80-20%,10V	91418	MX104Z1201R0
C950	283-0164-00			CAP., FXD, CER DI:2.2UF, 20%, 25V	72982	8141N037Z5U0225M
C951	283-0023-00			CAP., FXD, CER DI:0.1UF, +80-20%, 10V	91418	MX104Z1201R0
C952	283-0023-00			CAP., FXD, CER DI:0.1UF, +80-20%, 10V	91418	MX104Z1201R0
C953	283-0023-00			CAP.,FXD,CER DI:0.1UF,+80-20%,10V	91418	MX104Z1201R0
C954	283-0023-00			CAP.,FXD,CER DI:0.1UF,+80-20%,10V	91418	MX104Z1201R0
C955	283-0023-00			CAP., FXD, CER DI:0.1UF, +80-20%, 10V	91418	
C956	283-0164-00			CAP.,FXD,CER DI:2.2UF,20%,25V	72982	8141n037Z5U0225M
CR20	152-0323-01			SEMICOND DEVICE:SILICON, 35V, 100MA	80009	152-0323-01
CR21	152-0323-01			SEMICOND DEVICE:SILICON, 35V, 100MA	80009	152-0323-01
CR40	152-0323-01			SEMICOND DEVICE:SILICON, 35V, 100MA	80009	152-0323-01
CR41	152-0323-01			SEMICOND DEVICE:SILICON, 35V, 100MA	80009	152-0323-01

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	Tektronix	Serial/Model No.		Mfr	
Ckt No.	Part No.	Eff Dscont	Name & Description	Code	Mfr Part Number
CR60	152-0323-01		SEMICOND DEVICE:SILICON,35V,100MA	80009	152-0323-01
CR61	152-0323-01		SEMICOND DEVICE:SILICON,35V,100MA	80009	
CR68	152-0141-02		SEMICOND DEVICE:SILICON,30V,150MA	07910	
CR80	152-0323-01		SEMICOND DEVICE:SILICON,35V,100MA	80009	
CR81	152-0323-01		SEMICOND DEVICE:SILICON, 35V, 100MA	80009	152-0323-01
			, ,		
CR136	152-0071-00	XB010250	SEMICOND DEVICE:GERMANIUM,15V,40MA	14433	G865
CR137	152-0071-00	XB010250	SEMICOND DEVICE:GERMANIUM,15V40MA	14433	G865
CR212	152-0141-02		SEMICOND DEVICE:SILICON, 30V, 150MA	07910	
CR213	152-0141-02		SEMICOND DEVICE:SILICON,30V,150MA	07910	1N4152
CR214	152-0141-02		SEMICOND DEVICE: SILICON, 30V, 150MA	07910	lN4152
CR215	152-0141-02		SEMICOND DEVICE:SILICON,30V,150MA	07910	1N4152
CR215	152-0141-02		SEMICOND DEVICE:SILICON,30V,150MA	07910	1N4152 1N4152
CR217	152-0141-02		SEMICOND DEVICE:SILICON,30V,150MA	07910	
CR218	152-0141-02		SEMICOND DEVICE:SILICON,30V,150MA	07910	
CR219	152-0141-02		SEMICOND DEVICE:SILICON, 30V, 150MA	07910	1N4152
CR220	152-0141-02		SEMICOND DEVICE:SILICON, 30V, 150MA	07910	1N4152
CR312	152-0141-02		SEMICOND DEVICE:SILICON, 30V, 150MA	07910	1N4152
CR313	152-0141-02		SEMICOND DEVICE:SILICON, 30V, 150MA	07910	1N4152
CR314	152-0141-02		SEMICOND DEVICE:SILICON,30V,150MA	07910	
CR315	152-0141-02		SEMICOND DEVICE:SILICON, 30V, 150MA	07910	1N4152
CR316	152-0141-02		SEMICOND DEVICE:SILICON,30V,150MA	07910	1N4152
CR317	152-0141-02		SEMICOND DEVICE: SILICON, 30V, 150MA	07910	
CR318 CR319	152-0141-02 152-0141-02		SEMICOND DEVICE:SILICON,30V,150MA SEMICOND DEVICE:SILICON,30V,150MA	07910	1N4152 1N4152
CR412	152-0141-02		SEMICOND DEVICE:SILICON,30V,150MA	07910	1N4152 1N4152
CNAIL	132-0141 02		DEVICE DEVICE DE LE CONTROL PER LE C	07510	1117132
CR413	152-0141-02		SEMICOND DEVICE:SILICON, 30V, 150MA	07910	1N4152
CR414	152-0141-02		SEMICOND DEVICE:SILICON, 30V, 150MA	07910	
CR415	152-0141-02		SEMICOND DEVICE:SILICON, 30V, 150MA	07910	1N4152
CR416	152-0141-02		SEMICOND DEVICE:SILICON, 30V, 150MA	07910	1N4152
CR417	152-0141 - 02		SEMICOND DEVICE:SILICON, 30V, 150MA	07910	1N4152
CR418	152-0141-02		SEMICOND DEVICE:SILICON,30V,150MA	07910	1N4152
CR419	152-0141-02		SEMICOND DEVICE:SILICON,30V,150MA	07910	1N4152
CR512	152-0141-02		SEMICOND DEVICE:SILICON, 30V, 150MA	07910 07910	1N4152 1N4152
CR513 CR514	152-0141-02 152-0141-02		SEMICOND DEVICE:SILICON,30V,150MA SEMICOND DEVICE:SILICON,30V,150MA	07910	1N4152 1N4152
CRS14	132-0141-02		SEMICOND DEVICE:SILICON, 30V, 130MA	07310	1114775
CR515	152-0141-02		SEMICOND DEVICE:SILICON, 30V, 150MA	07910	1N4152
CR516	152-0141-02		SEMICOND DEVICE:SILICON, 30V, 150MA	07910	1N4152
CR517	152-0141-02		SEMICOND DEVICE:SILICON, 30V, 150MA	07910	1N4152
CR518	152-0141-02		SEMICOND DEVICE:SILICON, 30V, 150MA	07910	lN4152
CR519	152-0141-02		SEMICOND DEVICE:SILICON, 30V, 150MA	07910	1N4152
			v.		
CR563	152-0071-00		SEMICOND DEVICE: GERMANIUM, 15V, 40MA	14433	
CR564	152-0071-00		SEMICOND DEVICE:GERMANIUM,15V,40MA	14433	
CR566	152-0141-02		SEMICOND DEVICE:SILICON,30V,150MA	07910 07910	1N4152 1N4152
CR567	152-0141-02	DO10100 D010240V	SEMICOND DEVICE:SILICON,30V,150MA	07910	1N4152 1N4152
CR607	152-0141-02	B010100 B010249X	SEMICOND DEVICE:SILICON, 30V, 150MA	07910	±117±76
CR608	152-0141-02		SEMICOND DEVICE:SILICON, 30V, 150MA	07910	1N4152
CR609	152-0141-02		SEMICOND DEVICE:SILICON,30V,150MA	07910	1N4152
CR610	152-0141-02		SEMICOND DEVICE:SILICON,30V,150MA	07910	1N4152
CR611	152-0141-02		SEMICOND DEVICE: SILICON, 30V, 150MA	07910	1N4152
CR615	152-0141-02		SEMICOND DEVICE: SILICON, 30V, 150MA	07910	1N4152
CR620	150-1029-00		LAMP, LED: LIGHT-EMITTING DIODE, 20V		XC2096
CR693	152-0141-02		SEMICOND DEVICE:SILICON,30V,150MA	07910	1N4152
CR694	152-0141-02		SEMICOND DEVICE:SILICON, 30V, 150MA	07910	1N4152

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	Tektronix	Serial/Model No.		Mfr	AAC Don't Niverbook	
Ckt No.	Part No.	Eff Dscont	Name & Description	Code	Mfr Part Number	
CR726	152-0141-02		SEMICOND DEVICE:SILICON, 30V, 150MA	07910	1N4152	
CR727	152-0141-02		SEMICOND DEVICE:SILICON, 30V, 150MA	07910	1N4152	
CR728	152-0141-02		SEMICOND DEVICE: SILICON, 30V, 150MA	07910	1N4152	
CR732	152-0141-02		SEMICOND DEVICE: SILICON, 30V, 150MA	07910	1N4152	
CR734	152-0141-02		SEMICOND DEVICE:SILICON, 30V, 150MA	07910	1N4152	
CR736	152-0141-02		SEMICOND DEVICE: SILICON, 30V, 150MA		1N4152	
CR737	152-0141-02		SEMICOND DEVICE: SILICON, 30V, 150MA		1N4152	
CR843	152-0323-01		SEMICOND DEVICE:SILICON, 35V, 100MA		152-0323-01	
CR844	152-0323-01		SEMICOND DEVICE: SILICON, 35V, 100MA		152-0323-01	
CR904 '	152-0462-00		SEMICOND DEVICE: SILICON, 200V, 2.5A	04713	MDD970-3	
				20000	152 0626 00	
CR905	152-0636-00		SEMICOND DEVICE: RECT, SI, SCHOTTKY, 35V, 5A		152-0636-00	
CR928	152-0141-02	XB010250	SEMICOND DEVICE:SILICON, 30V, 150MA	0/910	1N4152	
				07034	9AS15	
D\$565	150-0093-01		LAMP, INCAND: 5V, 0.06A, 0.05 MSCP, SEL	87034	9AS15 8AS15	
DS708	150-0093-01		LAMP, INCAND: 5V, 0.06A, 0.05 MSCP, SEL	87034	OMSIS	
			0 15 105% F10W	75075	279-100	
F510	159-0056-00		FUSE, CARTRIDGE: 0.1A,125V, FAST-BLOW	75915 75915		
F520	159-0116-00		FUSE, CARTRIDGE: 1A, 125V, 0.4 SEC 0.17 LEADS		AGC2-1/2	
F905	159-0126-00		FUSE, CARTRIDGE: 3AG, 2.5A, 250V, 0.65 SEC	71400	AGC2-1/2	
			CONTRACTOR DODG DVG DEWALE	24021	28JR200-1	
J22	131-0955-00		CONNECTOR, RCPT, :BNC, FEMALE		131-1003-00	
J24	131-1003-00		CONNECTOR BODY,:CKT BD MT,3 PRONG		28JR200-1	
J42	131-0955-00		CONNECTOR, RCPT, :BNC, FEMALE	80009		
J44	131-1003-00		CONNECTOR BODY,:CKT BD MT,3 PRONG		28JR200-1	
J62	131-0955-00		CONNECTOR, RCPT, :BNC, FEMALE	24701	ZOURZOO Z	
TC 4	121 1002 00		CONNECTOR BODY,:CKT BD MT,3 PRONG	80009	131-1003-00	
J64	131-1003-00		CONNECTOR, RCPT, :BNC, FEMALE		28JR200-1	
J82	131-0955-00		CONNECTOR BODY,:CKT BD MT,3 PRONG		131-1003-00	
J84	131-1003-00		CONNECTOR BODI, SCRI BD MI, 3 TRONG	71468		
J100	131-0569-00		CONN, RCPT, ELEC: 25 PIN FEMALE		DB25S	
J 1 20	131-0569-00		CONN, RCF1, EDEC: 25 FIR FERRIE	, 2 . 0 0		
J138	131-1003-00		CONNECTOR BODY,: CKT BD MT, 3 PRONG	80009	131-1003-00	
J214	131-1003-00		CONNECTOR BODY,:CKT BD MT,3 PRONG	80009	131-1003-00	
J314	131-1003-00		CONNECTOR BODY, : CKT BD MT, 3 PRONG	80009	131-1003-00	
J414	131-1003-00		CONNECTOR BODY, : CKT BD MT, 3 PRONG	80009	131-1003-00	
J514	131-1003-00		CONNECTOR BODY,:CKT BD MT,3 PRONG	80009	131-1003-00	
0314	131-1003-00					
J 609	131-0955-00		CONNECTOR, RCPT, : BNC, FEMALE	24931	28JR200-1	
J698	131-1003-00		CONNECTOR BODY, : CKT BD MT, 3 PRONG	80009	131-1003-00	
J699	131-0955-00		CONNECTOR, RCPT, : BNC, FEMALE	24931	28JR200-1	
J730	131-1003-00		CONNECTOR BODY, : CKT BD MT, 3 PRONG	80009	131-1003-00	
J731	131-0955-00		CONNECTOR, RCPT, : BNC, FEMALE	24931	28JR200-1	
5,51	202 0000					
J738	131-1003-00		CONNECTOR, BODY, : CKT BD MT, 3 PRONG		131-1003-00	
J739	131-0955-00		CONNECTOR, RCPT, : BNC, FEMALE	24931	28JR200-1	
J829	131-0955-00		CONNECTOR, RCPT, : BNC, FEMALE		28JR200-1	
J830	131-1003-00		CONNECTOR BODY,: CKT BD MT, 3 PRONG	80009	131-1003-00	
J838	131-1003-00		CONNECTOR BODY, : CKT BD MT, 3 PRONG	80009	131-1003-00	
J846	131-0258-00		CONNECTOR, RCPT, : JACK ASSEMBLY	80009	131-0258-00	
L800	108-0182-00		COIL, RF: 0.3UH	80009		
L841	108-0550-00		COIL, RF: 110NH, 10%	80009	108-0550-00	
L905	108-0337-00		COIL, RF: 25UH	80009	108-0337-00	
L932	108-0556-00		COIL, RF: 12UH, 20%	80009	108-0556-00	
			TRANSFERMOR STATES OF THE	01295	2N3906	
Q16	151-0188-00		TRANSISTOR:SILICON, PNP	80009		
Q18	151-0190-00		TRANSISTOR: SILICON, NPN	80009		
Q22A,B	151-1090-02		TRANSISTOR: FE, DUAL, N-CHANNEL, SI		151-1090-02	
Q42A,B	151-1090-02		TRANSISTOR: FE, DUAL, N-CHANNEL, SI	50009	-J1-1070-02	
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	Tektronix	Serial/M	odel No.		Mfr	
Ckt No.	Part No.	Eff	Dscont	Name & Description	Code	Mfr Part Number
Q62A,B	151-1090-02			TRANSISTOR: FE, DUAL, N-CHANNEL, SI	80009	151-1090-02
Q82A,B	151-1090-02			TRANSISTOR: FE, DUAL, N-CHANNEL, SI	80009	151-1090-02
Q136	151-0220-00	XB010250		TRANSISTOR: SILICON, PNP	80009	151-0220-00
Q602	151-0188-00			TRANSISTOR:SILICON, PNP	01295	2N3906
Q604	151-0190-00			TRANSISTOR: SILICON, NPN	80009	151-0190-00
Q606	151-0504-00	B010100	B010324	TRANSISTOR: SILICON, N-CHAN, UNIJUNCTION	04713	2N4851
0606	151-0504-01	B010325	2010324	TRANSISTOR:SILICON, N-CHAN, UNIJUNCTION, CHKD	80009	151-0504-01
Q620	151-0190-00	2010323		TRANSISTOR: SILICON, NPN	80009	151-0190-00
2628	151-0190-00			TRANSISTOR: SILICON, NPN	80009	151-0190-00
Q629	151-0188-00			TRANSISTOR: SILICON, PNP	01295	2N3906
Q640	151-0190-00			TRANSISTOR: SILICON, NPN	80009	151-0190-00
2010	202 0230 00					
2642	151-0190-00			TRANSISTOR: SILICON, NPN	80009	151-0190-00
2644	151-0190-00			TRANSISTOR: SILICON, NPN	80009	151-0190-00
2650	151-0190-00			TRANSISTOR: SILICON, NPN	80009	151-0190-00
2652	151-0190-00			TRANSISTOR: SILICON, NPN	80009	151-0190-00
2654	151-0190-00			TRANSISTOR: SILICON, NPN	80009	151-0190-00
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2660	151-0190-00			TRANSISTOR: SILICON, NPN	80009	151-0190-00
662	151-0190-00			TRANSISTOR: SILICON, NPN	80009	151-0190-00
2664	151-0190-00			TRANSISTOR: SILICON, NPN	80009	151-0190-00
2670	151-0190-00			TRANSISTOR: SILICON, NPN	80009	151-0190-00
2672	151-0190-00			TRANSISTOR: SILICON, NPN	80009	151-0190-00
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Q674	151-0190-00			TRANSISTOR: SILICON, NPN	80009	151-0190-00
2680	151-0190-00			TRANSISTOR: SILICON, NPN	80009	151-0190-00
2682	151-0190-00			TRANSISTOR: SILICON, NPN	80009	151-0190-00
2684	151-0190-00			TRANSISTOR: SILICON, NPN	80009	151-0190-00
2694	151-0190-00			TRANSISTOR: SILICON, NPN	80009	151-0190-00
					01.005	011000
Q698	151-0188-00			TRANSISTOR: SILICON, PNP	01295	2N3906
Q702	151-0190-00			TRANSISTOR: SILICON, NPN	80009	151-0190-00
Q7 0 4	151-0190-00			TRANSISTOR: SILICON, NPN	80009	151-0190-00
Q708	151-0190-00			TRANSISTOR: SILICON, NPN	80009	151-0190-00
Q 71 2	151-0190-00			TRANSISTOR: SILICON, NPN	80009	151-0190-00
	151 0100 00			MDANGTOMOD - CTI TOON NDN	80009	151-0190-00
Q714	151-0190-00			TRANSISTOR: SILICON, NPN	80009	151-0190-00
Q716	151-0190-00			TRANSISTOR: SILICON, NPN	80009	151-0190-00
Q718	151-0190-00			TRANSISTOR: SILICON, NPN	01295	2N3906
Q720	151-0188-00			TRANSISTOR: SILICON, PNP	01295	2N3906
Q722	151-0188-00			TRANSISTOR: SILICON, PNP	01293	2NJ 900
Q724	151-0190-00			TRANSISTOR: SILICON, NPN	80009	151-0190-00
Q724 Q728	151-0190-00			TRANSISTOR:SILICON,NPN	80009	151-0190-00
	151-0198-00			TRANSISTOR:SILICON, PNP	01295	2N3906
Q732				TRANSISTOR:SILICON,PNP	01295	2N3906
Q733 Q734	151-0188-00 151-0190-00			TRANSISTOR:SILICON,NPN		151-0190-00
2/34	131-0190-00			11441020201110222001111111		
Q736	151-0188-00			TRANSISTOR: SILICON, PNP	01295	2N3906
Q738	151-0188-00			TRANSISTOR:SILICON, PNP	01295	2N3906
Q740	151-0190-00			TRANSISTOR: SILICON, NPN	80009	151-0190-00
0846A,B	151-1090-02			TRANSISTOR: FE, DUAL, N-CHANNEL, SI	80009	151-1090-02
Q905	151-0603-00			TRANSISTOR:SILICON,NPN	02735	2N5039
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Q9 1 0	151-0183-00			TRANSISTOR: SILICON, NPN	12040	
Õ914	151-0188-00			TRANSISTOR: SILICON, PNP	01295	2N3906
Q916	151-0188-00			TRANSISTOR: SILICON, PNP	01295	2N3906
Q922	151-0190-00			TRANSISTOR: SILICON, NPN	80009	151-0190-00
Q928	151-0190-00			TRANSISTOR: SILICON, NPN	80009	151-0190-00
-						
Q932	151-0506-00			TRANSISTOR:SILICON, CONTROLLED RECTIFIER	03508	C106B2
Q934	151-0188-00			TRANSISTOR: SILICON, PNP	01295 01295	2N3906 2N3906
Z224				TRANSISTOR: SILICON, PNP		

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	Tektronix	Serial/Model No.		Mfr	
Ckt No.	Part No.	Eff Dscont	Name & Description	Code	Mfr Part Number
Q944	151-0190-00		TRANSISTOR: SILICON, NPN	80009	151-0190-00
8244	131-0130 00				
Rl	321-0145-00		RES.,FXD,FILM:316 OHM,1%,0.125W	75042	CEATO-3160F
R2	321-0127-00		RES.,FXD,FILM:205 OHM,1%,0.125W	75042	CEATO-2050F
R3	321-0134-00		RES.,FXD,FILM:243 OHM,1%,0.125W	75042	CEATO-2430F
R4	321-0119-00		RES.,FXD,FILM:169 OHM,1%,0.125W	75042	CEATO-1690F
R5	321-0062-01		RES.,FXD,FILM:43.2 OHM,0.5%,0.125W	91637	MFF1816G43R20D
			,		
R6	321-0800-02		RES., FXD, FILM: 184.6 OHM, 0.5%, 0.125W	75042	CEAT2-184R6D
R7	321-0131-00		RES.,FXD,FILM:226 OHM,1%,0.125W	75042	CEAT0-2260F
R8	321-1166-01		RES.,FXD,FILM:530 OHM,0.5%,0.125W	75042	CEATO-5300D
R9	321-0782-03		RES.,FXD,FILM:40 OHM,0.25%,0.125W	75042	CEAT2-40R0C
R10	311-1311-00		RES., VAR, NONWIR: 1K OHM, 20%, 1W	01121	10M155A
Rll	315-0911-00		RES., FXD, CMPSN:910 OHM, 5%, 0.25W		CB9115
R12	315-0471-00		RES.,FXD,CMPSN:470 OHM,5%,0.25W		CB4715
R14	321-1170-03		RES., FXD, FILM: 583 OHM, 0.25%, 0.125W	91637	
R15	321-1216-03		RES.,FXD,FILM:1.76K OHM,0.25%,0.125W	91637	
R16	321-1645-03		RES.,FXD,FILM:841 OHM,0.25%,0.125W	91637	MFF18160841R0C
R17	321-0195-02		RES.,FXD,FILM:1.05K OHM,0.5%,0.125W		CEAT2-105ID
R18	321-0770-03		RES.,FXD,FILM:4.204K OHM,0.25%,0.125W		CEAT2-42040C
R19	321-1645-03		RES.,FXD,FILM:841 OHM,0.25%,0.125W	91637	MFF18160841R0C
R20	315-0104-00		RES.,FXD,CMPSN:100K OHM,5%,0.25W		CB1045
R21	321-0481-00		RES.,FXD,FILM:1M OHM,1%,0.125W	75042	CEATO-1004F
R22	321-0030-00		RES.,FXD,FILM:20 OHM,1%,0.125W		CEATO-20ROF
R23	315-0100-00		RES.,FXD,CMPSN:10 OHM,5%,0.25W		CB1005
R24	315-0470-00		RES.,FXD,CMPSN:47 OHM,5%,0.25W	01121	CB4705
R25	311-1501-00		RES., VAR, NONWIR: 20 OHM, 10%, 0.50W	73138	72X-37-0-200
R26	315-0102-00		RES.,FXD,CMPSN:1K OHM,5%,0.25W	01121	CB1025
					4015
R27	315-0431-00		RES.,FXD,CMPSN:430 OHM,5%,0.25W		CB4315
R28	315-0102-00		RES.,FXD,CMPSN:1K OHM,5%,0.25W		CB1025
R29	315-0431-00		RES.,FXD,CMPSN:430 OHM,5%,0.25W		CB4315
R40	315-0104-00		RES., FXD, CMPSN:100K OHM, 5%, 0.25W		CB1045
R41	321-0481-00		RES.,FXD,FILM:1M OHM,1%,0.125W	75042	CEAT0-1004F
				75040	CERTO CODOE
R42	321-0030-00		RES.,FXD,FILM:20 OHM,1%,0.125W		CEATO-20ROF
R43	315-0100-00		RES.,FXD,CMPSN:10 OHM,5%,0.25W		CB1005
R44	315-0470-00		RES., FXD, CMPSN: 47 OHM, 5%, 0.25W		CB4705
R45	311-1501-00		RES., VAR, NONWIR: 20 OHM, 10%, 0.50W	73138	72X-37-0-200
R60	315-0104-00		RES.,FXD,CMPSN:100K OHM,5%,0.25W	01121	CB1045
			14 OFF	75042	CEATO-1004F
R61	321-0481-00		RES.,FXD,FILM:1M OHM,1%,0.125W		CEATO-20ROF
R62	321-0030-00		RES.,FXD,FILM:20 OHM,1%,0.125W		
R63	315-0100-00		RES., FXD, CMPSN:10 OHM, 5%, 0.25W	01121	
R64	315-0470-00		RES.,FXD,CMPSN:47 OHM,5%,0.25W		CB4705
R65	311-1501-00		RES., VAR, NONWIR: 20 OHM, 10%, 0.50W	73138	72X-37-0-200
			and the distance of the control of t	01121	CB2725
R68	315-0272-00		RES.,FXD,CMPSN:2.7K OHM,5%,0.25W	01121	CB1045
R80	315-0104-00		RES.,FXD,CMPSN:100K OHM,5%,0.25W	75042	
R81	321-0481-00		RES.,FXD,FILM:1M OHM,1%,0.125W	75042	
R82	321-0030-00		RES.,FXD,FILM:20 OHM,1%,0.125W		
R83	315-0100-00		RES.,FXD,CMPSN:10 OHM,5%,0.25W	01121	CB1005
204	215 0452 55		RES.,FXD,CMPSN:47 OHM,5%,0.25W	01121	CB4705
R84	315-0470-00		RES.,FXD,CMPSN:47 OHM,5%,0.25W RES.,VAR,NONWIR:20 OHM,10%,0.50W	73138	72x-37-0-200
R85	311-1501-00	VP010250	RES., FXD, CMPSN: 470 OHM, 5%, 0.125W	01121	
R100	317-0471-00	XB010250	RES.,FXD,CMPSN:470 OHM,5%,0.125W	01121	
R101	317-0471-00	XB010250 B010404X	RES., FXD, CMPSN:470 OHM, 5%, 0.125W	01121	BB4715
R102	317-0471-00	XB010250	TEBLIERD COMEDITATIO CHELICATION		
R110	315-0510-00	B010100 B010404	RES.,FXD,CMPSN:51 OHM,5%,0.25W	01121	CB5105
VTT0	313-0310-00				
R110	315-0820-00	B010405	RES.,FXD,CMPSN:82 OHM,5%,0.25W	01121	CB8205

Ckt No.	Tektronix Part No.	Serial/Mod Eff	del No. Dscont	Name & Description	Mfr Code	Mfr Part Numb
2111	315-0510-00	XB010250	B010404	RES.,FXD,CMPSN:51 OHM,5%,0.25W	01101	
R111	315-0750-00		2010404	RES.,FXD,CMPSN:75 OHM,5%,0.25W		CB5105
R112	315-0510-00			PEC PYD CMPCN.El OWN Es O DEW		CB7505
R120	315-0680-00			RES.,FXD,CMPSN:51 OHM,5%,0.25W		CB5105
R136	315-0510-00			RES.,FXD,CMPSN:68 OHM,5%,0.25W		CB6805
X136	313-0510-00	XB010250		RES.,FXD,CMPSN:51 OHM,5%,0.25W	01121	CB5105
R137	315-0750-00	XB010250		RES.,FXD,CMPSN:75 OHM,5%,0.25W	01121	CB7505
R150	315-0511-00			RES.,FXD,CMPSN:510 OHM,5%,0.25W	01121	
R213	321-0318-00			RES.,FXD,FILM:20K OHM,1%,0.125W	91637	MFF1816G20001F
R214	321-0318-00			RES.,FXD,FILM:20K OHM,1%,0.125W	91637	MFF1816G20001F
R217	321-0318-00			RES.,FXD,FILM:20K OHM,1%,0.125W	91637	MFF1816G20001F
R218	321-0318-00			DEC. EVD ETTM. 20% OVM 10 0 105**		
220	315-0272-00			RES.,FXD,FILM:20K OHM,1%,0.125W	91637	MFF1816G20001F
R270	315-0750-00	XB010250		RES.,FXD,CMPSN:2.7K OHM,5%,0.25W	01121	
R313	321-0318-00	AB010230		RES.,FXD,CMPSN:75 OHM,5%,0.25W	01121	
R314				RES.,FXD,FILM:20K OHM,1%,0.125W	91637	MFF1816G20001F
1314	321-0318-00			RES.,FXD,FILM:20K OHM,1%,0.125W	91637	MFF1816G20001F
R317	321-0318-00			RES.,FXD,FILM:20K OHM,1%,0.125W	91637	MFF1816G20001F
318	321-0318-00			RES.,FXD,FILM:20K OHM,1%,0.125W	91637	MFF1816G20001F
R 4 13	321-0318-00			RES.,FXD,FILM:20K OHM,1%,0.125W	91637	
414	321-0318-00			RES., FXD, FILM: 20K OHM, 1%, 0.125W		MFF1816G20001F
417	321-0318-00			RES., FXD, FILM: 20K OHM, 1%, 0.125W	91637	MFF1816G20001F
	1320 00				91637	MFF1816G20001F
418	321-0318-00			RES.,FXD,FILM:20K OHM,1%,0.125W	91637	MFF1816G20001F
435	315-0680-00			RES.,FXD,CMPSN:68 OHM,5%,0.25W	01121	
2513	321-0318-00			RES.,FXD,FILM:20K OHM,1%,0.125W	91637	MFF1816G20001F
R514	321-0318-00			RES.,FXD,FILM:20K OHM,1%,0.125W	91637	MFF1816G20001F
R517	321-0318-00			RES.,FXD,FILM:20K OHM,1%,0.125W	91637	MFF1816G20001F
518	321-0318-00			DEG. EVE ETT V SON OUT 10 0 1050		
545	315-0101-00	XB010250		RES.,FXD,FILM:20K OHM,1%,0.125W	91637	MFF1816G20001F
1565		AB010230		RES.,FXD,CMPSN:100 OHM,5%,0.25W		CB1015
	311-1815-00			RES., VAR, NONWIR:50K OHM, 20%, 0.50W		13M813
1567	315-0272-00			RES.,FXD,CMPSN:2.7K OHM,5%,0.25W	01121	CB2725
2571	301-0202-00			RES.,FXD,CMPSN:2K OHM,5%,0.50W	01121	EB2025
1601	315-0821-00			RES.,FXD,CMPSN:820 OHM,5%,0.25W	01121	CB8215
1602	315-0182-00			RES.,FXD,CMPSN:1.8K OHM,5%,0.25W	01121	CB1825
603	315-0103-00			RES.,FXD,CMPSN:10K OHM,5%,0.25W		CB1025
604	315-0103-00			RES., FXD, CMPSN:10K OHM, 5%, 0.25W	01121	
.605 ¹	311-1827-00			RES., VAR, NONWIR: 100K OHM, 20%, 1W	01121	13M874
606	315-0331-00			RES., FXD, CMPSN: 330 OHM, 5%, 0.25W	01121	
607	315 0100 00					
607 608	315-0102-00 315-0272-00			RES., FXD, CMPSN:1K OHM, 5%, 0.25W		CB1025
609		B010100	DO10040-	RES.,FXD,CMPSN:2.7K OHM,5%,0.25W	01121	
	315-0753-00	B010100	B010249X	,,	01121	
610	315-0102-00			RES.,FXD,CMPSN:1K OHM,5%,0.25W		CB1025
611	315-0301-00			RES.,FXD,CMPSN:300 OHM,5%,0.25W		CB3015
612	315-0751-00			RES.,FXD,CMPSN:750 OHM,5%,0.25W	01121	CB7515
613	315-0330-00	XB010250		RES.,FXD,CMPSN:33 OHM,5%,0.25W	01121	CB3305
	315-0101-00	XB010250		RES.,FXD,CMPSN:100 OHM,5%,0.25W		
	315-0272-00	,,		RES., FXD, CMPSN: 100 CHM, 5%, 0.25W	01121	
	315-0511-00			RES.,FXD,CMPSN:510 OHM,5%,0.25W	01121	
	315-0102-00			• • •	01121	
	315-0101-00			RES.,FXD,CMPSN:1K OHM,5%,0.25W RES.,FXD,CMPSN:100 OHM,5%,0.25W	01121	
~	0101-00			ALS., FAD, CMFSN: IOU OHM, 5%, U. 25W	01121	CR1012
	315-0511-00			RES.,FXD,CMPSN:510 OHM,5%,0.25W	01121	CB5115
627	321-0269-00	B010100	B010249	RES.,FXD,FILM:6.19K OHM,1%,0.125W		MFF1816G61900F
627	315-0512-00	B010250		RES., FXD, CMPSN:5.1K OHM, 5%, 0.25W		CB5125
628	321-0097-00	-		RES.,FXD,FILM:100 OHM,1%,0.125W		MFF1816G100R0F
	315-0822-00			RES.,FXD,CMPSN:8.2K OHM,5%,0.25W		CB8225
	315-0242-00			RES.,FXD,CMPSN:2.4K OHM,5%,0.25W	01121	
:32	315-0101-00					
	315-0101-00 321-0343-00			RES.,FXD,CMPSN:100 OHM,5%,0.25W RES.,FXD,FILM:36.5K OHM,1%,0.125W		CB1015 MFF1816G36501F

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	T 1	Cantal/Akadal Nie		Mfr	
a	Tektronix	Serial/Model No		Code	Mfr Part Number
Ckt No.	Part No.	Eff Dscor	nt Name & Description		
R642	315-0102-00		RES., FXD, CMPSN:1K OHM, 5%, 0.25W	01121	
R650	321-0314-00		RES., FXD, FILM: 18.2K OHM, 1%, 0.125W	75042	
R652	315-0102-00		RES.,FXD,CMPSN:1K OHM,5%,0.25W	01121	
R660	321-0276-00		RES., FXD, FILM: 7.32K OHM, 1%, 0.125W		CEATO-7321F
R662	315-0102-00		RES.,FXD,CMPSN:1K OHM,5%,0.25W	01121	CB1025
	207 2047 20		RES.,FXD,FILM:3.65K OHM,1%,0.125W	75042	CEATO-3651F
R670	321-0247-00		RES.,FXD,FILM:3.65A OHM,14,0.125W		CB1025
R672 R680	315-0102-00 315-0182-00		RES.,FXD,CMPSN:1.8K OHM,5%,0.25W		CB1825
R681	315-0182-00		RES.,FXD,CMPSN:270 OHM,5%,0.25W		CB2715
R682	315-0751-00		RES.,FXD,CMPSN:750 OHM,5%,0.25W		CB7515
1.002	020 0.02 00		,,,,,		
R683	315-0182-00		RES.,FXD,CMPSN:1.8K OHM,5%,0.25W	01121	CB1825
R684	315-0102-00		RES.,FXD,CMPSN:1K OHM,5%,0.25W	01121	CB1025
R685	315-0471-00		RES.,FXD,CMPSN:470 OHM,5%,0.25W		CB4715
R686	315-0510-00		RES.,FXD,CMPSN:51 OHM,5%,0.25W		CB5105
R688	315-0432-00		RES.,FXD,CMPSN:4.3K OHM,5%,0.25W		CB4325
R689 _	315-0102-00	XB010250	RES., FXD, CMPSN: 1K OHM, 5%, 0.25W		CB1025
R690 ¹	311-1831-00		RES., VAR, NONWIR: DUAL, 2.5K X 1K OHM, 10%, 0.5W	12697	
R691	315-0221-00	B010100 B01012			CB2215
R691	315-0241-00	B010125	RES.,FXD,CMPSN:240 OHM,5%,0.25W		CB2415
R692	315-0101-00		RES., FXD, CMPSN:100 OHM, 5%, 0.25W		CB1015
R693	315-0431-00	B010100 B01012	4 RES.,FXD,CMPSN:430 OHM,5%,0.25W	01121	CB4315
		-010105	DEG THE CURRY 220 OTH ES O 25M	01121	CB3315
R693	315-0331-00	B010125	RES.,FXD,CMPSN:330 OHM,5%,0.25W		CB2215
R694 R694	315-0221-00	B010100 B01012 B010125	4 RES.,FXD,CMPSN:220 OHM,5%,0.25W RES.,FXD,CMPSN:430 OHM,5%,0.25W		CB4315
R694 R695 2	315-0431-00 311-1831-00	B010125	RES., VAR, NONWIR: DUAL, 2.5K X 1K OHM, 10%, 0.5W	12697	
R696	321-0104-00		RES.,FXD,FILM:118 OHM,1%,0.125W	75042	
ROSO	321-0104 00		MD:// MD// LD:// COM// CO// COM// CO// COM// CO// COM// CO// CO		
R697	315-0621-00		RES.,FXD,CMPSN:620 OHM,5%,0.25W	01121	CB6215
R698	321-0097-00		RES., FXD, FILM:100 OHM, 1%, 0.125W	75042	CEATO-1000F
R702	315-0102-00		RES., FXD, CMPSN:1K OHM, 5%, 0.25W	01121	CB1025
R703	315-0563-00		RES.,FXD,CMPSN:56K OHM,5%,0.25W	01121	CB5635
R704	315-0102-00		RES.,FXD,CMPSN:1K OHM,5%,0.25W	01121	CB1025
R705	315-0563-00		RES.,FXD,CMPSN:56K OHM,5%,0.25W		CB5635
R706	315-0183-00		RES.,FXD,CMPSN:18K OHM,5%,0.25W		CB1835
R708	315-0302-00		RES.,FXD,CMPSN:3K OHM,5%,0.25W		CB3025 CB1025
R710	315-0102-00		RES.,FXD,CMPSN:1K OHM,5%,0.25W		CB4325
R711	315-0432-00		RES.,FXD,CMPSN:4.3K OHM,5%,0.25W	01121	CD4323
D710	215 0102 00		RES.,FXD,CMPSN:1K OHM,5%,0.25W	01121	CB1025
R712 R713	315-0102-00 315-0432-00		RES.,FXD,CMPSN:4.3K OHM,5%,0.25W		CB4325
R713	321-0281-00		RES.,FXD,FILM:8.25K OHM,1%,0.125W	75042	
R715	321-0281-00		RES.,FXD,FILM:16.5K OHM,1%,0.125W	75042	CEATO-1652C
R716	315-0102-00		RES., FXD, CMPSN:1K OHM, 5%, 0.25W	01121	CB1025
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R717	321-0281-00		RES.,FXD,FILM:8.25K OHM,1%,0.125W		CEAT0-8251F
R720	315-0152-00		RES.,FXD,CMPSN:1.5K OHM,5%,0.25W		CB1525
R721	315-0392-00		RES.,FXD,CMPSN:3.9K OHM,5%,0.25W	01121	
R722	315-0222-00		RES.,FXD,CMPSN:2.2K OHM,5%,0.25W		CB2225
R723	315-0102-00		RES.,FXD,CMPSN:1K OHM,5%,0.25W	01121	CB1025
				01101	OD 2025
R727	315-0302-00		RES.,FXD,CMPSN:3K OHM,5%,0.25W		CB3025 CB1025
R729	315-0102-00		RES.,FXD,CMPSN:1K OHM,5%,0.25W	01121	
R730	315-0101-00		RES.,FXD,CMPSN:100 OHM,5%,0.25W RES.,FXD,CMPSN:51 OHM,5%,0.25W	01121	
R731	315-0510-00		RES.,FXD,CMPSN:31 OHM,5%,0.25W		CB1015
R732	315-0101-00		Ido. II no jour on 1200 of or 2011		
R733	315-0471-00		RES.,FXD,CMPSN:470 OHM,5%,0.25W	01121	CB4715
R734	321-0126-00		RES.,FXD,FILM:200 OHM,1%,0.125W	75042	CEATO-2000F
R735	315-0101-00		RES., FXD, CMPSN:100 OHM, 5%, 0.25W	01121	CB1015
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 $^{^{\}mbox{\scriptsize 1}}_{\mbox{\scriptsize Furnished}}$ as a unit with R695 $^{\mbox{\scriptsize 2}}_{\mbox{\scriptsize Furnished}}$ as a unit with R690

	Tektronix	Serial/M	Mfr			
Ckt No.	Part No.	Eff	Dscont	Name & Description	Code	Mfr Part Number
CKI 140.	ran No.	<u>CTT</u>	DSCOIII	Name & Description	Code	MIT Part Number
R736	321-0158-00			RES.,FXD,CMPSN:432 OHM,1%,0.125W	75042	CEAT0-4320F
R737	321-0126-00			RES.,FXD,FILM:200 OHM,1%,0.125W		CEATO-2000F
R738	321-0139-00			RES.,FXD,FILM:274 OHM,1%,0.125W	75042	
R7401	311-1831-00			RES., VAR, NONWIR: DUAL, 2.5K X 1K OHM, 10%, 0.5W	12697	388CM40965
R741	321-0173-00			RES., FXD, FILM:619 OHM, 1%, 0.125W	75042	CEATO-6190F
11741	321-01/3 00			105.,FAD,FILM:019 OHM,18,0.125#	73042	CEA10-0190F
R742	315-0151-00			RES.,FXD,CMPSN:150 OHM,5%,0.25W	01121	CB1515
R743	315-0823-00			RES.,FXD,CMPSN:82K OHM,5%,0.25W	01121	CB8235
R744	321-0072-00			RES., FXD, FILM: 54.9 OHM, 1%, 0.125W	75042	
R745 ²	311-1831-00			RES., VAR, NONWIR: DUAL, 2.5K X 1K OHM, 10%, 0.5W	12697	388CM40965
R800	315-0512-00			RES., FXD, CMPSN:5.1K OHM, 5%, 0.25W	01121	
1000	313-0312-00			RES.,FAD,CHPSN:5.1R OHM,5%,0.25W	01121	CB3123
R829	321-0068-00			RES., FXD, FILM: 49.9 OHM, 1%, 0.125W	75042	CEATO-49R90F
R830	321-0219-00			RES., FXD, FILM: 1.87K OHM, 1%, 0.125W		CEATO-1871F
R833	315-0101-00	B010100	BU10246A	RES., FXD, CMPSN:100 OHM, 5%, 0.25W		CB1015
R841	315-0470-00	DOLOLOO	DOLOZIJA	RES.,FXD,CMPSN:47 OHM,5%,0.25W		CB4705
R842				· · · · · · · · · · · · · · · · · · ·		
K042	315-0100-00			RES.,FXD,CMPSN:10 OHM,5%,0.25W	01121	CB1005
R843	321-0481-00			RES.,FXD,FILM:1M OHM,1%,0.125W	75042	CEAT0-1004F
R844	315-0104-00			RES., FXD, CMPSN:100K OHM, 5%, 0.25W	01121	
R845	311-1007-00			RES., VAR, NONWIR: 20 OHM, 20%, 0.50W	80294	
R846	321-0030-00			RES.,FXD,FILM:20 OHM,1%,0.125W		CEAT0-20R0F
R847						CB1005
K04/	315-0100-00			RES.,FXD,CMPSN:10 OHM,5%,0.25W	01121	CB1002
R905	315-0181-00			RES.,FXD,CMPSN:180 OHM,5%,0.25W	01121	CB1815
R910	315-0681-00			RES., FXD, CMPSN:680 OHM, 5%, 0.25W		CB6815
R911	307-0111-00			RES.,FXD,CMPSN:3.6 OHM,5%,0.25W		CB36G5
R912	315-0431-00			RES.,FXD,CMPSN:430 OHM,5%,0.25W		CB4315
R914	321-0143-00			RES.,FXD,FILM:301 OHM,1%,0.125W		CEATO-3010F
V2T-4	321-0143-00			RES., FAD, FILM: SUI ORM, 18, U. 125W	73042	CERIO-3010F
R916	315-0121-00			RES., FXD, CMPSN:120 OHM, 5%, 0.25W	01121	CB1215
R920	315-0243-00			RES., FXD, CMPSN:24K OHM, 5%, 0.25W		CB2435
R921	315-0751-00			RES., FXD, CMPSN: 750 OHM, 5%, 0.25W		CB7515
R922	315-0301-00			RES., FXD, CMPSN: 300 OHM, 5%, 0.25W		CB3015
R923	321-0132-00			RES.,FXD,FILM:232 OHM,1%,0.125W	75042	
1023	321 0132 00			MOO. JI RD JI ILM. 232 OHR JE 0 JO. 1254	, 5042	CIMIO 23201
R925	311-1244-00			RES., VAR, NONWIR:100 OHM, 10%, 0.50W	80294	3386X-T07-101
R926	321-0189-00			RES.,FXD,FILM:909 OHM,1%,0.125W	75042	CEAT0-9090F
R927	315-0102-00			RES., FXD, CMPSN:1K OHM, 5%, 0.25W		CB1025
R928	315-0823-00			RES., FXD, CMPSN:82K OHM, 5%, 0.25W		CB8235
R929	315-0112-00			RES., FXD, CMPSN:1.1K OHM, 5%, 0.25W		CB1125
R932	315-0271-00			RES.,FXD,CMPSN:270 OHM,5%,0.25W	01121	CB2715
R934	315-0430-00			RES.,FXD,CMPSN:43 OHM,5%,0.25W	01121	CB4305
R936	315-0471-00			RES.,FXD,CMPSN:470 OHM,5%,0.25W	01121	CB4705
R942	315-0391-00			RES., FXD, CMPSN:390 OHM, 5%, 0.25W		CB3915
R943	301-0202-00			RES., FXD, CMPSN: 2K OHM, 5%, 0.50W		EB2025
				. , , , ,		
R944	315-0241-00			RES.,FXD,CMPSN:240 OHM,5%,0.25W	01121	CB2415
S1 0	263-0013-03			ACTR ASSY, PB:3 LATCHING, 10MM, 3 CONTACTS	80009	263-0013-03
S1 5	263-0011-01			ACTR ASSY, PB:1 PUSH, 10MM, W/2 CONTACTS	80009	263-0011-01
S110	263-0013-01			ACTR ASSY, PB:3 LATCHING, 10MM, 3 CONTACTS	80009	263-0013-01
S565	263-1132-00			ACTR ASSY, CAM S:SELECTOR	80009	263-1132-00
s605 ³	311-1827-00			RES., VAR, NONWIR: 100K OHM, 20%, 1W DPST/SW	80009	311-1827-00
					00000	262 2011 21
S608	263-0011-01			ACTR ASSY, PB:3 LATCHING, 10MM, 3 CONTACTS	80009	263-0011-01
S610	263-0011-03			ACTR ASSY, PB:1 PUSH, 10MM, 1 CONTACT	80009	263-0011-03
S625	263-0013-02			ACTR ASSY, PB:3 LATCHING, 10MM, 4 CONTACT	80009	
S720	260-0723-00			SWITCH, SLIDE: DPDT, 0.5A, 125VAC	79727	GF126-0028
S825	263-1133-00			ACTR ASSY, CAM S:TIME BASE	80009	263-1133-00
6025	260 2004 22			CWIMOU CLIDE, DD2DOGW A EX 105WA DC	70707	C_1290D0 /7140
\$ 835	260-0984-00			SWITCH, SLIDE: DP3POSN, 0.5A, 125VAC-DC	79727	G-128SPC/7140

Furnished as a unit with R745 Furnished as a unit with R740

³Furnished as a unit with R605

	Tektronix	Serial/Model No		Mfr	
Ckt No.		Eff Dscon		Code	Mfr Part Number
5848	260-0723-00		SWITCH, SLIDE: DPDT, 0.5A, 125VAC	79727	GF126-0028
5040	260-0723-00		SWITCH, SHIDE: DIDIJO: SKIZZSVAC		3123 3383
т911	120-1034-00		TRANSFORMER, RF: POT CORE	80009	120-1034-00
			WARRACTE OF A CONTRACT AND THE CEL	80009	156-0067-05
U14	156-0067-05		MICROCIRCUIT, LI: OPERATIONAL AMPLIFIER, SEL	80009	
U15	156-0067-00		MICROCIRCUIT, LI: OPERATIONAL AMPLIFIER		
U48	156-0705-00		MICROCIRCUIT,DI:DUAL A/D COMPARATOR	04713	
U68	156-0705-00		MICROCIRCUIT, DI: DUAL A/D COMPARATOR	04713	
U110	156-0757-00		MICROCIRCUIT, DI: DUAL 3-IN, 3-OUT OR NOR GATE	04713	
Ulll	307-0488-00		RES NTWK, THK FI:100 OHM, 20%, 0.75W	32997	
U120	156-0638-00		MICROCIRCUIT, DI: FOUR-BIT UNIV SHIFT RGTR	04713	
U121	307-0489-00		RES NTWK, THK FI:100 OHM, 20%, 1.0W	32997	4408R0011010
U130	156-0638-00		MICROCIRCUIT, DI: FOUR-BIT UNIV SHIFT RGTR	04713	MC10140L
U132	156-0205-00		MICROCIRCUIT, DI: QUAD 2-INPUT NOR GATE	04713	MC10102L
U136	156-0295-00	B010100 B010249	MICROCIRCUIT, DI: MECL 10K OHM, TRIPLE 2-INPUT	04713	MC10107L
U136	156-0687-00	B010250	MICROCIRCUIT, DI:QUAD EXCLUSIVE OR COMPARATOR	04713	MC10113
U140	156-0641-00		MICROCIRCUIT, DI: UNIVERSAL HEXIDECIMAL CNTR	04713	MC10136L
U141	307-0501-00		RES NTWK, THK FI: (5) 50 OHM, 5%, 0.125W	91637	CSP06E01500J
U150	156-0641-00		MICROCIRCUIT, DI: UNIVERSAL HEXIDECIMAL CNTR	04713	MC10136L
U151	307-0493-00		RES NTWK, THK FI: (7) 50 OHM, 5%, 0.125W	32997	4408R001500
			MICROCIRCUIT DI:DUAL A/D COMPARATOR	04713	
U214	156-0333-00		MICROCIRCUIT DI:DUAL A/D COMPARATOR	04713	
U218	156-0333-00		MICROCIRCUIT DI:DUAD 2 INPUT MUX/LATCH	04713	
U225	156-0632-00			32997	4408R0011010
U231	307-0489-00		RES NTWK, THK FI:100 OHM, 20%, 1.0W	32331	440010022020
U235	156-0638-00		MICROCIRCUIT, DI: FOUR-BIT UNIV SHIFT RGTR	04713	MC10140L
U241	307-0489-00		RES NTWK, THK FI:100 OHM, 20%, 1.0W	32997	4405R0011010
U245			MICROCIRCUIT, DI:FOUR-BIT UNIV SHIFT RGTR	04713	MC10140L
	156-0638-00		RES NTWK, THK FI:100 OHM, 20%, 0.75W	32997	
U251	307-0488-00		MICROCIRCUIT DI:256 BIT RAM	80009	
U252	156-0657-00			80009	
U254	156-0657-00		MICROCIRCUIT DI:256 BIT RAM	80009	
U256	156-0657-00		MICROCIRCUIT DI:256 BIT RAM	80009	156-0657-00
U258	156-0657-00		MICROCIRCUIT DI:256 BIT RAM	04713	
บ260	156-0458-00		MICROCIRCUIT, DI:ECL 10K QUAD AND GATE		
U261	307-0489-00		RES NTWK, THK FI:100 OHM, 20%, 1.0W	32997	440000011010
บ270	156-0650-00		MICROCIRCUIT, DI:8 LINE MULTIPLEXER	04713	MC10164L
U314	156-0333-00		MICROCIRCUIT DI:DUAL A/D COMPARATOR	04713	MC1650L
U318	156-0333-00		MICROCIRCUIT DI:DUAL A/D COMPARATOR	04713	MC1650L
			MICROCIRCUIT, DI:FOUR-BIT UNIV SHIFT RGTR	04713	
U335	156-0638-00		RES NTWK, THK FI:100 OHM, 20%, 1.0W	32997	
U341	307-0489-00		MICROCIRCUIT, DI:FOUR-BIT UNIV SHIFT RGTR	04713	
U345	156-0638-00			32997	
U351	307-0488-00		RES NTWK, THK FI:100 OHM, 20%, 0.75W	80009	
U352	156-0657-00		MICROCIRCUIT DI:256 BIT RAM	80009	
U354	156-0657-00		MICROCIRCUIT DI:256 BIT RAM		156-0657-00
U 35 6	156-0657-00		MICROCIRCUIT DI:256 BIT RAM	80009	130-0037 00
บ358	156-0657-00		MICROCIRCUIT DI:256 BIT RAM	80009	156-0657-00
	307-0489-00		RES NTWK,THK FI:100 OHM,20%,1.0W	32997	
U361			MICROCIRCUIT DI:DUAL A/D COMPARATOR	04713	
U414	156-0333-00		MICROCIRCUIT DI:DUAL A/D COMPARATOR	04713	
U418	156-0333-00		MICROCIRCUIT,DI:QUAD 2 INPUT MUX/LATCH	04713	
U425	156-0632-00		RES NTWK,THK FI:100 OHM,20%,1.0W	32997	
U431	307-0489-00		RES NIWK, THE FI HOUR DIM NUTU CHIEF DOWN	04713	
U435	156-0638-00		MICROCIRCUIT, DI:FOUR-BIT UNIV SHIFT RGTR	32997	
U441	307-0488-00		RES NTWK, THK FI:100 OHM, 20%, 0.75W	04713	
U445	156-0638-00		MICROCIRCUIT, DI:FOUR-BIT UNIV SHIFT RGTR	32997	
U451	307-0487-00		RES NTWK, THK FI:100 OHM, 20%, 0.5W	34331	200711002202
U452	156-0657-00		MICROCIRCUIT DI:256 BIT RAM	80009	
U454	156-0657-00		MICROCIRCUIT DI:256 BIT RAM	80009	156-0657-00
U456	156-0657-00		MICROCIRCUIT DI:256 BIT RAM	80009	156-0657-00
U458	156-0657-00		MICROCIRCUIT DI:256 BIT RAM	80009	156-0657-00
U460	156-0458-00		MICROCIRCUIT, DI: ECL 10K QUAD AND GATE	04713	MC10104L
0.100	0.50 00		· -		

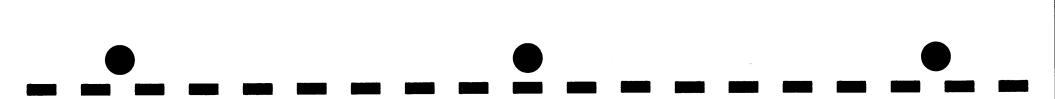
	Tektronix	Serial/Mode	l No.		Mfr	
Ckt No.	Part No.	Eff C	Scont	Name & Description	Code	Mfr Part Number
U461	307-0489-00			RES NTWK,THK FI:100 OHM,20%,1.0W	32997	4408R0011010
U514	156-0333-00			MICROCIRCUIT DI:DUAL A/D COMPARATOR	04713	MC1650L
U518	156-0333-00			MICROCIRCUIT DI:DUAL A/D COMPARATOR	04713	MC1650L
U531	307-0489-00			RES NTWK, THK FI:100 OHM, 20%, 1.0W	32997	4408R0011010
ช535	156-0638-00			MICROCIRCUIT, DI: FOUR-BIT UNIV SHIFT RGTR	04713	MC10140L
U541	307-0489-00			RES NTWK, THK FI:100 OHM, 20%, 1.0W	32997	4408R0011010
U 54 5	156-0638-00			MICROCIRCUIT, DI: FOUR-BIT UNIV SHIFT RGTR		MC10140L
บ551	307-0489-00			RES NTWK, THK FI:100 OHM, 20%, 1.0W	32997	
U552	156-0657-00			MICROCIRCUIT DI:256 BIT RAM		156-0657-00
U554	156-0657-00			MICROCIRCUIT DI:256 BIT RAM	80009	156-0657-00
U556	156-0657-00			MICROCIRCUIT DI:256 BIT RAM	80009	156-0657-00
บ558	156-0657-00			MICROCIRCUIT DI:256 BIT RAM	80009	156-0657-00
U560	156-0458-00			MICROCIRCUIT, DI: ECL 10K QUAD AND GATE	04713	MC10104L
U561	307-0488-00			RES NTWK, THK FI:100 OHM, 20%, 0.75W	32997	
บ565	156-0687-00			MICROCIRCUIT DI:QUAD EXCLUSIVE-OR COMPARATOR		MC10113
บ570	156-0640-00			MICROCIRCUIT, DI:8 LINE MULTIPLEXER		MC10164L
U601	307-0489-00			RES NTWK, THK FI:100 OHM, 20%, 1.0W		4408R0011010
U 60 8	156-0205-00			MICROCIRCUIT, DI: QUAD 2-INPUT NOR GATE		MC10102L
U610	156-0295-00	B010100 B0	10249	MICROCIRCUIT, DI: MECL 10K OHM, TRIPLE 2-INPUT		MC10107L
U 61 0	156-0687-00	B010250		MICROCIRCUIT, DI: QUAD EXCLUSIVE OR COMPARATOR	04713	MC10113
U611	307-0489-00			RES NTWK,THK FI:100 OHM,20%,1.0W	32997	4408R0011010
U615	156-0230-00			MICROCIRCUIT, DI: DUAL D MA-SLAVE FLIP-FLOP	04713	MC10131L
U616	156-0230-00			MICROCIRCUIT, DI: DUAL D MA-SLAVE FLIP-FLOP	04713	MC10131L
U621	307-0487-00			RES NTWK, THK FI:100 OHM, 20%, 0.5W	32997	
U622	156-0641-00			MICROCIRCUIT, DI: UNIVERSAL HEXIDECIMAL CNTR		MC10136L
U624	156-0641-00			MICROCIRCUIT, DI: UNIVERSAL HEXIDECIMAL CNTR		MC10136L
U628	156-0688-00			MICROCIRCUIT, DI: DUAL J-K MASTER-SLAVE FF		MC10135L
U630	156-0641-00			MICROCIRCUIT, DI: UNIVERSAL HEXIDECIMAL CNTR		MC10136L
U631	307-0488-00			RES NTWK, THK FI:100 OHM, 20%, 0.75W	32997	4406R001101
U632	156-0205-00			MICROCIRCUIT, DI:QUAD 2-INPUT NOR GATE	04713	MC10102L
U800	156-0205-00			MICROCIRCUIT, DI: QUAD 2-INPUT NOR GATE	04713	MC10102L
U801	307-0493-00			RES NTWK, THK FI: (7)50 OHM, 5%, 0.125W	32997	4408R001500
U810	156-0642-00			MICROCIRCUIT, DI:BI-QUINARY CNTR		MC10138L
U811	307-0489-00			RES NTWK, THK FI:100 OHM, 20%, 1.0W		4408R0011010
U812	156-0642-00			MICROCIRCUIT, DI:BI-QUINARY CNTR		MC10138L
U814	156-0642-00			MICROCIRCUIT, DI:BI-QUINARY CNTR		MC10138L
U816	156-0642-00			MICROCIRCUIT, DI:BI-QUINARY CNTR		MC10138L
U818	156-0642-00			MICROCIRCUIT, DI:BI-QUINARY CNTR		MC10138L
U820	156-0640-00			MICROCIRCUIT, DI:8 LINE MULTIPLEXER		MC10164L
U821	307-0488-00			RES NTWK,THK FI:100 OHM,20%,0.75W	32997	4406R001101
U824	156-0637-00			MICROCIRCUIT, DI: DUAL 4 TO 1 MULTIPLEXER	04713	
U828	156-0642-00			MICROCIRCUIT, DI:BI-QUINARY CNTR	04713	
U830	156-0705-00			MICROCIRCUIT, DI: DUAL A/D COMPARATOR	04713	SC62438L
U831	307-0492-00			RES NTWK, THK FI: (3)50 OHM, 5%, 0.125	32997	
U838	156-0637-00			MICROCIRCUIT, DI: DUAL 4 TO 1 MULTIPLEXER	04713	MC10174P
U942	156-0158-00			MICROCIRCUIT, LI: DUAL OPERATIONAL AMPLIFIER	80009	156-0158-00
VR571	152-0243-00			SEMICOND DEVICE: ZENER, 0.4W, 15V, 5%	81483	
VR688	152-0243-00			SEMICOND DEVICE: ZENER, 0.4W, 15V, 5%	81483	1N965B
VR716	152-0195-00			SEMICOND DEVICE: ZENER, 0.4W, 5.1V, 5%	80009	152-0195-00
VR903	152-0309-00	XB010275		SEMICOND DEVICE: ZENER, 1W, 6.2V, 5%	04713 04713	1N3828A 1N821
VR920	152-0461-00		10159	SEMICOND DEVICE: ZENER, 0.4W, 6.2V, 5%	80009	153-0060-00
VR920 VR922	153-0060-00 152-0514-00	в010160		SEMICOND DEVICE:ZENER,6.2V,2%,7.5MA,SEL SEMICOND DEVICE:ZENER,0.4W,10V	99942	R4763
					01402	69-6512
VR926	152-0195-00			SEMICOND DEVICE: ZENER, 0.4W, 5.1V, 5%	81483 04713	
VR932	152-0175-00			SEMICOND DEVICE: ZENER, 0.4W, 5.6V, 5%	04/13 81483	
VR942	152-0195-00			SEMICOND DEVICE:ZENER, 0.4W, 5.1V, 5% SEMICOND DEVICE:ZENER, 0.4W, 15V, 5%	81483	1N965B
VR943	152-0243-00			XTAL UNIT,QTZ:100HMZ,+/-0.0025%,SERIES	13571	TEK158-0106-00
Y800	158-0106-00			Will Outliken toomen' , orogan alaminen		

	
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INSTRUMENT OPTIONS

No options were available for this instrument at the time of this printing.

Information on any subsequent options may be found in the CHANGE INFORMATION section in the back of this manual.



DIAGRAMS AND CIRCUIT BOARD ILLUSTRATIONS

Symbols and Reference Designators

Electrical components shown on the diagrams are in the following units unless noted otherwise:

Capacitors = Values one or greater are in picofarads (pF).

Values less than one are in microfarads (μ F).

Resistors = Ohms (Ω) .

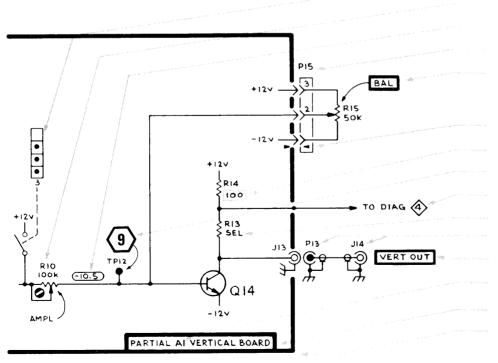
Symbols used on the diagrams are based on ANSI Standard Y32.2-1970.

Logic symbology is based on ANSI Y32.14-1973 in terms of positive logic. Logic symbols depict the logic function performed and may differ from the manufacturer's data.

The following prefix letters are used as reference designators to identify components or assemblies on the diagrams.

Α	Assembly, separable or repairable	н	Heat dissipating device (heat sink,	RT	Thermistor
	(circuit board, etc.)		heat radiator, etc.)	S	Switch
AT	Attenuator, fixed or variable	HR	Heater	Т	Transformer
В	Motor	HY	Hybrid circuit	TC	Thermocouple
вт	Battery	J	Connector, stationary portion	TP	Test point
С	Capacitor, fixed or variable	K	Relay	U	Assembly, inseparable or non-repairable
СВ	Circuit breaker	L	Inductor, fixed or variable		(integrated circuit, etc.)
CR	Diode, signal or rectifier	LR	Inductor/resistor combination	V	Electron tube
DL	Delay line	M	Meter	VR	Voltage regulator (zener diode, etc.)
DS	Indicating device (lamp)	P	Connector, movable portion	Υ	Crystal
E	Spark Gap	Q	Transistor or silicon-controlled	Z	Phase shifter
F	Fuse		rectifier		
FL	Filter	R	Resistor, fixed or variable		

The following special symbols are used on the diagrams:



VERTICAL AMPLIFIER

Cam Switch Closure Chart

Internal Screwdriver Adjustment

Test Voltage

Plug to E.C. Board

Panel Adjustment

Plug Index

Modified Component-See Parts List

Refer to Waveform

Refer to Diagram Number

SEL Value Selected at Factory

Coaxial Connector

Panel Connector

Assembly Number

Board Name

Etched Circuit Board Outlined in Black

Schematic Name and Number

DIAGRAMS SEMICONDUCTORS BOARD LOCATOR

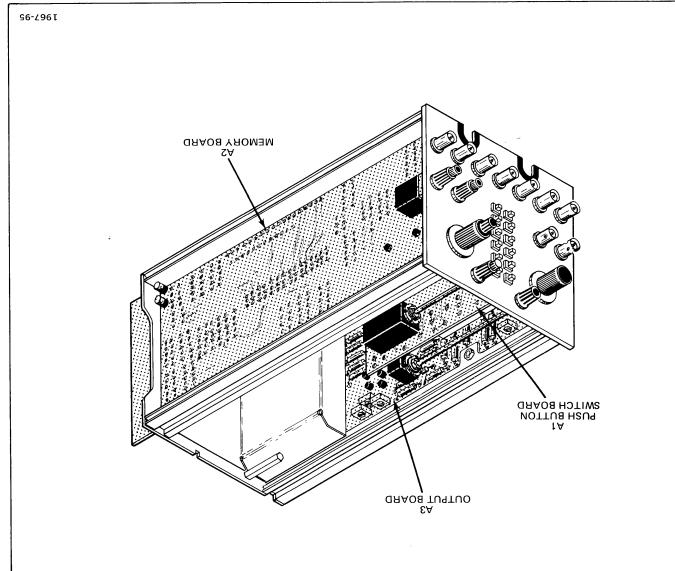


Fig. 8-2. Circuit board locations.

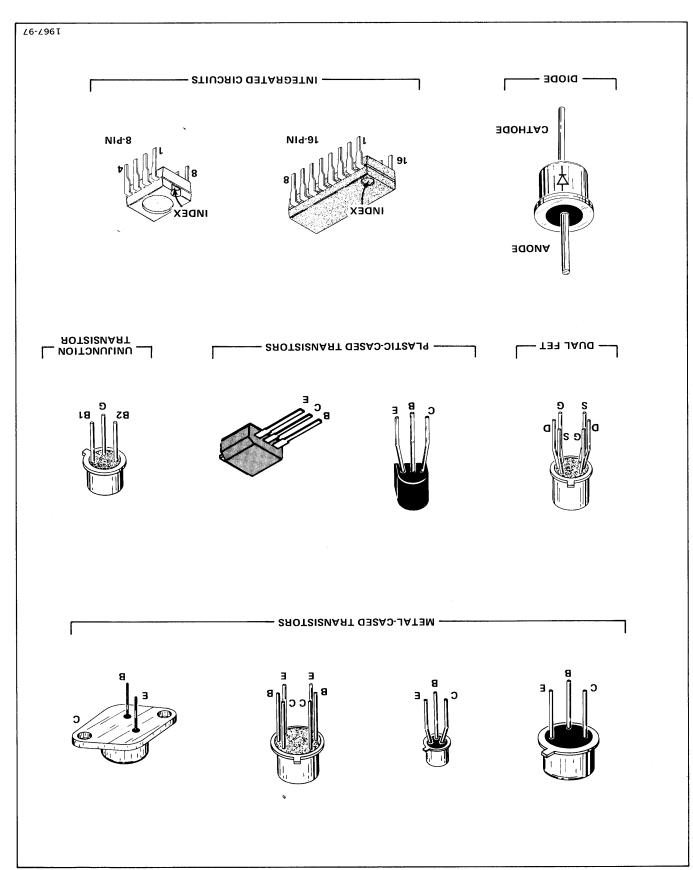
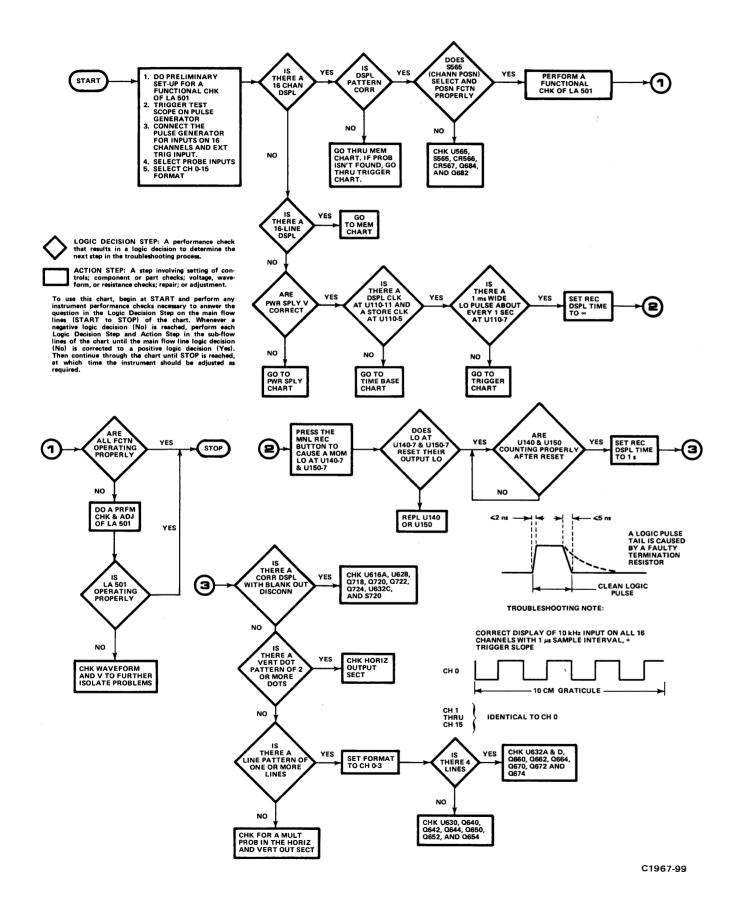


Fig. 8-1. Semiconductor lead configuration.



CHK U942, Q944, VR942, VR943, VR57 AND SERIES XSTR IN PWR MDL • YES YES **-(1**) REPL F510 NO YES 1. TURN PWR OFF
2. UNPLUG EXT CABLE
FROM LA 501.
3. UNPLUG J30 Q905, L905 T911 AND L932 OK NO REPLACE FAULTY IS THERE A SHORT IN THE FRONT IS RES FROM TP933 TO GNI ABOUT 40 CORRECT OHMS NO NO (SHORTED) IS SHORT PRESEN IS SHORT PRESENT YES CHK OUT BOARD -4.8 V DC BUS YES WITH P80 UNPLUGGED NO CHK SW BD FOR SHORT ON -4.8 V DC BUS CHK MEM BD FOR SHOR ON -4.8 V DC CHK Q916, Q932, Q910, Q905, Q914 C905 1. REMOVE F908 2. TURN PWR ON 1. TURN PWR OFF 2. REPL F905 C1967-22

IS V ABOUT -4.8 V DC IS V AT P5-2 ABOUT-2 V

CHK Q934, Q936, U800 AND SERIES XSTR IN PWI YES

IS V AT P4-3 ABOU

> IS F520 BLN

YES

REPL F520

END OF PWR SPLY CHART

YES

ADJ R925

. CONN LA 501 TO TM 500-SERIES PWR MDL WITH EXT CABLE

TURN POWER ON

START

IS THERE V AT

NO

Fig. 8-3. Main troubleshooting chart for LA 501.

Fig. 8-4. Troubleshooting chart for Power Supplies.

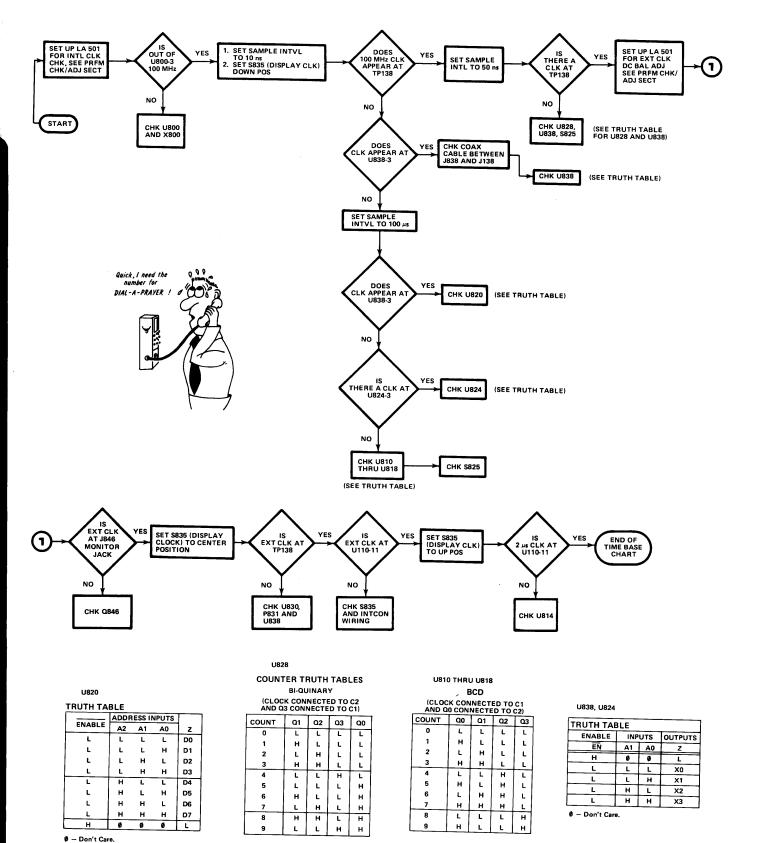
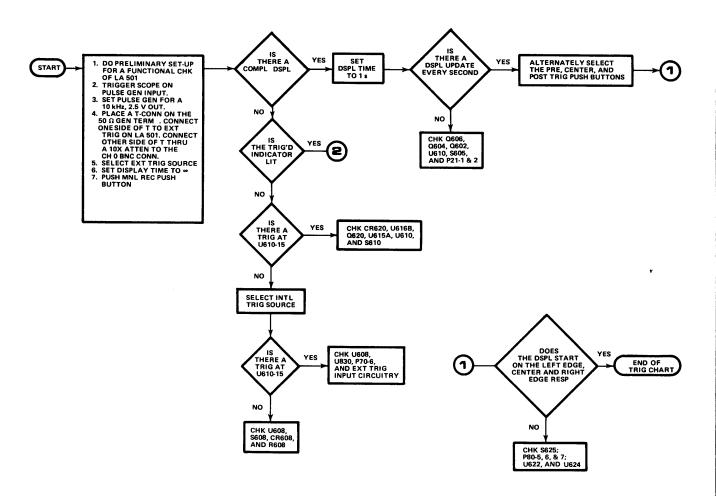
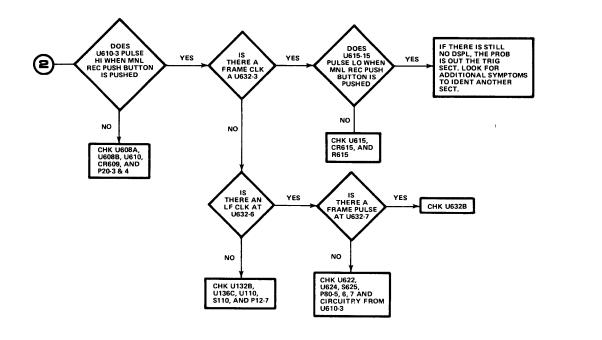


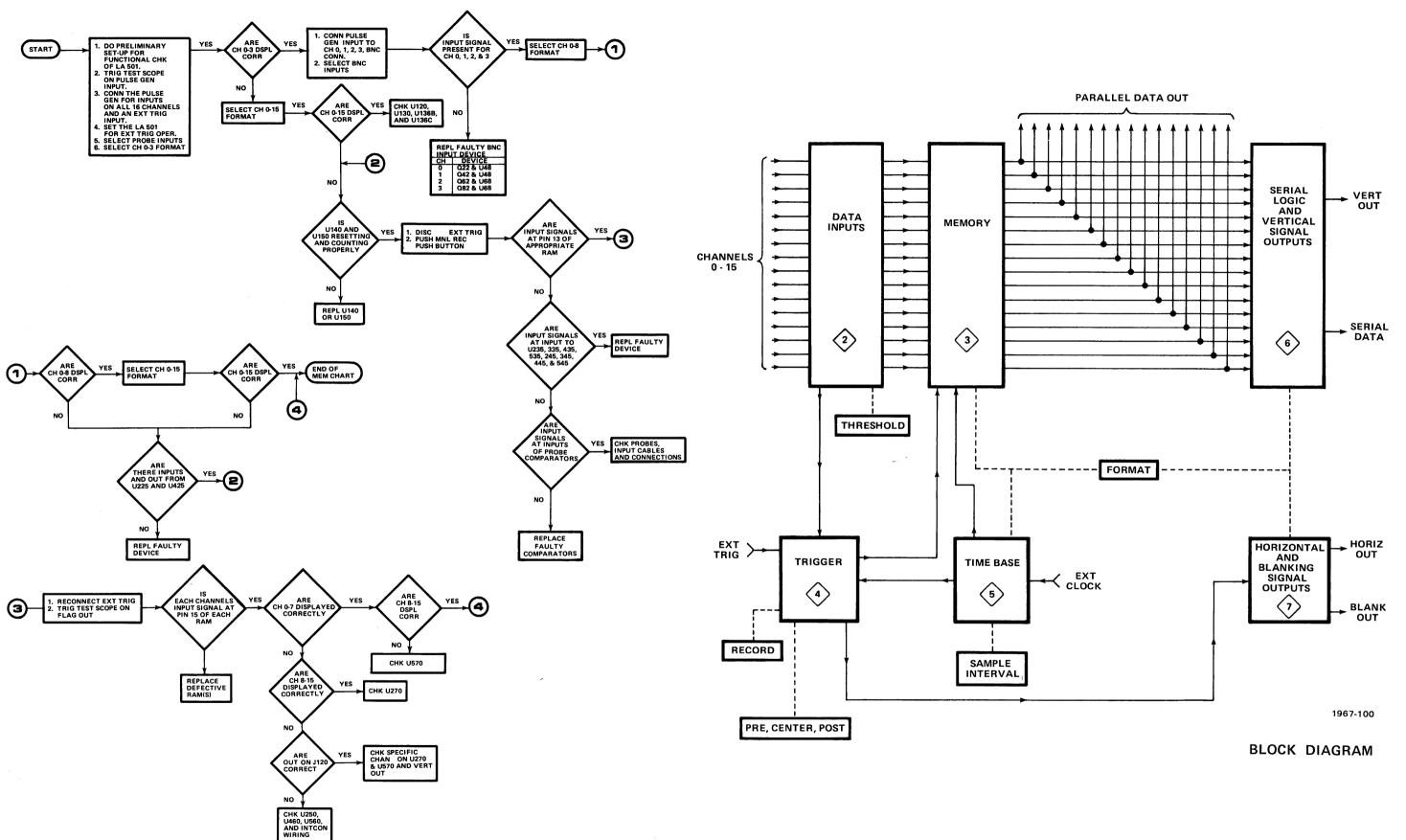
Fig. 8-5. Troubleshooting chart for Time Base circuit.

C1967-21



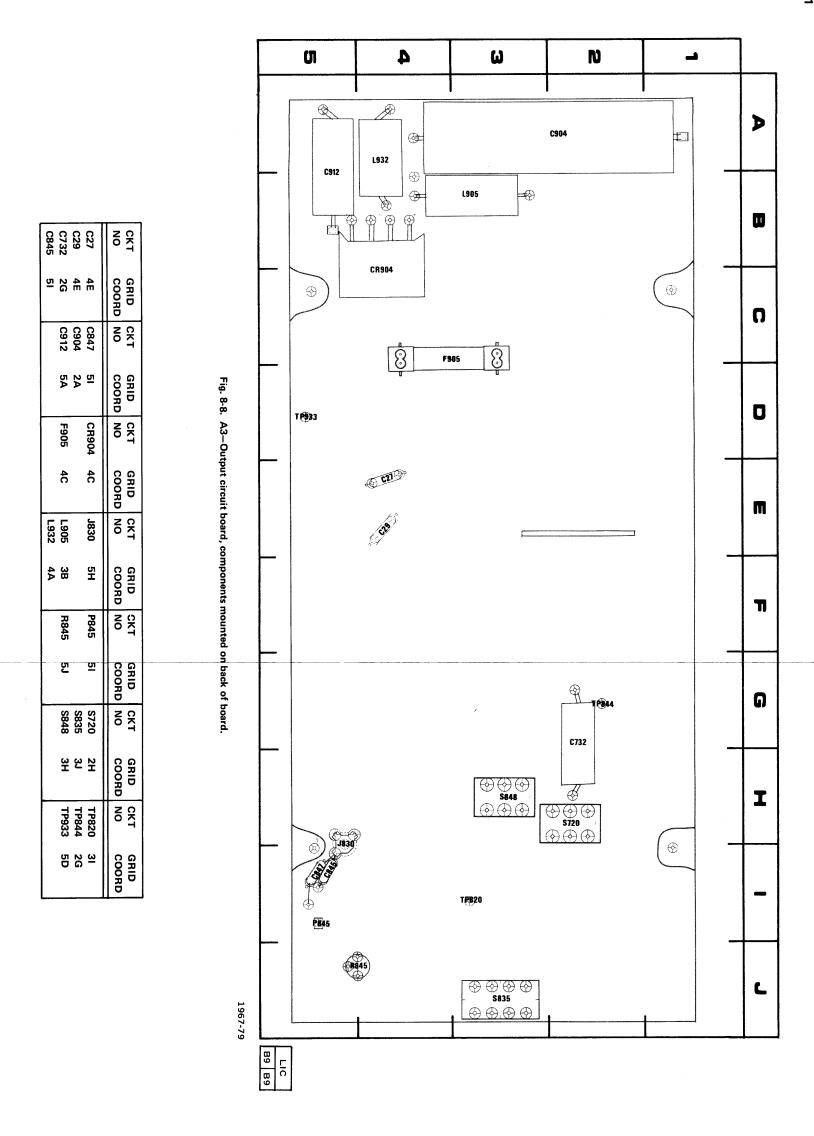


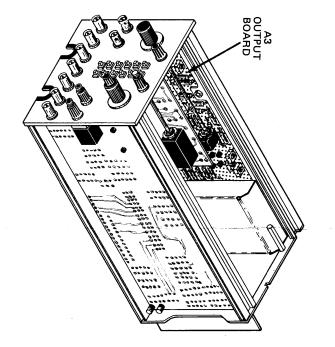
C1967-98

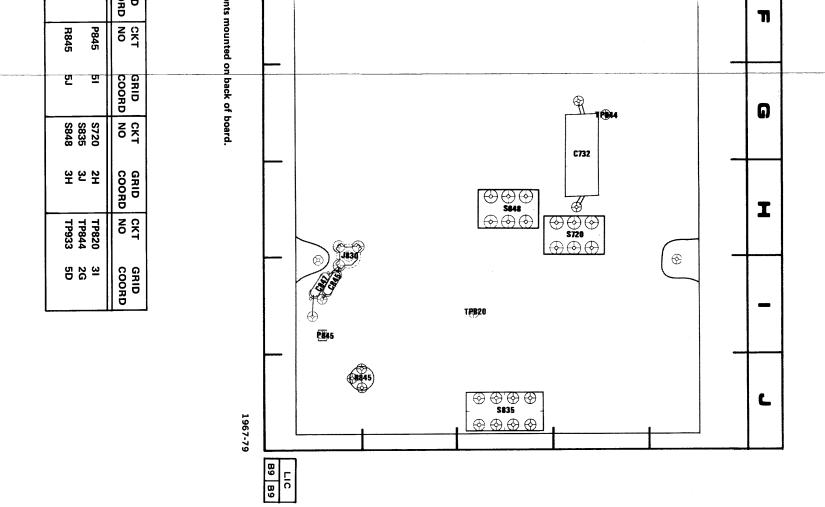


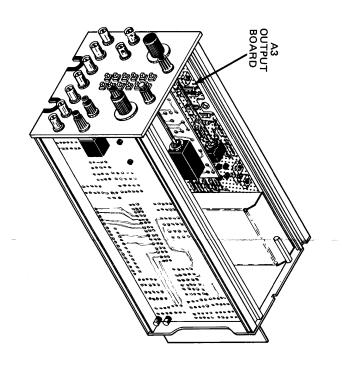
C1967-25

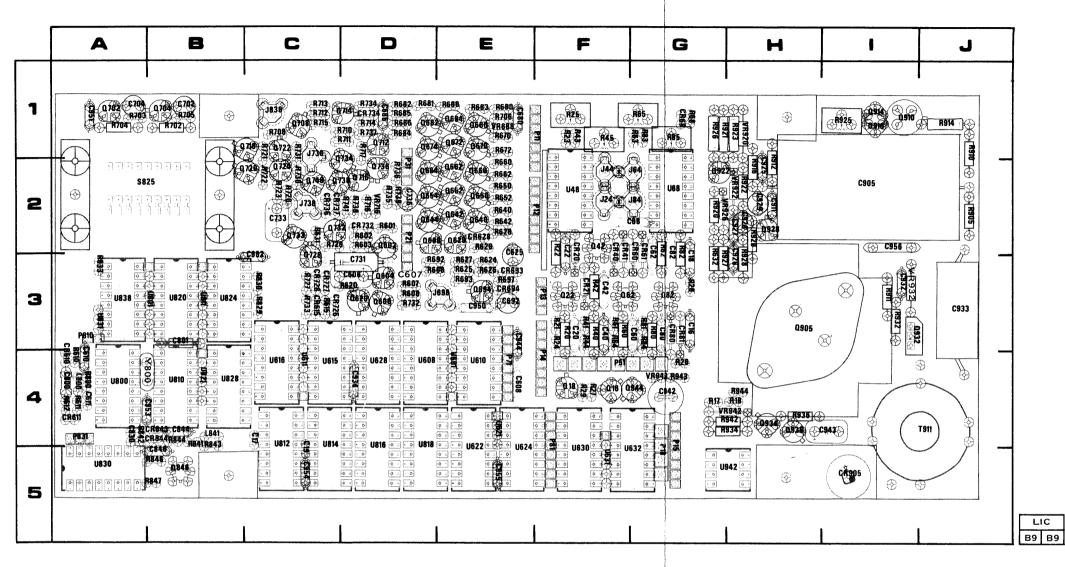
Fig. 8-7. Troubleshooting chart for Memory circuit.





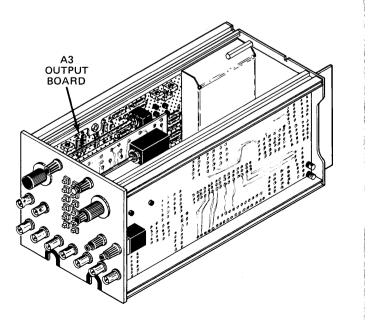




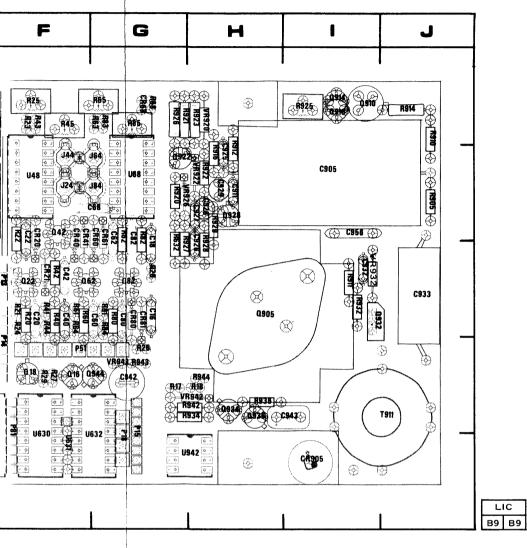


CKT	GRID	CKT	GRID	CKT	GRID	CKT	GRID
NO	COORD	NO	COORD	NO	COORD	NO	COORD
C686	1D	C942	4G	CR611	4A	J730	1C
C692	3E	C943	4I	CR615	3C	J738	2C

Fig. 8-9. A3—Output circuit board, component side.



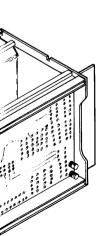
CKT NO	GRID	CKT NO	GRID
R652	2E	R706	1E
R660	2E	R708	1C
R662	2E	R710	1D
R670	1E	R711	1D
R672	1E	R712	1C
R680	1E	R713	1C
R681	1D	R714	1D
R682	1D	R715	1C
R683	1E	R716	2D
R684	1D	R717	1D
R685	1D	R720	2C
R686	1D	R721	1C
R688	1E	R722	2C
R692	3E	R723	2C
R693	3E	R727	3C
R697	3E	R729	2C
R698	3E	R730	2C
R702	1B	R731	1C
R703	1A	R732	3D
R704	1A	R733	3C
R705	1B	R734	1D
	R652 R660 R662 R670 R672 R680 R681 R682 R683 R684 R685 R686 R688 R692 R693 R697 R698 R702 R703 R704	NO COORD R652 2E R660 2E R662 2E R670 1E R672 1E R681 1D R682 1D R683 1E R684 1D R685 1D R686 1D R688 1E R692 3E R693 3E R697 3E R698 3E R702 1B R703 1A R704 1A	NO COORD NO R652 2E R706 R660 2E R708 R662 2E R710 R670 1E R711 R672 1E R712 R680 1E R713 R681 1D R714 R682 1D R715 R683 1E R716 R684 1D R717 R685 1D R720 R686 1D R721 R688 1E R722 R692 3E R723 R693 3E R727 R697 3E R729 R698 3E R730 R702 1B R731 R703 1A R732 R704 1A R733



CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD
C16	3G	C702	1B	C944	3E	CR628	2E	J838	1C	Q22	3F	Ω680	1E	Ω740	2C	R26	4G	R84	3G
C17	4C	C704	1A	C950	3E	CR693	3E			Q42	3F	Q682	1D	Q846	5B	R27	4F	R85	1G
C18	3G	C731	3D	C951	1A	CR694	3E	L800	4A	Q62	3F	Q684	1E	Q905	3H	R28	3G	R601	2D
C19	5C	C733	2C	C952	3C	CR726	3C	L841	4B	Q82	3G	Q694	3E	Q910	11	R29	4F	R602	2D
C20	3F	C736	2D	C953	4A	CR727	3C			Q602	2D	Q698	2D	Q914	11	R40	3F	R603	2D
C22	2F	C801	3B	C954	5C	CR728	3C	P11	1F	Q604	3D	Q702	1A	Q916	11	R41	3F	R606	3D
C40	3F	C830	4A	C955	5E	CR732	2D	P12	2F	Q606	3D	Q704	1B	Q922	2G	R42	3F	R607	3D
C42	3F	C844	4B	C956	21	CR734	1D	P13	3F	Q620	3D	Q708	1C	Q928	2H	R43	1F	R610	4A
C60	3G	C846	5B			CR736	2C	P14	4F	Q628	2E	Q712	1D	Q932	31	R44	3F	R611	4A
C62	2G	C905	21	CR20	2F	CR737	2C	P15	5G	Q640	2E	Q714	1D	Q934	4H	R45	1F	R615	3C
C68	2G 3G	C911	2H	CR21	3 F	CR843	4B	P18	5G	Q642	2E	Q716	2D	Q936	4H	R60	3F	R620	3D
C80 C82	3G 2G	C925	2H	CR40	2F	CR844	4B	P21	2D	Q644	2D	Q718	1C	Q944	4G	R61	3F	R624	3E
C606	3D	C926	3H	CR41	2F	CR905	51	P31	2D	Q650	2E	Q720	2C			R62	2G	R625	3E
C607	3D	C927	2H	CR60	2G			P51	4F	Q652	2E	Q722	1C	R17	4G	R63	1G	R626	3E
C608	4E	C928	2H	CR61	2G	J24	2F	P71	4E	Q654	2D	Q724	2C	R18	4H	R64	3F	R627	3E
C610	4A	C929	2H	CR68	1G	J44	2F	P81	4F	Q660	2E	Q728	3C	R20	3F	R65	1G	R629	2E
C611	4A	C932	31	CR80	3G	J64	2G	P610	3A	Q662	2E	Q732	2C	R21	3F	R68	1G	R631	2C
C625	3E	C933	3J	CR81	3G	J84	2G	P831	4A	Q664	2D	Q733	2C	R22	2F	R80	3G	R632	3G
C680	1E	C934	4D	CR610	4A	J698	3E			Q670	1E	Q734	2D	R23	1F	R81	3G	R640	2E
C686	1D	C942	4G	CR611	4A	J730	1C	Q16	4F	Q672	1E	Q736	2D	R24	3F	R82	2G	R642	2E
C692	3E	C943	41	CR615	3C	J738	2C	Q18	4F	Q674	1D	Q738	2D	R25	1F	R83	1G	R650	2E

CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD
R652	2E	R706	1E	R735	2D	R920	2G	U68	2G	U818	5D
R660	2E	R708	1C	R736	2D	R921	1G	U601	4E	U820	3B
R662	2E	R710	1D	R737	1D	R922	2H	U608	4D	U821	4B
R670	1E	R711	1D	R738	2D	R923	1H	U610	4E	U824	3B
R672	1E	R712	1C	R739	2D	R925	11	U611	4C	U828	4B
R680	1E	R713	1C	R741	2D	R926	1G	U615	4C	U830	5A
R681	1D	R714	1D	R829	3C	R927	3G	U616	4C	U831	3A
R682	1D	R715	1C	R830	3C	R928	3H	U621	4E	U838	3A
R683	1E	R716	2D	R833	3A	R929	2H	U622	5E	U932	31
R684	1D	R717	1D	R841	5B	R932	31	U624	5E	U942	5G
R685	1D	R720	2C	R842	4A	R934	4H	U628	4D		
R686	1D	R721	1C	R843	5B	R936	4H	U630	5F	VR688	1E
R688	1E	R722	2C	R844	4B	R942	4H	U631	5 F	VR716	2D
R692	3E	R723	2C	R846	5B	R943	4G	U632	5G	VR920	1H
R693	3E	R727	3C	R847	5B.	R944	4H	U800	4A	VR922	2H
R697	3E	R729	2C	R905	2J			U801	3B	VR926	
R698	3E	R730	2C	R910	1J	S825	2A	U810	4B	VR942	4H
R702	1B	R731	1C	R914	1J			U811	3B	VR943	4G
R703	1A	R732	3D	R911	31	T911	4J	U812	5C		
R704	1A	R733	3C	R912	2H			U814	5C	Y800	4B
R705	1B	R734	1D	R916	2H	U48	2F	U816	5D		

t board, component side.



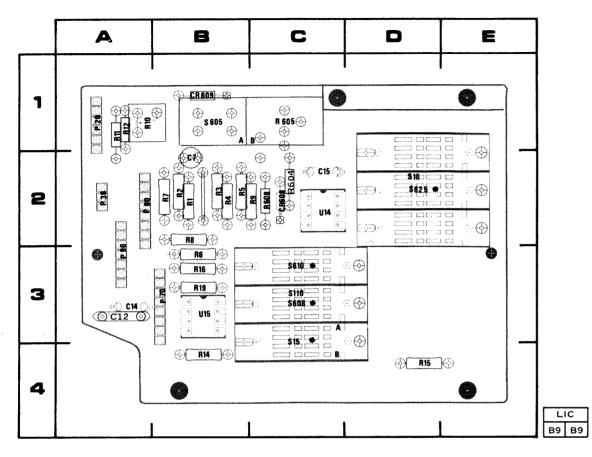
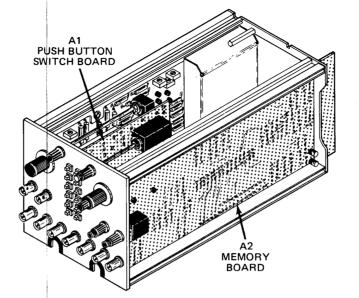


Fig. 8-10. A1-Push Button Switch board assembly.

СКТ	GRID	СКТ	GRID	СКТ	GRID	СКТ	GRID	СКТ	GRID
NO	COORD	NO	COORD	NO	COORD	NO	COORD	NO	COORD
C7	2B	P30	2A	R5	2B	R15	4D	S110	3C
C12	3A	P70	3B	R6	3B	R16	3B	S605	1B
C14	3A	P80	2A	R7	2B	R19	3B	S608	3C
C15	2C	P90	3A	R8	2B	R604	2C	S610	3C
				R9	2C	R605	1C	S625	2D
CR608	2C	R1	2B	R10	1A	R608	2C		
CR609	1B	R2	2B	R11	1A			U14	2C
		R3	2B	R12	1A	S10	2D	U15	3B
P20	1A	R4	2B	R14	4B	S15	3C		



										_
СКТ	GRID	CKT	GRID	CKT	GRID	СКТ	GRID	СКТ	GRID	CI
NO	COORD	NO	COORD	NO	COORD	NO	COORD	NO	COORD	N
	4E	CR213	4E	CR416	5G	J214	5D	P110	3G	R4
	4E	CR214	5E	CR417	5G	J314	5D	P111	3G	R4
	1E	CR215	5E	CR418	5G	J414	3H	P112	3G	R4
	3K	CR216	5E	CR512	5H	J514	3H	P113	3G	R4
	5C	CR217	5E	CR513	5H			P114	3H	RE
	5K 1H	CR218	5E	CR514	4G	P1	1A	P115	́зн	R
	4E	CR219	5F	CR515	4G	P2	2A	P300	4B	R
	5B	CR220	4E	CR516	4H	P3	3A			RE
	4B	CR312	5F	CR517	4H	P4	4A	R110	2E	RE
	5B	CR313	5F	CR518	5H	P5	5A	R150	2B	RE
C572	3C	CR314	5F	CR519	5H	P8	5B	R213	4E	
C573	2C	CR315	5F	CR561	11	P9	21	R214	5E	S5
	2E	CR316	4F	CR563	4 J	P102	3F	R217	5E	TP
	4E	CR317	4F	CR564	4J	P103	3F	R218	5F	
	3D	CR318	4G	CR566	21	P104	3F	R220	4E	U
	4C	CR319	4G	CR567	1K	P105	3F	R313	5F	U
	41	CR412	5G			P106	3F	R314	5F	U
1	4K 2H	CR413	5F	F510	5G	P107	3F	R317	4F	U'
C300	20	CR414	5G	F520	5B	1	_	R318	4G	Ü
CR212	4E	CR415	5G	J138	1E	P108 P109	3G 3G	R413	5G	Ŭ
L		0.1410		3130	16	L 108	30			

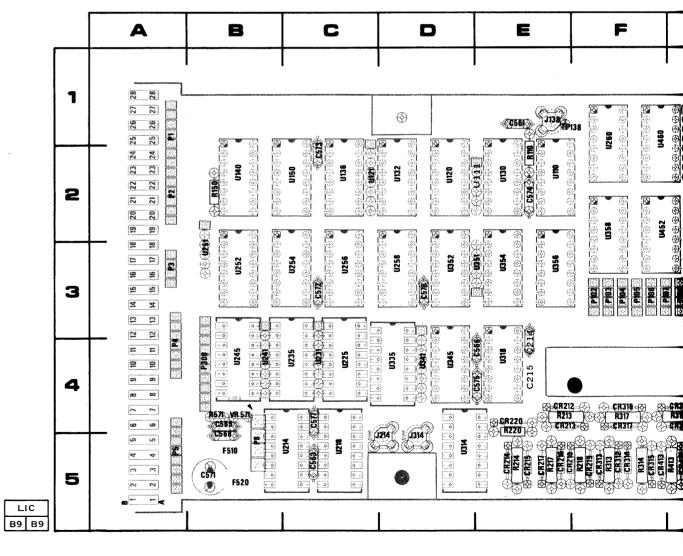
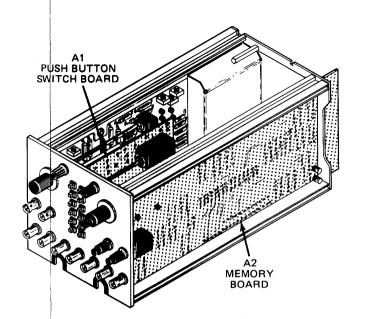


Fig. 8-11. A2-Memory circuit board, co



CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD
C214 C215 C561 C562 C563 C564 C565 C566 C568 C571 C572 C573 C574 C575 C576 C577 C578 C579 C580	4E 4E 1E 3K 5C 5K 1H 4E 5B 4B 5B 3C 2C 2E 4E 3D 4C 4I 4K 2H	CR213 CR214 CR215 CR216 CR217 CR218 CR219 CR220 CR312 CR313 CR314 CR315 CR316 CR317 CR317 CR318 CR317	4E 5E 5E 5E 5F 5F 5F 5F 4F 4G 5F 5G	CR416 CR417 CR418 CR512 CR513 CR514 CR515 CR516 CR517 CR518 CR519 CR561 CR563 CR564 CR566 CR567 F510 F520	5G 5G 5H 5H 4G 4H 4H 5H 5H 1I 4J 2I 1K 5B	J214 J314 J414 J514 P1 P2 P3 P4 P5 P8 P9 P102 P103 P104 P105 P106 P107	5D 5D 3H 3H 1A 2A 3A 4A 5B 2I 3F 3F 3F 3F 3F 3F	P110 P111 P112 P113 P114 P115 P300 R110 R150 R213 R214 R217 R218 R220 R313 R314 R317 R318	3G 3G 3G 3H 3H 4B 2E 2B 4E 5E 5F 4E 5F 4F 4G	R414 R417 R418 R435 R513 R514 R517 R518 R565 R567 R571 S565 TP138 U110 U111 U120 U121 U130 U132	5G 5G 5H 5H 4G 4H 5H 2I 1K 4B 2K 1E 2D 2D 2C 2E 2D	U140 U141 U150 U151 U214 U218 U225 U231 U235 U241 U245 U251 U252 U254 U256 U258 U260 U261 U270	2B 4J 2C 3J 5C 5C 4C 4C 4B 4B 3B 3C 3C 3D 1F 1G	U318 U335 U341 U345 U351 U352 U354 U356 U358 U361 U411 U414 U418 U425 U431 U435 U441 U445 U445 U451	4E 4D 4D 3E 3E 2F 1G 2E 5H 4I 4H 4H 4H 2F	U456 U458 U460 U461 U514 U518 U531 U535 U541 U545 U551 U552 U554 U556 U558 U560 U561 U565 U565	2H 3H 1F 1H 5J 5K 4J 4J 4K 2I 3I 3J 3J 2H 1I 2I
CR212	4E	CR415	5G	J138	1E	P109	3G	R413	5G	U136	2C	U314	5D	U454	2G	VR571	4B

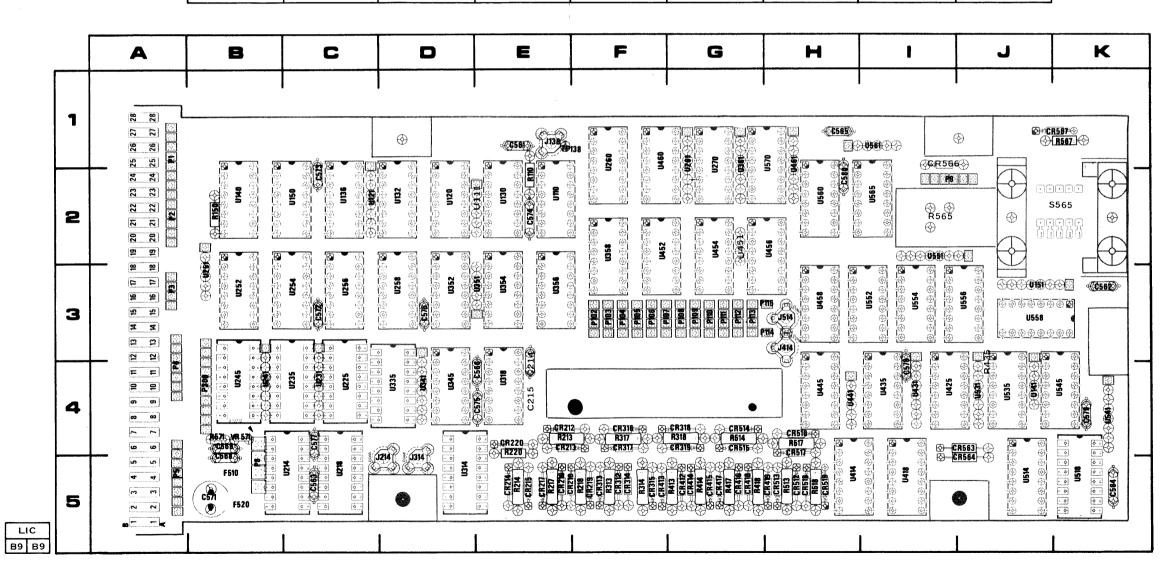
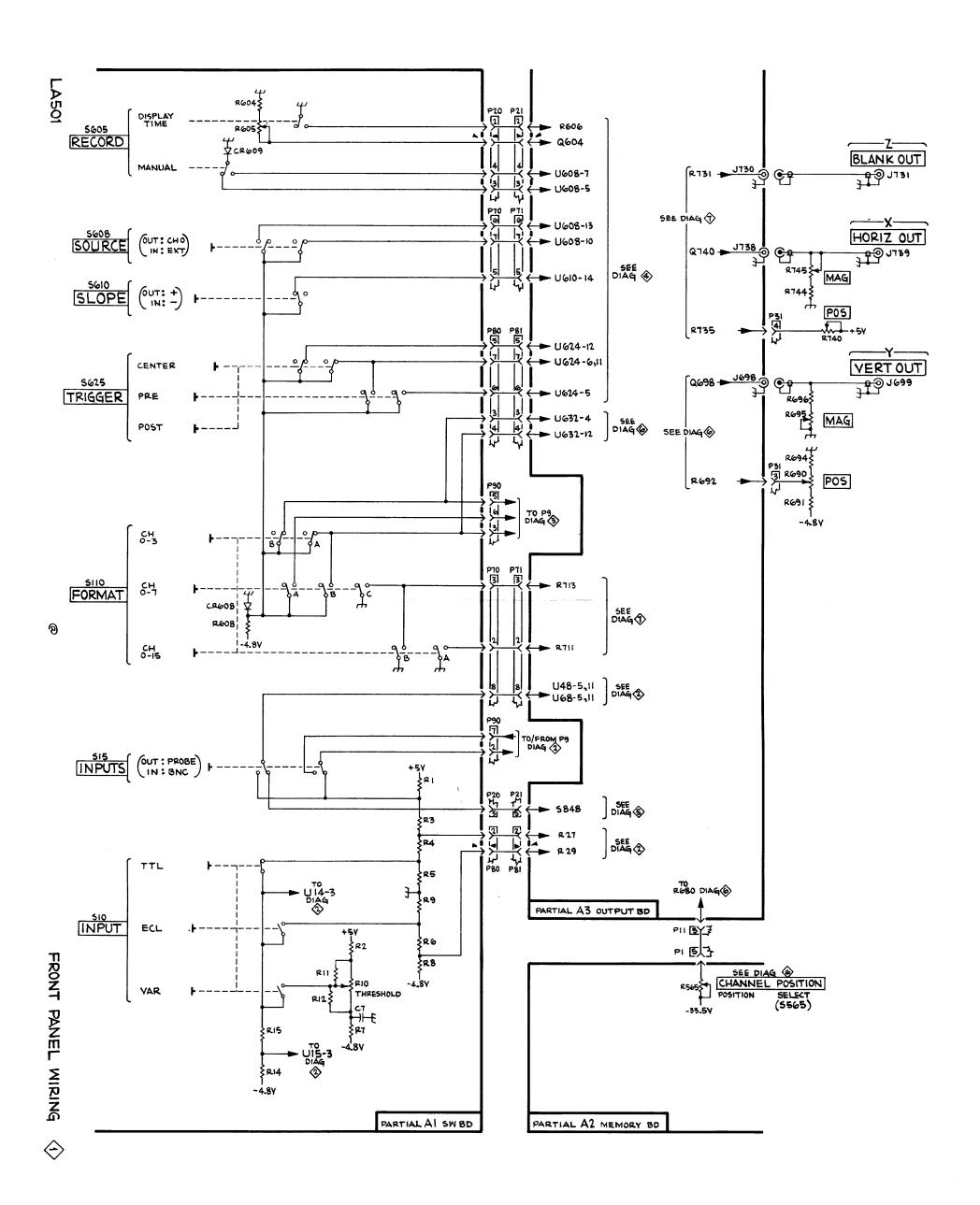
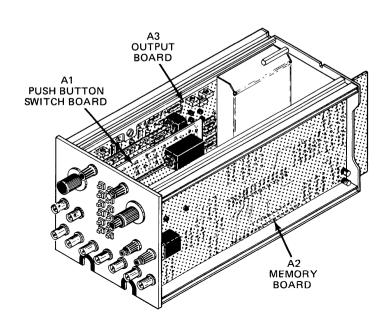
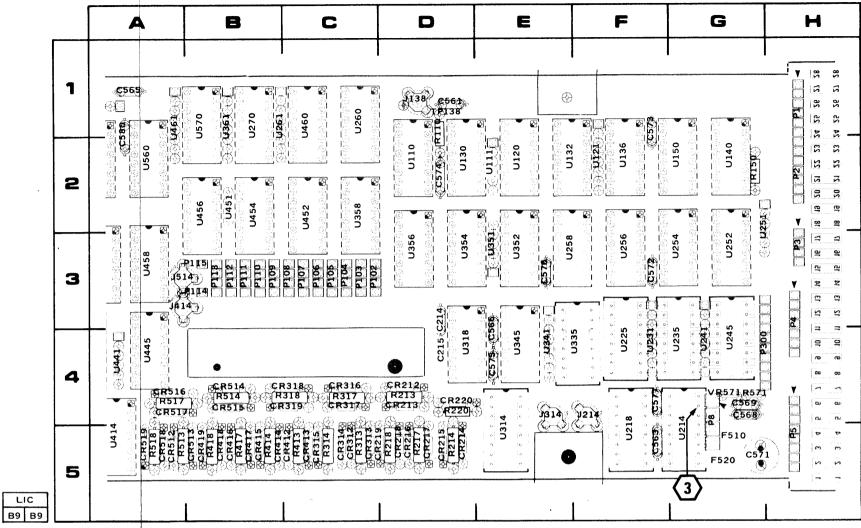


Fig. 8-11. A2—Memory circuit board, component side.



Refer to Figure 8-10 for locations of components mounted on Push Button Switch board.





COMPONENT LOCATIONS AS VIEWED WITH BOARD INSTALLED. FOR VIEW OF COMPONENT SIDE OF BOARD, SEE FIGURE 8-11 IN THIS SECTION.

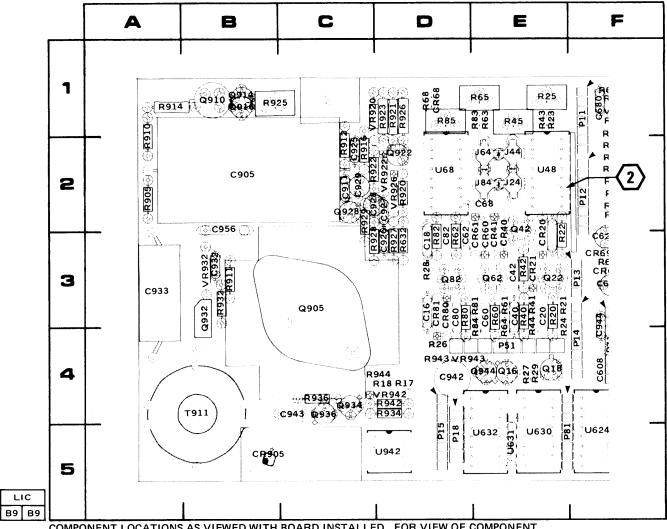
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Fig. 8-12. A2-Memory circuit board. Component locations as viewed with board installed.

CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD
				NO CR419 CR512 CR513 CR514 CR515 CR516 CR517 CR518 CR519 F510 F520	5B 5A 5B 4B 4B 4A 5A 5A 5G 5G	P2 P3 P4 P5 P8 P102 P103 P104 P105 P106 P107 P108 P109	2H 3H 3H 5H 4G 3C 3C 3C 3C 3C 3C 3C 3C 3C 3C 3C 3C 3C	R110 R150 R213 R214 R217 R218 R220 R313 R314 R317 R318 R413	1D 2G 4D 5D 5D 5D 4D 5C 5C 4C 4C 5C 5B	U110 U111 U120 U121 U130 U132 U136 U140 U150 U214 U218 U225	2D 2E 2F 2D 2E 2F 2G 5G 5F 4F	U256 U258 U260 U261 U270 U314 U318 U335 U341 U345 U351 U352 U354	3F 3E 1C 1B 1B 5E 4D 4F 4E 4E 3E 3E 3D		
C577 C580	4F 1A	CR412 CR413 CR414	5C 5C 5B	J138 J214 J314	1D 4F 4E	P110 P111 P112	3B 3B 3B	R417 R418 R513	5B 5B 5A	U231 U235 U241	4F 4G 4G	U356 U358 U361	3D 2C 1B		
CR212 CR213 CR214 CR215	4D 4D 5D 5D	CR415 CR416 CR417 CR418	5B 5B 5B 5B	J414 J514 P1	3A 3A 1H	P113 P114 P115 P330	3B 3B 3B 4G	R514 R517 R518 R571	4B 4A 5A 4G	U245 U251 U252 U254	4G 2G 3G 3G	U414 U441 U445 U451	5A 4A 4A 2B		



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COMPONENT LOCATIONS AS VIEWED WITH BOARD INSTALLED. FOR VIEW OF COMPONENT SIDE OF BOARD, SEE FIGURE 8-9. FOR LOCATION OF COMPONENTS MOUNTED ON REAR OF BOARD, SEE FIGURE 8-8 IN THIS SECTION.

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Fig. 8-13. A3—Output circuit board. Component locations as viewed with board installed.

СКТ	GRID	СКТ	GRID	скт	GRID	СКТ	GRID	СКТ	GRID	СКТ	GRID
NO	COORD	NO	COORD	NO	COORD	NO	COORD	NO	COORD	NO	COORD
C16	3D	C944	3F	P15	5D	R20	3E	R65	1E	R929	2C
C18	3D	C956	2B	P18	5D	R21	3E	R68	1D	R934	4D
C20	3E			P81	5E	R22	3E	R80	3D	R936	4C
C40	3E	CR20	3E			R23	1E	R81	3E	R942	4D
C42	3E	CR21	3E	Q16	4E	R24	3E	R82	3D	R943	4D
C60	3E	CR40	3E	Q18	4E	R25	1E	R83	1E	R944	4D
C62	3D	CR41	3E	Q22	3E	R26	4D	R84	3E		
C68	2E	CR60	3E	Q42	2E	R27	4E	R85	1D	T911	4B
C80	3D	CR61	3E	Q62	3E	R28	3D	R632	3D		
C82	3D	CR68	1D	Q82	3D	R29	4E	R905	2A	U48	2E
C608	4F	CR80	3D	Q905	3C	R40	3E	R910	1A	U68	2D
C680	1F	CR81	3D	Q910	1B	R41	3E	R911	3B	U624	5F
C905	2B	CR905	5 B	Q914	1B	R42	3E	R912	2C	U630	5E
C911	2C			Q916	1B	R43	1E	R914	1A	U631	5E
C925	2C	J24	2E	Q922	2D	R44	3E	R916	2C	U632	5E
C926	3D	J44	2E	Q928	2C	R43	1E	R920	2D	U932	3B
C927	2D	J64	2E	Q932	3B	R45	1E	R921	1D	U942	5D
C928	2C	J84	2E	Q934	4C	R51	4E	R922	2C		
C929	2C			Q936	4C	R60	3E	R923	1D	VR920	1C
C932	3B	P11	1F	Q944	4E	R61	3E	R925	1B	VR922	2D
C933	3A	P12	2F			R62	3D	R926	1D	VR926	2D
C942	4D	P13	3F	R17	4D	R63	1E	R927	3D	VR942	4D
C943	4C	P14	4F	R18	4D	R64	4E	R928	3C	VR943	4D

VOLTAGE AND WAVEFORM CONDITIONS

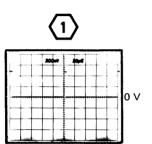
The voltages and waveforms shown were obtained with the LA 501 controls set as follows:

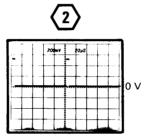
SAMPLE INTERVAL, 50 ns; INPUT THRESHOLD, TTL; FORMAT, CH 0-3 X1024; TRIGGER, CENTER; SLOPE, +; SOURCE, CH 0; INPUTS, BNC; RECORD (DISPLAY TIME), 1 s; CHANNEL/POSITION (SELECT), channel 0; CHANNEL/POSITION (POSITION), fully counterclockwise. A 10X probe was connected from the front panel CH 0 BNC input connector to a +5 volt pulse (5 microsecond duration, 100 microsecond period).

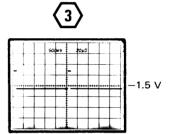
Voltage Conditions. The voltages shown on the diagram were obtained using a digital multimeter with 10 M Ω input impedance (Tektronix DM 501 Digital Multimeter or 7D13 Digital Multimeter used with readout equipped, 7000-series oscilloscope).

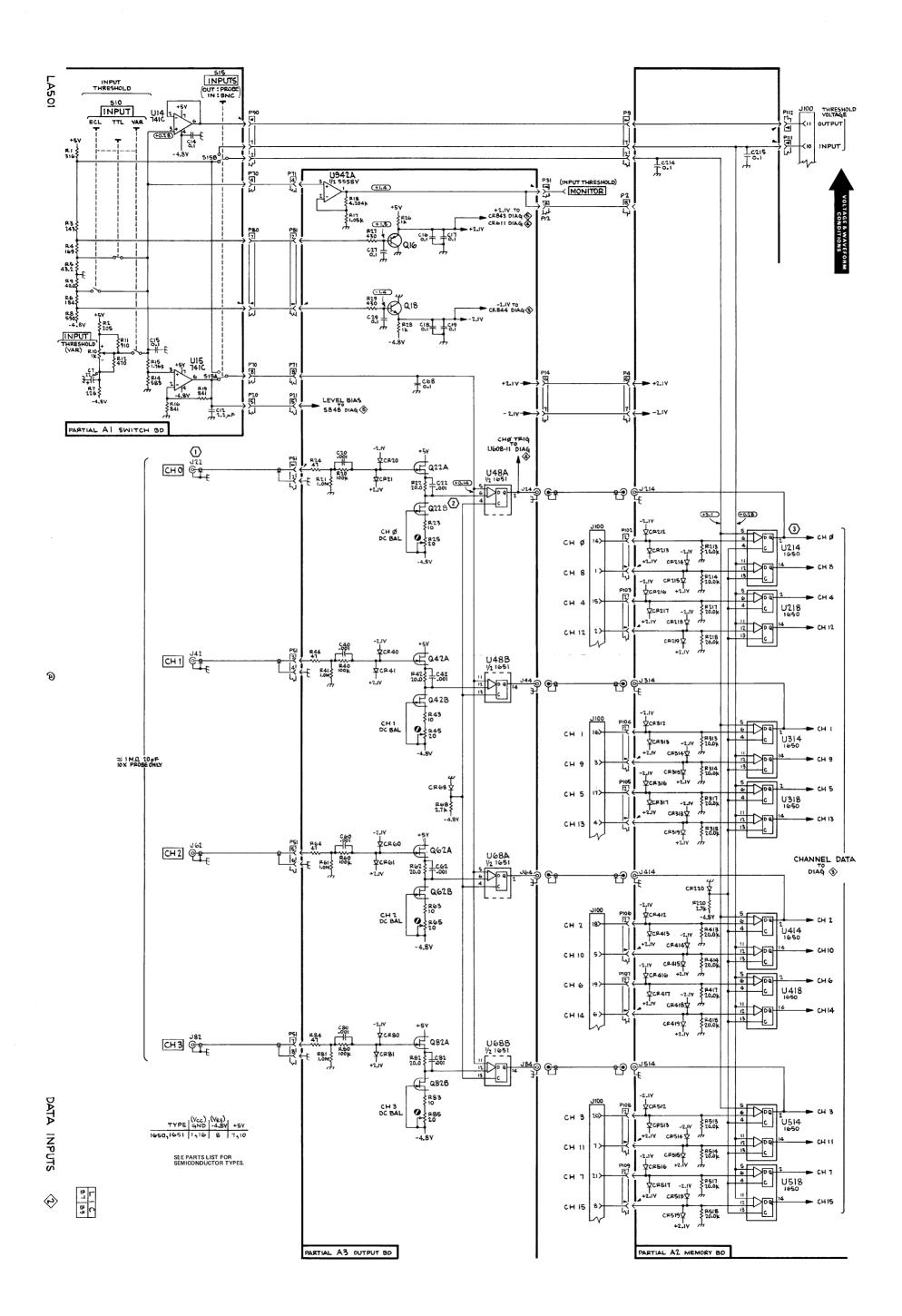
Waveform Conditions. The waveforms shown below were obtained using a test oscilloscope system with 10 M Ω input impedance and at least 60 MHz bandwidth (Tektronix 465 Oscilloscope equipped with 10X probe, or 7603 Oscilloscope, 7853A Time Base, and 7A15A Amplifier equipped with 10X probe). A 7A13 Differential Comparator with 10X probe was used to obtain the calibrated offset voltage.

NOTE









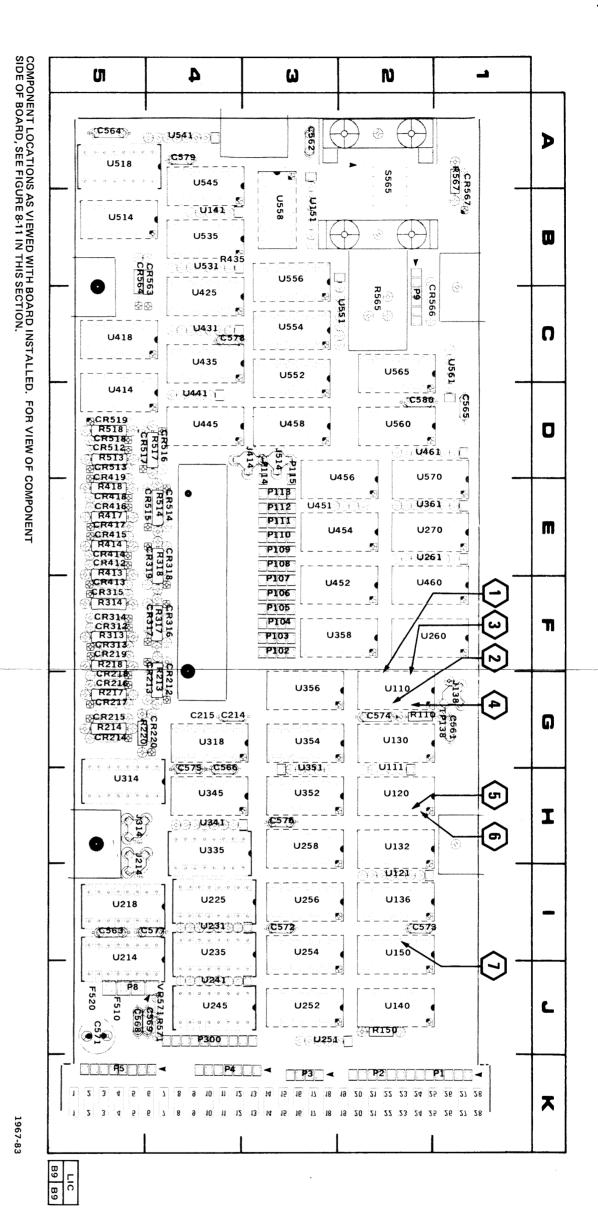
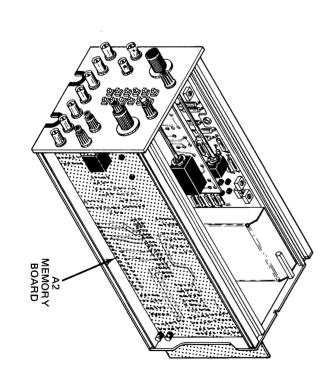
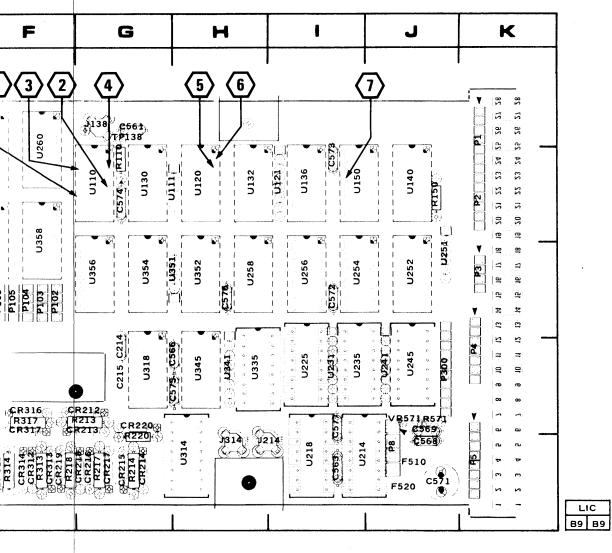


Fig. 8-14. A2—Memory circuit board. Component locations as viewed with board installed.



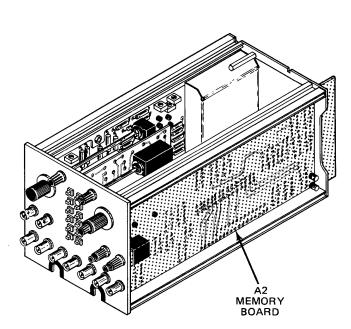
			ļ	
F510	31 TI	CR413	3	C580
CR5	5E	CR412	4A	C579
CRE	4E	CR319	4C	C578
CRE	4E	CR318	4	C577
CRE	4F	CR317	3H	C576
CRS	4F	CR316	4H	C575
CRS	5F	CR315	2G	C574
CR5	5F	CR314	21	C573
CRE	5F	CR313	<u> </u>	C572
CRE	5F	CR312	5	C571
CRS	5 G	CR220	4	C569
CRE	5F	CR219	ភ្	C568
CRB		CR218	4 H	C566
1		CRZII	5	C565
		00017	5A	C564
CR4		-	51	C563
CR4	5G	CR215	3A	C562
CR4	5G	CR214	16	C561
CR4	4G	CR213	4G	C215
CR4	4G	CR212	4G	C214
N O	COORD	O	COORD	O
CKT	GRID	CKT	GRID	S

NO.



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Component locations as viewed with board installed.



CKT	GRID	CKT	GRID	CKT	GRID
NO	COORD	NO	COORD	NO	COORD
U256 U258 U260 U261 U270 U314 U318 U335 U341 U345 U351 U352 U354 U356 U358 U361 U411 U414	3I 3H 2F 2E 2E 5H 4G 4H 4H 3H 3G 3G 3G 3F 2E 2H 5D	U425 U431 U435 U441 U445 U451 U452 U454 U456 U458 U460 U461 U514 U518 U531 U535 U541 U545 U551	4C 4C 4D 4D 3E 3F 2E 2E 2D 5B 5A 4B 4A 4A 2C 3C	U554 U556 U558 U560 U561 U565 U570 VR571	3C 3B 3B 2D 1C 2C 2E 4J

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VOLTAGE AND WAVEFORM CONDITIONS

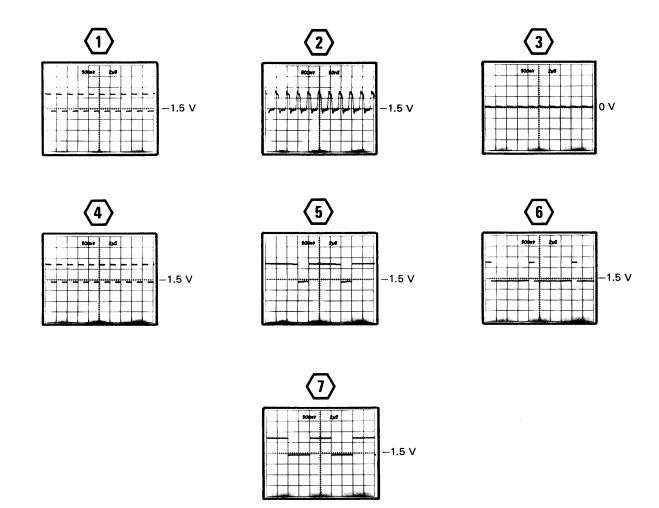
The voltages and waveforms shown were obtained with the LA 501 controls set as follows:

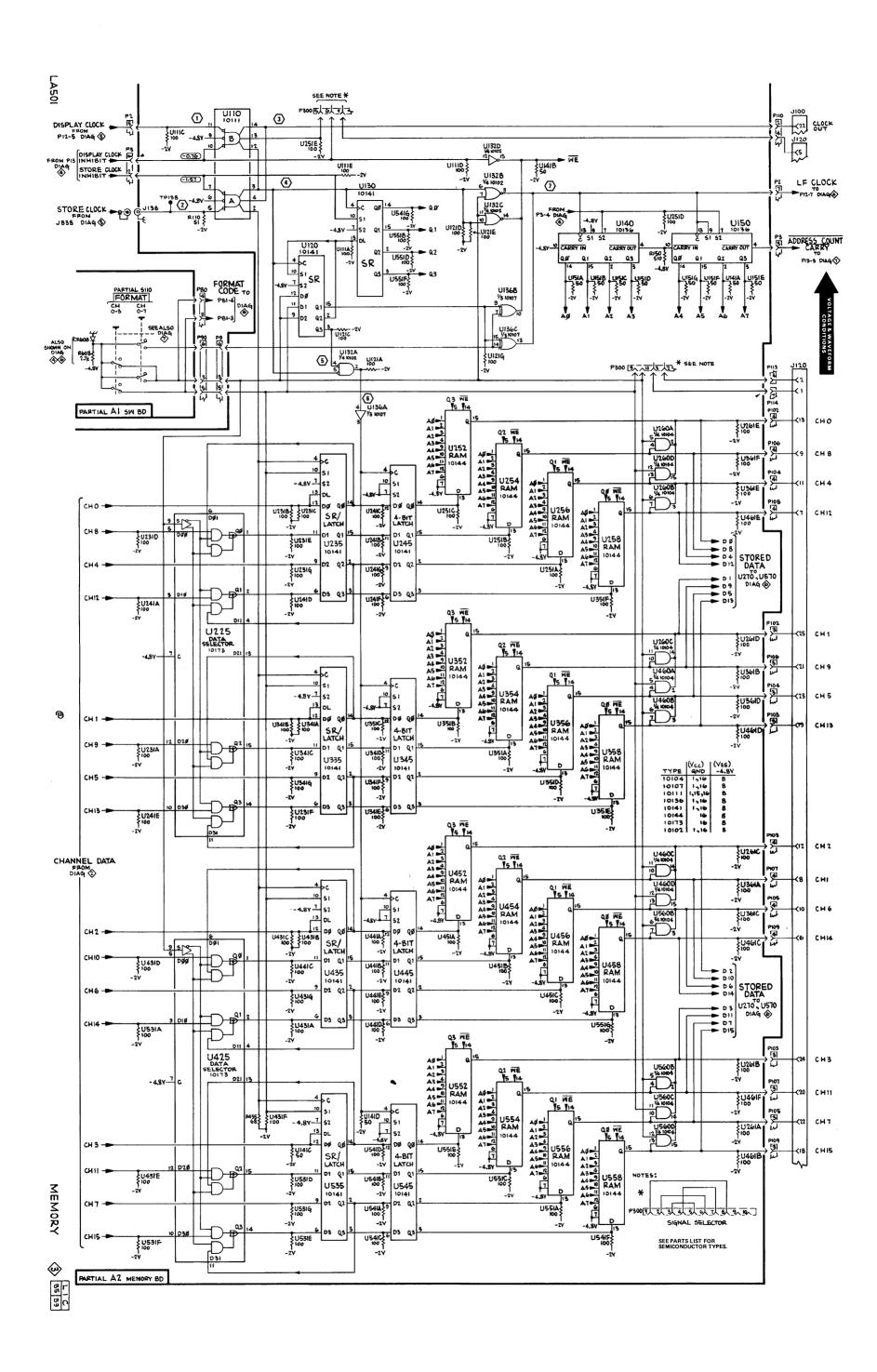
SAMPLE INTERVAL, 50 ns; INPUT THRESHOLD, TTL; FORMAT, CH 0-3 X1024; TRIGGER, CENTER; SLOPE, +; SOURCE, CH 0; INPUTS, BNC; RECORD (DISPLAY TIME), 1 s; CHANNEL/POSITION (SELECT), channel 0; CHANNEL/POSITION (POSITION), fully counterclockwise. A 10X probe was connected from the front panel CH 0 BNC input connector to a +5 volt pulse (5 microsecond duration, 100 microsecond period).

Voltage Conditions. The voltages shown on the diagram were obtained using a digital multimeter with 10 M Ω input impedance (Tektronix DM 501 Digital Multimeter or 7D13 Digital Multimeter used with readout equipped, 7000-series oscilloscope).

Waveform Conditions. The waveforms shown below were obtained using a test oscilloscope system with 10 M Ω input impedance and at least 60 MHz bandwidth (Tektronix 465 Oscilloscope equipped with 10X probe, or 7603 Oscilloscope, 7B53A Time Base, and 7A15A Amplifier equipped with 10X probe). A 7A13 Differential Comparator with 10X probe was used to obtain the calibrated offset voltage.

NOTE





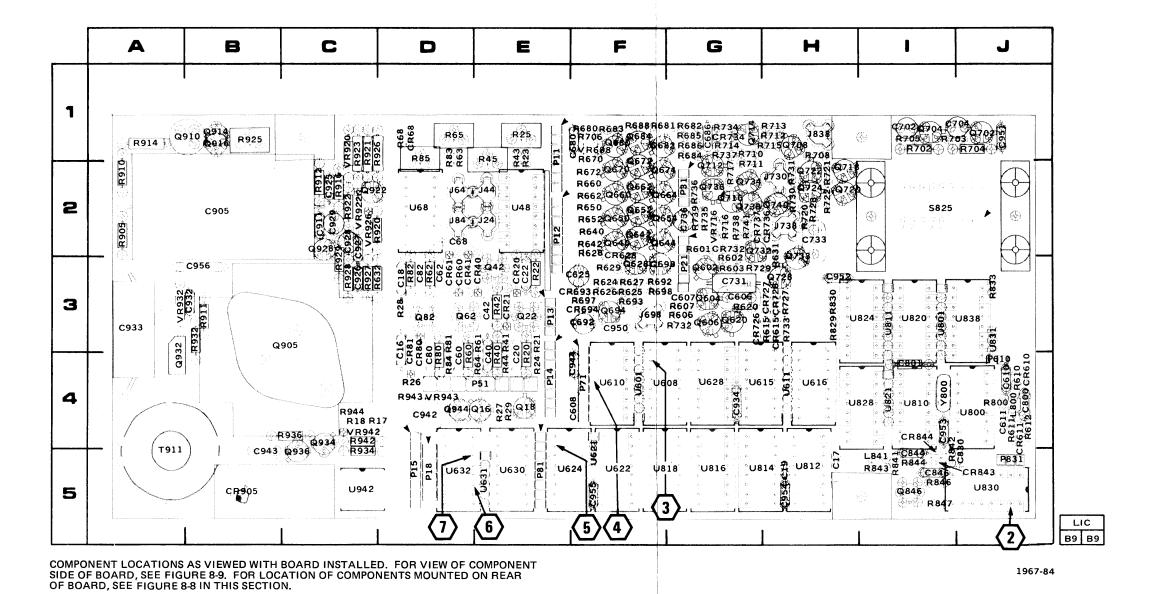
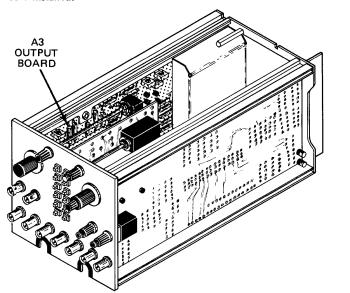
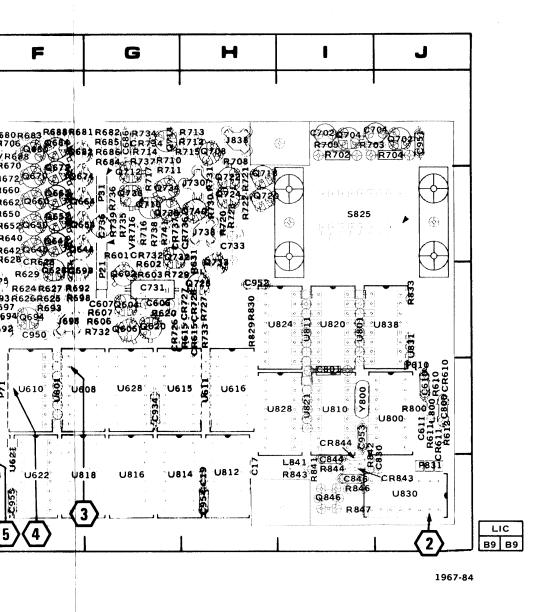


Fig. 8-15. A3—Output circuit board. Component locations as viewed with board installed.

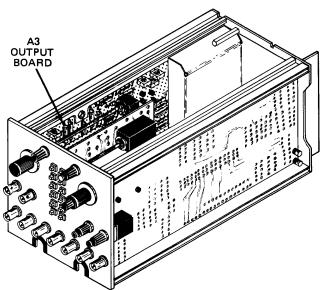


СКТ	GRID	СКТ	GRID	СКТ
NO	COORD	NO	COORD	NO
C16	3D	C704	1J	C950
C17	5H	C731	3G	C951
C18	3D	C733	2H	C952
C19	5H	C736	2G	C953
C20	4E	C800	4J	C954
C40	4E	C801	41	C955
C42	3E	C830	5J	C956
C60	4D	C844	51	
C62	3D	C846	51	CR20
C68	2D	C905	2B	CR21
C80	4D	C911	2C	CR40
C82	3D	C925	2C	CR41
C606	3G	C926	3C	CR60
C607	3G	C927	2C	CR61
C608	4F	C928	2C	CR68
C610	4 J	C929	2C	CR80
C611	4J	C932	3B	CR81
C625 C650	3F 3F	C933	3A	CR610
C666	1G	C934	4G	CR611
C680	16 1F	C942	4D	CR615
C692	3F	C943	5B	CR628
C702	11	C944	4F	CR693

CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	0
R42	3E	R611	4J	R682	1
R43	1E	R612	4J	R683	1
R44	4E	R615	3H	R684	1
R45	1 E	R620	3G	R685	1
R60	4D	R624	3F	R686	•
R61	3E	R625	3F	R688	1
R62	3D	R626	3F	R692	;
R63	1D	R627	3F	R693	3
R64	4E	R628	2F	R697	:
R65	1D	R629	3F	R698	3
R68	1D	R631	3H	R702	•
R80	4D	R632	3D	R703	•
R82	3D	R640	2F	R704	1
R83	1D	R642	2F	R705	1
R84	4D	R650	2F	R706	•
R85	1D	R652	2F	R708	1
R601	2G	R660	2F	R710	1
R602	3G	R662	2F	R711	2
R603	3G	R670	1F	R712	•
R606	3G	R672	2F	R713	•
R607	3G	R680	1F	R714	•
R610	4J	R681	1F	R715	•



nent locations as viewed with board installed.



CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD
		C704 C731 C733 C736 C800 C801 C830 C844 C846 C905 C911 C925 C926 C927 C928 C929 C932	1J 3G 2H 2G 4J 4I 5J 5I 2B 2C 2C 2C 2C 2C 3C 2C 2C 3B	C950 C951 C952 C953 C954 C955 C956 CR20 CR21 CR40 CR41 CR60 CR61 CR68 CR80 CR81	3F 1J 3H 4I 5H 5F 3B 3E 3E 3D 3D 1D 3D 3D	CR694 CR726 CR727 CR728 CR732 CR734 CR736 CR737 CR843 CR844 CR905 J24 J44 J64 J84 J698	COORD 3F 3G 3H 3H 2G 1G 2H 2G 5I 5I 5B 2E 2E 2D 2D 3F	NO L841 P11 P12 P13 P14 P15 P18 P21 P31 P51 P71 P81 P610 P831 Q16	51 1E 2E 3E 4E 5D 5D 3G 2G 4E 4F 5E 4J 5J	Q602 Q604 Q606 Q620 Q628 Q640 Q642 Q644 Q650 Q652 Q654 Q660 Q662 Q664 Q670 Q672 Q674	3G 3G 3G 3G 3F 2F 2F 2G 2F 2G 2F 2G 2F 2G 2F 2G 2F 2G 2F 2G 2F 2G 2F 2G 2F 2G 2F 2G 2G 2G 2G 2G 2G 2G 2G 2G 2G 2G 2G 2G	0702 0704 0708 0712 0714 0716 0718 0720 0722 0724 0728 0732 0733 0734 0736 0738	1J 11 1H 2G 1G 2G 2H 2H 2H 2H 2H 2G 3H 2G 3H 2G 3H 2G 3H 2G 3H 2G 3H 2G 3H 2G 3H 2G 3H 2G 3H 3H 3H 3H 3H 3H 3H 3H 3H 3H 3H 3H 3H	NO Q922 Q928 Q932 Q934 Q936 Q944 R17 R18 R20 R21 R22 R23 R24 R25 R26 R27	2C 2C 4A 4C 5C 4D 4C 4C 4E 3E 3E 1E 4E 1E 4D 4E
C650 C666 C680 C692 C702	3F 1G 1F 3F 1I	C933 C934 C942 C943 C944	3A 4G 4D 5B 4F	CR610 CR611 CR615 CR628 CR693	4J 4J 3H 2F 3F	J730 J738 J838 L800	2H 2H 1H 4J	Q18 Q22 Q42 Q62 Q82	4E 3E 3E 3D 3D	Q680 Q682 Q684 Q694 Q698	1F 1F 1F 3F 3F	Q846 Q905 Q910 Q914 Q916	51 3C 1B 1B 1B	R28 R29 R31 R40 R41	3D 4E 3D 4E 3E

CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD
R42	3E	R611	4J	R682	1G	R716	2G	R833	3J	R934	5C	U630	5E	VR716	2G
R43	1E	R612	4J	R683	1F	R717	2G	R841	51	R936	4C	U631	5E	VR920	1C
R44	4E	R615	3H	R684	1G	R720	2H	R842	5J	R942	4C	U632	5D	VR922	2C
R45	1E	R620	3G	R685	1G	R721	2H	R843	51	R943	4D	U800	4J	VR926	2C
R60	4D	R624	3F	R686	1G	R722	2H	R844	51	R944	4C	U801	31	VR942	4C
R61	3E	R625	3F	R688	1F	R723	2H	R846	51			U810	41	VR943	4D
R62	3D	R626	3F	R692	3F	R727	3H	R847	51	S825	21	U811	31		
R63	1D	R627	3F	R693	3F	R729	3G	R905	2A			U812	5H	Y800	41
R64	4E	R628	2F	R697	3F	R730	2H	R910	2A	T911	5A	U814	5H		
R65	1D	R629	3F	R698	3F	R731	2H	R911	3B			U816	5G		
R68	1D	R631	3H	R702	11	R732	3G	R912	2C	U48	2E	U818	5G		
R80	4D	R632	3D	R703	1J	R733	3H	R914	1A	U68	2D	U820	31		
R82	3D	R640	2F	R704	1J	R734	1G	R916	2C	U601	4F	U821	41		
R83	1D	R642	2F	R705	11	R735	2G	R920	2D	U608	4G	U824	31		
R84	4D	R650	2F	R706	1F	R736	2G	R921	1C	U610	4F	U828	41		
R85	1D	R652	2F	R708	1H	R737	1G	R922	2C	U611	4H	U830	5J		
R601	2G	R660	2F	R710	1G	R738	2G	R923	1C	U615	4G	U831	3J		
R602	3G	R662	2F	R711	2G	R739	2G	R925	1B	U616	4H	U838	3J		
R603	3G	R670	1F	R712	1H	R741	2G	R927	3C	U621	5F	U932	3A		
R606	3G	R672	2F	R713	1H	R800	4J	R928	3C	U622	5F	U942	5C		
R607	3G	R680	1F	R714	1G	R829	3H	R929	3C	U624	5F				
R610	4J	R681	1F	R715	1H	R830	3H	R932	3B	U628	4G	VR688	1F		

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VOLTAGE AND WAVEFORM CONDITIONS

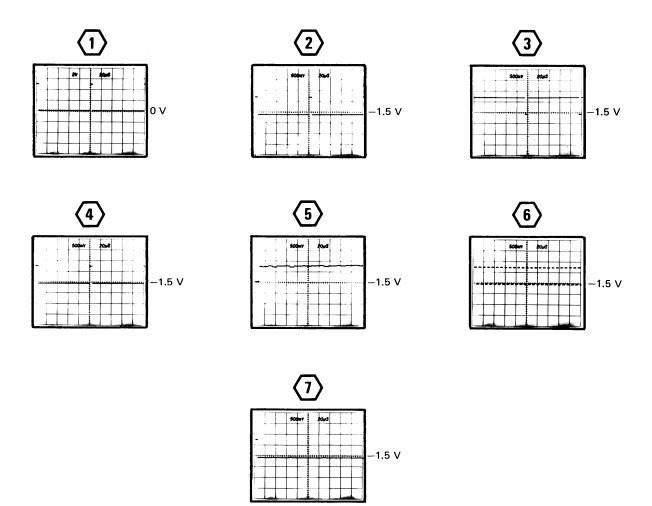
The voltages and waveforms shown were obtained with the LA 501 controls set as follows:

SAMPLE INTERVAL, 50 ns; INPUT THRESHOLD, TTL; FORMAT, CH 0-3 X1024; TRIGGER, CENTER; SLOPE, +; SOURCE, EXT; INPUTS, BNC; RECORD (DISPLAY TIME), 1 s; CHANNEL/POSITION (SELECT), channel 0; CHANNEL/POSITION), fully counterclockwise. A 50 Ω cable was connected from the EXT TRIG input connector to a +5 volt pulse (5 microsecond duration, 100 microsecond period).

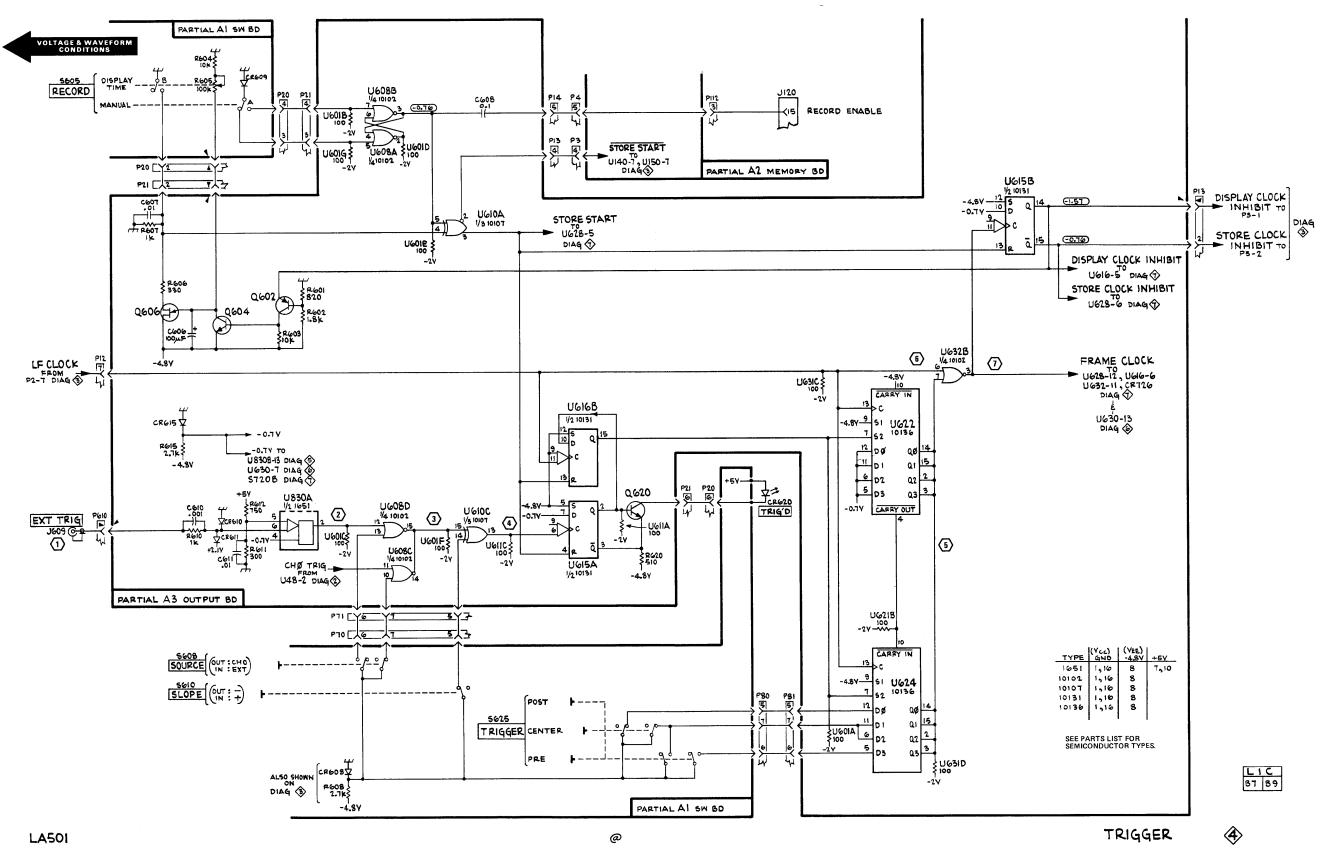
Voltage Conditions. The voltages shown on the diagram were obtained using a digital multimeter with 10 M Ω input impedance (Tektronix DM 501 Digital Multimeter or 7D13 Digital Multimeter used with readout equipped, 7000-series oscilloscope).

Waveform Conditions. The waveforms shown below were obtained using a test oscilloscope system with 10 M Ω input impedance and at least 60 MHz bandwidth (Tektronix 465 Oscilloscope equipped with 10X probe, or 7603 Oscilloscope, 7B53A Time Base, and 7A15A Amplifier equipped with 10X probe). A 7A13 Differential Comparator with 10X probe was used to obtain the calibrated offset voltage.

NOTE







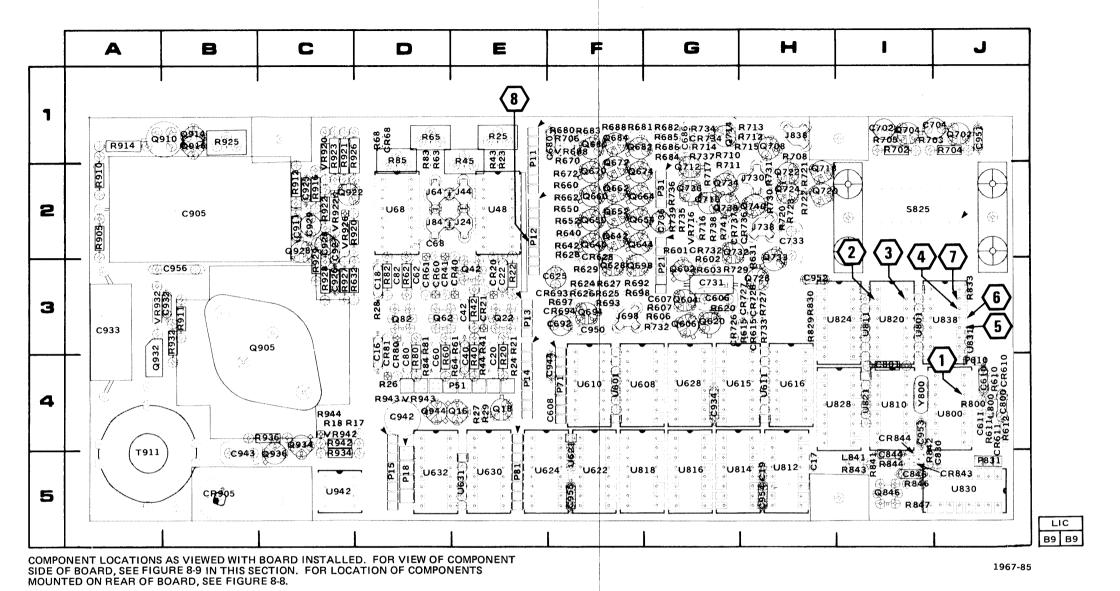
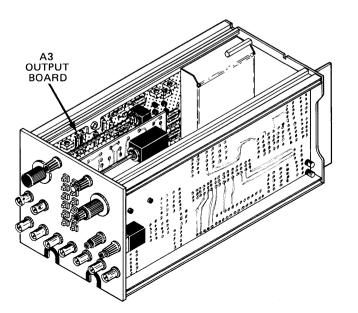
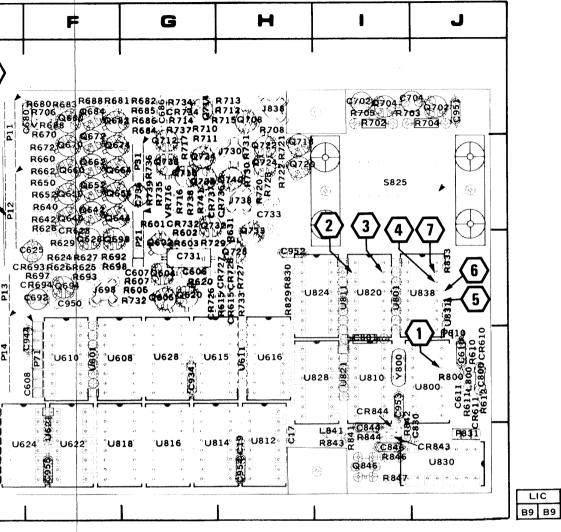


Fig. 8-16. A3—Output circuit board. Component locations as viewed with board installed.



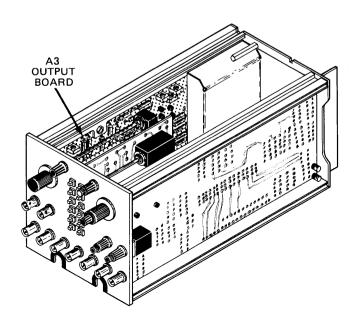
скт	GRID	СКТ	GRID	CKT
NO	COORD	NO	COORD	NO
C16	3D	C704	1J	C950
C17	5H	C731	3G	C951
C18	3D	C733	2H	C952
C19	5H	C736	2G	C953
C20	4E	C800	4J	C954
C40	4E	C801	41	C955
C42	3E	C830	5J	C956
C60	4D	C844	51	
C62	3D	C846	51	CR20
C68	2D	C905	2B	CR21
C80	4D	C911	2C	CR40
C82	3D	C925	2C	CR41
C606	3G	C926	3C	CR60
C607	3G	C927	2C	CR61
C608	4F	C928	2C	CR68
C610	4J	C929	2C	CR80
C611	4J 3F	C932	3B	CR81
C625 C660	3F	C933	3A	CR610
C666	JF 1G	C934	4G	CR611
C680	1F	C942	4D	CR615
C692	3F	C943	5B	CR628
C702	11	C944	4F	CR693

CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO
R42	3E	R611	4J	R682
R43	1E	R612	4J	R683
R44	4E	R615	3H	R684
R45	1E	R620	3G	R685
R60	4D	R624	3F	R686
R61	3E	R625	3F	R688
R62	3D	R626	3F	R692
R63	1D	R627	3F	R693
R64	4E	R628	2F	R697
R65	1D	R629	3F	R698
R68	1D	R631	3H	R702
R80	4D	R632	3D	R703
R82	3D	R640	2F	R704
R83	1D	R642	2F	R705
R84	4D	R650	2F	R706
R85	1D	R652	2F	R708
R601	2G	R660	2F	R710
R602	3G	R662	2F	R711
R603	3G	R670	1F	R712
R606	3G	R672	2F	R713
R607	3G	R680	1F	R714
R610	4J	R681	1F	R715



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omponent locations as viewed with board installed.



CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD
C16 C17 C18 C19 C20 C40 C42 C60 C62 C68 C80 C82 C606 C607 C608 C610 C611 C625 C660 C666 C680	3D 5H 3D 5H 4E 4E 3E 4D 3D 3D 3G 4F 4J 3F 3F 1G 1F	C704 C731 C733 C736 C800 C801 C830 C844 C846 C905 C911 C925 C926 C927 C928 C929 C932 C933 C934 C942	1J 3G 2H 2G 4J 4I 5J 5I 2B 2C 2C 2C 3C 2C 3C 4G 4G 4D	C950 C951 C952 C953 C954 C955 C956 CR20 CR21 CR40 CR41 CR60 CR61 CR68 CR80 CR81 CR610 CR611 CR611	3F 1J 3H 4I 5H 5F 3B 3E 3E 3D 3D 3D 3D 3D 4J 4J 4J 3H	CR694 CR726 CR727 CR728 CR732 CR734 CR736 CR737 CR843 CR844 CR905 J24 J44 J64 J84 J698 J730 J738 J838	3F 3G 3H 3H 2G 1G 2H 2G 5I 5I 5B 2E 2E 2D 2D 3F 2H 2H 2H 2H 2H 2H 2H 2H 2H 2H 2H 2H 2H	P11 P12 P13 P14 P15 P18 P21 P31 P51 P610 P831 Q16 Q18 Q22 Q42 Q62	51 1E 2E 3E 4E 5D 5D 3G 2G 4E 4F 5E 4J 5J 4E 4E 3E 3E 3D 3D 3D 3D 3D 3D 3D 3D 3D 3D 3D 3D 3D	Q602 Q604 Q606 Q620 Q628 Q640 Q642 Q644 Q650 Q652 Q654 Q660 Q662 Q664 Q670 Q672 Q674 Q680 Q682 Q684 Q694	3G 3G 3G 3F 2F 2F 2G 2F 2G 2F 2G 2F 2G 1F 1F 1F	Q702 Q704 Q708 Q712 Q714 Q716 Q718 Q720 Q722 Q724 Q728 Q733 Q733 Q734 Q736 Q738 Q740 Q846 Q905 Q910	1J 11 1H 2G 1G 2H 2H 2H 2H 2G 3H 2G 2G 2H 51 3C 1B	Q922 Q928 Q932 Q934 Q936 Q944 R17 R18 R20 R21 R22 R23 R24 R25 R26 R27 R28 R29 R31 R40	2C 2C 4A 4C 5C 4D 4C 4C 4E 3E 1E 4E 1E 4D 4E 3D 4E 3D 4E
C692 C702	3F 1I	C943 C944	5B 4F	CR628 CR693	3F	L800	4 J	Q82	3D	Q698	3F	Q916	1B	R41	3E

CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD
240		5644	4.	2000	40	D746	00	5000	21	D004	F.O.	LICOO	5E	VR716	2G
R42	3E	R611	4J	R682	1G	R716	2G	R833	3J	R934	5C	U630	_		
R43	1E	R612	4J	R683	1F	R717	2G	R841	51	R936	4C	U631	5E	VR920	1C
R44	4E	R615	3H	R684	1G	R720	2H	R842	5J	R942	4C	U632	5D	VR922	2C
R45	1E	R620	3G	R685	1G	R721	2H	R843	51	R943	4D	U800	4J	VR926	2C
R60	4D	R624	3F	R686	1G	R722	2H	R844	51	R944	4C	U801	31	VR942	4C
R61	3E	R625	3F	R688	1F	R723	2H	R846	51			U810	41	VR943	4D
R62	3D	R626	3F	R692	3F	R727	3H	R847	51	S825	21	U811	31		İ
R63	1D	R627	3F	R693	3F	R729	3G	R905	2A			U812	5H	Y800	41
R64	4E	R628	2F	R697	3F	R730	2H	R910	2A	T911	5A	U814	5H	i	
R65	1D	R629	3F	R698	3F	R731	2H	R911	3B			U816	5G		
R68	1D	R631	3H	R702	11	R732	3G	R912	2C	U48	2E	U818	5G		İ
R80	4D	R632	3D	R703	1J	R733	3H	R914	1A	U68	2D	U820	31		
R82	3D	R640	2F	R704	1J	R734	1G	R916	2C	U601	4F	U821	41		
R83	1D	R642	2F	R705	11	R735	2G	R920	2D	U608	4G	U824	31		
R84	4D	R650	2F	R706	1F	R736	2G	R921	1C	U610	4F	U828	41		
R85	1D	R652	2F	R708	1H	R737	1G	R922	2C	U611	4H	U830	5J		
R601	2G	R660	2F	R710	1G	R738	2G	R923	1C	U615	4G	U831	3J		
R602	3G	R662	2F	R711	2G	R739	2G	R925	1B	U616	4H	U838	3J		
R603	3G	R670	1F	R712	1H	R741	2G	R927	3C	U621	5 F	U932	3A		
R606	3G	R672	2F	R713	1H	R800	4J	R928	3C	U622	5F	U942	5C		
R607	3G	R680	1F	R714	1G	R829	3H	R929	3C	U624	5F				
R610	4J	R681	1F	R715	1H	R830	3H	R932	3B	U628	4G	VR688	1F		

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The voltages and waveforms shown were obtained with the LA 501 controls set as follows:

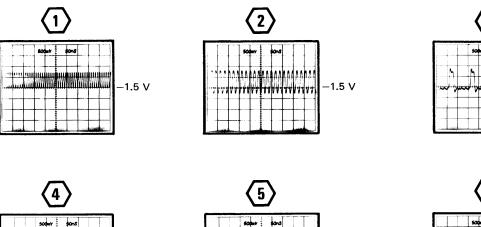
SAMPLE INTERVAL, 50 ns; INPUT THRESHOLD, TTL; FORMAT, CH 0-3 X1024; TRIGGER, CENTER; SLOPE, +; SOURCE, CH 0; INPUTS, BNC; RECORD (DISPLAY TIME), 1 s; CHANNEL/POSITION (SELECT), channel 0; CHANNEL/POSITION (POSITION), fully counterclockwise. A 10X probe was connected from the front panel CH 0 BNC input connector to a +5 volt pulse (5 microsecond duration, 100 microsecond period).

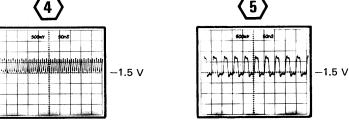
Voltage Conditions. The voltages shown on the diagram were obtained using a digital multimeter with 10 M Ω input impedance (Tektronix DM 501 Digital Multimeter or 7D13 Digital Multimeter used with readout equipped, 7000-series oscilloscope).

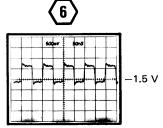
Waveform Conditions. The waveforms shown below were obtained using a test oscilloscope system with $10 \, M\Omega$ input impedance and at least 60 MHz bandwidth (Tektronix 465 Oscilloscope equipped with 10X probe, or 7603 Oscilloscope, 7B53A Time Base, and 7A15A Amplifier equipped with 10X probe). A 7A13 Differential Comparator with 10X probe was used to obtain the calibrated offset voltage.

NOTE

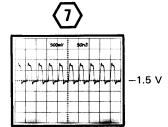
Voltages and waveforms are not absolute and may vary between instruments.

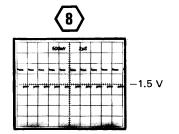


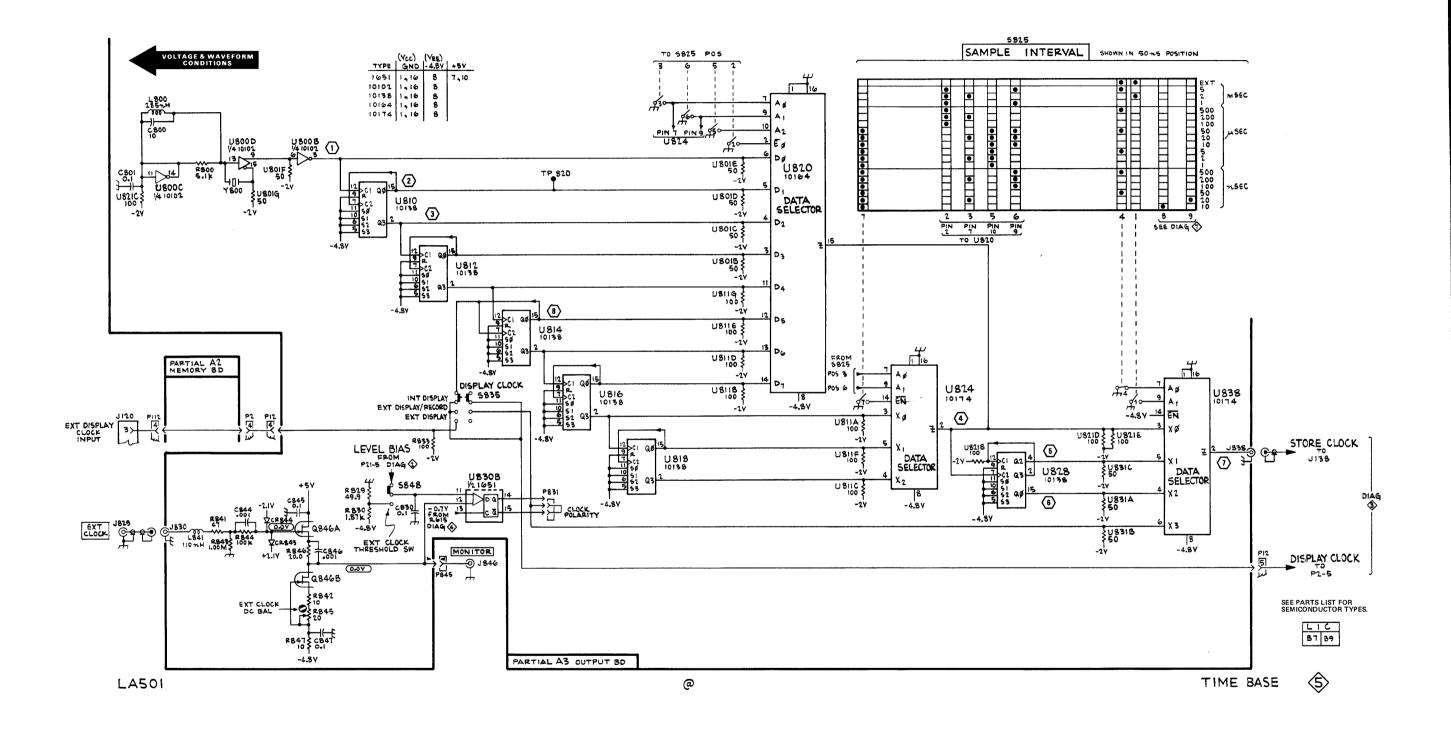




-1.5 V









COMPONENT LOCATIONS AS VIEWED WITH BOARD INSTALLED. FOR VIEW OF COMPONENT SIDE OF BOARD, SEE FIGURE 8-11 IN THIS SECTION.

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Fig. 8-17. A2-Memory circuit board. Component locations as viewed with board installed.

CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD
1				P108 P109 P110 P111 P112 P113 P114 P115 R314 R318 R413 R414 R418 R435 R513 R514 R517	3F 3E 3E 3E 3E 3E 3E 3E 3E 5F 4F 5F 5E 5E 5D 4E 4D	NO S565 U141 U151 U261 U270 U361 U414 U418 U425 U431 U435 U441 U445 U445 U451 U452 U454	2B 4B 3B 1E 1E 5D 5C 4C 4C 4C 4D 4D 4D 2E 2F 1E		
CR419 CR512	5E 5D	P106 P107	3F 3F	R518 R565 R567	5D 2C 1B	U456 U458 U460	2E 3D 1F		

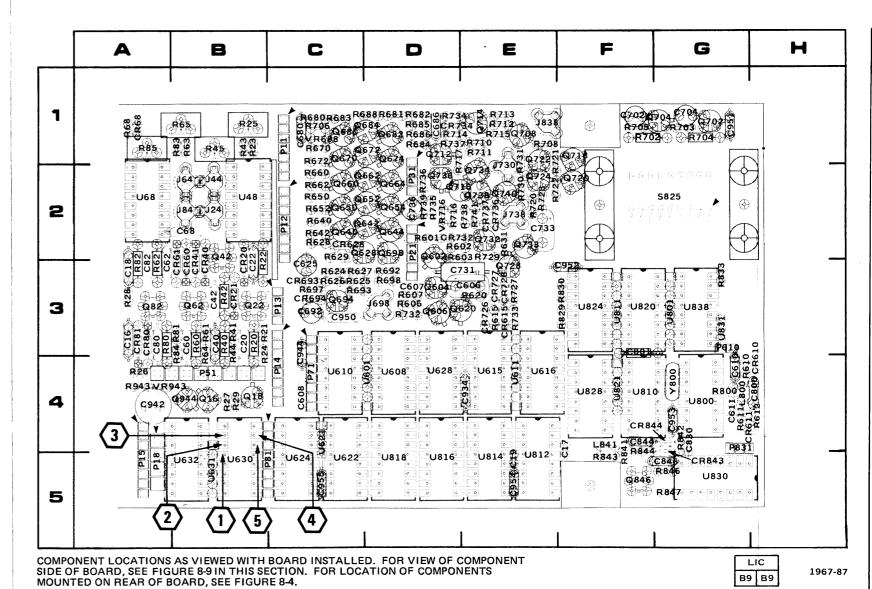
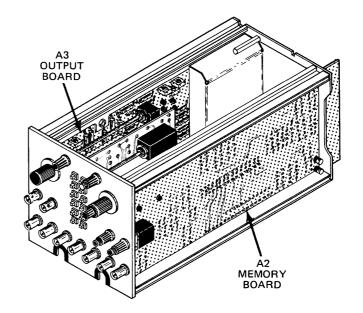


Fig. 8-18. A3—Output circuit board. Component locations as viewed with board installed.



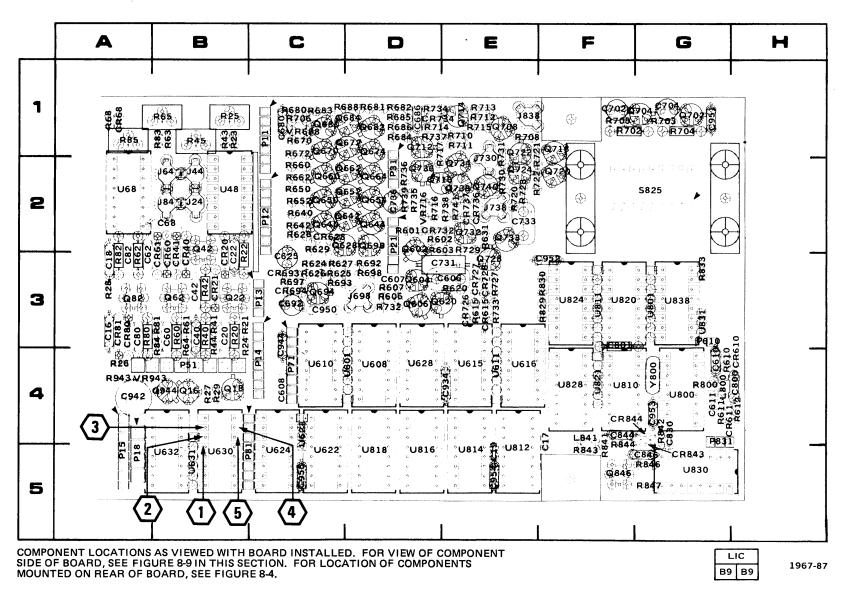
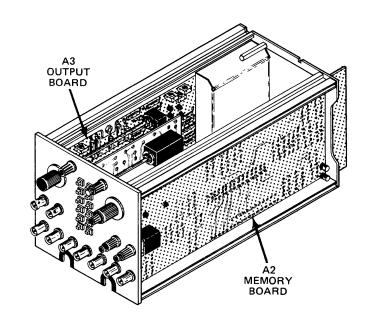


Fig. 8-18. A3-Output circuit board. Component locations as viewed with board installed.

B9 B9



CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD
C16	3A	CR610	4H	Q604	3D	R28	3A	R684	1D	R943	4A
C17	4F	CR611	4G	Q606	3D	R29	4B	R685	1D		
C18	3A	CR615	3E	Q620	3E	R40	3B	R686	1D	S825	2G
C19	5E	CR628	2C	Q628	2D	R41	3B	R688	1D		
C20	3B	CR693	3C	Q640	2C	R42	3B	R692	3D	U48	2B
C40	3B	CR694	3C	Q642	2D	R43	1B	R693	3C	U68	2A
C42	3B	CR726	3E	Q644	2D	R44	3B	R697	3C	U601	4D
C60	3B	CR727	3E	Q650	2C	R45	1B	R698	3D	U608	4D
C62	3A	CR728	3E	Q652	2D	R60	3B	R702	1F	U610	4C
C68	2B	CR732	2D	Q654	2D	R61	3B	R703	1G	U611	4E
C80	3A	CR734	1D	Q660	2C	R62	3A	R704	1G	U615	4E
C82	3A	CR736	2E	Q662	2D	R63	1B	R705	1F	U616	4E
C606	3E	CR737	2E	Q664	2D	R64	3B	R706	1C	U621	4C
C607	3D	CR843	5G	Q670	1C	R65	1B	R708	1E	U622	5C
C608	4C	CR844	4G	Q672	1D	R68	1A	R710	1E	U624	5C
C610	4G			Q674	1D	R80	3A	R711	1E	U628	4E
C611 C625	4G 3C	J24	2B	Q680	1C	R81	3B	R712	1E	U630	5B
C666	1D	J44	2B	Q682	1D	R82	3A	R713	1E	U631	5B
C680	1C	J64	2B	Q684	1D	R83	1B	R714	1D	U632	5B
C692	3C	J84	2B	Q694	3C	R85	1A	R715	1E	U800	4G
C702	1F	J698	3D	Q698	2D	R601	2D	R716	2D	U801	3G
C704	1G	J730	2E	Q702	1G	R602	2D	R717	1D	U810	4F
C731	3E	J738	2E	Q704	1G	R603	2D	R720	2E	U811	3F
C733	2E	J838	1E	Q708	1E	R606	3D	R721	1E	U812	5E
C736	2D			Q712	1D	R607	3D	R722	2E	U814	5E
C800	4H	L800	4G	Q714	1E	R610	4G	R723	2E	U816	5D
C801	3F	L841	4F	Q716	2D	R611	4G	R727	3E	U818	5D
C830	4G			Q718	1F	R612	4H	R729	2E	U820	3F
C844	4F	P11	1C	Q720	2F	R615	3E	R730	2E	U821	4F
C846	5G	P12	2C	Q722	1E	R620	3E	R731	1E	U824	3F
C934	4E	P13	3C	Q724	2E	R624	3C	R732	3D	U828	4F
C942	4A	P14	4C	Q728	3E	R625	3C	R733	3E	U830	5G
-C944	3C	P15	5A	Q732	2E	R626	3C	R734	1D	U831	3G
C950	3C	P18	5A	Q733	2E	R627	3C	R735	2D	U838	3G
C951	1G	P21	2D	Q734	2E	R628	2C	R736	2D		
C952	3F	P31	2D	Q736	2D	R629	2C	R737	1D	VR688	1C
C953	4G	P51	4B	Q738	2E	R631	2E	R738	2E	VR712	2D
C954	5E	P71	4C	Q740	2E	R640	2C	R739	2D	VR943	4B
C955	5C	P81	5C	Q846	5F	R642	2C	R741	2E		
		P610	3G	Q944	4B	R650	2C	R800	4G	Y800	4G
CR20	2B	P831	4G			R652	2C	R829	3F		
CR21	3B			R20	3B	R660	2C	R830	3F		
CR40	3B	Q16	4B	R21	3B	R662	2C	R833	3G		
CR41	3B	Q18	4B	R22	3B	R670	1C	R841	5F		
CR60	3B	Q22	3B	R23	1B	R672	1C	R842	4G]
CR61	3B	Q42	2B	R24	3B	R680	1C	R843	5F		
CR68	1A	Q62	3B	R25	1B	R681	1D	R844	5F		
CR80	3A	Q82	3A	R26	4A	R682	1D	R846	5G		
CR81	3A	Q602	2D	R27	4B	R683	1C	R847	5G		

SERIAL LOGIC AND

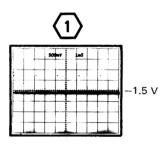
The voltages and waveforms shown were obtained with the LA 501 controls set as follows:

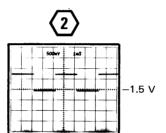
SAMPLE INTERVAL, 50 ns; INPUT THRESHOLD, TTL; FORMAT, CH 0-3 X1024; TRIGGER, CENTER; SLOPE, +; SOURCE, CH 0; INPUTS, BNC; RECORD (DISPLAY TIME), 1 s; CHANNEL/POSITION (SELECT), channel 0; CHANNEL/POSITION (POSITION), fully counterclockwise. A 10X probe was connected from the front panel CH 0 BNC input connector to a +5 volt pulse (5 microsecond duration, 100 microsecond period).

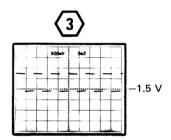
Voltage Conditions. The voltages shown on the diagram were obtained using a digital multimeter with $10 \text{ M}\Omega$ input impedance (Tektronix DM 501 Digital Multimeter or 7D13 Digital Multimeter used with readout equipped, 7000-series oscilloscope).

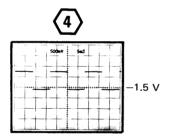
Waveform Conditions. The waveforms shown below were obtained using a test oscilloscope system with $10~M\Omega$ input impedance and at least 60 MHz bandwidth (Tektronix 465 Oscilloscope equipped with 10X probe, or 7603 Oscilloscope, 7B53A Time Base, and 7A15A Amplifier equipped with 10X probe). A 7A13 Differential Comparator with 10X probe was used to obtain the calibrated offset voltage.

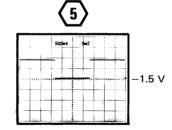
NOTE

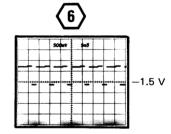


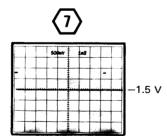


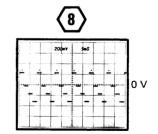


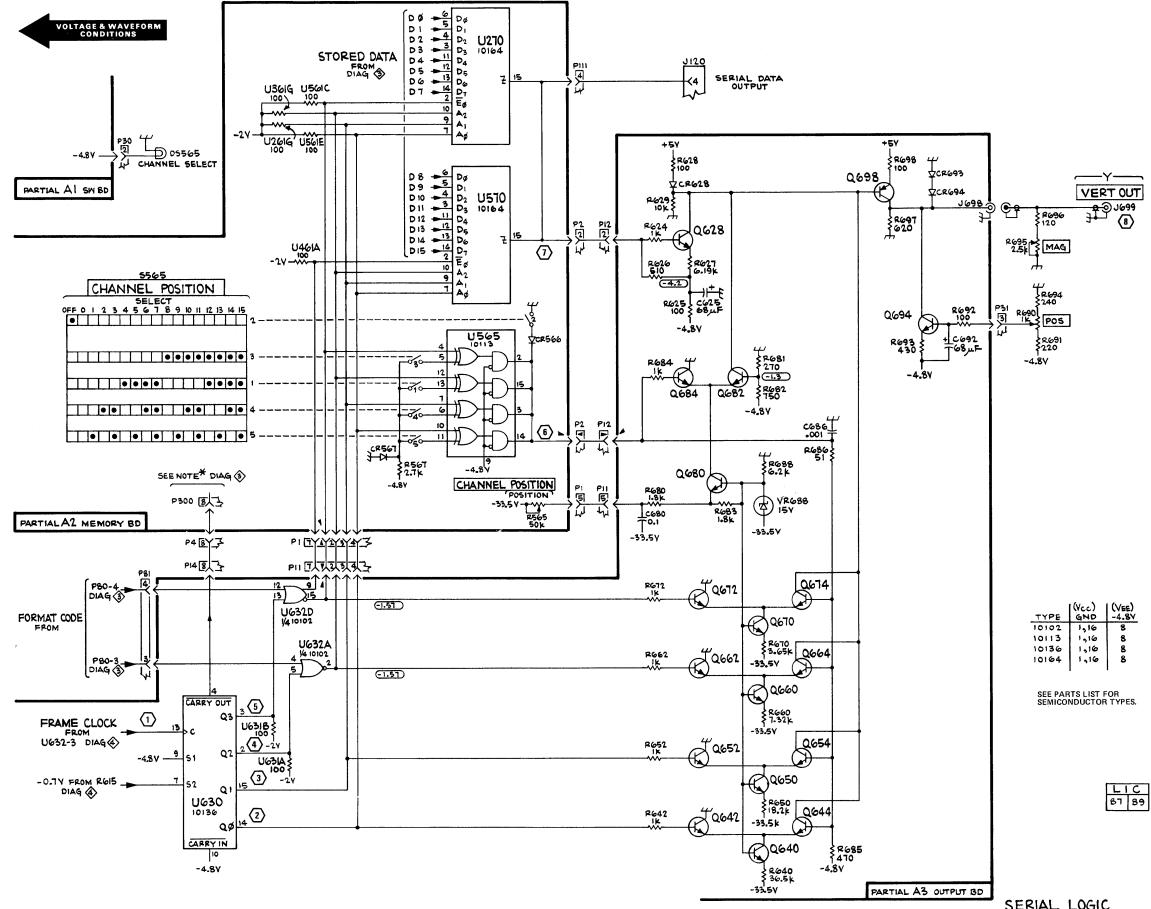








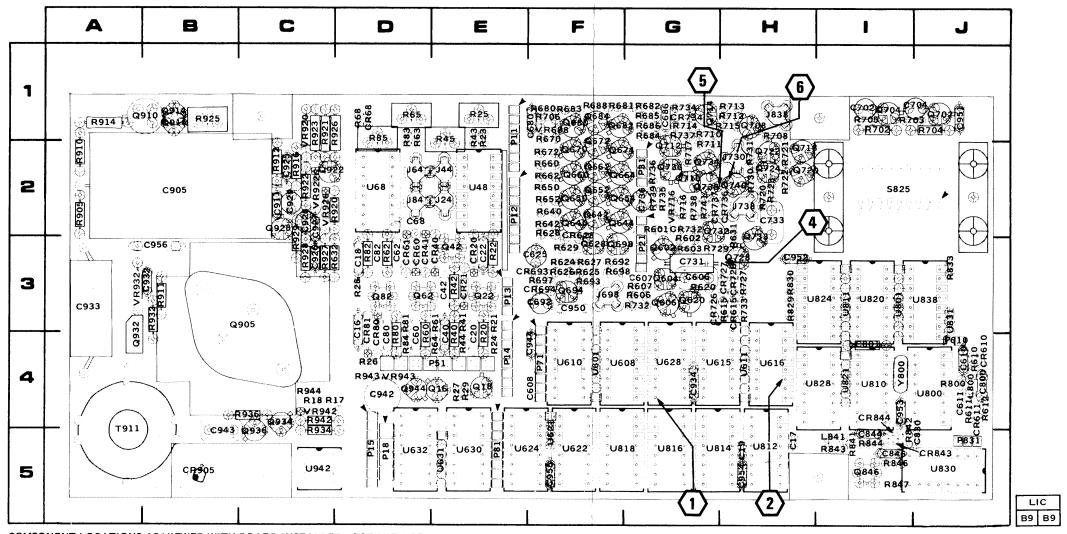




LA501

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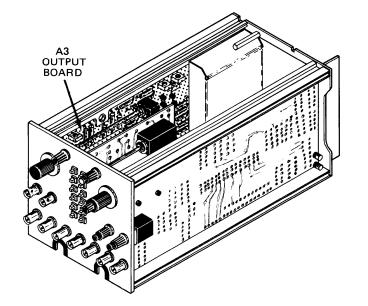
SERIAL LOGIC
VERTICAL SIGNAL OUTPUTS



COMPONENT LOCATIONS AS VIEWED WITH BOARD INSTALLED. FOR VIEW OF COMPONENT SIDE OF BOARD, SEE FIGURE 8-9 IN THIS SECTION. FOR LOCATION OF COMPONENTS MOUNTED ON REAR OF BOARD, SEE FIGURE 8-8.

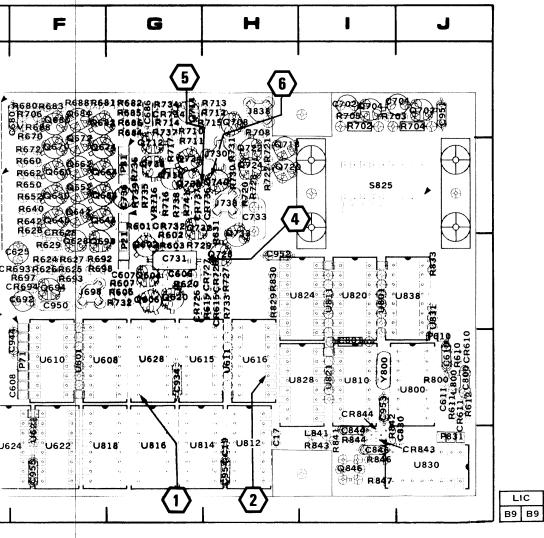
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Fig. 8-19. A3—Output circuit board. Component locations as viewed with board installed.



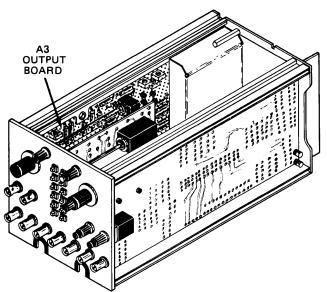
CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO
C16	3D	C704	1J	C950
C17	5H	C731	3G	C951
C18	3D	C733	2H	C952
C19	5H	C736	2G	C953
C20	4E	C800	4J	C954
C40	4E	C801	41	C955
C42	3E	C830	5J	C956
C60	4D	C844	51	
C62	3D	C846	51	CR20
C68	2D	C905	2B	CR21
C80	4D	C911	2C	CR40
C82	3D	C925	2C	CR41
C606	3G	C926	3C	CR60
C607 C608	3G 4F	C927	2C	CR61
C610	4J	C928	2C	CR68
C611	4J	C929	2C	CR80
C625	3F	C932	3B	CR81
C650	3F	C933	3A	CR610
C666	1G	C934	4G	CR611
C680	1F	C942	4D	CR615
C692	3F	C943	5B	CR628
C702	11	C944	4F	CR693

CKT	GRID	CKT	GRID	CKT
NO	COORD	NO	COORD	NO
R42	3E	R611	4J	R682
R43	1 E	R612	4J	R683
R44	4E	R615	3H	R684
R45	1E	R620	3G	R685
R60	4D	R624	3F	R686
R61	3E	R625	3F	R688
R62	3D	R626	3F	R692
R63	1D	R627	3F	R693
R64	4E	R628	2F	R697
R65	1D	R629	3F	R698
R68	1D	R631	3H	R702
R80	4D	R632	3D	R703
R82	3D	R640	2F	R704
R83	1D	R642	2F	R705
R84	4D	R650	2F	R706
R85	1D	R652	2F	R708
R601	2G	R660	2F	R710
R602	3G	R662	2F	R711
R603	3G	R670	1F	R712
R606	3G	R672	2F	R713
R607	3G	R680	1F	R714
R610	4J	R681	1F	R715



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nent locations as viewed with board installed.



CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD
C16	3D	C704	1J	C950	3F	CR694	3F	L841	51	Q602	3G	Q702	1J	Q922	2C
C17	5H	C731	3G	C951	1J	CR726	3G			Q604	3G	Q704	11	Q928	2C
C18	3D	C733	2H	C952	3H	CR727	3H	P11	1E	Q606	3G	Q708	1H	Q932	4A
C19	5H	C736	2G	C953	41	CR728	3H	P12	2E	Q620	3G	Q712	2G	Q934	4C
C20	4E	C800	4J	C954	5H	CR732	2G	P13	3E	Q628	3F	Q714	1G	Q936	5C
C40	4E	C801	41	C955	5F	CR734	1G	P14	4E	Q640	2F	Q716	2G	Q944	4D
C42	3E	C830	5J	C956	3B	CR736	2H	P15	5D	Q642	2F	Q718	2H		
C60	4D	C844	51			CR737	2G	P18	5D	Q644	2G	Q720	2H	R17	4C
C62	3D	C846	51	CR20	3E	CR843	51	P21	3G	Q650	2F	Q722	2H	R18	4C
C68	2D	C905	2B	CR21	3E	CR844	51	P31	2G	Q652	2F	Q724	2H	R20	4E
C80	4D	C911	2C	CR40	3E	CR905	5B	P51	4E	Q654	2G	Q728	3H	R21	3E
C82	3D	C925	2C	CR41	3D			P71	4F	Q660	2F	Q732	2G	R22	3E
C606	3G	C926	3C	CR60	3D	J24	2E	P81	5E	Q662	2F	Q733	3H	R23	1E
C607 C608	3G 4F	C927	2C	CR61	3D	J44	2E	P610	4J	Q664	2G	Q734	2G	R24	4E
C610	47 4J	C928	2C	CR68	1D	J64	2D	P831	5J	Q670	2F	Q736	2G	R25	1E
C611	4J	C929	2C	CR80	3D	J84	2D			Q672	2F	Q738	2G	R26	4D
C625	3F	C932	3B	CR81	3D	J698	3F	Q16	4E	Q674	2G	Q740	2H	R27	4E
C650	3F	C933	3A	CR610	4J	J730	2H	Q18	4E	Q680	1F	Q846	51	R28	3D
C666	1G	C934	4G	CR611	4J	J738	2H	Q22	3E	Q682	1F	Q905	3C	R29	4E
C680	1F	C942	4D	CR615	3H	J838	1H	Q42	3E	Q684	1F	Q910	1B	R31	3D
C692	3F	C943	5B	CR628	2F			Q62	3D	Q694	3F	Q914	1B	R40	4E
C702	11	C944	4F	CR693	3F	L800	4J	Q82	3D	Q698	3F	Q916	1B	R41	3E

CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD
R42	3E	R611	4J	R682	1G	R716	2G	R833	31	R934	5C	U630	5E	VR716	2G
R43	1E	R612	4J	R683	1F	R717	2G	R841	51	R936	4C	U631	5E	VR920	1C
R44	4E	R615	3H	R684	1G	R720	2H	R842	5J	R942	4C	U632	5D	VR922	2C
R45	1E	R620	3G	R685	1G	R721	2H	R843	51	R943	4D	U800	4J	VR926	2C
R60	4D	R624	3F	R686	1G	R722	2H	R844	51	R944	4C	U801	31	VR942	4C
R61	3E	R625	3F	R688	1F	R723	2H	R846	51			U810	41	VR943	4D
R62	3D	R626	3F	R692	3F	R727	3H	R847	51	S825	21	U811	31		
R63	1D	R627	3F	R693	3F	R729	3G	R905	2A			U812	5H	Y800	41
R64	4E	R628	2F	R697	3F	R730	2H	R910	2A	T911	5A	U814	5H		
R65	1D	R629	3F	R698	3F	R731	2H	R911	3B			U816	5G		
R68	1D	R631	3H	R702	11	R732	3G	R912	2C	U48	2E	U818	5G		
R80	4D	R632	3D	R703	1J	R733	3H	R914	1A	U68	2D	U820	31		
R82	3D	R640	2F	R704	1J	R734	1G	R916	2C	U601	4F	U821	41		
R83	1D	R642	2F	R705	11	R735	2G	R920	2D	U608	4G	U824	31		
R84	4D	R650	2F	R706	1F	R736	2G	R921	1C	U610	4F	U828	41		
R85	1D	R652	2F	R708	1H	R737	1G	R922	2C	U611	4H	U830	5J		
R601	2G	R660	2F	R710	1G	R738	2G	R923	1C	U615	4G	U831	3J		
R602	3G	R662	2F	R711	2G	R739	2G	R925	1B	U616	4H	U838	3J		
R603	3G	R670	1F	R712	1H	R741	2G	R927	3C	U621	5F	U932	3A		
R606	3G	R672	2F	R713	1H	R800	4J	R928	3C	U622	5F	U942	5C		
R607	3G	R680	1F	R714	1G	R829	3H	R929	3C	U624	5F				
R610	4J	R681	1F	R715	1H	R830	3H	R932	3B	U628	4G	VR688	1F		

VOLTAGE AND WAVEFORM CONDITIONS

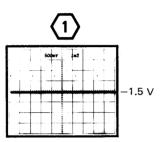
The voltages and waveforms shown were obtained with the LA 501 controls set as follows:

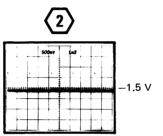
SAMPLE INTERVAL, 50 ns; INPUT THRESHOLD, TTL; FORMAT, CH 0-3 X1024; TRIGGER, CENTER; SLOPE, +; SOURCE, CH 0; INPUTS, BNC; RECORD (DISPLAY TIME), 1 s; CHANNEL/POSITION (SELECT), channel 0; CHANNEL/POSITION (POSITION), fully counterclockwise. A 10X probe was connected from the front panel CH 0 BNC input connector to a +5 volt pulse (5 microsecond duration, 100 microsecond period).

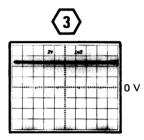
Voltage Conditions. The voltages shown on the diagram were obtained using a digital multimeter with 10 M Ω input impedance (Tektronix DM 501 Digital Multimeter or 7D13 Digital Multimeter used with readout equipped, 7000-series oscilloscope).

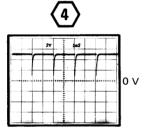
Waveform Conditions. The waveforms shown below were obtained using a test oscilloscope system with 10 M Ω input impedance and at least 60 MHz bandwidth (Tektronix 465 Oscilloscope equipped with 10X probe, or 7603 Oscilloscope, 7853A Time Base, and 7A15A Amplifier equipped with 10X probe). A 7A13 Differential Comparator with 10X probe was used to obtain the calibrated offset voltage.

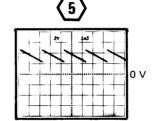
NOTE

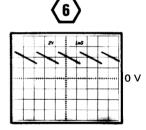


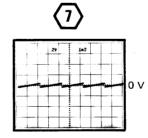




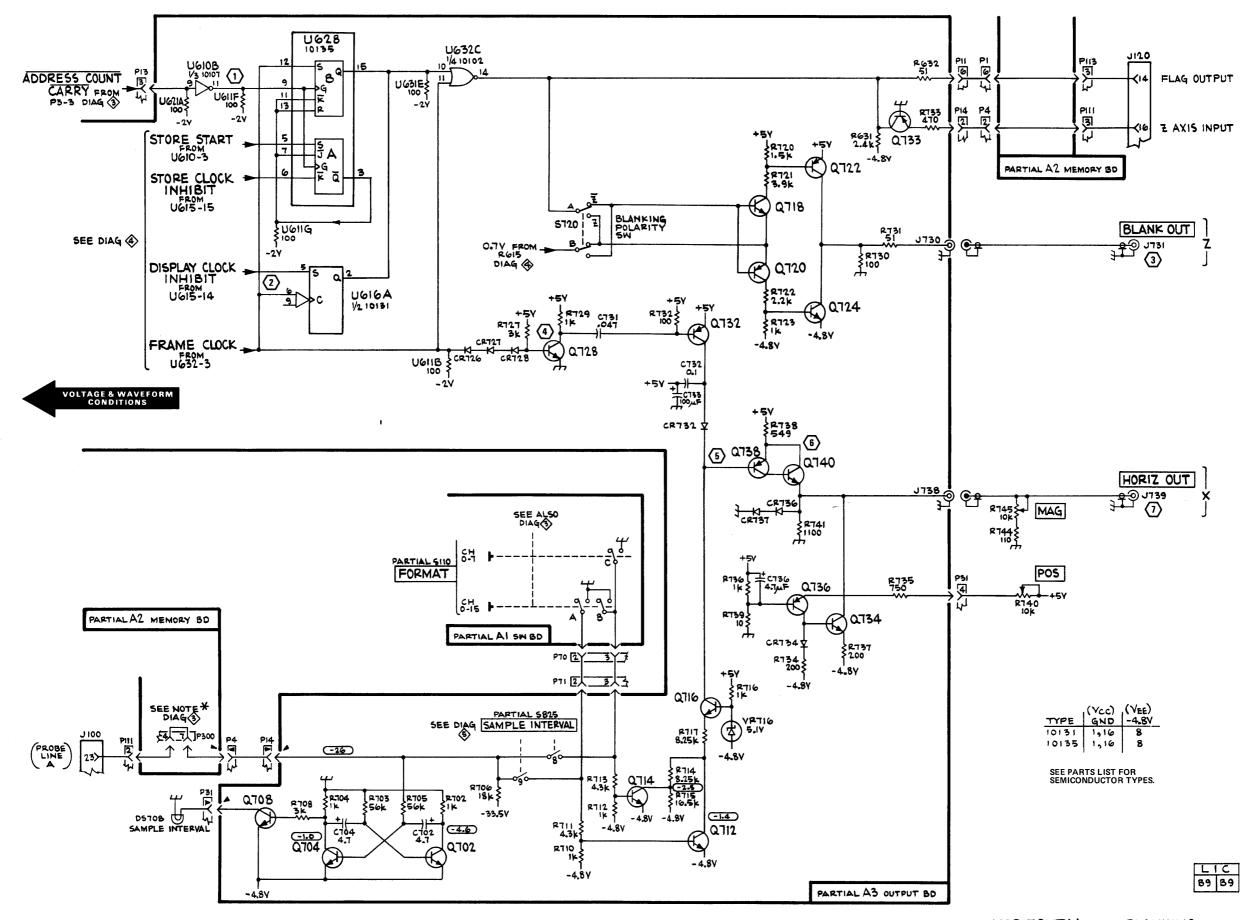




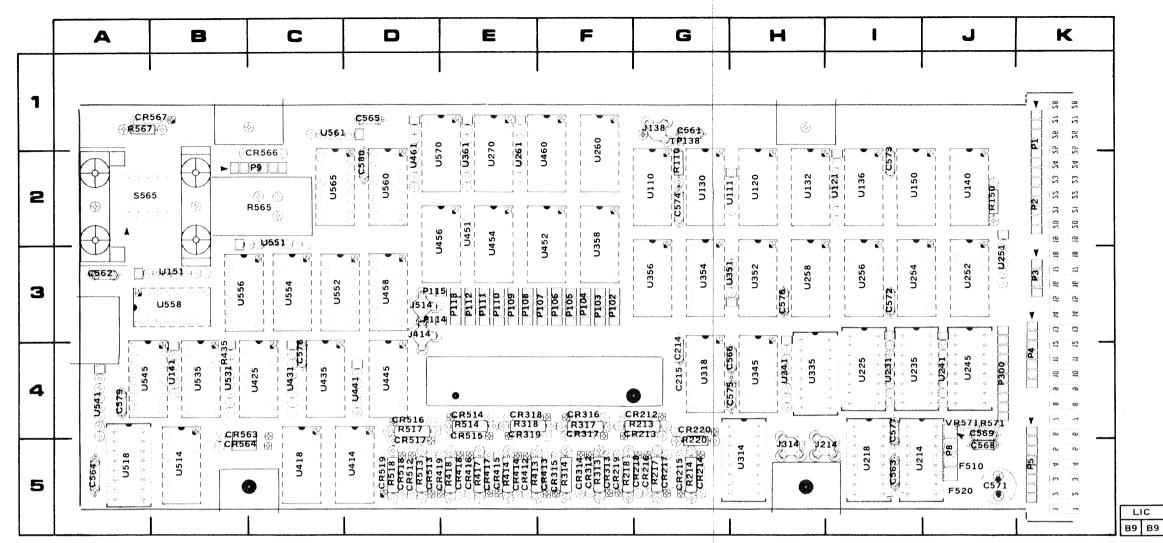




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HORIZONTAL AND BLANKING SIGNAL OUTPUTS



COMPONENT LOCATIONS AS VIEWED WITH BOARD INSTALLED. FOR VIEW OF COMPONENT SIDE OF BOARD, SEE FIGURE 8-11 IN THIS SECTION.

Fig. 8-20. A2-Memory circuit board. Component locations as viewed with board installed.

CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD
C214 C215	4G 4G	CR212 CR213	4G 4G	CR414 CR415	5E 5E	F520	5J	P106 P107	3F 3F	R313 R314	5F 5F	U120 U121	2H	U256	31	U425	4C	U554	3C
C561 C562	1G 3A	CR214 CR215	5G 5G	CR416 CR417	5E 5E	J138 J214	1G 5H	P108 P109	3E 3E	R317 R318	4F 4E	U130	2H	U258 U260	3H 2F 2E	U431 U435 U441	4C 4C 4D	U556 U558 U560	3B 3B 2D
C563 C564	51 5A	CR216 CR217	5G 5G	CR418 CR419	5E 5D	J314 J414	5H 3D	P110 P111	3E 3E	R413 R414	5E 5E	U136 U140	2I 2J	U261 U270 U314	2E 2E 5H	U445 U451	5D 2E	U561 U565	1C 2C
C565 C566 C568	1D 4H 5J	CR218 CR219	5G	CR512 CR513	5D 5D	J514	3D	P112 P113	3E 3E	R417 R418	5E 5E	U141 U150	4B 2l	U318 U335	5 п 4Н	U452 U454	3F 2E	U570	2E
C569 C571	4J 5J	CR220 CR312	5F	CR514 CR515	4E 4E	P1 P2	1K 2K	P114 P115	3D 3D	R435 R513 R514	4C 5D 4E	U151 U214	3B 5I	U341 U345	4H 4H	U456 U458	2E 3D	VR571	4 J
C572 C573	31 21	CR313 CR314	5F 5F	CR516	4D 5D	P3 P4	3K 4K	P300	4J	R517 R518	4D 5D	U218 U225	51 41	U351	3H 3H	U460 U461 U514	2F 2D 4B		
C574 C575	2. 4H	CR315 CR316	5F 4F	CR518	5D 5D	P5 P8	5K 5J	R110 R150	2G 2J	R565 R567	2C 1A	U231 U235	41	U352 U354	311	U518	5A		
C576	3H	CR317 CR318	4F 4E	CR563	4B 5B	P9 P102	2C 3F	R213 R214	4G 5G	R571 S565	4J 2A	U241 U245	4J	U356 U358		U531 U535	4B 4B		
C577 C578	41 4C	CR319	4E	CR566	2C	P103	3F	R217	5G			U251	3J	U361 U411	2E 2H	U541 U545	4A 4A		
C579 C580	4A 2D	CR412 CR413	5E	CR567 F510	1A 5J	P104 P105	3F 3F	R218 R220	5F 5G	U110 U111	2G 2H	U252 U254	31 31 31	U414 U418	5D 5C	U551 U552	2C 3C		

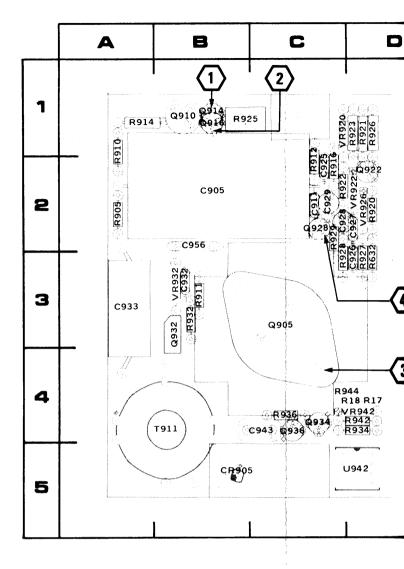
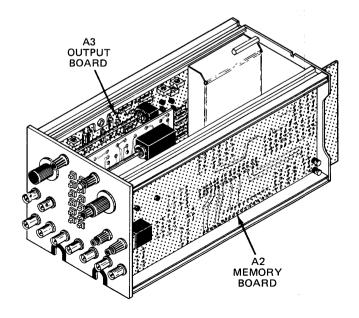
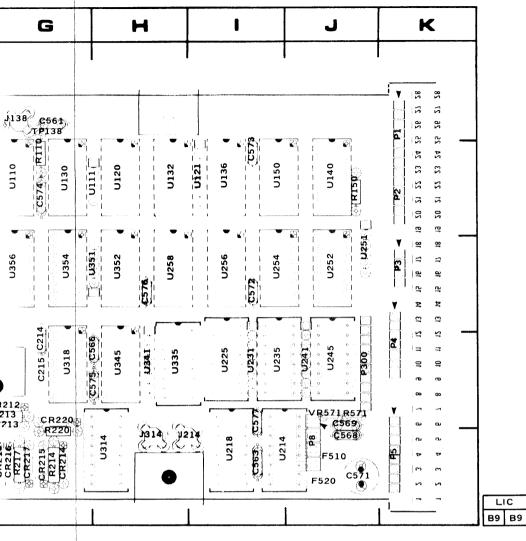


Fig. 8-21. A3—Output circuit board. Component locations as viewed with board



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A B C 1 R914 Q910 0914 R925 C905 2 C956 Q932 VR932 C932 R931 3 C933 Q905 R944 R18 R17 OVR942 R942 R934 4 C943 8936 Т911 CP**9**05 U942 5

B9 B9

CKT NO	GRID COORD	CKT NO	GRID COORD	CKT NO	GRID COORD
C905	2B	Q932	3B	R928	3C
C911	2C	Q934	4C	R929	2C
C925	2C	Q936	4C	R932	3B
C926	3D			R934	4D
C927	2D	R17	4D	R936	4C
C928	2C	R18	4D	R942	4D
C929	2C	R632	3D	R944	4D
C932	3B	R905	2A		
C933	3A	R910	1A	T911	4B
C943	4C	R911	3B		
C956	2B	R912	2C	U932	3B
		R914	1A	U942	5D
CR905	5B	R916	2C		
		R920	2D	VR920	1C
Q905	3C	R921	1D	VR922	2D
Q910	1B	R922	2C	VR926	2D
Q914	1B	R923	1D	VR942	4D
Q916	1B	R925	1B		
Q922	2D	R926	1D		
Q928	2C	R927	3D		

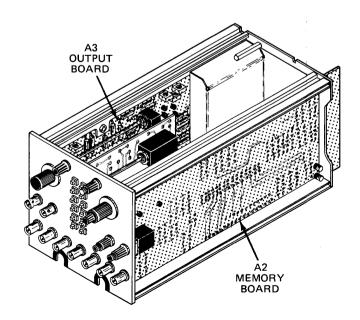
COMPONENT LOCATIONS AS VIEWED WITH BOARD INSTALLED! FOR VIEW OF COMPONENT SIDE OF BOARD, SEE FIGURE 8-5 IN THIS SECTION. FOR LOCATION OF COMPONENTS MOUNTED ON REAR OF BOARD, SEE FIGURE 8-4.

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Fig. 8-21. A3—Output circuit board. Component locations as viewed with board installed.

lions as viewed with board installed.

СКТ	GRID	СКТ	GRID	СКТ	GRID	СКТ	GRID
NO	COORD	NO	COORD	NO	COORD	NO	COORD
U120	2H	LIGEC	31	U425	4C	U554	3C
U121	21	U256					
U130		U258	3H	U431	4C	U556	3B
	211	U260	2F	U435	4C	U558	3B
U132	2H	U261	2E	U441	4D	U560	2D
U136	21	U270	2E	U445	5D	U561	1C
U140	2J	U314	5H	U451	2E	U565	2C
U141	4B	U318		U452	3F	U570	2E
U150	21	U335	4H	U454	2E		
U151	3B	U341	4H	U456	2E	VR571	4J
U214	51	U345	4H	U458	3D	*****	••
U218	51	U351	3H	U460	2F		
U225	41			U461	2D		
U231	41	U352	3H	U514	4B		
		U354		U518	5A		
U235	41	U356		U531	4B		
U241	4J	U358		U535	4B		
U245	4J	U361	2E	U541	4A		
U251	3J	U411	2H	U545	4A		
U252	3J	U414	5D	U551	2C		
U254	31	U418	5C	U552	3C		



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VOLTAGE AND WAVEFORM CONDITIONS

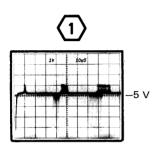
The voltages and waveforms shown were obtained with the LA 501 controls set as follows:

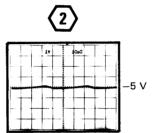
SAMPLE INTERVAL, 50 ns; INPUT THRESHOLD, TTL; FORMAT, CH 0-3 X1024; TRIGGER, CENTER; SLOPE, +; SOURCE, CH 0; INPUTS, BNC; RECORD (DISPLAY TIME), 1 s; CHANNEL/POSITION (SELECT), channel 0; CHANNEL/POSITION (POSITION), fully counterclockwise. A 10X probe was connected from the front panel CH 0 BNC input connector to a +5 volt pulse (5 microsecond duration, 100 microsecond period).

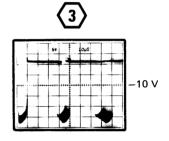
Voltage Conditions. The voltages shown on the diagram were obtained using a digital multimeter with 10 $M\Omega$ input impedance (Tektronix DM 501 Digital Multimeter or 7D13 Digital Multimeter used with readout equipped, 7000-series oscilloscope).

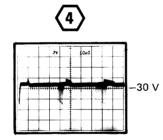
Waveform Conditions. The waveforms shown below were obtained using a test oscilloscope system with $10~M\Omega$ input impedance and at least 60 MHz bandwidth (Tektronix 465 Oscilloscope equipped with 10X probe, or 7603 Oscilloscope, 7B53A Time Base, and 7A15A Amplifier equipped with 10X probe). A 7A13 Differential Comparator with 10X probe was used to obtain the calibrated offset voltage.

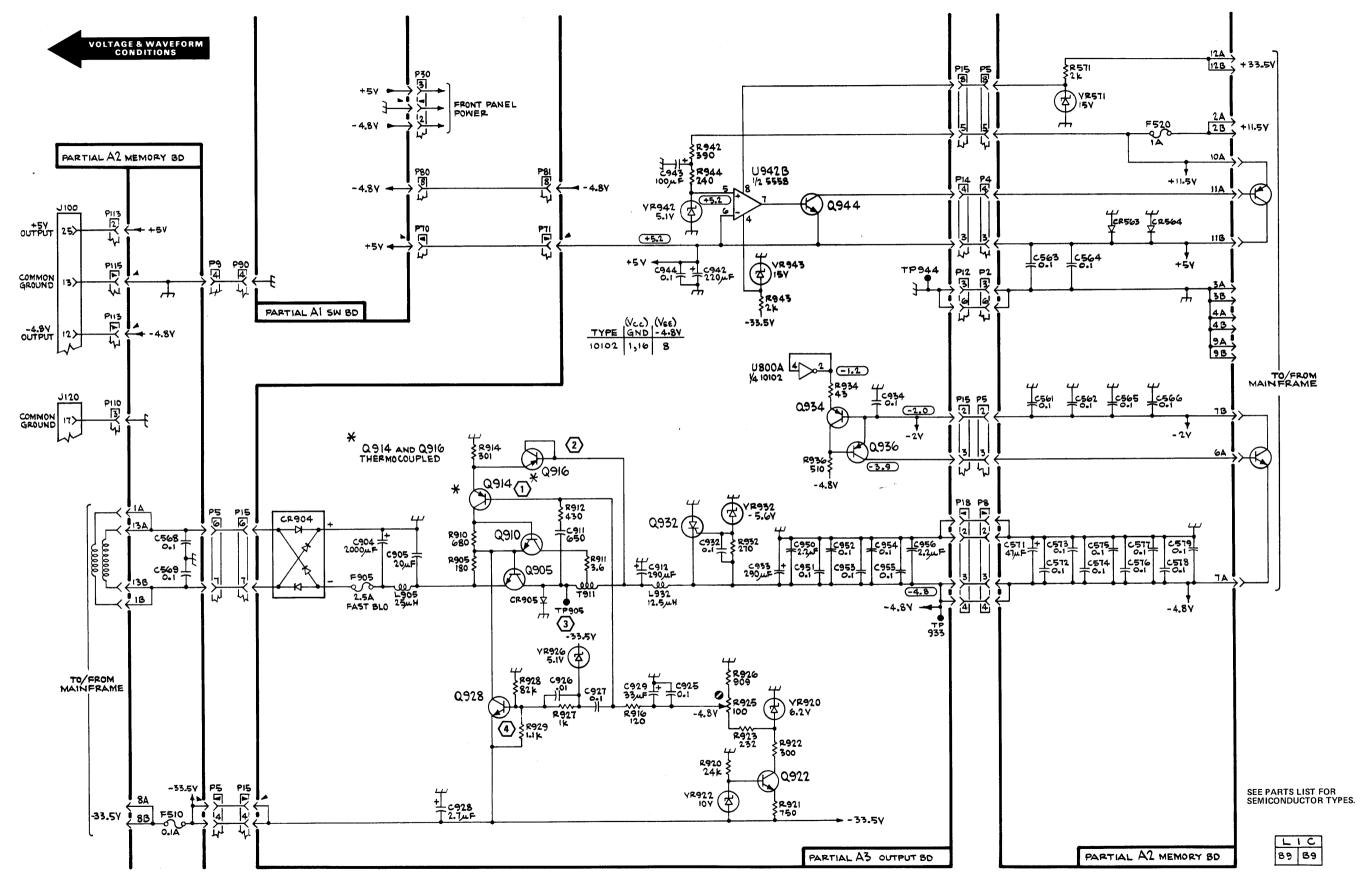
NOTE











POWER SUPPLIES (8)

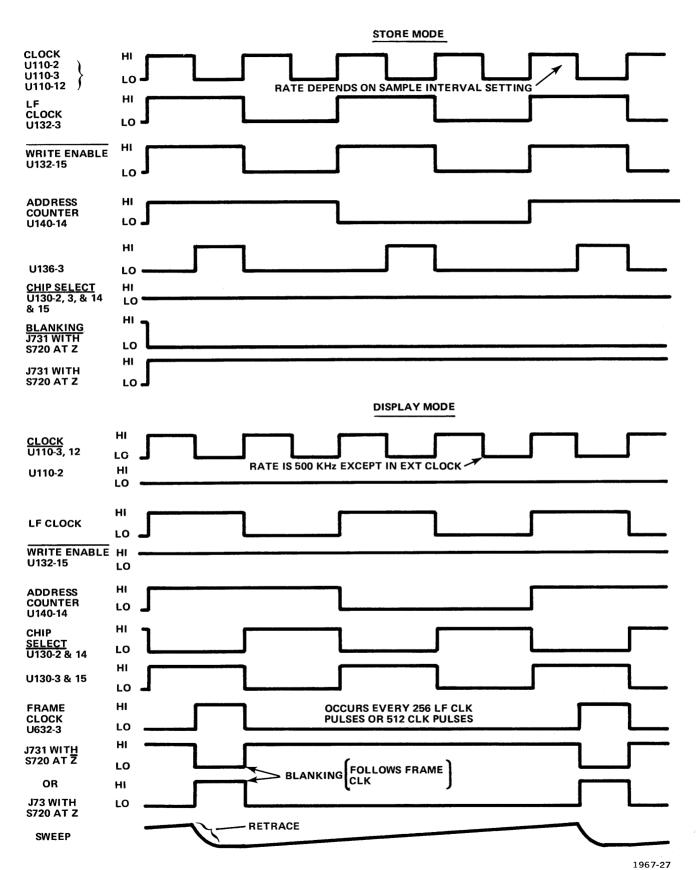
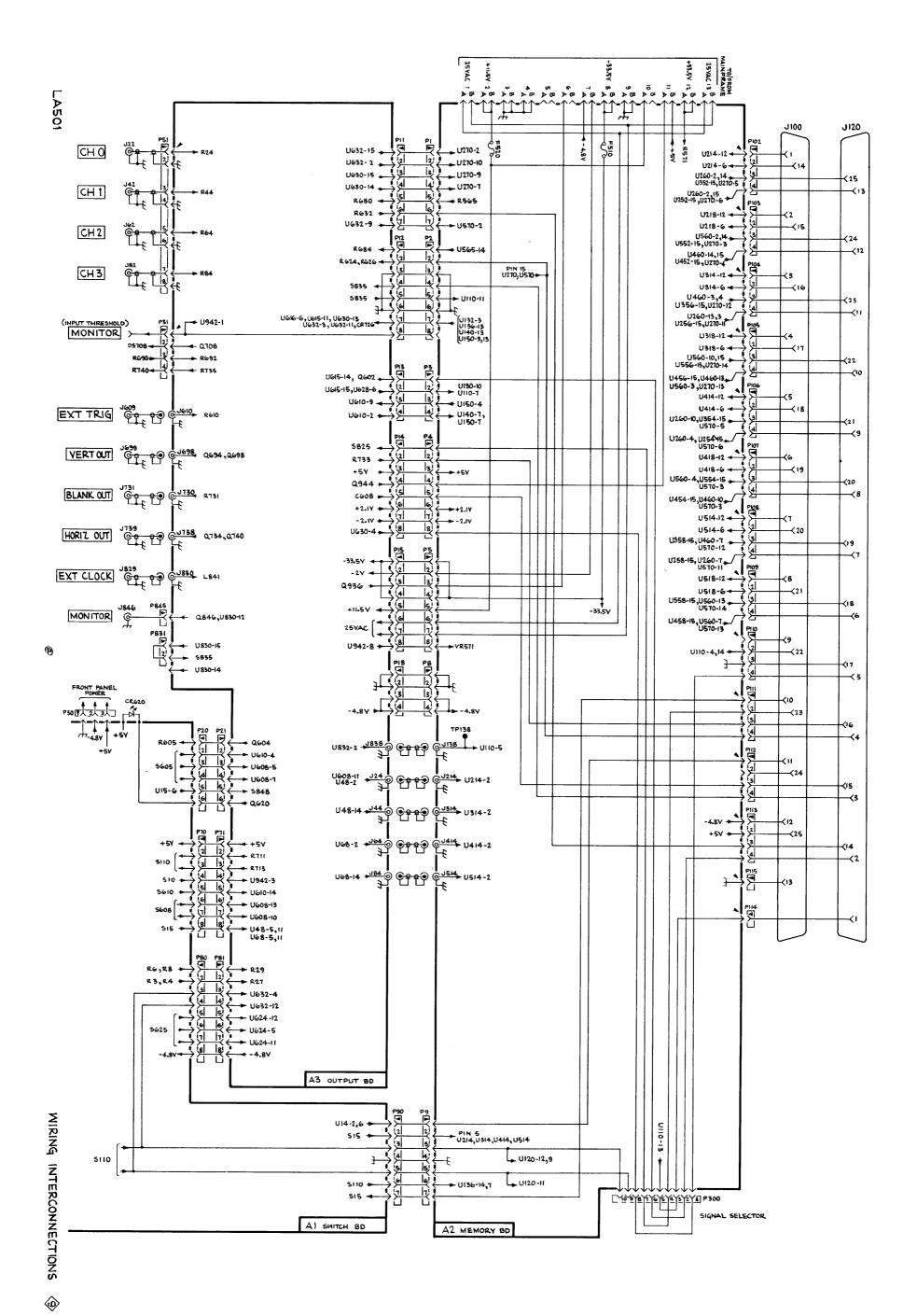


Fig. 8-22. Composite logic timing for CH 0-7 X512 format.



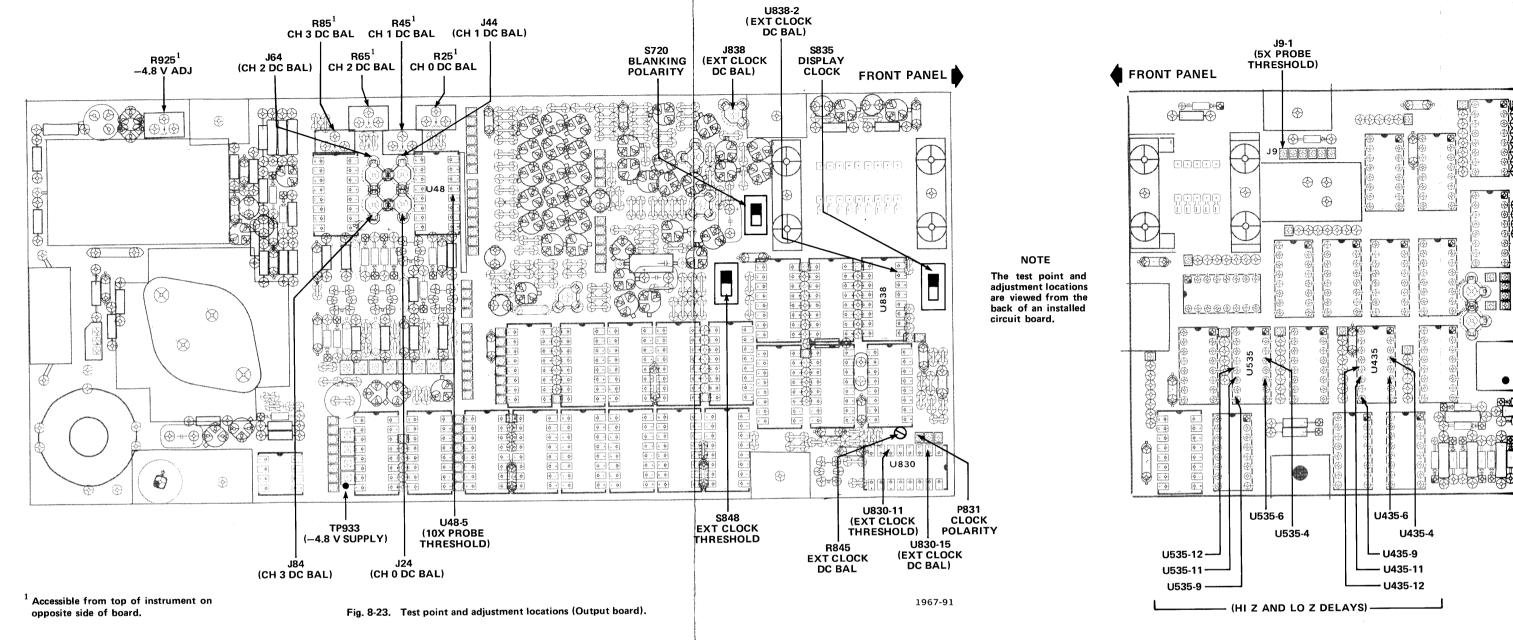
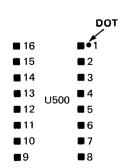
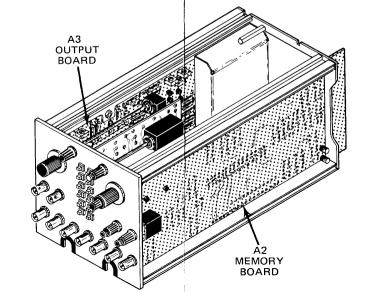
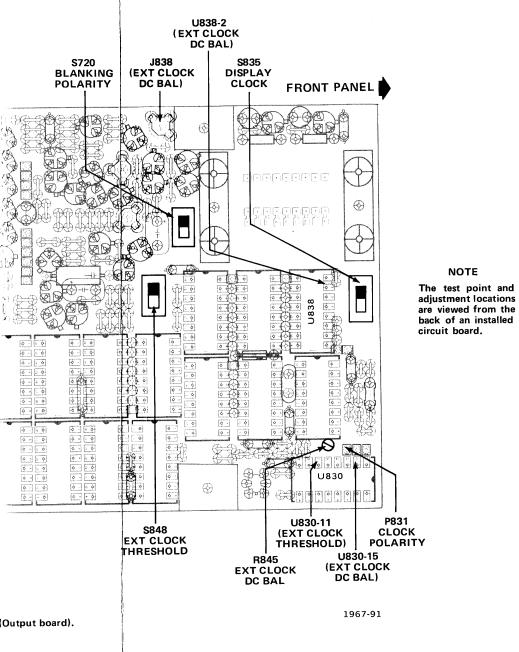


Fig. 8-24. Te



Typical integrated circuit pin numbering sequence as viewed from back of boards. Pin 1 is coded with an adjacent dot.





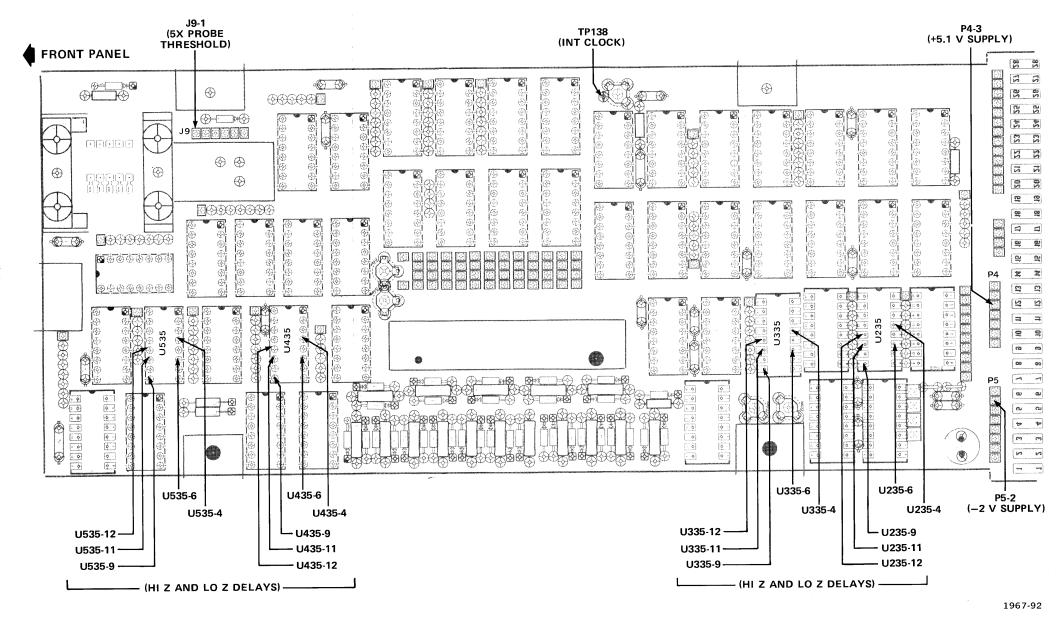
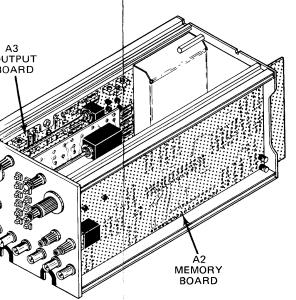


Fig. 8-24. Test point and adjustment locations (Memory board).



REPLACEABLE MECHANICAL PARTS

PARTS ORDERING INFORMATION

Replacement parts are available from or through your local Tektronix, Inc. Field Office or representative.

Changes to Tektronix instruments are sometimes made to accommodate improved components as they become available, and to give you the benefit of the latest circuit improvements developed in our engineering department. It is therefore important, when ordering parts, to include the following information in your order: Part number, instrument type or number, serial number, and modification number if applicable.

If a part you have ordered has been replaced with a new or improved part, your local Tektronix, Inc. Field Office or representative will contact you concerning any change in part number.

Change information, if any, is located at the rear of this manual.

SPECIAL NOTES AND SYMBOLS

X000 Part first added at this serial number

00X Part removed after this serial number

FIGURE AND INDEX NUMBERS

Items in this section are referenced by figure and index numbers to the illustrations.

INDENTATION SYSTEM

This mechanical parts list is indented to indicate item relationships. Following is an example of the indentation system used in the description column.

1 2 3 4 5

Name & Description

Assembly and/or Component Attaching parts for Assembly and/or Component

Detail Part of Assembly and/or Component Attaching parts for Detail Part

Parts of Detail Part Attaching parts for Parts of Detail Part

Attaching Parts always appear in the same indentation as the item it mounts, while the detail parts are indented to the right. Indented items are part of, and included with, the next higher indentation. The separation symbol - - - * - - - indicates the end of attaching parts.

Attaching parts must be purchased separately, unless otherwise specified.

ITEM NAME

In the Parts List, an Item Name is separated from the description by a colon (:). Because of space limitations, an Item Name may sometimes appear as incomplete. For further Item Name identification, the U.S. Federal Cataloging Handbook H6-1 can be utilized where possible.

ABBREVIATIONS

**	INCH	ELCTRN	ELECTRON	IN	INCH	SE	SINGLE END
#	NUMBER SIZE	ELEC	ELECTRICAL	INCAND	INCANDESCENT	SECT	SECTION
ACTR	ACTUATOR	ELCTLT	ELECTROLYTIC	INSUL	INSULATOR		SEMICONDUCTOR
ADPTR	ADAPTER	ELEM	ELEMENT	INTL	INTERNAL	SHLD	SHIELD
ALIGN	ALIGNMENT	EPL	ELECTRICAL PARTS LIST	LPHLDR	LAMPHOLDER	SHLDR	SHOULDERED
AL	ALUMINUM	EQPT	EQUIPMENT	MACH	MACHINE	SKT	SOCKET
ASSEM	ASSEMBLED	EXT	EXTERNAL	MECH	MECHANICAL	SL	SLIDE
ASSY	ASSEMBLY	FIL	FILLISTER HEAD	MTG	MOUNTING	SLFLKG	SELF-LOCKING
ATTEN	ATTENUATOR	FLEX	FLEXIBLE	NIP	NIPPLE	SLVG	SLEEVING
AWG	AMERICAN WIRE GAGE	FLH	FLAT HEAD		NOT WIRE WOUND	SPR	SPRING
BD	BOARD	FLTR	FILTER	OBD	ORDER BY DESCRIPTION	SQ	SQUARE
BRKT	BRACKET	FR	FRAME or FRONT	OD	OUTSIDE DIAMETER	SST	STAINLESS STEEL
BRS	BRASS	FSTNR	FASTENER	OVH	OVAL HEAD	STL	STEEL
BRZ	BRONZE	FT	FOOT	PH BRZ	PHOSPHOR BRONZE	sw	SWITCH
BSHG	BUSHING	FXD	FIXED	PL	PLAIN or PLATE	T	TUBE
CAB	CABINET	GSKT	GASKET	PLSTC	PLASTIC	TERM	TERMINAL
CAP	CAPACITOR	HDL	HANDLE	PN	PART NUMBER	THD	THREAD
CER	CERAMIC	HEX	HEXAGON	PNH	PAN HEAD	THK	THICK
CHAS	CHASSIS	HEX HD	HEXAGONAL HEAD	PWR	POWER	TNSN	TENSION
CKT	CIRCUIT	HEX SOC	HEXAGONAL SOCKET	RCPT	RECEPTACLE	TPG	TAPPING
COMP	COMPOSITION	HLCPS	HELICAL COMPRESSION	RES	RESISTOR	TRH	TRUSS HEAD
CONN	CONNECTOR	HLEXT	HELICAL EXTENSION	RGD	RIGID	V	VOLTAGE
COV	COVER	HV	HIGH VOLTAGE	RLF	RELIEF	VAR	VARIABLE
CPLG	COUPLING	IC	INTEGRATED CIRCUIT	RTNR	RETAINER	W/	WITH
CRT	CATHODE RAY TUBE	ID	INSIDE DIAMETER	SCH	SOCKET HEAD	WSHR	WASHER
DEG	DEGREE	IDENT	IDENTIFICATION	SCOPE	OSCILLOSCOPE	XFMR	TRANSFORMER
DWR	DRAWER	IMPLR	IMPELLER	SCR	SCREW	XSTR	TRANSISTOR

CROSS INDEX MFR. CODE NUMBER TO MANUFACTURER

MFR.CODE	MANUFACTURER	ADDRESS	CITY,STATE,ZIP
0000C	GETTIG ENGINEERING AND MANUFACTURING CO.		SPRINGMILL, PA 16875
00779	AMP, INC.	P. O. BOX 3608	HARRISBURG, PA 17105
01295	TEXAS INSTRUMENTS, INC.,		
0200	SEMICONDUCTOR GROUP	P. O. BOX 5012	DALLAS, TX 75222
06982	MOORE, HOWARD J., CO.	105 E. 16TH ST.	NEW YORK, NY 10003
07707	USM CORP., USM FASTENER DIV.	510 RIVER RD.	SHELTON, CT 06484
08261	SPECTRA-STRIP CORP.	7100 LAMPSON AVE.	GARDEN GROVE, CA 92642
12327	FREEWAY CORP.	9301 ALLEN DR.	CLEVELAND, OH 44125
22526	BERG ELECTRONICS, INC.	YOUK EXPRESSWAY	NEW CUMBERLAND, PA 17070
23499	GAVITT WIRE AND CABLE, DIVISION OF		-
	RSC INDUSTRIES, INC.	455 N. QUINCE ST.	ESCONDIDO, CA 92025
24931	SPECIALTY CONNECTOR CO., INC.	3560 MADISON AVE.	INDIANAPOLIS, IN 46227
71159	BRISTOL SOCKET SCREW, DIV. OF		
	AMERICAN CHAIN AND CABLE CO., INC.	40 BRISTOL ST.	WATERBURY, CT 06720
71279	CAMBRIDGE THERMIONIC CORP.	445 CONCORD AVE.	CAMBRIDGE, MA 02138
73743	FISCHER SPECIAL MFG. CO.	446 MORGAN ST.	CINCINNATI, OH 45206
74445	HOLO-KROME CO.	31 BROOK ST. WEST	HARTFORD, CT 06110
77969	RUBBERCRAFT CORP. OF CALIF., LTD.	1800 W. 220TH ST.	TORRANCE, CA 90507
78189	ILLINOIS TOOL WORKS, INC.	•	
,	SHAKEPROOF DIVISION	ST. CHARLES ROAD	ELGIN, IL 60120
79807	WROUGHT WASHER MFG. CO.	2100 S. O BAY ST.	MILWAUKEE, WI 53207
80009	TEKTRONIX, INC.	P. O. BOX 500	BEAVERTON, OR 97077
82647	TEXAS INSTRUMENTS, INC.,		
	CONTROL PRODUCTS DIV.	34 FOREST ST.	ATTLEBORO, MA 02703
83385	CENTRAL SCREW CO.	2530 CRESCENT DR.	BROADVIEW, IL 60153
86445	PENN FIBRE AND SPECIALTY CO., INC.	2032 E. WESTMORELAND ST.	PHILADELPHIA, PA 19134
87308	N. L. INDUSTRIES, INC., SOUTHERN SCREW		
07300	DIV.	P. O. BOX 1360	STATESVILLE, NC 28677
89663	REESE, J. RAMSEY, INC.	71 MURRAY ST.	NEW YORK, NY 10007
97464	INDUSTRIAL RETAINING RING CO.	57 CORDIER ST.	IRVINGTON, NJ 07111
98159	RUBBER TECK, INC.	19115 HAMILTON AVE.	GARDENA, CA 90247

Fig. & Index No.	Tektronix Part No.	Serial/Model N Eff Dsco		1 2 3 4 5	Name & Description	Mfr Code	Mfr Part Number
1-1	337-1399-04		2	SHIELD, ELEC:SID	F	80009	337-1399-04
-2	200-1931-00		2	COVER, SCOPE: TOP		80009	200-1931-00
- 3	211-0038-00		2		-40 X 0.312"100 DEG,FLH STL	83385	OBD
-4	366-1023-00 213-0246-00			KNOB: GRAY	X 0.093 INCH L, HEX SOC	80009 71159	366-1023-00 OBD
-5	366-1630-00				ID,1.125 OD,0.79 H	80009	366-1630-00
-	213-0153-00			•	X 0.125 INCH, HEX SOC STL	74445	OBD
- 6	366-1631-00				ID,1.25 OD,0.79 H	80009	366-1631-00
_	213-0153-00		2	. SETSCREW:5-40	X 0.125 INCH, HEX SOC STL	74445	OBD
- 7	366-0494-00)	1	KNOB: GRAY	·	80009	366-0494-00
	213-0153-00)	1	. SETSCREW:5-40	X 0.125 INCH, HEX SOC STL	74445	OBD
-8	366-1059-00)	1	PUSH BUTTON: GRA	Y	80009	366-1059-00
-9	366-1319-00)	2	KNOB: GRAY		80009	366-1319-00
		-	_	. EACH KNOB INC	LUDES:		
	213-0725-00)	1	. SETSCREW: 3-48	X 0.095 INCH, HEX SOC STL	74445	
-10	366-1334-00)	3	KNOB: GRAY		80009	366-1344-00
		•	_	. EACH KNOB INC	LUDES:		
	213-0153-00				X 0.125 INCH, HEX SOC STL	74445	
-11		L B010100 B010		KNOB: LATCH		80009	366-1520-01
	366-1520-02	2 B010425	1			80009	366-1520-02
			_		ATTACHING PARTS)	00000	214 1040 00
-12	214-1840-00)	1	PIN, KNOB SECRG:	0.094 OD X 0.120 INCH LONG	80009	
-13	366-1559-00)		PUSH BUTTON: GRA		80009	
-14	131-0955-00			CONNECTOR, RCPT,		24931	
-15	210-0255-00			•	391" ID INT TOOTH	80009	
-16	179-2200-00			WIRING HARNESS,		80009	
-17	131-0622-00				0.577"L,28-32 AWG WIRE		46241
-18	131-0792-00			•	0.577"L,18-20 AWG WIRE	22526	
	131-0707-00				0.48"L,22-26 AWG WIRE	22526 80009	
-19	210-0255-00				0.391" ID INT TOOTH IC:0.152 OD X 0.245 INCH L,BRS	80009	
-20	210-0774-00				IC:0.126 OD X 0.23 INCH L,BRS	80009	
-21 -22	210-0775-00 352-0204-00			. CONN BODY, PL,		80009	
-22	352-0166-0				EL:8 WIRE VIOLET	80009	352-0166-07
	352-0166-08			. CONN BODY, PL,		80009	
-23	352-0161-0				EL:3 WIRE ORANGE	80009	
-25	352-0162-0			. CONN BODY, PL,		80009	352-0162-00
-24	358-0342-0			BSHG, MACH. THD: C	.25 x 32 x 0.352 INCH LONG ATTACHING PARTS)	80009	358-0342-00
-25	210-0583-00	0	1	NUT, PLAIN, HEX.:	0.25-32 X 0.312 INCH,BRS	73743	2x20224-402
-26	210-0223-0	0	1	TERMINAL, LUG:0.	25 INCH DIA,SE	78189	
-27	348-0031-0	0	1	GROMMET, PLASTIC	::0.156 INCH DIA	80009	348-0031-00
-28		-	1		EE R740,R745 EPL) ATTACHING PARTS)		
-29	210-0583-0	0			0.25-32 X 0.312 INCH,BRS		2X20224-402
-30	210-0940-0	0	1	WASHER, FLAT: 0.2	5 ID X 0.375 INCH OD,STL	79807	OBD
-31		-			EE R690,R695 EPL) ATTACHING PARTS)		
-32	210-0583-0	0			0.25-32 X 0.312 INCH,BRS		2X20224-402
-33	210-0940-0	0 ,	1	WASHER, FLAT: 0.2	5 ID x 0.375 INCH OD,STL	79807	OBD
-34	358-0363-0	0	2	BUSHING, SLEEVE:	CAM SWITCH MTG (ATTACHING PARTS FOR EACH)	80009	358-0363-00
25	220 0405 0	^	,		0.375-32 X 0.438 INCH BRS	73743	OBD
-35 -36	220-0495-0 210-0840-0				99 ID X 0.562 INCH OD, STL	89663	
-37	344-0195-0	1	າ	CLIP, ELECTRICAL		80009	344-0195-01
-37 -38	426-1072-0			FRAME, PUSH BTN:			426-1072-00

REV. A AUG. 1976

Mechanical Parts List—LA 501

Fig. & Index	Tektronix	Sorial/Ma	adal Na				Mfr	
No.	Part No.	Eff	Dscont	Qty	1 2 3 4 5	Name & Description	Code	Mfr Part Number
1-39	333-2037-00	B010100	B020486	1	PANEL, FRONT:		80009	333-2037-00
	333-2037-01	B020487		1	PANEL, FRONT:		80009	333-2037-01
-40	200-0935-00			2	BASE, LAMPHOLDER	R:0.29 OD X 0.19 CASE	80009	200-0935-00
-41	352-0360-00			2	HOLDER, LED: 0.08	36 ID X 0.20 I OD,PLSTC	80009	352-0360-00
-42	378-0635-00			2	LENS, LIGHT: WHIT	re .	80009	378-0635-00
-43				1	CONNECTOR, RCPT:	(SEE J138 EPL)		
-44	200-1929-00			2	CABLE, R AND L:		80009	200-1929-00
					((ATTACHING PARTS FOR EACH		ODD.
-45	210-0586-00			1	NUT, PLAIN, EXT V	V:4-40 X 0.25 INCH,STL	78189	OBD
-46	386-3493-00			2	PLATE, SECURING:	: (ATTACHING PARTS FOR EACH	80009	386-3493-00
-47	210-0586-00			1		V:4-40 x 0.25 INCH,STL	78189	OBD
-48	348-0145-00	B010100	B010249	2	GROMMET PLASTIC	:U-SHP,1.0 X 0.42 INCH	80009	348-0145-00
-40	348-0145-01				GROMMET, PLASTIC			348-0145-01
-49	131-0809-00			ī	•	PNL MT,4-40 TAP 1 END	71279	
-50	214-1513-01				LCH, PLUG-IN RET		80009	
30	214 1515 01			_	•	(ATTACHING PARTS)		
- 51	213-0113-00			1		R:2-32 X 0.312 INCH, PNH S	TL 83385	OBD
- 52	252-0571-00	1		ተጥ	RUB. SPL SHAPED	CHANNEL, 0.334 INCH LONG	77969	1353
-53	386-2464-00		B020486		PANEL, REAR:	 ,	80009	386-2464-00
	386-3620-00				PANEL, REAR:		80009	
	300 3020 00	2020107		_		(ATTACHING PARTS)		
-54	213-0192-00	1		4		R:6-32 X 0.50 INCH, PNH ST	ıı 87308	OBD
- 55	211-0507-00			2		5-32 X 0.312 INCH, PNH STL		OBD
				_		*	22222	227 2215 22
	337-2315-00			1			80009	
	337-2315-01	. во10250		1	•	NNECTORS (ATTACHING PARTS)	80009	337-2315-01
	211-0008-00)		2		4-40 X 0.25 INCH, PNH STL	83385	OBD
	220-0449-00			2		X 0.188 X 0.50" LONG	80009	220-0449-00
						*		
	175-1823-00)		1		C:50,26 AWG,2.625 L (ATTACHING PARTS)	80009	175-1823-00
-56	131-0976-00	во10100	B010249	4	POST, SIDE LOCK	:	80009	131-0976-00
	131-0976-00	во10250	l	2	POST, SIDE LOCK	:	80009	131-0976-00
						*		
		•		-	. CABLE ASSY II			
-57			B010249	2		EC: (SEE J100 EPL)		
						EC: (SEE J100 EPL)		
- 58	131-0707-00		B010249	50		:0.48"L,22-26 AWG WIRE		47439
	131-0707-00					:0.48"L,22-26 AWG WIRE		47439
-59	352-0171-09		B010249	2		,EL:1 WIRE WHITE		352-0171-09
	352-0171-09					,EL:1 WIRE WHITE	80009	352-0171-09 352-0162-09
-60	352-0162-09					,EL:4 WIRE WHITE		352-0162-09
	352-0169-09			12	•	,EL:2 WIRE WHITE	80009	
	175-1892-00	XB010250)	1	•	C:50,26 AWG,2.625 L (ATTACHING PARTS)	80009	175-1892-00
	131-0976-00)		2	POST, SIDE LOCK		80009	131-0976-00
		_		_	. CABLE ASSY II	NCLUDES:		
				1		EC:(SEE J120 EPL)		
	131-0707-00					:0.48"L,22-26 AWG WIRE	22526	47439
	352-0171-02			1	. CONN BODY, PL		80009	352-0171-02
	352-01/1-02				. CONN BODY, PL		80009	
-61	407-1733-00				BRACKET, CONN:	<u>-</u>	80009	407-1733-00
	2.00			_		(ATTACHING PARTS)		
-62	211-0097-00)		2		4-40 x 0.312 INCH, PNH STI	83385	OBD
-63	210-0586-00				-	W:4-40 X 0.25 INCH,STL	78189	
0.5	211-0012-00					4-40 x 0.375 INCH, PNH STI		
	0011 00	-		_		*		

9-4

Fig. & Index	Tektronix			04	400	4.5	Nama & Dagavintian		Mfr	Mfr. David November
No.	Part No.	Eff [Oscont	uty	123	4 5	Name & Description		Code	Mfr Part Number
1-	672-0528-00			1	CKT BO		Y:MEMORY W/CAM SWITCH (ATTACHING PARTS)		80009	672-0528-00
-64	211-0097-00			4	SCREW,	MACHINE:	4-40 x 0.312 INCH, PNH STL		83385	OBD
- 65	407-1773-00			4	BRACKE	T, COVER:			80009	407-1773-00
							*			
				-	. CKT	BOARD ASS	SY INCLUDES:			
-66							:(SEE R563 EPL)			
-67	361-0515-00			1		ER, SWITCH			80009	361-0515-00
				-	. ACTE		Y:(SEE S565 EPL) (ATTACHING PARTS)			
-68	211-0207-00	B010100 I	B010544	4			R:4-40 X 0.312 INCH, PNH S		83385	
	211-0244-00	B010545		4	. SCR,	ASSEM WSI	HR:4-40 X 0.312 INCH,PNH S	SST	781 89	OBD
				-	AC	TR ASSY	INCLUDES:			
- 69	200-1858-00			1	cc		SW:1.4 L,ALUMINUM (ATTACHING PARTS)		80009	200-1858-00
-70	211-0008-00			4	sc	REW, MACH	INE:4-40 X 0.25 INCH, PNH S	STL	83385	OBD
-71	210-0004-00			4	WA	SHER, LOCI	K:INTL,0.12 ID X 0.26"OD,	STL	78189	1204-00-00-0541C
							+			
- 72	210-0406-00						HEX.:4-40 X 0.188 INCH, BRS	5	73743	
-73	214-1139-00					•	I:GOLD COLORED		80009	214-1139-00
	214-1139-02						I:GREEN COLORED		80009	214-1139-02
-74	214-1127-00					•	ENT: 0.125 DIA X 0.125 INC	L	80009	214-1127-00
- 75	401-0081-00					•	M SW:FRONT (ATTACHING PARTS)		80009	401-0081-00
- 76	354-0391-00			1	RI		NING:0.395"FREE ID X 0.025	" STL	97464	3100-43-CD
-77	105-0692-00			1	AC	TUATOR, CA	AM SW:SELECTOR		80009	105-0692-00
-78	210-0406-00			4	NU	T,PLAIN,	HEX.:4-40 X 0.188 INCH, BRS	3	73743	2X12161-402
-79	401-0115-00			1	BE	ARING, CAN	M SW:CENTER		80009	401-0115-00
-80							SY:MEMORY(SEE A2 EPL)			
				-			ASSY INCLUDES:		00000	101 0004 00
-81	131-0604-00			5			EC:0.025 SQ X 0.365 INCH I	ONG		131-0604-00
-82	131-0589-00			4			EC:0.46 INCH LONG		22526	
	131-0993-00		.010040	4			CONNE:2 WIRE BLACK		22526	530153-2
-83	131-0608-00		B010249	102			EC:0.365 INCH LONG		22526	
-84	131-0608-00	B010250		127 5			EC:0.365 INCH LONG BODY,:CKT BD MT,3 PRONG			131-1003-00
-85	131-1003-00 136-0252-04	P010100 1	BV50108	5			EC:0.188 INCH LONG		22526	
-63	136-0252-04		5010243				EC:0.188 INCH LONG		22526	75060
-86	136-0260-02	D010230					G-IN:16 CONTACT, LOW CLEAR	NCE		C931602
-87	136-0352-00			4		•	EC:FOR 0.02 INCH DIAMETER		00779	
-88	214-0579-00						PT:0.40 INCH LONG	•	80009	
	131-0566-00						CONNE:0.086 DIA X 2.375 IN	ICH L	0000C	L-2007-1
-89	426-1246-00					T,PLUG-I	N:RIGHT SIDE, TOP AND BOTTO (ATTACHING PARTS FOR EACH)	M	80009	426-1246-00
- 90	213-0229-00			2	SCR, TE		R:6-20 X0.375"100 DEG,FLH		83385	OBD
-91	384-1394-00			1	EXTENS	ION SHAF	r:3.4 L x 0.125 DIA,AL,CRM	1	80009	384-1394-00
-92	376-0051-00	B010100 I	B010124	1	CPLG.S	HAFT, FLE	K:FOR 0.125 INCH DIA SHAFT	rs	80009	376-0051-00
	213-0022-00			4	. SETS	CREW: 4-40	X 0.188 INCH, HEX SOC ST		74445	OBD
	376-0051-01						K:FOR 0.125 INCH DIA SHAFT		80009	376-0051-01
	213-0048-00	B010125		4	. SETS	CREW: 4-40	X 0.125 INCH, HEX SOC ST		74445	OBD
- 93	384-1099-00			6	EXTENS	ION SHAF	r:push button,1.54 inch Lo	ONG	80009	384-1099-00
-94				1	CKT BO		:(SEE Al EPL) (ATTACHING PARTS)			
- 95	211-0116-00			4	SCR,AS		:4-40 x 0.312 INCH, PNH BRS	3	83385	OBD
- 96				-	. RESI		:(SEE R605 EPL) (ATTACHING PARTS)			
- 97	210-0583-00			1	. NUT		x.:0.25-32 x 0.312 INCH,B	રક	73743	2X20224-402
-98	210-0940-00					-	0.25 ID X 0.375 INCH OD,S		79807	

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Fig. & Index No.	Tektronix Se Part No. Et	erial/Model No. ff Dscont	Qtv	12345	Name & Description	Mfr Code	Mfr Part Number	
1-99	407-1707-00		<u>-</u> -	. BRACKET,		80009	407-1707-00	
					Y,PB:(SEE S625 EPL)			
					Y,PB:(SEE S15,S608 EPL)			
					Y,PB:(SEE S610 EPL)			
					Y,PB:(SEE S10 EPL) Y:(SEE S110 EPL)			
-104	343-0497-03				CH:REAR, 10 MM X 3 UNIT (ATTACHING PARTS FOR EACH)	80009	343-0497-03	
-106	210-3050-00		3	. EYELET,M	ETALLIC:0.218 L X 0.059 OD, BRS	07707	SE-27	
-107	343-0496-03		2	. CLIP,SWI	TCH:FRONT,10 MM X 3 UNIT (ATTACHING PARTS FOR EACH)	80009	343-0496-03	
-108	210-3050-00		3	. EYELET,M	ETALLIC:0.218 L X 0.059 OD,BRS	07707	SE-27	
-109			1	. RESISTOR	,VAR: (SEE R10 EPL) (ATTACHING PARTS)			
	210-0583-00 210-0940-00				N,HEX.:0.25-32 X 0.312 INCH,BRS LAT:0.25 ID X 0.375 INCH OD,STL	73743 79807	2X20224-402 OBD	
-112	407-1707-00		1	. BRACKET,	VAR RES:	80009	407-1707-00	
		B010100 B010249			ELEC:0.365 INCH LONG	22526	47357	
		B010250			ELEC:0.365 INCH LONG	22526		
	136-0514-00			•	LUG-IN:MICROCIRCUIT,8 CONTACT		C930802 386-3376-00	
	386-3376-00 211-0038-00			SUPPORT, CK	(ATTACHING PARTS) INE:4-40 x 0.312"100 DEG,FLH STL	83385		
-117				SUPPORT, CK	*	80009	386-3410-00	
-118	211-0038-00		1	SCREW, MACH	(ATTACHING PARTS) INE:4-40 X 0.312"100 DEG,FLH STL	83385	OBD	
-119	129-0589-00		2	SPACER, POS	* T:0.25 HEX X 0.95 L	80009	129-0589-00	4
-120	211-0008-00		2	SCREW, MACH	(ATTACHING PARTS FOR EACH) INE:4-40 X 0.25 INCH, PNH STL	83385	OBD	•
-121	337-2261-00		1	SHIELD, ELE	C:POWER SUPPLY	80009	337-2261-00	
-122	211-0097-00		1	SCREW, MACH	(ATTACHING PARTS) INE:4-40 X 0.312 INCH, PNH STL	83385	OBD	
-123	214-2322-00		2	HEAT SINK,		80009	214-2322-00	
-124	211-0016-00		1	SCREW, MACH	INE:4-40 X 0.625 INCH, PNH STL	83385	OBD	
-125	210-0586-00		1	NUT, PLAIN,	EXT W:4-40 X 0.25 INCH,STL	78189	OBD	
-126	129-0429-00				MECH:0.25 OD X 0.31 " LONG (ATTACHING PARTS)	80009	129-0429-00	
-127	211-0207-00				WSHR:4-40 X 0.312 INCH, PNH STL	83385		
	672-0529-00				ASSY:OUTPUT W/CAM SWITCH (ATTACHING PARTS)		672-0529-00	
	211-0207-00			•	WSHR:4-40 X 0.312 INCH,PNH STL	83385		
-129	210-0586-00				EXT W:4-40 X 0.25 INCH,STL * D ASSY INCLUDES:	78189	dao	
					Y,CAM S: (SEE S825 EPL) (ATTACHING PARTS)			
-130	211-0207-00	B010100 B010544	4	. SCR,ASSE	M WSHR:4-40 X 0.312 INCH, PNH STL	83385	OBD	
200	211-0244-00			•	M WSHR:4-40 X 0.312 INCH,PNH SST	78189		
					ASSY INCLUDES:		200 1055 22	
	200-1859-00				CAM SW:1.8 L,ALUMINUM (ATTACHING PARTS)	80009		
	211-0008-00 210-0004-00				MACHINE:4-40 X 0.25 INCH,PNH STL ,LOCK:INTL,0.12 ID X 0.26"OD,STL	83385 78189	OBD 1204-00-00-0541C	

9-6 REV. B AUG. 1976

Fig. &									
Index		Serial/Model No. Eff Dscont	O+v	1 2	3 4 5	Name & Description		Mfr Code	Mfr Part Number
No.	Part No. E	III DSCOIIL	uly	1 2	. 3 4 3	Name & Description			WITH TAIL INGINDER
1-	131-0963-00	XB010405				ELEC: GROUNDING		30009	131-0963-00
-134	210-0406-00		4		NUT, PLAI	N, HEX.: 4-40 X 0.188 INCH, BR		73743	
-135	214-1139-02					LAT:GREEN COLORED	-	30009	214-1139-02
-136	214-1127-00		2	٠	ROLLER,D	ETENT:0.125 DIA X 0.125 INC	HL 8	30009	214-1127-00
-137	401-0081-02		1		BEARING,	CAM SW:FRONT	8	30009	401-0081-02
						(ATTACHING PARTS)			
-138	354-0391-00		1		RING, RET	AINING:0.395"FREE ID X 0.02	5" STL 9	97464	3100-43-CD
-1 39	105-0693-00		1		ACTUATOR	,CAM SW:TIME BASE	ε	30009	105-0693-00
	210-0406-00					N, HEX.: 4-40 X 0.188 INCH, BR		73743	
	401-0115-00					CAM SW:CENTER	•		401-0115-00
	401-0115-00					ASSY:OUTPUT(SEE A3 EPL)			
-142						D ASSY INCLUDES:			
_1/2						OR: (SEE Q905 EPL)			
			*	• •	114110101	(ATTACHING PARTS)			
-144	211-0012-00		2		SCREW, MA	CHINE:4-40 X 0.375 INCH, PNH	STL 8	33385	OBD
	210-0004-00					OCK: INTL, 0.12 ID X 0.26"OD,		78189	1204-00-00-0541C
	210-0812-00					ONMETAL: #10, FIBER		06982	OBD
	210-1133-00					ONMETAL: 0.142 ID X 0.25 OD	FIBER 8	36445	OBD
3.46	240 0023 02		_		CDOM/CD	* DIACRIC.O 156 INCH DIA		30009	348-0031-00
	348-0031-00					PLASTIC:0.156 INCH DIA		30009	386-0978-00
	386-0978-00					R,PLATE:0.002 INCH MICA,FOR			
	214-0559-02				HEAT SIN			30009	214-0559-02
-151	129-0370-00		2	• •	POST, ELE	C-MECH: 0.25 HEX X 0.16 INCH (ATTACHING PARTS FOR EACH		30009	129-0370-00
-152	210-0586-00		1		NUT.PLAI	N,EXT W:4-40 X 0.25 INCH,ST		78189	OBD
202	210-0802-00	XB010200				LAT: 0.15 ID X 0.312 INCH OD		12327	OBD
	210 0002 00	ADOLOLOG	-	• •		*			
-153	337-2298-00		1		SHIELD.F	LEC:CIRCUIT BOARD,1.34 L	ε	30009	337-2298-00
	337-2297-00					LEC:CIRCUIT BOARD,1.1 L		30009	
	131-0604-00					ELEC:0.025 SQ X 0.365 INCH		30009	
-156	131-0589-00					ELEC:0.46 INCH LONG		22526	
		B010100 B010124				ELEC:0.365 INCH LONG		22526	
-15/						ELEC:0.365 INCH LONG		22526	
		B010125 B010249				ELEC:0.365 INCH LONG		22526	
150	131-0608-00	B010250				IK, ELEC: 0.28 X 0.18 OVAL X 0		30009	
	214-0973-00							30009	131-1003-00
	131-1003-00					OR BODY,:CKT BD MT,3 PRONG			
-160	136-0252-04					ELEC: 0.188 INCH LONG		22526	
	136-0254-00					ELEC: 0.088 OD X 0.145 INCH		00779	
-162	136-0254-01					ELEC: 0.145 INCH LONG		00779	
	136-0260-02		22		SOCKET, F	LUG-IN:16 CONTACT, LOW CLEAR	ANCE C	01295	
-164	136-0514-00					PLUG-IN:MICROCIRCUIT,8 CONTA		32647	
-165						ST PT:0.40 INCH LONG		30009	
-166		B010100 B010249				M.CONNE:2 WIRE BLACK			530153-2
	131-0993-00	в010250				M.CONNE:2 WIRE BLACK			530153-2
	131-0566-00	XB010250				M.CONNE:0.086 DIA X 2.375 I	NCH L C	0000C	L-2007-1
-167					•	LIDE: (SEE S720,S848 EPL)			
-168						LIDE: (SEE S835 EPL)			
-169	344-0154-00		2		CLIP, ELE	CTRICAL:FOR 0.25 INCH DIA F		30009	344-0154-00
-170	346-0032-00		1		STRAP, RE	TAINING:		98159	2829-75-4
-171	214-1061-00		1	SPI	RING, GROUN	ID:FLAT	8	80009	214-1061-00
-172	426-1245-00		2	FR	SECT, PLUG	-IN:LEFT SIDE, TOPAND BOTTOM	8	80009	426-1245-00
						(ATTACHING PARTS FOR EACH)		
-173	213-0229-00		2	SCI	R, TPG, THD	FOR:6-20 X0.375"100 DEG,FLH	STL 8	83385	OBD
						*_	,	9000	206-2205-01
-174		B010100 B020486			BPANEL, FRO			80009	386-3385-01
	386-3385-02	B020487			BPANEL, FRO			80009	386-3385-02
-175	210-0774-00				-	LIC:0.152 OD X 0.245 INCH L	•	80009	210-0774-00
-176	210-0775-00		11	EYI	ELET, METAI	LIC:0.126 OD X 0.23 INCH L,		80009	210-0775-00
-177	131-0792-00		8	COL	TACT, ELEC	:0.577"L,18-20 AWG WIRE		22526	46221
-178	131-0707-00		106	COI	TACT, ELEC	:0.48"L,22-26 AWG WIRE	2	22526	47439
-179	175-0827-00		FT	WII	RE, ELECTRI	CAL:4 WIRE RIBBON	(08261	TEK-175-0827-00
	175-0828-00		FT	WIE	RE, ELECTRI	CAL:5 WIRE RIBBON	2	23499	TEK-175-0828-00

9-7

Mechanical Parts List—LA 501

Fig. & Index No.	Tektronix Part No.	Serial/M Eff	odel No. Dscont	Qty	123	3 4 5	Nam	e & Description	Mfr Code	Mfr Part Number
1-181	175-0830-0	0		FT	WIRE	ELECTRICAL:7	WIRE	RIBBON	08261	TEK-175-0830-00
-182	175-0831-0	0		FT	WIRE	ELECTRICAL:8	WIRE	RIBBON	08261	TEK-175-0831-00
-183	352-0171-0	3		1	CONN	BODY, PL, EL:1	WIRE	ORANGE	80009	352-0171-03
	352-0171-0	9		1	CONN	BODY, PL, EL:1	WIRE	WHITE	80009	352-0171-09
-184	352-0162-0	3		2	CONN	BODY, PL, EL:4	WIRE	ORANGE	80009	352-0162-03
-185	352-0163-0	2		4	CONN	BODY, PL, EL:5	WIRE	RED	80009	352-0163-02
-186	352-0165-0	1		2	CONN	BODY, PL, EL:7	WIRE	BROWN	80009	352-0165-01
	352-0165-0	9		2	CONN	BODY, PL, EL: 7	WIRE	WHITE	80009	352-0165-09
-187	352-0166-0	2		2	CONN	BODY, PL, EL:8	WIRE	RED	80009	352-0166-02
	352-0166-0	4		2	CONN	BODY, PL, EL:8	WIRE	YELLOW	80009	352-0166-04
	352-0166-0	5		2	CONN	BODY, PL, EL:8	WIRE	GREEN	80009	352-0166-05
-188	352-0168-0	0		1	CONN	BODY, PL, EL:1	WIR	E BLACK	80009	352-0168-00
-189	352-0200-0	8		2	CONN	BODY, PL EL:8	WIRE	GRAY	80009	352-0200-08

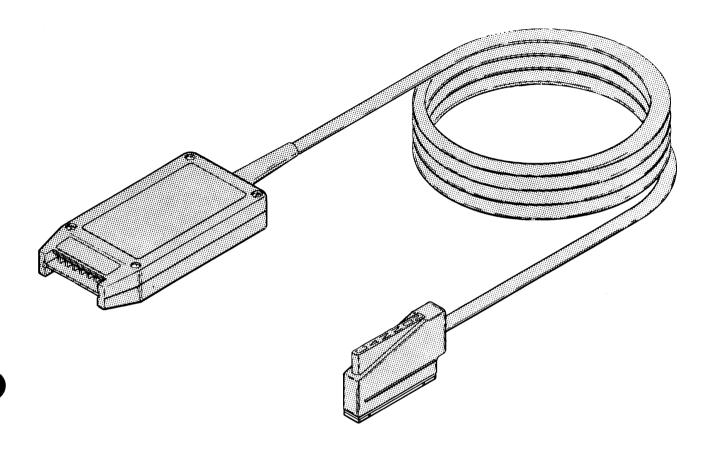


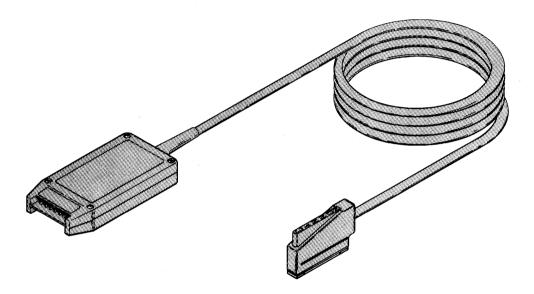
Fig. & Index No.	Tektronix Part No.	Serial/Mo	del No. Dscont	Qty	1 2 3 4 5	Name &	Description	Mfr Code	Mfr Part Number
	010-6450-01	_		1	PROBE, DIGITA	L:MULTI LEAD	,W/ACCESSORY	80009	010-6450-01
	070-1967-00)		1	MANUAL, TECH:	INSTRUCTION (NOT SHOWN)	80009	070-1967-00
	070-2047-00)		1	MANUAL, TECH:	OPERATORS (NO	T SHOWN)	80009	070-2047-00



Fig. & Index No. | Tektronix | Serial/Model No. | Part No. | Eff | Dscont | | O12-0057-01 | | 3 | CABLE | ASSY, RF: | | 80009 | O12-0051-01



P6450PROBE ASSY, DATA ACQUISITION



The P6450 is a multiple input, 5X, passive probe for use with digital circuit analysis instruments, such as the LA501. The probe has 16 independent 5X attenuation inputs, 3 straight through connectors (A, B, and C) for customer assignment, and one ground. The 5X attenuation is compatible with instruments having an input resistance of $20 \mathrm{K}\Omega$ and an input capacitance of approximately 20 pf.

The probe leads lock into the probe head. They will not pull out if the probe lead is accidently pulled. To remove a probe lead, place your fingernail on the connector and pull. To insert a probe lead, push the connector into the probe head as shown in Figure 1, page 4. Be sure the correct side of the connector is facing upward.

The probe leads come in 4 sets of 10 leads. There are 10 different colored leads in each set. Two sets of leads are terminated with retractable hook. The other two sets of leads are terminated in square-pin connectors.



WARRANTY

All TEKTRONIX instruments are warranted against defective materials and workmanship for one year. Any questions with respect to the warranty should be taken up with your TEKTRONIX Field Engineer or representative.

All requests for repairs and replacement parts should be directed to the TEKTRONIX Field Office or representative in your area. This will assure you the fastest possible service. Please include the instrument Type Number or Part Number and Serial Number with all requests for parts or service.

Specifications and price change privileges reserved.

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 $\mbox{U.S.A.}$ and foreign TEKTRONIX products covered by $\mbox{U.S.}$ and foreign patents and/or patents pending.

TEKTRONIX is a registered trademark of Tektronix, Inc.

SPECIFICATIONS

ELECTRICAL

All electrical specifications apply to channels 0 through 15 only.

Attenuation: 5% within 3% (when instrument input resistance is 20 k Ω within 1%). Series resistor 81 k Ω within 1.1%

Input Resistance: 100 $k\Omega$ within 3% (when instrument resistance is 20 $k\Omega$ within 1%).

Input Capacitance: (without test leads) approximately 45 pF (with probe connected to instrument).

Risetime (Probe Only): 9 ns (channels, 0, 1, 2, 3,); 15 ns (channels 4-15).

Maximum Input Voltage: 50 V (dc + peak ac).

Probe delay time (from end of signal input lead to multi-pin connector):
Approximately, 15 nsec.

ENVIRONMENTAL

Probe operates within specifications over the following ranges:

Temperature; 0 C to +75 C (32 F to 167 F).

Altitude: To 15,000 ft.

PHYSICAL

Net Weight: 377 gms (13.3 oz).

Length: Probe; 1.5 m (4.9 ft).

Input Leads; 40 cm (15.7 in).

MAINTENANCE

The P6450 contains only passive components. These components are located on 2 circuit boards, one in the probe head and one in the multipin cable connector body.

PROBE HEAD COMPONENT ACCESS

- 1. Remove 4 screws from the probe head.
- 2. While pulling apart the 2 halves of the probe head body, make note of which half of the body covers which side of the circuit board.
- 3. Replace the defective components.
- 4. When reinstalling the circuit board be sure the correct half of the body covers the correct side of the circuit board. Verify by tracing ground braid connection to the ground input.

MULTIPIN CONNECTOR COMPONENT ACCESS

- 1. Set the connector locking flange to gain access to the 3 screws (see Figure 2).
- 2. Remove 2 screws and loosen 1 screw.



The leads from the cable to the circuit board are fragile. Be careful not to damage them.

- 3. Carefully push the cable into the plastic body while pulling out the connector.
- 4. Replace the defective component.
- 5. To reassemble, carefully pull on the cable while guiding the connector and circuit board back into the plastic body.
- 6. Replace the 3 screws.

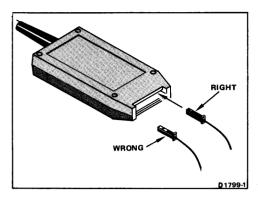


FIGURE 1

TABLE I

PROBE INPUTS	CONNECTOR
1	16
2	18
3	50
4	1,5
5	17
6	19
7	51
8	ı
9	3
10	5
11	7
15	2
13	4
14	6
15	8
	15 N.C.
i	22 N.C.
<u> </u>	25 N.C.

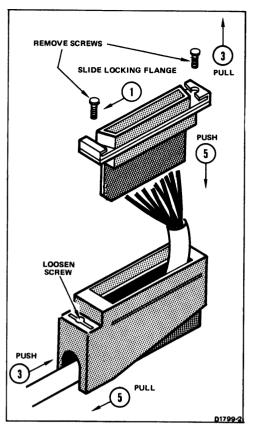
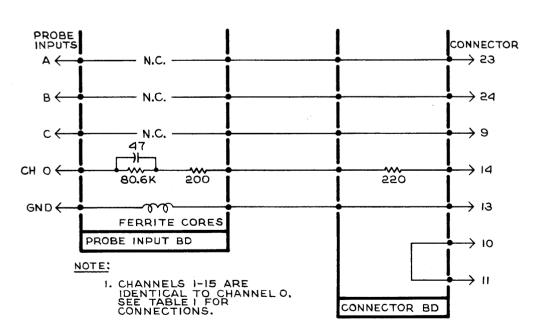
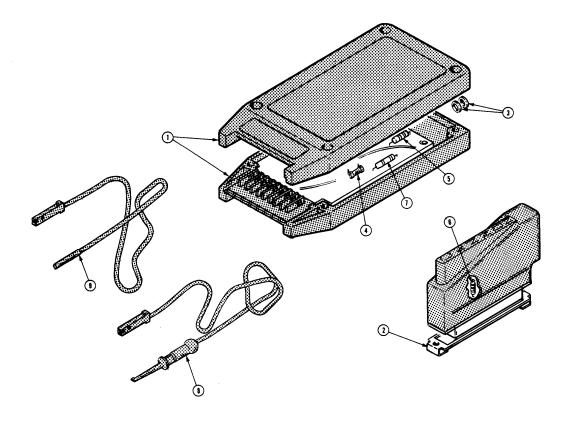


FIGURE 2

SCHEMATIC





Index	Tektronix Serial	Model No.	Oh.				Mfr	
No.	Part No. Eff	Dscont	Qiy	1 2 3 4 5	Name & Desc	ription	Code	Mfr Part Number
					MECHANICAL PART	S LIST		
-1	010-6450-01 010-6450-00 380-0463-01		1 1 1	. PROBE, DAT.	ACQ:MULTI LEAD,W/A A ACQ:MULTILEAD,20 ,PROBE:W/IDENTIFIC R,CONN:25 PIN D CO	ATION MARKERS	80009 80009 80009 09133	010-6450-01 010-6450-00 380-0463-01 DB51221-1
- 2	343-0323-00		1	RETAINE	•	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	03200	
					ELECTRICAL PART	LIST		
-3 -4 -5 -6 -7	276-0596-00 281-0651-00 315-0201-00 317-0221-00 321-0376-00		2 16 16 16 16	. CAP.,FX . RES.,FX	ROID,FER:0.09 ID X D,CER DI:47PF,5%,2 D,CMPSN:200 OHM,5% D,CMPSN:220 OHM,5% D,FILM:80.6K OHM,1	00V ,0.25W ,0.125W	78488 72982 01121 01121 75042	56-1657 374-001T2H0470J CB2015 CB2215 CEATO-8062F
					ACCESSORIES			
-8 -9	012-0670-00 012-0655-01 016-0537-00 062-1799-00		2 2 1 1	. LEAD SET, . POUCH,ACC	TEST:W/10 15.748L TEST:INPUT,W/10 15 TESSORY:6" X 9" W/2 T:P6450 (not shown)	IPPER	80009 80009 80009	012-0670-00 012-0655-01 016-0537-00 062-1799-00

CROSS INDEX MFR. CODE NUMBER TO MANUFACTURER

MFR.CODE	MANUFACTURER	ADDRESS	CITY,STATE,ZIP
01121 09133 72982	ALLEN-BRADLEY CO. KIERULFF ELECTRONICS, INC. ERIE TECHNOLOGICAL PRODUCTS, INC.	1201 2ND ST. SOUTH 2585 COMMERCE WAY 644 W. 12TH ST.	MILWAUKEE, WI 53204 LOS ANGELES, CA 90015 ERIE, PA 16512
75042 78488	TRW ELECTRONIC COMPONENTS, IRC FIXED RESISTORS, PHILADELPHIA DIVISION STACKPOLE CARBON CO.	401 N. BROAD ST.	PHILADELPHIA, PA 19108 ST. MARYS, PA 15857
80009	TEKTRONIX, INC.	P. O. BOX 500	BEAVERTON, OR 97077

. 5.



MANUAL CHANGE INFORMATION

PRODUCT <u>LA 501</u> 070-1967-00 **CHANGE REFERENCE** <u>C1/1175</u> **DATE** <u>11-6-75</u>

CHANGE:

DESCRIPTION

TEXT CORRECTIONS

Page 1-7, step 7, re-word as follows:

7. Set the oscilloscope for X - Y mode and ground the inputs. Position the resulting dot display to center screen and adjust the oscilloscope for a well-defined display. If necessary, refer to the oscilloscope instruction manual for operating instructions.

Page 1-10, insert the following NOTE between the paragraphs titled "DATA OUTPUT CABLE" and "COAXIAL CABLE" in the lower left column:

NOTE

When inputting ECL on a P6450 probe, complete shielding between the input and output connectors is needed. Therefore, the cable connected to output connector J120 must be a shielded cable.

Page 1-11, delete the last two sentences of Step 3 so that Step 3 reads as follows:

Connect the 10X probe to be compensated to a 600 mV, fast-rise, 1 KHz square-wave signal source (e.g., oscilloscope calibrator) for low-frequency compensation.

Page 1-11, change Step 4 to read:

Adjust the probe compensation adjustment(s) (see probe instruction manual for adjustment locations) for an optimum flat top on the test oscilloscope display.

Page 1-12. The illustration for P831 EXT CLOCK POLARITY SELECTOR is in error. The callout that reads NEGATIVE EDGE should read POSITIVE EDGE and vice versa.

Page 1-13, under "Z BLANK OUT" at the bottom of the right hand column, add the following:

For Serial No.s B010245 and below, the only function of the Z-axis blanking signal is to blank the crt retrace lines.

PAGE 1 OF 10

DESCRIPTION

Page 1-15, top of the right column, under "Z-AXIS INPUT", change to read as follows:

Z-AXIS INPUT. This connection permits control of display intensity with an externally generated signal. As the external signal goes positive (5 volts maximum) the display intensifies.

Page 1-15, right column, under "RECORD ENABLE", change to read as follows:

RECORD ENABLE. This connection is provided to set the memory into the Store Mode by application of an external signal. A high pulse at ECL level is required.

- Page 2-3, in the lower part of Table 2-1, the CRT Retrace Blanking Time Performance Requirement should read as follows:
 - 4.2 µs within 20% (2 bits)
 - 2.2 μ s within 20% (1 bit)
 - 1.2 µs within 20% (1/2 bit)
- Page 2-3, in the lower part of Table 2-1, the Horizontal Output-Linearity Performance Requirement should read:

Pulse width within 10% from 1% to 100% of sweep.

- Page 2-5, in the middle of Table 2-1, the Record Enable Performance Requirement should read:
 - Pin 15. A positive-going pulse (high) from a low ECL level sets memory into Record mode.

From the end of Section 2 throughout the rest of the manual, the following signal names are to be changed:

- 1. Display Clock Inhibit is changed to Display Clock Enable.
- 2. Store Clock Inhibit is changed to Store Clock Enable.
- 3. Frame Clock is changed to Flag.
- Page 3-8, left column, first paragraph. For SN B010245 and below, change to read as follows:

Auto Record

The Auto Record stage controls the time that a display is presented before the Memory returns to the store mode. The display time is set by DISPLAY TIME control R605. Capacitor C606 charges through

DESCRIPTION

R604, R605, and R609. After approximately one time constant, Q606 conducts, discharging C606 and pulling pin 4 of U610A LO. When pin 4 of U610A is LO, pin 3 is HI. The HI at pin 3 resets the Q output (pin 14) of Store/Display Flip-Flop U615B to a HI level. Pin 14 of U615B is connected to the emitter of Q602. A HI at the emitter of Q602 causes Q602 and Q604 to conduct, disabling the timing circuit for 0606. Therefore, Q606 only operates when the memory is in the display mode (pin 14 of U615B is LO). C602 ensures that the conduction of 0606 is always longer than 20 ms. A HI level pulse at pin 3 of U610A can also be obtained by pressing MANUAL pushbutton S605A. NOR gates U608A and B are connected as a set-reset flip-flop to prevent any contact bounce in S605A from being coupled to the rest of the circuitry. When S605A is pressed, pin 5 of U608A goes LO and pin 7 of U608B goes HI. The resultant LO on pin 3 of U608B is connected to pin 5 of U610A, producing a HI level pulse at pin 3. U610A pin 3 is wired through U608B to produce the load command for the address counter.

Page 3-8, right column. Add the following sentence at the end of the second paragraph.

U628 pin 2 is connected to U615A pin 6 to produce trigger holdoff which requires the memory to cycle once before a trigger is accepted.

Page 3-11, left column, first paragraph, fifth line should read:

"at pin 5 sets the Q output (pin 2) HI. Pin 2 of U616A is"

Page 3-11, left column, second paragraph. The three paragraphs headed "BAD DATA" BLANKING, do not apply to instruments serial number B010245 and below.

Page 3-11, right column, third paragraph. The circuit description for the -4.8-Volt Supply should read as follows:

-4.8-Volt Supply

The -4.8-Volt Supply is derived from the 25-volt ac windings of the transformer in the power module. The ac input is rectified by CR904, then filtered by C904, L905, and C905. The resultant dc source is converted by a switching regulator to -4.8 volts. Zener diode VR922 and transistor Q922 maintain a constant current through VR920 to establish a reference voltage. The reference

DESCRIPTION

-4.8-Volt Supply (cont.)

voltage at the wiper of R925 is applied to the base of Q914.

CHANGE REFERENCE

Q905 is a series switching regulator that produces a rectangular power waveform whose energy is stored in T911. The negative transition of Q905 is coupled through C911 and R912 to the base of Q914 to control the on Time of Q914. The positive transition of Q905 is coupled through C911, R912, C927, and R927 to the base of Q928, resulting in a fast turn-off time for Q905.

Transistors Q914 and Q916 compare the output voltage with the reference voltage from R925. If the output voltage is more negative than the reference, the on time of Q914 becomes less, reducing the on time of Q910 and Q905. The amount of energy stored in T911 is thereby reduced, pulling the output voltage positive. When the output voltage becomes less negative than the reference voltage, Q914 conducts longer, increasing the on time of Q910 and Q905. The amount of energy stored is thereby increased and the output goes more negative.

Zener diode VR932 and SCR Q932 provide over-voltage protection for the IC's connected to this supply. If the output voltage exceeds about -6.2 volts, Q932 switches on, shorting the -4.8-Volt Supply and blowing fuse F905.

Page 4-3, left column, last paragraph, should read as follows:

The Trouble shooting Charts in the Diagrams section (or the following procedure) can be used as a guide for troubleshooting the I.A 501. Both the charts and the procedure check the simple trouble possibilities before proceeding with extensive troubleshooting. The first few checks ensure proper connection, operation, and adjustment. If the trouble is not located by these checks, the remaining steps aid in locating the defective component. When the defective component is located, it should be replaced using the replacement procedure given under Corrective Maintenance.

LITERACE

CHANGE:

PRODUCT_

DESCRIPTION

Page 4-3, right column, following the last paragraph, add the following:

NOTE

If the selector block is in the H position (108 V AC to 132 V AC) adjust the autotransformer for 120 V ac.

Page 4-4, Table 4-1. Change the Maximum Ripple Peak-to Peak specification for high freq. to 100 mV in both cases.

Page 5-13, right column

Delete Steps F1 j through p.

Change Step Fl i to read:

- i. Check for a clean, symmetrical 50 MHz ECL display.
- Page 5-15, left column, at Step F7 g, add the following material:

 Set SAMPLE INTERVAL to EXT. Connect 10X probe to the EXT

 CLOCK BNC connector. Connect the probe tip to Test Point

 TP820 and repeat part c again for Channel 7.
- Page 5-17, right column: Delete all of Step G2 for instruments with serial numbers B010245 and below.

SCHEMATIC CORRECTIONS

- Schematic 3 The terminating resistor on pin 13 of U258 is U121F instead of U351F.

 Delete U431F from U535 pin 10.
- Schematic 4 Terminate U615 pin 4 with termination resistor U611D (100 ohm to -2V supply). U615B Q and \overline{Q} are labeled backwards.
 - Terminate U616-pin 11, 100 ohm to -2V supply with U611E.

Schematic 7 DS 708 should be P31 - Pin 2.

U254

PRODU	JCTIA 50	01 CHANGE	REFERENCE	C1/1175	_ DATE	11-6-75
	CHANGE:		DESC	RIPTION		
		Control of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the State of the Sta				
						I
		ELECTRICAL PARTS		EMATIC CHANGE	≟	
	Pilot Change	#1 - #10 EFF SN	B010100-up			
	CHANGE TO:					
	C606	290-0724-00	CAP., FXD, ELC	CTLT:330 UF,20	0%,6V	
	R604	315-0472-00	RES.,FXD,CMP	SN:4.7K OHM,	5%,0.25W	
	R628	321-0097-00	RES.,FXD,FIL	M:100 OHM,1%,	,0.125W	
	R629	315-0822-00	RES., FXD, CMP	SN:8.2K OHM,5	5%,0.25W	
	R632	315-0101-00	RES., FXD, CMP	PSN:100 OHM,5%	%,0.25W	
	R688	315-0432-00	RES.,FXD,CMP	SN:4.3K OHM,5	5%,0.25W	
	R694	315-0221-00	RES.,FXD,CMP	'SN:220 OHM,5%	%,0.25W	
	R696	321-0104-00	RES.,FXD,FIL	M:118 OHM,1%,	,0.125W	
	R698	321-0097-00	RES.,FXD,FIL	.м:100 онм,1%,	,0.125W	
	R734	321-0126-00	RES.,FXD,FIL	M:200 OHM,1%,	,0.125W	
in Addressed	R735	315-0101-00	RES.,FXD,CMP	PSN:100 OHM,5%	%,0.25W	
	R736	321-0158-00	RES.,FXD,FIL	M:432 OHM,1%	,0.125W	
	R737	321-0126-00	RES.,FXD,FIL	LM:200 OHM,1%,	,0.125W	
	R738	321-0139-00	RES.,FXD,FIL	.M:274 OHM,1%	,0.125W	
	R740	311-1831	RES., VAR, NON	WIR:DUAL,2.5	к онм х 1к	
	R741	321-0173-00	RES.,FXD,FIL	.M:619 OHM,1%	,0.125W	
	R744	321-0072-00	RES.,FXD,FIL	_M:54.9 OHM,1%	%,0.125W	
	R925	311-1244-00	RESVAR.NON	WIR:100 OHM,1	10%.0.50W	
1	U14	156-0067-05	· ·	_		TIER (SELECTED)
	U110	156-0757-00	MICROCIRCUIT	i,DI:DUAL 3-II	NP,3-OUT N	OR GATE, 10211
	U252	156-0657-01		r DI:256 BIT F		
.]		_				

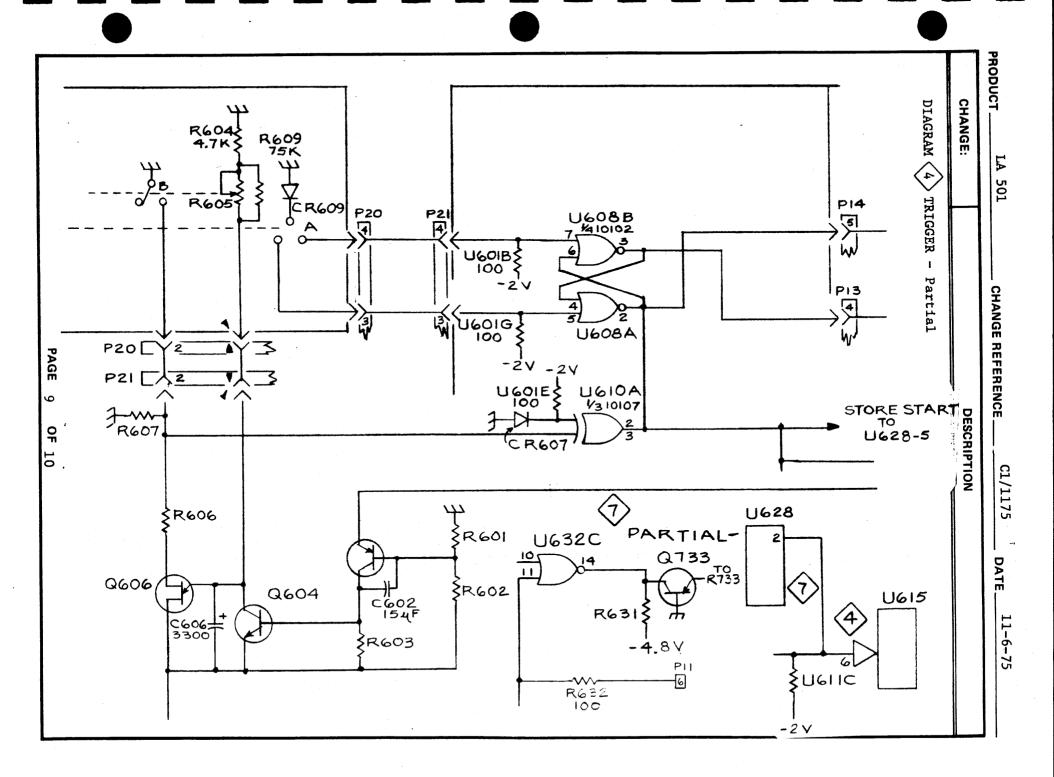
PRODUCT LA 501 CHANGE REFERENCE C1/1175 DATE 11-6-75

CHANGE:		DESCRIPTION
CHANGE TO:		
U256	156-0657-01	MICROCIRCUIT DI:256 BIT RAM, CHECKED
U258	11	11 11 11 11
U352	11 11	и, и и и и
U354	11	H H H H
U356	11	и и и и
U358	11	11 11 11 11
U452	11	11 11 11 11
U454	11 ,	п п п п
U456	11	11 11 11 11
U458	11	H H H H H
U5 5 2	11	H H H H H
U554	11	11 11 11 11
U556	11	11 11 11 11
U 558	11	11 11 11 11
REMOVE:		
C607	281-0773-00	CAP., FXD, CER DI:0.01UF, 10%, 100V
C608	283-0023-00	CAP.,FXD,CER DI:0.1UF,+80-20%,12V
CR628	152-0141-02	SEMICOND DEVICE:SILICON, 30V, 150MA, 1N4152
R739	315-0100-00	RES.,FXD,CMPSN:10 OHM,5%,0.25W
ADD:		
C67	283-0023-00	CAP., FXD, CER DI:0.1UF, +80-20%, 12V
C213	283-0023-00	CAP., FXD, CER DI:0.1UF, +80-20%, 12V
C216	283-0023-00	CAP., FXD, CER DI:0.1UF, +80-20%, 12V
C602	290-0527-00	CAP., FXD, ELCTLT: 15UF, 20%, 20V
CR607	152-0141-02	SEMICOND DEVICE:SILICON, 30V, 150MA, 1N4152
Q629	151-0188-00	TRANSISTOR: SILICON, PNP, 2N3906
		PAGE 7 OF 10

CHANGE:		DESCRIPTION
ADD:		
R609	315-0753-00	RES., FXD, CMPSN:75K OHM, 5%, 0.25W
R742	315-0151-00	RES., FXD, CMPSN:150 OHM, 5%, 0.25W
R743	315-0823-00	RES., FXD, CMPSN:82K OHM, 5%, 0.25W
	nange #11 EFF SN B	01 0125-up
		01 0125-up
CHANGE T		010125-up RES., FXD, CMPSN: 240 OHM, 5%, 0.25W
CHANGE T	CO:	
CHANGE T	315-0241-00	RES., FXD, CMPSN: 240 OHM, 5%, 0.25W
CHANGE TR691	315-0241-00 315-0331-00	RES., FXD, CMPSN: 240 OHM, 5%, 0.25W RES., FXD, CMPSN: 330 OHM, 5%, 0.25W

CHANGE TO:

VR920 153-0060-00 SEMICOND DEVICE: ZENER, 0.4W, 6.2V, 2% SELECTED FROM 1N3497



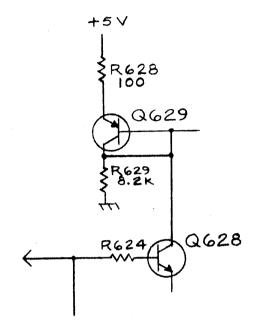
11-6-75

CHANGE:

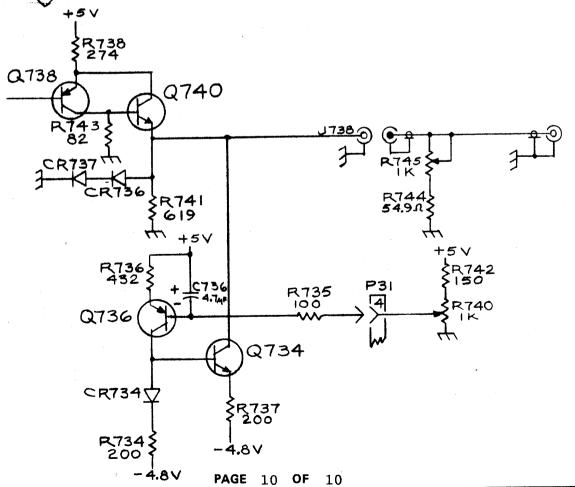
PRODUCT_

DESCRIPTION

DIAGRAM (6) SERIAL LOGIC AND VERTICAL SIGNAL OUTPUTS - Partial



HORIZONTAL & BLANKING SIGNAL OUTPUTS - Partial DIAGRAM (7





MANUAL CHANGE INFORMATION

PRODUCT LA 501 EFF SN B010250-up **CHANGE REFERENCE** <u>C2/276</u> **DATE** <u>2-26-76</u>

CHANGE:

DESCRIPTION

070-1967-00

TEXT CORRECTIONS

Page 1-1, right column

CHANGE: Delete the CLOCK OUT heading and accompanying text. Insert the following:

1 MHz CLOCK OUT: Provides an unterminated (negative voltage ECL

1evel) 1 MHz clock from an internal time base.

CHANGE: Delete the INVALID MODE heading and accompanying text. Replace it with the following:

AUX CLOCK INPUT. Provides for an external ECL level Store/Display Clock signal input.

AUX CLOCK INPUT. Provides an input for ECL level trigger signal.

Page 1-3, item 16, FORMAT

CHANGE: The third line should read "Maximum sample interval is 20 nanoseconds."

The fifth line should read "Maximum sample interval is 50 nanoseconds."

Page 1-6, right column, just ahead of the "Preliminary Set Up" heading CHANGE: Insert the following text.

Setting The Internal Jumpers

The internal jumpers should be set to the positions that will give the desired operation. The jumpers and their functions are as follows: P831-Clock Polarity (positive - pin 1 to pin 2*; negative - pin 2 to pin 3) and Variable Threshold Trigger (pin 3 to pin 4).

P629-Trigger Lockout (pin 1 to pin 2)* and Bad Data Blanking (pin 2 to pin 3).

P608-CH O Trigger (pin 2 to pin 3)*, Auxiliary Trigger (pin 3 to pin 4). P136-Clock Ticks (pin 1 to pin 2)* and No Clock Ticks (pin 2 to pin 3). P120-Trigger Sync Output (pin 1 to pin 2)* and Trigger Sync Input (pin 2 to pin 3).

P101-Auxiliary Clock (pin 2 to pin 3)* and Ext Store/Display Clock (pin 1 to pin 2).

Note: * indicates jumper position when shipped from the factory.

DATE__

LA 501

CHANGE:

DESCRIPTION

P100-Display Clock (pin 1 to pin 2)* and Ext Store/Display Clock (pin 2 to pin 3).

Page 1-7. left column, step 7.

CHANGE: Re-word Step 7 as follows:

7. Set the oscilloscope for X-Y mode and ground the inputs. Position the resulting dot display to center screen and adjust the oscilloscope for a well-defined display. If necessary, refer to the oscilloscope instruction manual for operating instructions.

Page 1-10, left column, between the paragraphs title DATA OUTPUT CABLE and COAXIAL CABLE.

CHANGE: Insert the following note.

NOTE

When inputting ECL data on a P6450 probe and outputting parallel data on J120, complete shielding between connectors and cables is needed. Therefore, shielded cables and connectors should be used on J120.

Page 1-11, Steps 3 and 4.

CHANGE: Delete the last two sentences of Step 3. In Step 4, delete the words "square front corner and".

Page 1-12, left column, top paragraph

CHANGE: Delete the last two sentences in the paragraph and insert the following headings and text before the paragraph titled "MONITOR".

INTERNAL JUMPERS:

P831-External Clock Polarity Selector.

In the first two positions, P831 selects external clock polarity. In the third position, it provides a means to use the EXT CLOCK connector on the front panel as a Variable Threshold Trigger source.

P629-Bad Data Blanking Selector.

This jumper is used to select either Trigger Lockout or Bad Data Blanking triggering mode.

DATE.

CHANGE:

DESCRIPTION

P608-Internal Trigger Selector.

This jumper permits selection of CH O or Auxiliary Trigger Input as the trigger source when the front panel SOURCE pushbutton is in CH O position.

P136-Clock Tick Selector.

Allows positive or negative Clock Ticks to be added to each channel of displayed data. Each Clock Tick represents the active edge of the Store Clock signal; moving the jumper disables the Clock Ticks.

P100-Display Clock Selector.

In a master/slave configuration (cascaded LA 501's), P100 provides the means to connect the Ext/Store/Display Clock from the master unit to the display clock circuitry in the slave unit.

P101-Ext Store/Display Clock Selector.

This jumper selects the Auxiliary Clock for the Store Clock. In a master/slave configuration, P101 connects the Ext Store/Display Clock to both the Store Clock and P100.

P120-Trigger Sync Selector.

Selects master or slave mode of operation. In master/slave configuration, synchronizes the memory multiplexers in the slave unit to the master unit.

Page 1-12, Fig. 1-7

Figure 1-7 is in error. The callout that reads negative edge should read positive edge and vice versa.

Page 1-14, right column, under the "DATA INPUT" heading, fifth line.

CHANGE: Delete all text under the foregoing head following the word "connector" in the fifth line.

Page 1-15, top of the right column, under "Z-AXIS INPUT", change to read as follows:

Z-AXIS INPUT. This connection permits control of display intensity with an externally generated signal. As the external signal goes positive (5 volts maximum) the display intensifies.

Page 1-15, right column, under "RECORD ENABLE", change to read as follows:

RECORD ENABLE. This connection is provided to set the memory into
the Store Mode by application of an external signal. A HI pulse at
ECL level is required. PAGE 3 OF 21

LA 501

CHANGE:

DESCRIPTION

C2/276

Page 1-15, Fig. 1-8.

CHANGE: Delete superscripts 3, 4, and 5. Change the nomenclature describing pin functions of J100 as follows:

- 9. AUX TRIGGER INPUT
- 22. AUX CLOCK INPUT
- 23. CLOCK STATUS
- 24. CLOCK STATUS
- 25. 1 MHz CLOCK OUTPUT

Page 1-16, Fig. 1-9.

CHANGE: Change the nomenclature describing pin functions of J120 as follows:

- 2. P300 PIN 1
- 5. P300 PIN 2

Page 1-17, left column.

CHANGE: Delete the paragraph entitled "INVALID MODE INPUT".

Page 1-17, Fig. 1-10

CHANGE: Change the nomenclature describing the pin functions of P300 as follows:

- -TO J120, PIN 2
- -TO J120, PIN 5 2
- -TRIGGER SYNC
- -MASTER RECORD ENABLE
- 11 -EXT STORE/DISPLAY CLOCK OUTPUT
- 12 -EXT STORE/DISPLAY CLOCK INPUT

Pins not listed retain their original nomenclature. Pins 11 and 12 are additions. In the detail circle showing the jumper positions, remove the jumper between 4 and 7, and add pins 11 and 12.

Page 1-17, left column, change the text under the FRAME OUTPUT heading as follows CHANGE: This connection provides for the output of an unterminated ECL level pulse. The negative edge of the frame output pulse indicates the start of channel 3 data. One complete pulse cycle represents one complete serial scan of data in the memory in 16-channel operation, two scans in 8-channel operation, and four scans in 4-channel operation.

PRODUCT.

DESCRIPTION

Page 2-3, in the lower part of Table 2-1, the CRT Retrace Blanking Time Performance Requirement should read as follows:

CHANGE REFERENCE

4.2 µs within 20% (2 bits)

2.2 µs within 20%, (1 bit)

1.2 μ s within 20% (1/2 bit)

Page 2-3, in the lower part of Table 2-1, the Horizontal Output-Linearity Performance Requirement should read:

Pulse width within 10% from 1% to 100% of sweep.

Following the title "Low-Impedance Data Input", Page 2-4

INSERT: (J100)

Page 2-4, under Low-Impedance Data Input

CHANGE: Clock Out, and its Performance Requirement to:

1 MHz Clock Output

Pin 25. Unterminated ECL level. When terminated,

the output is a standard, negative voltage ECL

1 MHz signal.

DELETE: Invalid Mode and its Performance Requirement.

DELETE: + 5 Volts and its Performance Requirement.

Page 2-4, following the last characteristic under Low-Impedance Data Input:

ADD: Aux Clock Input

Pin 22. Input to Store/Display clock gate.

(Negative level ECL.) Selected by P101.

ADD: Clock Status Output

Pins 23,24. Both pins are HI (gnd.) when SAMPLE

INTERVAL switch is in EXT position.

ADD: Aux Trigger Input

Pin 9. Provides trigger signal input from J100.

(Negative level ECL.)

Pages 2-4 & 2-5, following the title "DATA OUTPUT",

INSERT: J(120)

Pages 2-4 & 2-5, under Data Output

CHANGE: The Performance Requirement of Record Enable to read as follows:

Positive going pulse at ECL levels sets memory into record mode.

CHANGE: The Performance Requirement of Frame Output

Jumper, P300 pin 8. A negative going edge indicates the start of

Channel 3.

Page 2-5, following the last characteristic under Data Output:

PRODUCT LA JUI	CHANGE REFERENCE DATE DATE
CHANGE:	DESCRIPTION
ADD: Trigger Sync Output ADD: Master Store Enable	Permits synchronous displayed data from two or more units (master-slave operation).
ADD: Ext Store/Display C	lock Jumper, P300 pin 11. Master unit clock signal output for use by slave units (s).
ADD: Ext Store/Display C	lock Jumper, P300 pin 12. Clock signal input for slave unit (s) from master unit.
add a new major title 'R ADD: Display Clock Input ADD: Serial Data Output	Output B20 (same as P300-6) B12 (same as P300-8)
referred to as Frame Clo Page 3-3, paragraph Stor	2 throughout the rest of the manual the signal ck is to be changed to Flag. e/Display Clock Gate A's with UllOB and replace all UllOB's with UllOA.
Page 3-6, right hand col CHANGE: on line 4 change Page 3-6, right hand col CHANGE: on line 4 change	pin 14 to pin 11 umn, second paragraph pin 14 to pin 11
Page 3-6, under paragraph labeled "Sixteen Channel".	

CHANGE: on line 3 change pin 14 to pin 11

DESCRIPTION

Page 3-6, right column, just ahead of the "Data Selector" heading INSERT: The following heading and text.

Clock-Tick Generator

The Clock-Tick Generator provides a clock reference for the display, in the form of small pulses superimposed on the displayed waveforms. The clock ticks are positive pulses when the displayed signal level is LO, and negative when the displayed signal level is HI.

When the FORMAT switch, S110, is set for 4- or 8-channel operation, pin 13 of U136D is held HI. With pin 13 HI, the display clock signal at pin 12 is inverted by exclusive-OR gate U136D. When the FORMAT switch is set for 16-channel operation, pin 13 of U136D is LO and the display clock signal is passed, uninverted, by U136D. The output of Ul36D is connected by Pl36 to the anode of CR136 and the base of Ql36 through C136.

The operation of the circuit depends on the logic state of the displayed signal (from R270, diagram 6) during the positive transition of the clock signal at the output of U136D. If the displayed signal is LO, the positive transition of the clock signal is coupled through C136 and CR136 to the vertical output stage on diagram 6. This produces a LO level signal displayed with a positive pulse indicating the active edge of the clock signal. If the displayed signal is HI, the positive transition of the clock signal is coupled through Cl36 to the base of Ql36. The positive pulse at the base cuts off Q136 (Q136 is normally saturated), producing a negative pulse at the collector. This negative pulse is coupled through CR137 to the vertical output stage, resulting in a HI level signal displayed with a negative pulse indicating the active edge of the clock signal.

Page 3-8, left column, first paragraph, the sentence starting in the sixth line. CHANGE: Lines 6 through 9 should read as follows:

When pin 4 of U610A is LO, pin 2 is HI, setting the Q output (pin 2) of U616A HI. The HI at pin 2 of U616 resets the Q output (pin 14) of Store/Display flip-flop U615B to a HI level.

Page 3-8, left column, first paragraph

CHANGE: In lines 14 and 21 replace "pin 3" with "pin 2".

DESCRIPTION

Page 3-8, under paragraph "Trigger Source Selector".

CHANGE: On line 15 change "pin 13 of U608D" to read, pin 6 of U632B.

CHANGE REFERENCE.

CHANGE: On line 16 change "U608D" to U632B.

CHANGE: On line 17 change "D" to U632B.

Page 3-8, under paragraph "Trigger Position Counter"

DELETE: Sentence in line 18, starting with "The output line".....

CHANGE: Last two sentences to read as follows:

When all outputs are LO pin 13 of U608D is LO. When pin 13 and the LF Clock signal are both LO the $\underline{\text{NOR}}$ Output of U608D goes HI and the OR Output goes LO.

Page 3-10, Fig. 3-10

CHANGE: Column labeled "16 CH" to read as follows:

1.2

13

14

15

8

9

10

11

4

5

6

7

0

1

2

3

Page 3-11, left column, first paragraph, third line.

CHANGE: Starting with the words 'The display clock inhibit', replace the paragraph with the following:

The display clock inhibit signal on U610D, pin 12 is HI during the store time. A HI at pin 12 makes pin 15 HI, which drives U632C, pin 14 LO to blank the display. The output of U610D is HI as long

DESCRIPTION

CHANGE:

Page 3-6, right column, just ahead of the "Data Selector" heading

INSERT: The following heading and text.

Clock-Tick Generator

The Clock-Tick Generator provides a clock reference for the display, in the form of small pulses superimposed on the displayed waveforms. The clock ticks are positive pulses when the displayed signal level is LO, and negative when the displayed signal level is HI.

When the FORMAT switch, S110, is set for 4- or 8-channel operation, pin 13 of U136D is held HI. With pin 13 HI, the display clock signal at pin 12 is inverted by exclusive-OR gate U136D. When the FORMAT switch is set for 16-channel operation, pin 13 of U136D is LO and the display clock signal is passed, uninverted, by U136D. The output of U136D is connected by P136 to the anode of CR136 and the base of Q136 through C136.

The operation of the circuit depends on the logic state of the displayed signal (from R270, diagram 6) during the positive transition of the clock signal at the output of U136D. If the displayed signal is LO, the positive transition of the clock signal is coupled through C136 and CR136 to the vertical output stage on diagram 6. This produces a LO level signal displayed with a positive pulse indicating the active edge of the clock signal. If the displayed signal is HI, the positive transition of the clock signal is coupled through C136 to the base of Q136. The positive pulse at the base cuts off Q136 (Q136 is normally saturated), producing a negative pulse at the collector. This negative pulse is coupled through CR137 to the vertical output stage, resulting in a HI level signal displayed with a negative pulse indicating the active edge of the clock signal.

Page 3-8, left column, first paragraph, the sentence starting in the sixth line. CHANGE: Lines 6 through 9 should read as follows:

When pin 4 of U610A is LO, pin 2 is HI, setting the Q output (pin 2) of U616A HI. The HI at pin 2 of U616 resets the \overline{Q} output (pin 14) of Store/Display flip-flop U615B to a HI level.

Page 3-8, left column, first paragraph

CHANGE: In lines 14 and 21 replace "pin 3" with "pin 2".

DESCRIPTION

Page 3-8, under paragraph "Trigger Source Selector".

CHANGE: On line 15 change "pin 13 of U608D" to read, pin 6 of U632B.

CHANGE REFERENCE

CHANGE: On line 16 change "U608D" to U632B.

CHANGE: On line 17 change "D" to U632B.

Page 3-8, under paragraph "Trigger Position Counter"

DELETE: Sentence in line 18, starting with "The output line"....

CHANGE: Last two sentences to read as follows:

When all outputs are LO pin 13 of U608D is LO. When pin 13 and the LF Clock signal are both LO the NOR Output of U608D goes HI and the OR Output goes LO.

Page 3-10, Fig. 3-10

CHANGE: Column labeled "16 CH" to read as follows:

12

13

14

15

8

9

10

11

5

0

1

2

3

Page 3-11, left column, first paragraph, third line.

CHANGE: Starting with the words 'The display clock inhibit', replace the paragraph with the following:

The display clock inhibit signal on U610D, pin 12 is HI during the store time. A HI at pin 12 makes pin 15 HI, which drives U632C, pin 14 LO to blank the display. The output of U610D is HI as long

LA 501

DESCRIPTION

as the memory is storing data, which ensures that the display is blanked during the store cycle.

Page 3-11, left column, third and fourth paragraphs

REPLACE: The third and fourth paragraphs with the following:

In the Bad Data Blanking mode, P629 disables the Q output of U628A. At the beginning of the store cycle, the \overline{Q} output at U628A, pin 3 is set LO by the Store Start signal on U628, pin 5. If a trigger is present at U615A, pin 6 (Diagram 4) before the memory has time to cycle once, the \overline{Q} output of U628A remains LO and the Flag pulse sets the Q output at U628B, pin 15 HI, which blanks the display. Since the Flag signal occurs at the start of the sweep, the first part of the display is blanked. The $\overline{Address}$ Count Carry signal then clocks the Q output at U628, pin 15 LO, which unblanks the display.

If P629 is selected for the Trigger Lockout mode, the Store Start signal sets the Q output of U628A HI at the beginning of the store cycle. This HI will lockout any triggers by holding U615B, pin 6 (Diagram 4) HI. The HI at the Q output of U628A remains until the memory is full, which is signified by the Address Count Carry signal at U610B, pin 6 going LO. The Address Count Carry signal is inverted by U610B, and the positive edge of the inverted signal clocks the Q output of U628A LO, therby enabling the trigger circuits.

Page 3-11, left column, third paragraph, second sentence.

CHANGE: Normally, the address count carry signal at pin 9 causes the Q output (pin 15) to go HI, indicating a complete store cycle has occurred and all stored data is "good data".

Page 3-11, right column, third paragraph. The circuit description for the -4.8-Volt Supply should read as follows:

-4.8-Volt Supply

The -4.8-Volt Supply is derived from the 25-volt ac windings of the transformer in the power module. The ac input is rectified by CR904, then filtered by C904, L905, and C905. The resultant dc source is converted by a switching regulator to -4.8 volts. Zener diode VR922 and transistor Q922 maintain a constant current through VR920 to establish a reference voltage. The reference voltage at the wiper of R925 is applied to the base of Q914.

DATE

CHANGE:

LA 501

DESCRIPTION

0905 is a series switching regulator that produces a rectangular power waveform whose energy is stored in T911. The negative transition of Q905 is coupled through C911 and R912 to the base of Q914 to control the on-Time of Q914. The positive transition of Q905 is coupled through C911, R912, C927, and R927 to the base of Q928, resulting in a fast turn-off time for Q905.

Transistors Q914 and Q916 compare the output voltage with the reference voltage from R925. If the output voltage is more negative than the reference, the on-time of Q914 becomes less, reducing the on-time of Q910 and Q905. The amount of energy stored in T911 is thereby reduced, pulling the output voltage positive. When the output voltage becomes less negative than the reference voltage, Q914 conducts longer, increasing the on time of Q910 and Q905. The amount of energy stored is thereby increased and the output goes more negative.

Zener diode VR932 and SCR Q932 provide over-voltage protection for the IC's connected to this supply. If the output voltage exceeds about -6.2 volts, Q932 switches in, shorting the -4.8-Volt Supply and blowing fuse F905.

Page 4-3, left column, last paragraph, should read as follows: The Trouble shooting Charts in the Diagrams section (or the following procedure) can be used as a guide for troubleshooting the LA 501. Both the charts and the procedure check the simple trouble possibilities before proceeding with extensive troubleshooting. The first few checks ensure proper connection, operation, and adjustment. If the trouble is not located by these checks, the remaining steps aid in locating the defective component. When the defective component is located, it should be replaced using the replacement procedure given under Corrective Maintenance.

DATE.

LA 501 PRODUCT_

CHANGE:

DESCRIPTION

Page 4-3, right column, following the last paragraph, add the following: NOTE

> If the selector block is in the H position (108 V AC to 132 V AC) adjust the autotransformer for 120 V AC.

Page 4-4. Table 4-1. Change the Maximum Ripple Peak-to-Peak specification for high frequency to 100 mV in both cases.

Page 5-4, right column.

CHANGE: Add the following Step 4.

- 4. Check that the positions of the internal jumpers are as follows:
 - a. P831 jumper from pin 1 to pin 2.
 - b. P629 jumper from pin 1 to pin 2.
 - c. P608 jumper from pin 2 to pin 3.
 - d. P136 jumper from pin 1 to pin 2.
 - e. P100 jumper from pin 1 to pin 2.
 - f. P101 jumper from pin 2 to pin 3.
 - g. P120 jumper from pin 1 to pin 2.

Page 5-12, right column, under heading E5. CHECK HORIZONTAL LINEARITY.

CHANGE: Part d should read as follows:

d. Horizontally position display so that left 1.0% of display is off screen.

Page 5-12, right column, bottom of the page.

CHANGE: Add the following text.

E6. CHECK CLOCK TICKS

- a. Check the display in full vertical and horizontal magnified position for usable bipolar Clock Ticks on all four displayed channels.
- b. Check that the clock ticks are negative ticks for a logic 1 and positive ticks for a logic 0.

CHANGE:

PRODUCT_

DESCRIPTION

Page 5-13, right column.

CHANGE: Delete Steps F1 j through p.

Change Step F1 i to read:

i. Check for a clean, symmetrical 50 MHz ECL display.

Page 5-15, left column, at Step F7 g,

CHANGE: Add the following material:

Set SAMPLE INTERVAL to EXT. Connect 10% probe to the EXT CLOCK BNC connector. Connect the probe tip to Test Point

TP820 and repeat part c again for Channel 7.

Page 5-17, right column, Step G2.

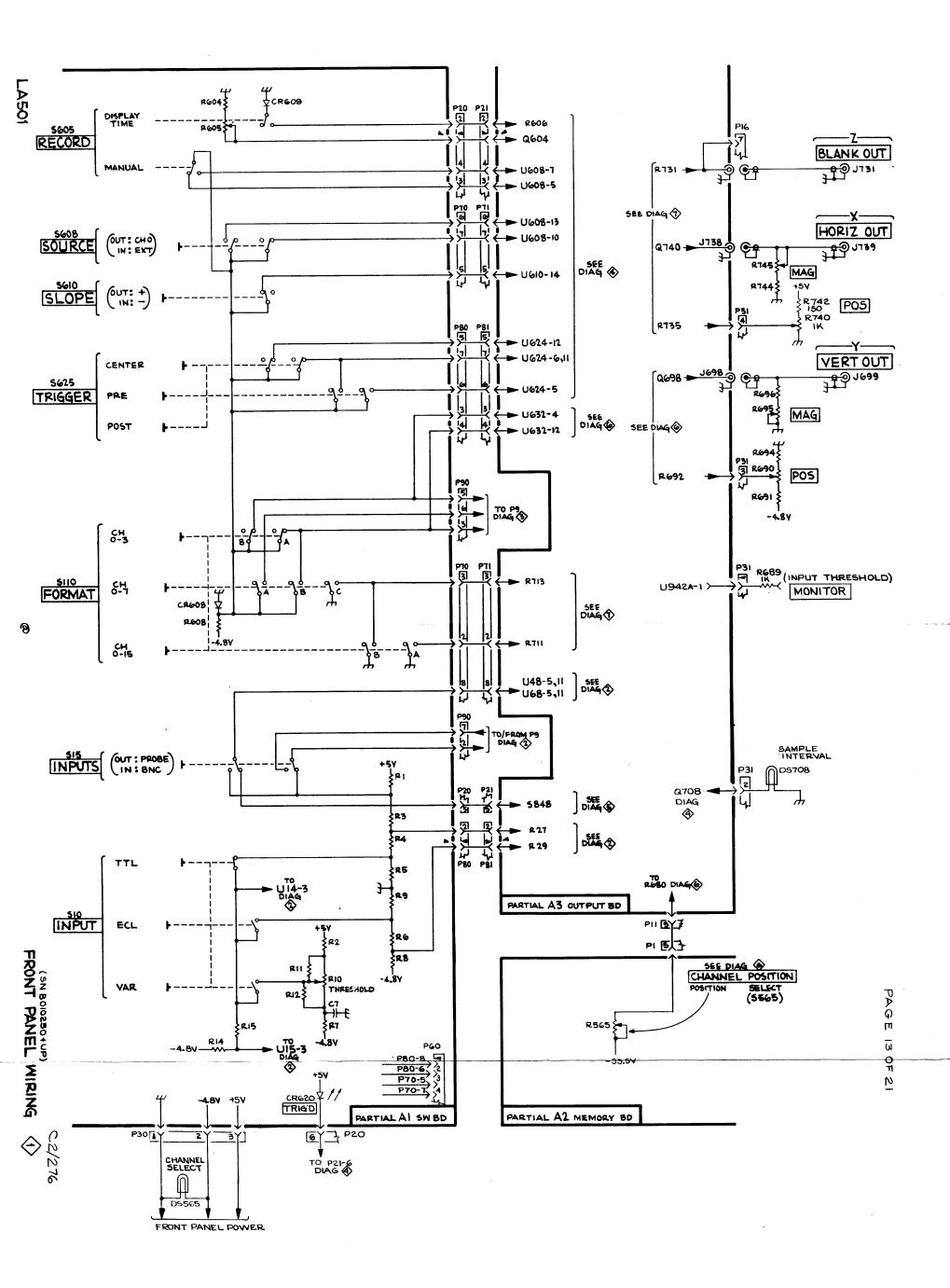
CHANGE: Insert the following text between the heading and part a:

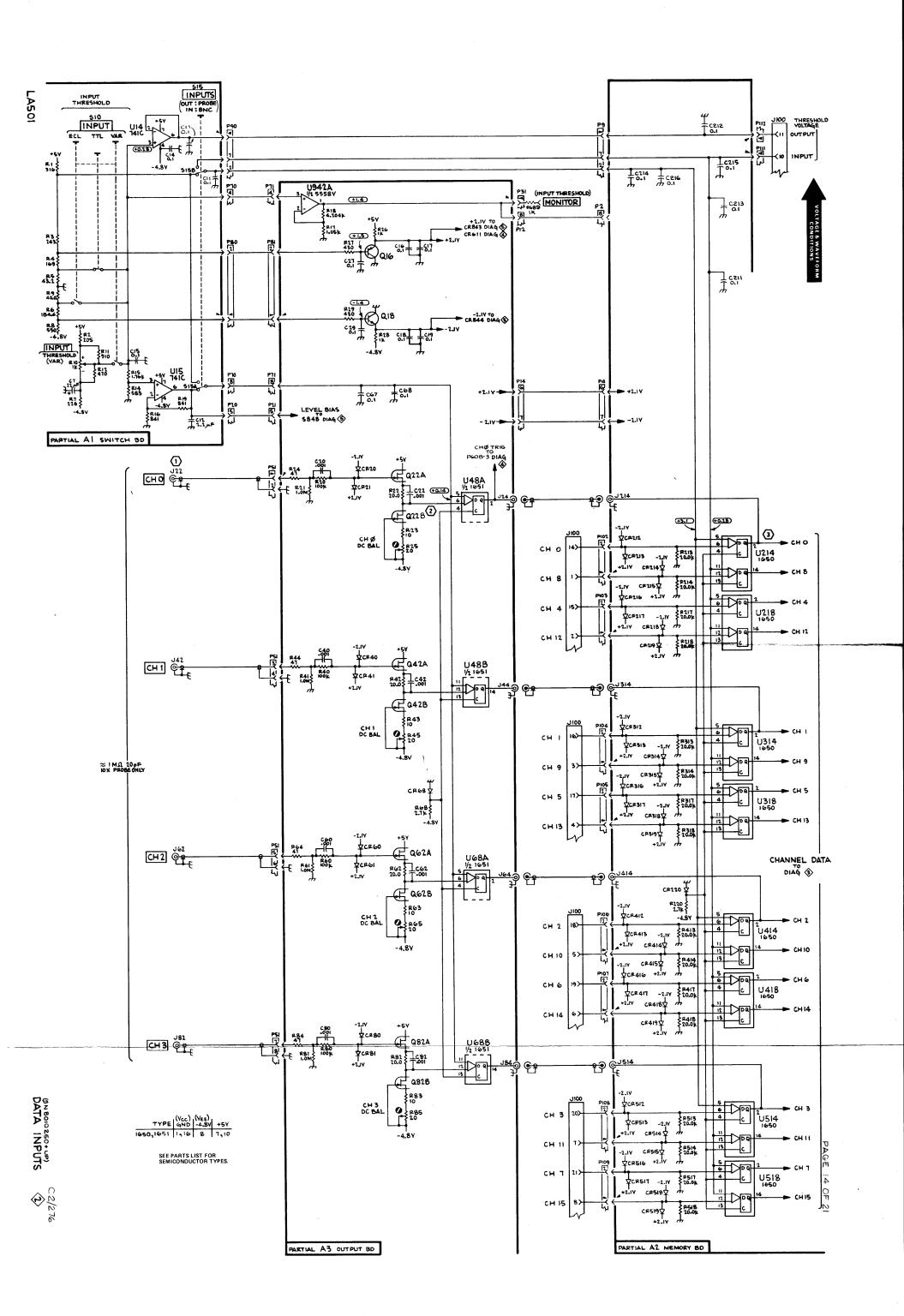
a. Change P629 jumper position to pins 2 and 3.

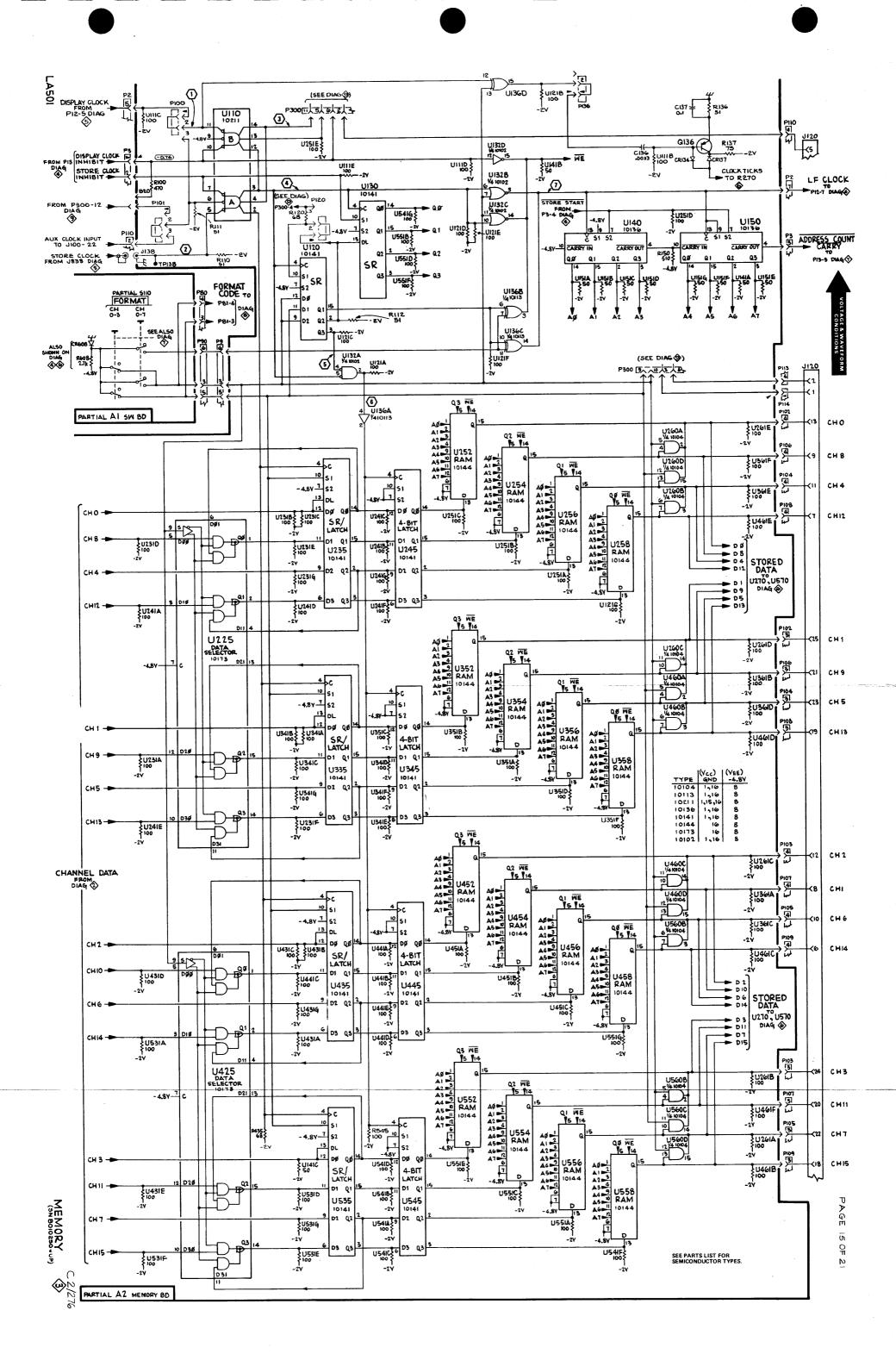
CHANGE: Re-letter the parts a through h to b through i.

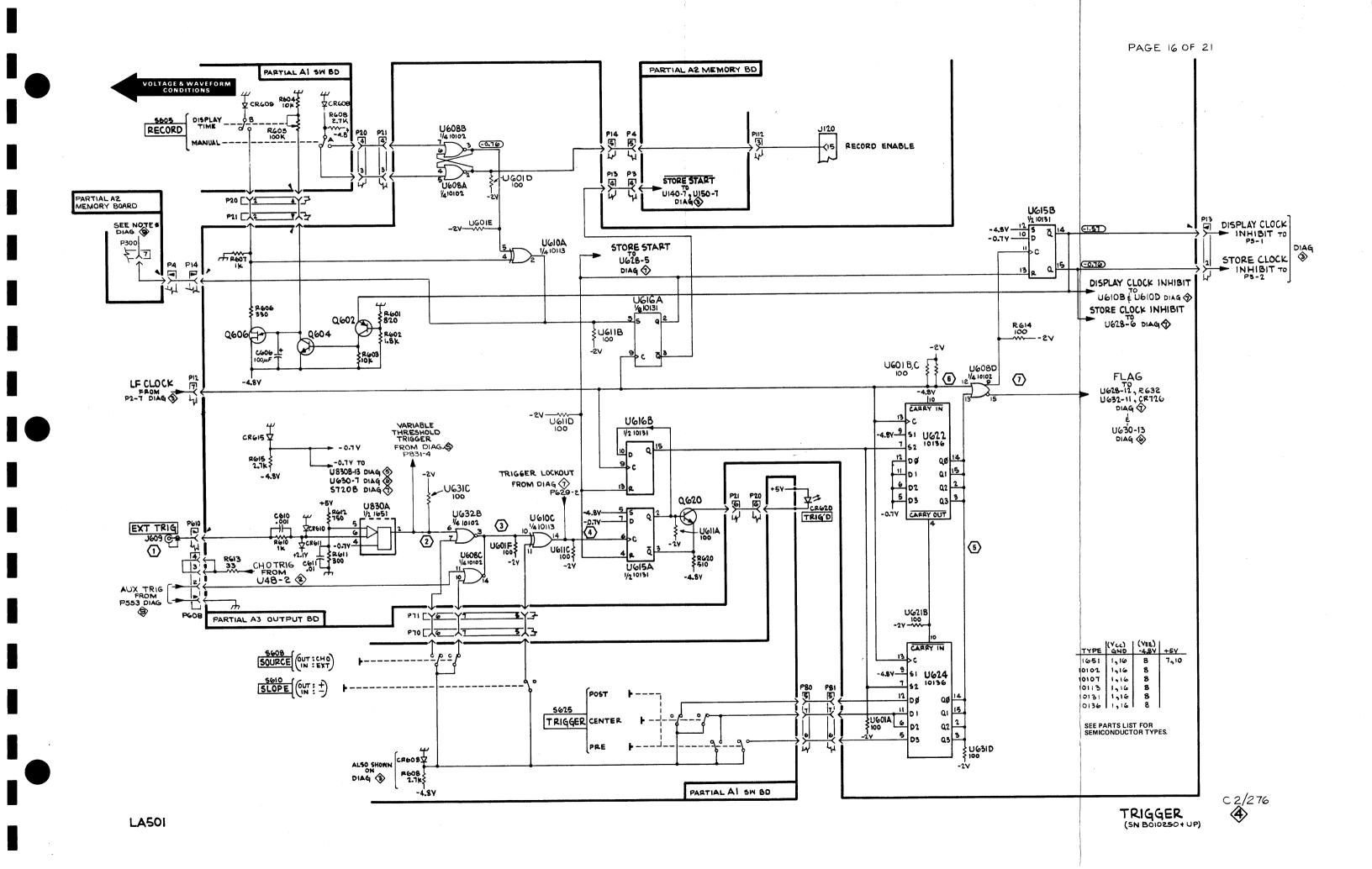
CHANGE: Add the following text at the end of G2:

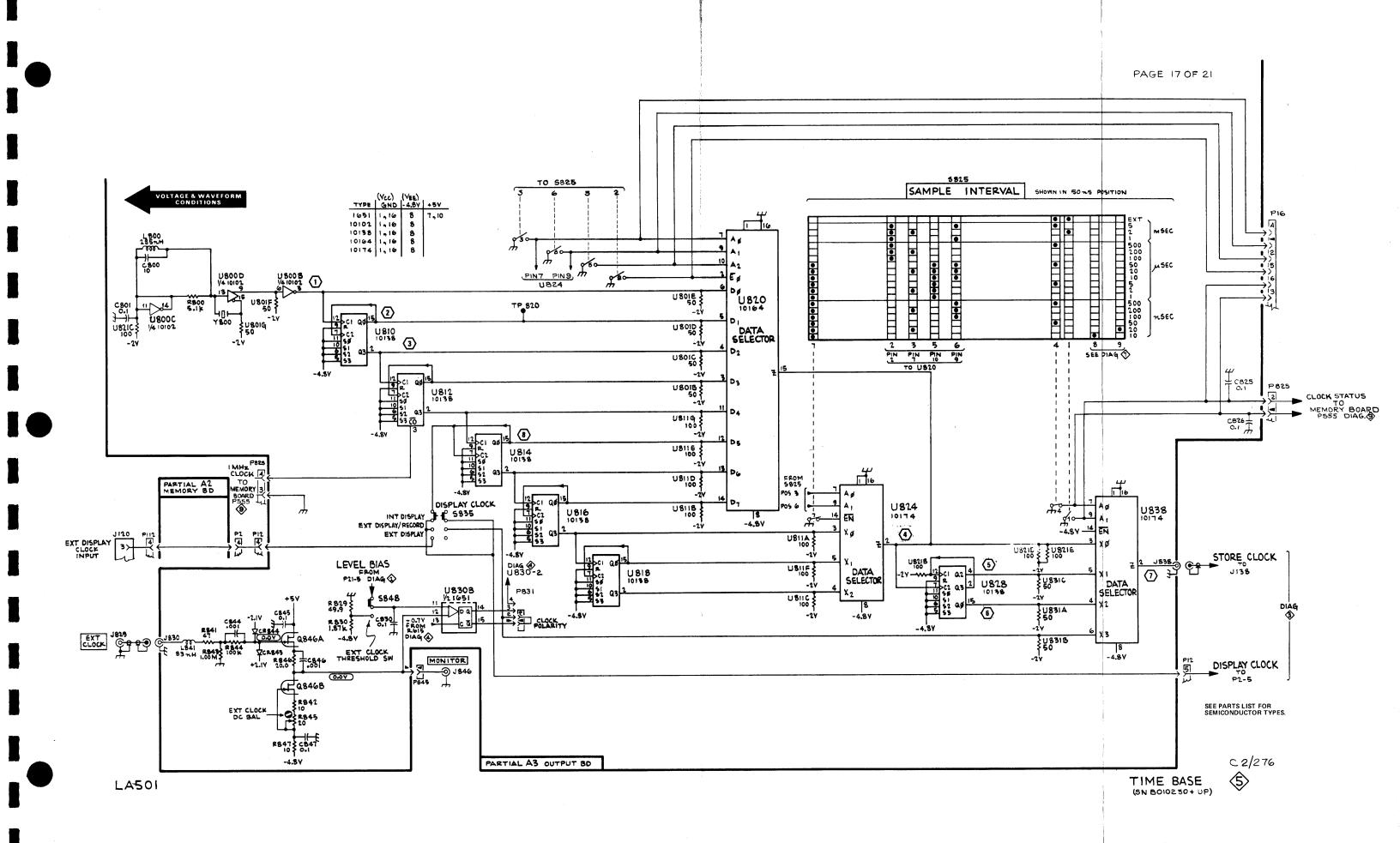
j. Return P629 jumper position to pins 1 and 2.

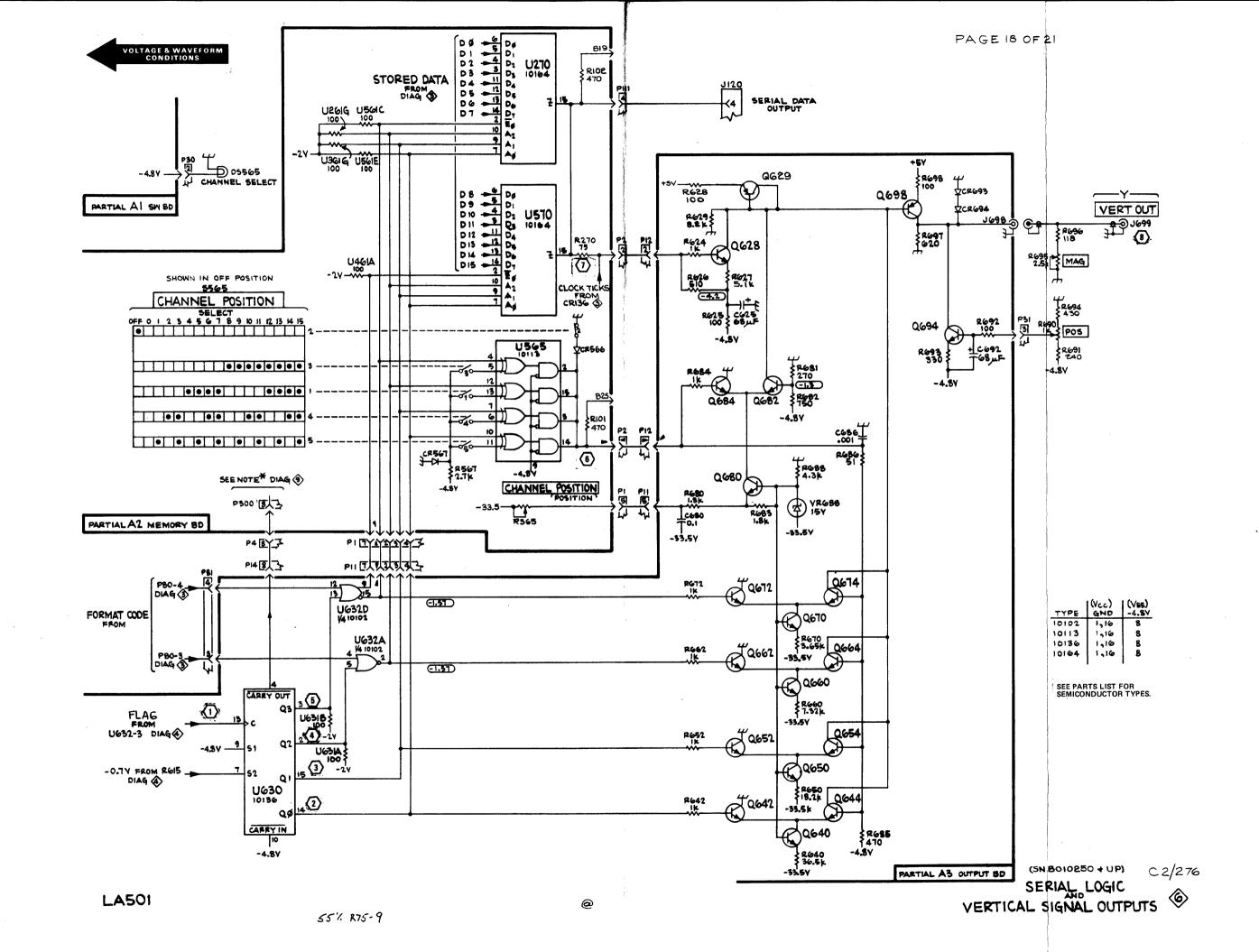


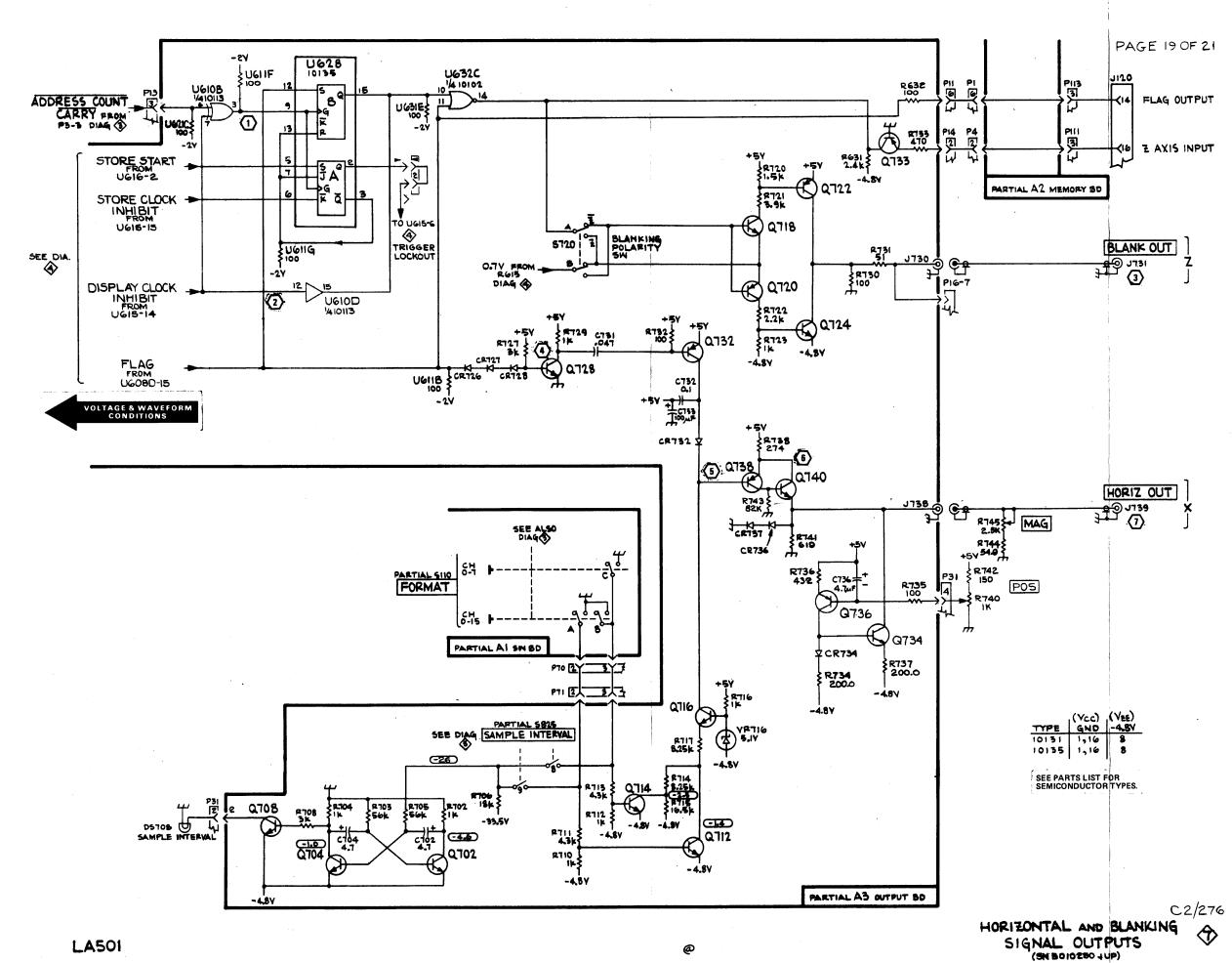


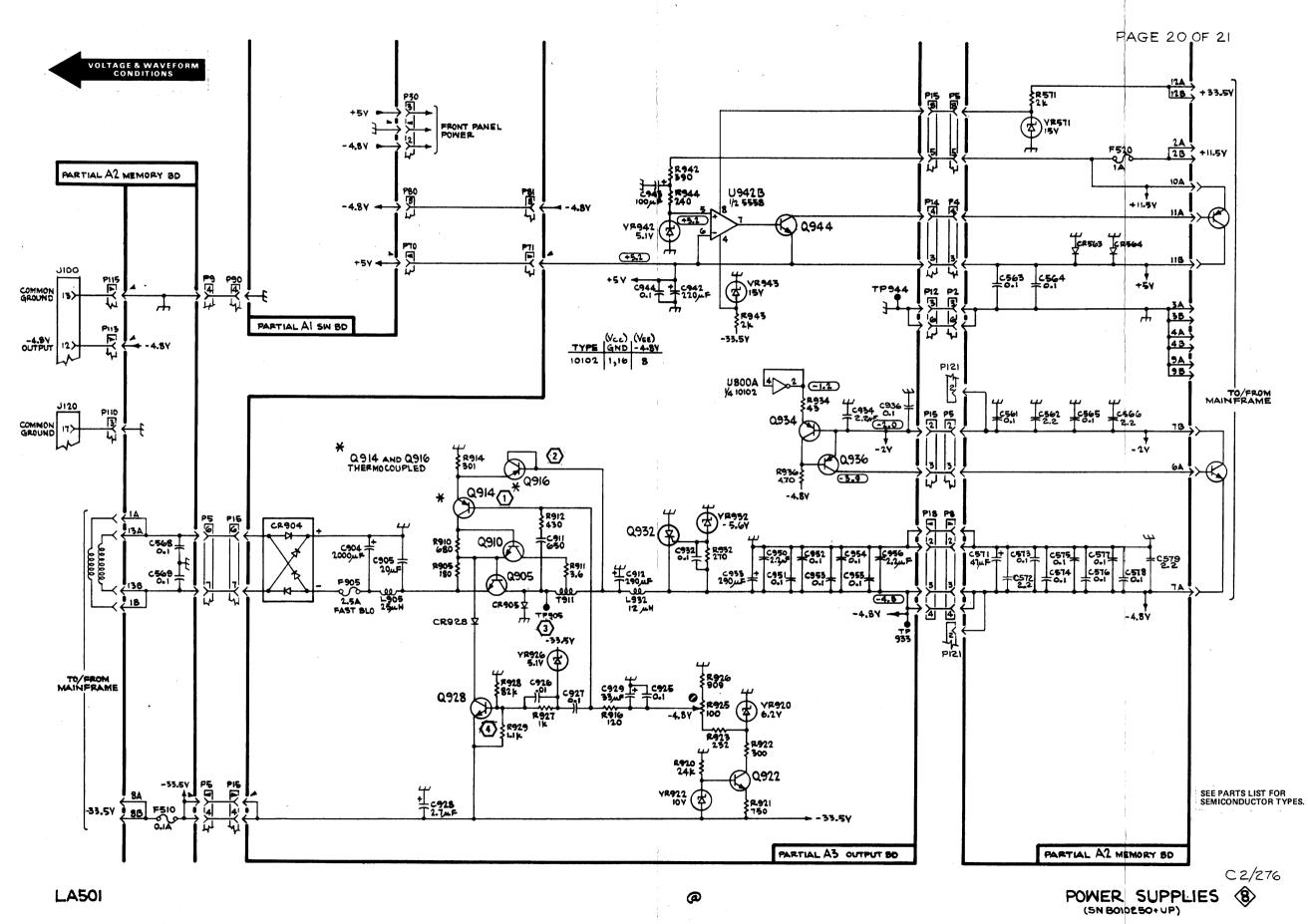


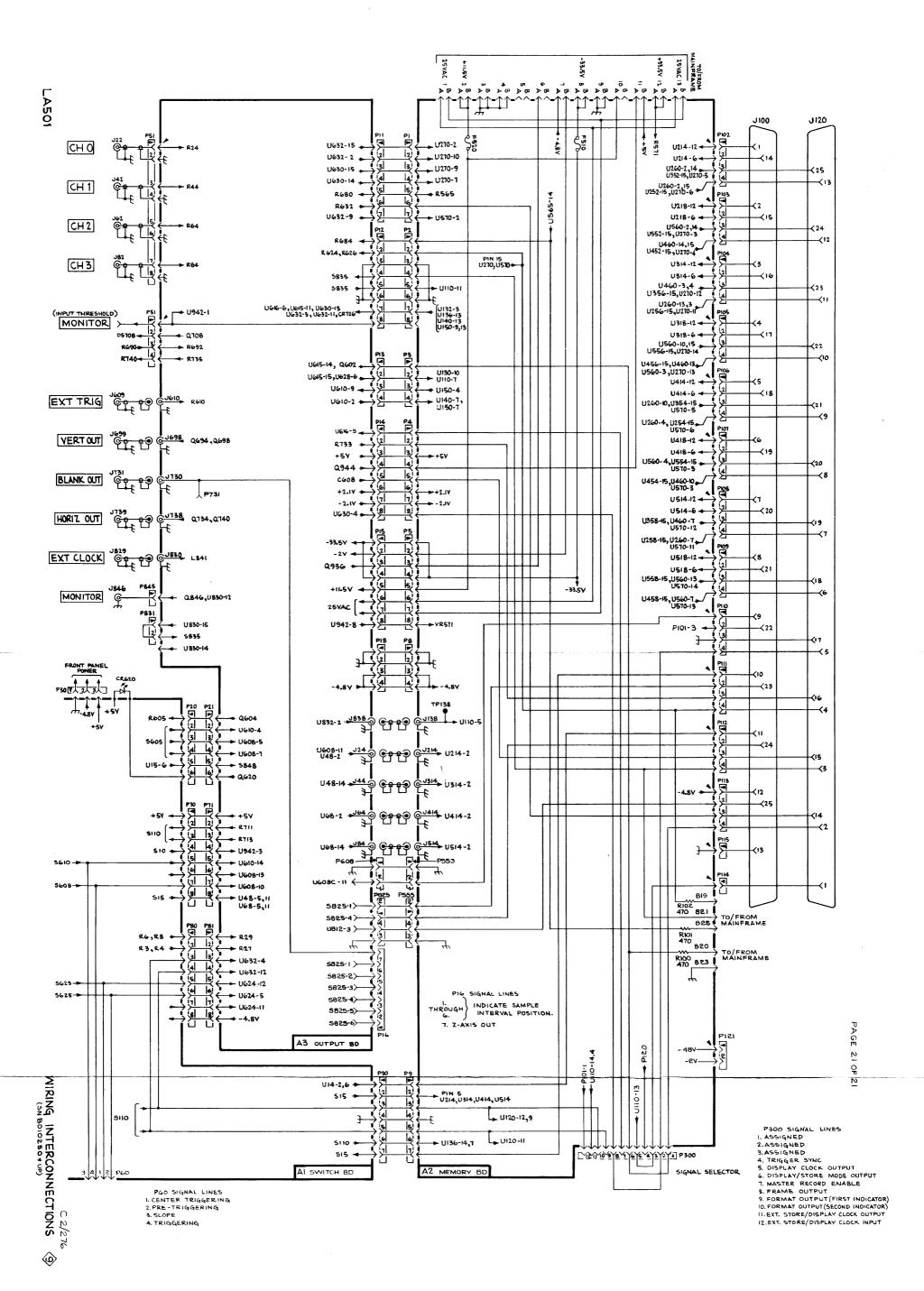














MANUAL CHANGE INFORMATION

LA 501 PRODUCT _ EFF SN B010250-up CHANGE REFERENCE C3/576 5-18-76 DATE

CHANGE:

DESCRIPTION

070-1967-00

ELECTRICAL PARTS LIST AND SCHEMATIC CHANGES

CHANGE TO:

(Pilot Change #22, EFF SN B010250-up)

R270

315-0750-00

RES., FXD, CMPSN:75 OHM, 5%, 0.25W

R627

315-0512-00

RES., FXD, CMPSN: 5.1K OHM, 5%, 0.25W

ADD:

C11 283-0023-00

CAP., FXD, CER DI:0.1UF, +80-20%, 12V (C276/Dia 2)

C13

283-0023-00

CAP., FXD, CER DI:0.1UF, +80-20%, 12V (C276/Dia 2)

283-0023-00 C211

CAP., FXD, CER DI:0.1UF, +80-20%, 12V (C276/Dia 2)

C825

283-0023-00

CAP., FXD, CER DI:0.1UF, +80-20%, 12V (C276/Dia 5)

C826

283-0023-00

CAP., FXD, CER DI:0.1UF, +80-20%, 12V (C276/Dia 5)

R545

315-0101-00

RES., FXD, CMPSN:100 OHM, 5%, 0.25W (C276/Dia 3)

R689

315-0102-00

RES., FXD, CMPSN:1K OHM, 5%, 0.25W (C276/Dia 2)

MECHANICAL PARTS LIST CHANGES

ADD:

210-0004-00

1 LOCKWASHER,#4

REMOVE:

131-0608-00

CONNECTOR, TERMINAL PIN

(Pilot Change #24 EFF SN B010275-up)

ADD:

C132

281-0564-00

CAP., FXD, CER DI:24PF, 5%

VR903

152-0309-00

SEMICOND DEVICE: ZENER, 1 W, 6.2V, 1N3828A

(Pilot Change #25 EFF SN B010325-up)

CHANGE TO:

C928

283-0212-00

CAP., FXD, CER DI:2UF, 20%, 50V

0606

151-0504-01

TRANSISTOR: SILICON, N-CHAN, UNIJUNCTION, CHECKED

PAGE

CHANGE:

DESCRIPTION

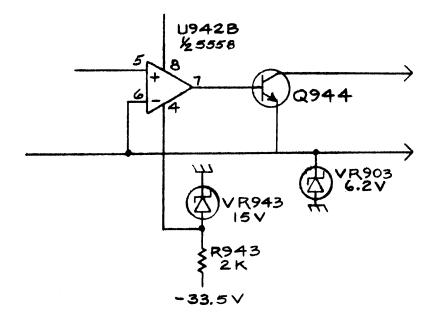
SCHEMATIC CHANGES

(C2/276) DIAGRAM (3)

Cl32 is added between pins 2 and 4 of Ul32A on the Memory board.

(C2/276) DIAGRAM (8)

VR903 is added from ground to the +5V supply on the OUTPUT board.





MANUAL CHANGE INFORMATION

PRODUCT LA 501 EFF SN B010405-up CHANGE REFERENCE ____C4/676

DATE 6-2-76 REV. 6-8-76

CHANGE:

DESCRIPTION

070-1967-00 Pilot Change #29

ELECTRICAL PARTS LIST AND SCHEMATIC CHANGES

CHANGE TO:

R110

315-0820-00

RES., FXD, CMPSN:82 OHM, 5%, 0.25W

R111

315-0750-00

RES., FXD, CMPSN:75 OHM, 5%, 0.25W

REMOVE:

R101

317-0471-00

RES., FXD, CMPSN: 470 OHM, 5%, 0.125W

ADD:

C609

283-0023-00

CAP., FXD, CER DI:0.1UF, +80-20%, 12V

Add C609 from pin 11, U610 to ground shown on diagram 4 on insert C2/276.